# $\begin{array}{llllllll}B & Y & \quad & E & B & O & K & S\end{array}$ BUILD YOUR OWN Z80 COMPUTER 



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Readers are encouraged to download this book of design guidelines and application notes from Steve Ciarcia, founder and editorial director of Circuit Cellar magazine. Although the original title first appeared in 1981, pre-dating Circuit Cellar "the magazine," I still get a number of purchase requests each year from electronics enthusiasts. Some are just interested in Steve's brand of designing and ability to overcome obstacles, while others still find themselves tweaking projects that use parts described in Steve's projects.

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Please enjoy "Build Your Own Z80 Computer" as a great blast from the past. Its style is the foundation on which Circuit Cellar magazine was built and continues to grow. I look forward to seeing you become a part of the ongoing Circuit Cellar success story.

Sincerely,

Sean Donnelly, Publisher - Circuit Cellar circuitcellar@circuitcellar.com


THE MAGAZINE FOR COMPUTER APPLICATIONS

# Build Your Own Z80 Computer 

Design Guidelines and<br>Application Notes

## Steve Ciarcia

## Build Your Own Z80 Computer

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## Build Your Own Z80 Computer

To my wife Joyce,
Steve Sunderland, and Judy and Lloyd Kishinsky

## Introduction

A few years ago, when microprocessors were first introduced, computer enthusiasts and electrical engineers were one and the same. Those of us who lived only to solder kluge after kluge basked in our glory. Now, however, the prices of completely assembled and packaged systems have plummeted. Today anyone with an interest, almost regardless of technical capabilities, can own and operate a computer. Buying a computer is now similar to purchasing a television set and the ranks of computer enthusiasts have swelled accordingly.

With any popular movement, the available literature reflects the concerns of a majority of the followers. And, consistent with the popularization of computer science, the technical emphasis on computer bookshelves has shifted away from hardware design. Other than introductory texts called, say, How Logic Gates Work, most computer books either treat microcomputer hardware simplistically or attempt to be "catch-all" cookbooks, sometimes omitting tasty ingredients. Often, the only alternatives are engineering texts and trade journals, tedious reading at best.

For a number of years, I have been writing a column for $B Y T E$ magazine, and reader response has shown that there still exists a great deal of interest in hardware design and do-it-yourself projects. At the same time, I've been painfully aware of the lack of materials for such people. Most queries come from technical or high school students who have read all the descriptions and studied the block diagrams, but who crave practical answers and system examples. Unfortunately, there are very few books I can suggest.

Build Your Own Z80 Computer is a book written for technically minded individuals who are interested in knowing what is inside a microcomputer. It is for persons who, already possessing a basic understanding of electronics, want to build rather than purchase a computer. It is not an introductory electronics handbook that starts by describing logic gates nor on the other hand is it a text written only for engineering students. While serving to educate the curious, the objective of this book is to present a practical, step-by-step analysis of digital computer architecture, and the construction details of a complete and functional microcomputer.
The computer to be constructed is called a Z80 Applications Processor-ZAP computer for short. It is based on the industry standard Zilog Z80 microprocessor chip. This chip was chosen on the basis of its availability and low cost, as were the other components for ZAP. To further help the homebrew enthusiast, and for those experimenters who prefer to start a book at the back, I have listed in Appendix A a company that supplies parts and programmed EPROMs (erasable-programmable read-only memory).

I have structured the book as a logical sequence of construction milestones interspersed by practical discussions on the theory of operation. My purpose is twofold: to help a potential builder gain confidence, and to make the material more palatable through concrete examples.

Though this is basically a construction manual, considerable effort is given to the "why's" and "how's" of computer design. The reader is exposed to various subjects, including: the internal architectures of selected microprocessors, memory mapping, input/output interfacing, power supplies, peripheral communication, and programming. All discussions try to make the reader aware of each individual component's effect on the total system. Even though I have documented the specific details of the ZAP computer, it is my intention (and the premise of the book) that the reader will be able to configure a custom computer. ZAP is an experimental tool that can be expanded to meet a variety of applications.

ZAP is constructed as a series of subsystems that can be checked and exercised independently. The first item to be built is the power supply. This is a good way to test ability and provide immediate positive reinforcement from successful construction. The three-voltage supply is both overvoltage and overtemperature protected and has adequate current for an expanded ZAP system.
Next, the reader learns why the Z80 was chosen for ZAP and the architectural considerations that affect component selection on the other subsystems. A full chapter is devoted to the Z80 chip. Each control signal is explained in detail and each instruction is carefully documented.
The hardware construction proceeds in stages with intermediate testing in order to ensure success. The basic elements of the computer are assembled first and then checked out. The reader selects which peripherals are to be added. The book contains sections on the construction of a hexadecimal display, keyboard, EPROM programmer, RS-232C serial interface, cassette mass storage system, and fully functional CRT terminal. In addition, a chapter addresses interfacing the ZAP to analog signals. I provide specific circuits that can convert ZAP into a digital speech synthesizer or a data acquisition system and data logger.
A special I K (1024 bytes) software monitor coordinates the activities of the basic computer system and the peripherals. Software is explained through flow diagrams and annotated listings. With this monitor as an integral component, ZAP can function as a computer terminal, a dedicated controller, or a software development system.

Build Your Own Z80 Computer is a book for hardware people. It cuts through the theoretical presentations on microcomputers and presents a real "How-to" analysis suitable for the reader with some electronics experience or for the novice who can call someone for supervision. From the power supply to the central processor, this book is written for people who want to understand what they build.

Steve Ciarcia
May 1981

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## CHAPTER 1

## POWER SUPPLY

It's not enough to build a central processor card with a little input/output (I/O) and memory, and call it a computer. From the time you walk over to the computer and flip the switch, the system is completely dependent upon the proper operation of its power supply. A book concerned with building a computer system from scratch would be completely inadequate without a description of how to construct an appropriate power supply.
Much has been written on the subject of direct current (DC) power supplies. There are $D C$ to $D C$ and $A C$ (alternating current) to DC converters, switching and shunt regulators, constant voltage transformers, and so on. It's not my intention to make a power supply expert out of everyone. Instead, I will outline the design of the specific DC power supply which we will use to power the Z80 Applications Processor (ZAP).
In large computers, the $D C$ supplies convert enormous amounts of power to run thousands of logic chips; by necessity, manufacturers choose the most efficient methods of power conversion. These state of the art methods would be expensive and difficult for the hobbyist to build in prototype form. Fortunately, the power demands for ZAP are much less than those of the large computers; we can take advantage of established design methods while incorporating the latest advances in regulator technology. Figure 1.1 is a block diagram of the power supply for ZAP.
Each of the three DC supplies necessary to power ZAP consists of three basic modules: a transformer section to reduce the 120 VAC line voltage to the lower voltage used by the computer; an input rectifier/filter to convert $A C$ to low ripple $D C$; and a regulator which stabilizes the output at a fixed voltage level. Overvoltage protection circuitry will be discussed separately.


Figure 1.1 A block diagram of the basic power supply for the Z80 Applications Processor (ZAP).

The proper specification of the transformer and input filter is often neglected by hobbyists who overlook the consequences of a poorly designed filter. This is caused, in part, by the abundant technical information circulated by semiconductor manufacturers extolling the virtues of their regulator circuits. One can easily conclude from this "publicity gap" that the regulation section of the power supply is the only component worthy of consideration; and in fact, advances in regulator design and the advent of high-power, three-terminal regulators have reduced the need for the analog designer in the application. In the past, 25 -odd components and considerable calculations were necessary to produce an adequate voltage regulator. Now, however, the majority of applications can be accommodated with a single, compact device. Even so, an input filter section should not be taken lightly and still requires thorough consideration and a modest amount of computation for each application.
There are three supply voltages necessary to operate ZAP. Each supply incorporates an input filter section. Because the +5 V supply is the most important, it receives the most attention. For the purposes of this discussion, we will divide the supply into two sections: transformer/input filter, and output regulator.

A standard input filter block diagram is shown in figure 1.2. In its simplest form, it consists of three components that function as follows:

- A transformer that isolates the supply from the power line and reduces the 120 VAC input to usable, low-voltage AC.
- A bridge rectifier that converts $A C$ to full-wave $D C$ and satisfies the charging current demands of the filter capacitor.
- A filter capacitor that maintains a sufficient level between charging cycles to satisfy the regulator input voltage limitations.


Photo 1.1 120 VAC RMS input/output waveform of a saturated transformer.


Figure 1.2 A block diagram of a standard input filter.

## DESIGNING AN INPUT FILTER

You would think that specifying the transformer would be the first consideration when designing a power supply. Yes and no. The approximate output voltage can be determined by rule of thumb, but the exact requirements are deduced only by a thorough analysis that proceeds from the desired output voltage back. In practice, the difference between a reasonable guess and a laborious analysis will be important only to a person capable of manufacturing his own transformer. In most instances, the hobbyist will have to rely upon readily acquired transformers with standard output voltages. For this reason, my approach is predicated on the practical aspects of power supply design rather than on the minute engineering details that have no real bearing on the outcome.

A 120 VAC RMS (root mean square) sine wave is applied to the primary of the transformer. Figure 1.2 illustrates the waveforms anticipated at selected points through the filter section. Photo 1.1 shows that 120 VAC is actually 340 V peak to peak; care should be used in the insulation and mounting of components.

The secondary output of the transformer will be a similar sine wave, reduced in voltage. It is then applied to a full-wave bridge and the waveform will appear as in photo 1.2 You'll notice a slight flat spot between "humps." As a result of dealing with actual electronic components rather than mathematical models, we should be aware of certain peculiarities. Silicon diodes exhibit threshold characteristics and, in fact, have a voltage drop of approximately 1 V across each diode. This voltage drop becomes significant in full-wave bridge designs and, as figures 1.3a, 1.3b, and photo 1.2 illustrate, can accumulate as diodes are added in series. The 2 V loss in the bridge is an important consideration and should be reflected in the calculations.

The voltage regulator requires a certain minimum $D C$ level to maintain a constant output voltage. Should the applied voltage dip below this point, output stability is


Figure 1.3 The direction of the current flow through the full-wave bridge.
a) During the positive half of the $A C$ cycle, current flow is through $D_{1}$ and $D_{3} ; D_{2}$ and $D_{4}$ are not conducting. $V_{D 1}+V_{D J}=2$ volts.
b) During the negative half of the $A C$ cycle, current flow is through $D_{2}$ and $D_{4} ; D_{1}$ and $D_{3}$ are not conducting. $V_{D 2}+V_{D 4} \approx 2$ volts.
severely degraded. Thus, a filter capacitor is used to smooth out the "humps" in the rectified sine wave. When the diodes are conducting, the capacitor stores enough charge to maintain the minimum voltage required until the next charge cycle. (In practice, we wouldn't want to cut it that close.) The input to the transformer is 60 Hz , but because of the characteristics of full-wave rectification, the charging cycles occur at 120 Hz . The capacitor charges up during one 8.3 ms cycle, and, as the regulator draws power from it to satisfy the load demands, it must continue to provide at least the highest minimum input voltage required by the regulator until the next charge cycle, 8.3 ms later. This periodic charge/discharge phenomenon is shown in photo 1.3. The magnitude of the voltage fluctuation between the two peaks of the cycle is referred to as ripple. The highest magnitude of the waveform including the ripple is designated as peak voltage. Both are important to remember and are shown in figure 1.4.


Figure 1.4 Output voltage as a combination of a certain steady-state voltage ( $V_{c}$ ) plus a ripple voltage ( $V_{\text {RIPPLE }}$ ).

Given a basic understanding of the individual components at this stage, we can proceed to the case at hand: a $5 \mathrm{~V}, 5 \mathrm{~A}$ power supply. For reasons we'll discuss later, the 5 V regulator section of this supply will require an absolute minimum of 8.5 V for proper operation. This means that whatever the magnitude of $\mathrm{V}_{\text {PEAK }}$ and $\mathrm{V}_{\text {RIPPLE, }}$, the final $\mathrm{V}_{c}$ level must not go below 8.5 V , or the regulator will not work. By giving ourselves some leeway, say $\mathrm{V}_{c}=10 \mathrm{~V}$, we can take a little more poetic license with the calculations and still produce a good design. Going much above 10 V , while still satisfying the input criteria, would increase power dissipation and possibly destroy the regulator. There is an answer to this vicious circle and that's to be conservative. Experience shows that adding a little insurance is worthwhile.

Now that 10 V is the goal, we can appropriately select the other filter components to meet it. Figure 1.5 is the filter circuit of our 5 V supply. $\mathrm{R}_{S}$ is the resistance of the secondary winding of the transformer. For a 5 to 8 A transformer, it will average about 0.1 ohms. The first values to recognize follow:

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{c}}=\mathrm{V}_{\text {regulator minimum input voltage }}=10 \mathrm{~V} \\
& \mathrm{I}_{\text {out }}=\mathrm{I}_{\text {Regulator load }}=5 \mathrm{~A} \\
& \mathrm{R}_{S}=\mathrm{R}_{\text {TRANSFORMER SECONDARY RESSTANCE }}=0.1 \text { ohms }
\end{aligned}
$$

$V_{P E A K}$ can be any voltage up to the maximum input for which the regulator is rated. However, this will increase the circuit power dissipation. The rule of thumb I use when designing supplies of this type is that $\mathrm{V}_{\text {PEAK }}$ should be approximately $25 \%$ higher than $\mathrm{V}_{c}$. In this way, the capacitor value will be kept within reasonable limits. The ratio of $\mathrm{V}_{c}$ to $\left(\mathrm{V}_{\text {PEAK }}-\mathrm{V}_{c}\right)$ is referred to as the ripple factor of the filter capacitor.

$$
Y_{F}=\frac{V_{P E A K}-V_{C}}{V_{c}}=\frac{12.5-10}{10}=25 \%
$$

A ripple factor of $25 \%$ at 5 A will fall well within the acceptable capacitor ripple current ratings and eliminate the need for the hobbyist to dig into manufacturers' specifications of capacitors. This ripple factor is arbitrary, but it is best to keep it as low as possible.


Figure 1.5 The input filter circuit of the 5 V power supply.

## SIZING THE CAPACITOR

We now know that the capacitor must sustain 10 V from a peak input of 12.5 V .

$$
\left.\begin{array}{rl}
\mathrm{V}_{P E A K} & =12.5 \mathrm{~V} \\
\mathrm{~V}_{C} & =10 \mathrm{~V} \\
\mathrm{~V}_{\text {RIPPLE }} & =2.5 \mathrm{~V}
\end{array}\right\} \quad V_{C}=\mathrm{V}_{P E A K}-\mathrm{V}_{\text {RIPPLE }}
$$

The next consideration is to choose a capacitor that will accomplish this goal. Another rule of thumb calculation that saves considerable labor is
where

$$
\mathrm{C}=\frac{\mathrm{dt}}{\mathrm{dv}} \mathrm{I}
$$

$$
\begin{aligned}
\mathrm{C} & =\text { capacitor value in farads }=? \\
\mathrm{I} & =\text { maximum regulator current }=5 \mathrm{~A} \\
\mathrm{dt} & =\text { charging time of capacitor }=8.3 \mathrm{~ms}(120 \mathrm{~Hz}) \\
\mathrm{dv} & =\text { allowable ripple voltage }=2.5 \mathrm{~V}
\end{aligned}
$$

Plugging in the values of our circuit,

$$
C=\frac{(5)\left(8.3 \times 10^{-3}\right)}{(2.5)}=16.6 \times 10^{-3} \text { farads }
$$

or,

$$
\mathrm{C}=16,600 \text { microfarads }(\mu \mathrm{F})
$$

Generally available commercial electrolytic capacitors have a tolerance of +50 and $-20 \%$. To be on the safe side and to make it easier to find a standard stock component, a value of $20,000 \mu \mathrm{~F}$ is better. The added $3,400 \mu \mathrm{~F}$ reduces the ripple by another 0.4 V and gives us a little "insurance." The only other item to consider with the capacitor is operating voltage. Because the design dictates that $\mathrm{V}_{\text {PEAK }}$ is 12.5 V , this should be a satisfactory rating. However, experience shows that transformers end up running at higher output voltages than labeled and that 12.5 V at 115 VAC hits 13.6 V when the line voltage goes up to 125 VAC . A capacitor voltage of 15 VDC would appear to satisfy the requirement, but I recommend using the next increased standard value of 20 VDC.

The capacitor is therefore $20,000 \mu \mathrm{~F}$ at 20 VDC . The rectifier can be a monolithic full-wave bridge, or it can be four discrete diodes. Note that because a bridge is usually encapsulated, the four terminals are labeled instead of showing the polarity markings of the individual diodes. The designations for the four terminals are two AC input terminals, and a + and - output terminal.

## THE RECTIFIER

There are three considerations when choosing a rectifier: surge current rating, continuous current, and PIV (peak inverse voltage) rating. These choices are not inconsequential and must be considered carefully.
When a power supply is first turned on, the capacitor is totally discharged. In fact, it will instantaneously appear to be a 0 ohm impedance to the voltage source. The only aspect of the circuit that limits the initial current flow is the resistance of the secondary transformer windings and the connecting wiring; designers often add a series resistance to limit surge current.
The surge current in this circuit is

$$
\mathrm{I}_{\text {SURGE }}=\frac{\mathrm{V}_{\text {PEAK }}}{\mathrm{R}_{S}}=\frac{12.5}{0.1}=125 \mathrm{~A}
$$

and the time constant of the capacitor is

$$
\tau \cong \mathrm{R}_{s} \times \mathrm{C} \cong(0.1)\left(20 \times 10^{-3}\right)=2 \mathrm{~ms}
$$

As a rule of thumb, the surge current will cause no damage to the diode if $\mathrm{I}_{\text {surge }}$ is less than the surge current rating of the diode and if

$$
\tau<8.3 \mathrm{~ms} \text { (which it is) }
$$

We can't check surge rating until after we choose a diode bridge, but the other two parameters can be defined.
The bridge can be either of the following:

$$
\begin{aligned}
& \text { Motorola MDA 980-2: } \mathrm{I}_{\text {cowt }}=12 \mathrm{~A}, \mathrm{I}_{\text {SURGE }}=300 \mathrm{~A}, \mathrm{PIV}=100 \mathrm{~V} \\
& \text { Motorola MDA 990-2: } \mathrm{I}_{\text {coNT }}=27 \mathrm{~A}, \mathrm{I}_{\text {SURGE }}=300 \mathrm{~A}, \mathrm{PIV}=100 \mathrm{~V}
\end{aligned}
$$

Both of the above bridges have a surge current rating of 300 A , so our surge requirement is also satisfied.

## PIV

PIV (peak inverse voltage) is the maximum voltage that may appear across the diode before it self-destructs. Diodes, unlike capacitors, are unforgiving; transients will wipe them out. It is not unusual to have 400 V transients on the 115 VAC input line. This causes our 12.5 V to shoot up momentarily to 43 V ! The bridge rectifier should therefore have a minimum PIV rating of 50 V . For a few pennies more, you can get a bridge rated for 100 PIV. Remember, insurance costs less than computers.

## CONTINUOUS CURRENT

The last consideration is continuous current rating. Whereas the regulator may be designed for a 5 A output, the particular regulator I have chosen will draw 7 A if shorted. This is not standard operating procedure, but it can happen. The suggested standard component would be a $12 \mathrm{~A}, 50$ PIV bridge. A preferred component would be one rated for 12 A at 100 PIV or, for an additional $15 \%$ cost premium, a 27 A at 100 PIV. This last design choice is strictly brute force, but it saves the diode bridge should the capacitor ever short-out accidentally. A 6 A transformer might put out more than 12 A in a short-circuit mode, but it's unlikely that it would be capable of 27 A . Either choice will satisfy the design, but only one saves the design from the builder.

## THE TRANSFORMER

Now let's consider the transformer. We have determined the voltage drops across the various components. The values are used to calculate the required RMS (root mean
square) secondary voltage in the following way:

$$
\begin{aligned}
\mathrm{V}_{S E C(R M S)} & =\frac{\mathrm{V}_{C}+\mathrm{V}_{R I P P L E}+\mathrm{V}_{R E C T}}{\sqrt{2}} \quad \mathrm{~V}_{R E C T}=\begin{array}{c}
\text { Voltage drop across each diode } \\
\text { (approximately I V per diode) }
\end{array} \\
& =\frac{10+2.5+2.0}{1.414} \\
& =10.25 \mathrm{~V}
\end{aligned}
$$

In practice, a $10 \mathrm{~V}, 6 \mathrm{~A}$ standard value transformer will be close enough.
The components of the + and -12 V supplies are chosen in a similar manner, with the exception that required current is only 1 A , and a 200 PIV bridge is recommended because of the particular rectifier configuration. The finished schematic of the transformer and filter section of our computer is illustrated in figure 1.6.


Figure 1.6 A schematic diagram of a transformer and input filter section.

## VOLTAGE REGULATORS

The voltage regulator section of our power supply is the next consideration. All voltage regulators perform the same task: they convert a given $D C$ input voltage into a specific, stable DC output voltage and maintain this setpoint over wide variations of input voltage and output load. The typical voltage regulator, as shown in figure 1.7, consists of the following:

- a reference element that provides a known stable reference voltage
- a voltage translation element that samples the output voltage level
- a comparator element that compares the reference and output level to produce an error signal
- a control element that can utilize this error signal to provide translation of the input voltage to produce the desired output

The control element depends on the design of the regulator and varies widely. The control determines the classification of the voltage regulator: series, shunt, or switch-
ing. For the series regulator, the control element regulates the output voltage by modulating the series element, usually a transistor, and causes it to act as a variable resistor (figure 1.8). As the input voltage increases, the series resistance $\mathrm{R}_{s}$ also increases, causing a larger voltage drop across it. In this way, the output voltage ( $\mathrm{V}_{\text {out }}$ ) is maintained at a constant level.


Figure 1.7 A block diagram of a typical voltage regulator.


Figure 1.8 A series control element in the voltage regulator.
a) The series control element acts as a variable resistance, $R_{s}$.
b) The series element is most often a transistor.

To accomplish this closed-loop control, a reference comparison and feedback system is incorporated into the hardware. A fixed and stabilized reference voltage is easily produced by a zener diode. The current produced is low, however; the device could not serve as a power regulator by itself.

The voltage translator connected to the output of the series control element produces a feedback signal that is proportional to the output voltage. In its simplest form, the voltage translator is a resistor-divider network. The two signals, reference and feedback, provide the necessary information to the voltage comparator for closed loop feedback to occur (figure 1.9). The output of the comparator effectively drives the base of the series pass transistor so that the voltage drop across the transistor will be maintained at a stabilized preset value when subtracted from the input voltage.
Modern power supply designers can still use individual components to construct the modular elements of a series voltage regulator, but most reserve this laborious endeavor for specialized applications. The ZAP computer system outlined here requires $+5 \mathrm{~V},+12 \mathrm{~V}$, and -12 V . The combined temperature, stability, and drift
tolerances cannot exceea $\pm 5 \%$ on any of the three set points. The easiest way to minimize risk is to reduce the number of circuit components to the bare minimum. Other designers had the same idea and thus the three-terminal regulator was invented. Figure 1.10 is the block diagram of such a device.


Figure 1.9 A schematic diagram of a series voltage regulator.


Figure 1.10 A block diagram of a three-terminal voltage regulator.
Basically, a three-terminal regulator incorporates all the individual transistors, resistors, and diodes into a single integrated circuit. While simple to use, these devices have a far more complicated internal structure than the series regulator of figure 1.9. Only three terminals are necessary in applications where the fixed output is a standard value such as: $\pm 5 \mathrm{~V}, \pm 6 \mathrm{~V}, \pm 8 \mathrm{~V}, \pm 12 \mathrm{~V}, \pm 15 \mathrm{~V}$ or $\pm 24 \mathrm{~V}$. The three connections are unregulated $D C$ from our input filter, a ground reference, and finally, regulated $D C$ output.

In a three-terminal regulator, the voltage reference is the most important part because any abnormality or perturbation will be reflected in the output. Therefore, the reference must be stable and free from noise or drift. More advanced designs use bandgap reference circuits rather than zener diodes. Because of its complexity, such an approach is practical only in the integrated circuit (IC) environment. Essentially, a bandgap reference voltage is derived from the predictable temperature, current, and voltage relationships of a transistor base-emitter junction.

Another advantage of the three-terminal regulator is that in monolithic circuits, stable current sources can easily be realized by taking advantage of the good matching and tracking capability of monolithic components. Also, as in the previous case, the designer can add as many active devices as necessary without significantly increasing the IC circuit area. Operation of the reference circuit at a constant current level reduces fluctuations due to line-voltage variation. Thus, the output has increased stability. The error amplifier is also operated at a constant current to reduce line-voltage influence.

The most important consideration for the hobbyist is that these chips incorporate protective circuitry, guarding the regulator from certain types of overloads. They protect the regulator against short-circuit conditions (current limit); excessive input/output differential condition (safe operating area); and excessive junction temperatures (thermal limit). Of course, all this circuitry is designed to protect the regulator, not the computer.

## CHOOSING A REGULATOR

The $5 \mathrm{~A} \mu \mathrm{~A} 78 \mathrm{H} 05$ hybrid voltage regulator has all the inherent characteristics of the monolithic three-terminal regulator (ie: full protective circuitry). Each hermeticallysealed TO-3 package contains a $\mu$ A78M05 monolithic regulator chip driving a discrete series-pass transistor Q1 and two short-circuit-detection transistors Q2 and Q3 (see figure 1.11). The pass transistor is mounted on the same beryllium oxide substrate as the regulator chip, thus insuring nearly ideal thermal transfer between Q1 and the tem-perature-sensing circuit of the 78 M 05 .


Figure 1.11 A block diagram of a 5 A $\mu$ A78H05 and $\mu 478 \mathrm{HG} 05$ hybrid voltage regulator.

ELECTAICAL CHARACTEAISTICS: $\mathrm{TJ}_{\mathrm{J}}=25^{\circ} \mathrm{C}$. IOUT $=2.0 \mathrm{~A}$ Unless otherwise spectiled.

| CHARACTEAISTICS | CONOTIIONS | HA7 ${ }^{\text {H25 }}$ |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | Max |  |
| Output Vohage | SOUT $=20 \mathrm{AV} \mathrm{V}^{\prime}=10 \mathrm{~V}$ | 4.8 | 5.0 | 5.2 | $v$ |
| Line Regulation | $V_{\text {IN }}=8.51025 \mathrm{~V}$ |  | 10 | 50 | mV |
| Load Requlation | $10 \mathrm{~mA} \leqslant 1 \mathrm{IOUT} 55.0 \mathrm{~A}, \mathrm{~V}_{\text {IN }}=10 \mathrm{~V}$ |  | 10 | 50 | $m \mathrm{~m}$ |
| Quiescent Currems | $\mathrm{I}_{\text {OUT }}=0 . \mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {OUT }}+5.0 \mathrm{~V}$ |  |  | 10 | ma |
| Ripple Repection | IOUT $=1.0 \mathrm{~A}, t=210 \mathrm{~Hz} .5 .0 \mathrm{VP.P}$ | 60 |  |  | do |
| Oulpul Norse | $10 \mathrm{~Hz}+1 \leq 100 \mathrm{kHz}, \mathrm{V} / \mathrm{N}-\mathrm{V}_{\text {OUT }}+50 \mathrm{~V}$ |  | 40 |  | $\rho V_{\text {RMS }}$ |
| Drepont Voltage | $10=50 \mathrm{~A}$ |  | 30 |  | V |
|  | $10^{\prime} \cdot 30 \mathrm{~A}$ |  | 26 |  | $V$ |
| Shori Curcuit Current Limt | $V_{1 N}=10 \mathrm{~V}$ |  | 70 |  | $\mathrm{A}_{\mathrm{p} k}$ |

Figure 1.12 Electrical characteristics of the $\mu A 78 \mathrm{H} 05$ voltage regulator.

The output circuit is designed so that the worst-case current requirement of the Q1 base, added to the current through R2, always remains below the current-limit threshold of the 78 M 05 . Resistor R1, in conjunction with Q2 and Q3, makes up a current ser.se and limit circuit to protect the series-pass device from excessive current drain.
Safe area protection is achieved by brute force and is designed with the hobbyist in mind. The series-pass transistor is capable of handling the short-circuit current at the maximum input voltage rating of the 78 HOS . (See figure 1.12 for the electrical characteristics of the 78 H 05 .)
The output of the device is nominally 5.0 V but can vary between 4.8 and 5.2 V . Even though this falls within the $5.0 \mathrm{~V} \pm 15 \%$ tolerance necessary to run the computer, there might be a problem with the voltage drop in the cabling between the power supply and the computer. Up to 0.5 V could be lost in the wiring and connectors. Remember that at 5 A , a resistance of only 0.1 ohms can cause a 0.5 V drop. Unfortunately, the 78 H 05 is a fixed-output device when referenced to ground. If 4.8 V happens to come out, "that's all you gets" (sic). But, in a classic case of engineering razzle-dazzle, we can fool the regulator by making the ground reference adjustable. Figure 1.13 shows the circuit that makes this possible. A potentiometer sourced from the -12 V supply creates a relative-ground reference for the 78 H 05 . If the particular device in question had an output of 4.95 V , and we adjusted R1 for a potential of 0.20 V on the common regulator pin, the output referenced to ground would change to $4.95+0.20$, or 5.15 V . For the fanatics in the crowd, this particular circuit also allows a high-output device to be reduced to 5.00 V by selecting an appropriate negative voltage ground reference pin.


Figure 1.13 Adding "trim adjust" to the $\mu A 78 H 05$ three-terminal voltage regulator.

With the 5 V supply complete，our next concern is the +12 V and -12 V supplies． Other devices within the 7800 family of regulators will satisfy the requirements．The 7812 and a 7912 are 1 A positive and negative regulators respectively；they exhibit the same protection，characteristics as the 78 H 05 ．Figures 1.14 and 1.15 outline the exact specifications．Because we are dealing with much lower currents than the +5 V supply， there is considerably less concern over voltage losses through connecting cables，and it is unnecessary to add trim adjustment circuitry．Figure 1.16 is the finished schematic of the ZAP power supply．Additional regulator circuit diagrams（figures 1．17a，b，c and d）are included to demonstrate how the 7800 series of regulators can be used in our ap－ plication．Are we finished yet？Of course not．Close examination of figure 1.16 shows two items not discussed previously：heat sinks and overvoltage protection．These two subjects and a short discussion of the importance of correct layout complete the chapter．


Figure 1．14 Electrical characteristics of the $\mu A 7812$ voltage regulator．

」A7912

| CHARACTERISTICS |  | CONOITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Voltage | $T_{J}=25^{\circ} \mathrm{C}$ |  | －115 | －12．0 | －12．5 | $V$ |
| Line Repulation | $T_{J}=25^{\circ} \mathrm{C}$ | －14．5VくVin＜-30 V |  | 10 | 120 | $m \mathrm{~V}$ |
|  |  | －16Vく $V_{10}<-22 \mathrm{~V}$ |  | 3.0 | 60 | mv |
| Lood Ragutationt | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | 5 mA く lout 61.5 A |  | 12 | 120 | mv |
|  |  | 250 mA ＜ $1 \mathrm{OUT} \leqslant 750 \mathrm{~mA}$ |  | 4.0 | 60 | mv |
| Output Voltape | $\begin{aligned} & -15.5 \vee \& V_{I N}<-27 \mathrm{~V} \\ & 5 \mathrm{~mA}<\mathrm{IOUT}<1.0 \mathrm{~A} \\ & 0<15 \mathrm{~W} \end{aligned}$ |  | －11．4 |  | －12．6 | V |
| Cutasent Curemi | $\mathrm{T}_{\mathrm{J}}+25^{\circ} \mathrm{C}$ |  |  | 1.5 | 3.0 | ma |
| Quiesiant Curcent Change | $-15 \vee<V_{1 N}<-30 \mathrm{~V}$ |  |  |  | 1.0 | ma |
|  | $5 \mathrm{~mA}<1 \mathrm{OUT}<1.0 \mathrm{~A}$ |  |  |  | 0.5 | mA |
| Output Nors Vortage | $T_{A}=25^{\circ} \mathrm{C}, 10 \mathrm{~Hz}<t<100 \mathrm{kHz}$ |  |  | 25 | 80 | MVIVOUT |
| Rippla Rejec！ $0_{0 n}$ | $f=120 \mathrm{~Hz},-15 \mathrm{~V}<\mathrm{V}_{1} \mathrm{~N}<-25 \mathrm{~V}$ |  | 54 | 60 |  | d8 |
| Dropout Vollage | IOUT $=1.0 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | 1.1 | 2.3 | $\checkmark$ |
| －Peak Output curtent | $\mathrm{Tg}=25^{\circ} \mathrm{C}$ |  | 1.3 | 2.1 | 3.3 | A |
| Avertag Tamowsture Coefficient of Output Voltaga | IOUT $=5 \mathrm{~mA},-55^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{J}}<150^{\circ} \mathrm{C}$ |  |  |  | 0.3 | $m v \hat{c} f$ Vout |
| Short Circuit Curent | $\mathrm{V}_{1 \mathrm{~N}}=-35 \mathrm{~V} . \mathrm{F}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  |  | 1.2 | A |

Figure 1.15 Electrical characteristics of the $\mu \mathrm{A} 7912$ voltage regulator．


Figure 1.16 A schematic diagram of the finished power supply for the ZAP computer.


## LAYOUT IS IMPORTANT

Integrated circuit regulators employ wide-band transistors in their construction to optimize response. As a result, they must be properly compensated to ensure stable closed-loop operation. Their compensation can be upset by stray capacitance and line inductance of an improper layout. Circuit lead lengths should be held to a minimum, and external bypass capacitors in particular should be located as close as possible to the regulator control circuit.

Figure 1.18a illustrates a typical layout of the components of our supply, and figure 1.18 b details the areas that can cause problems. Improper placement of the input capacitor can induce unwanted ripple on the output voltage. This occurs when the current flowing in the input circuit influences the common ground line of the regulator. The voltage drop produced across R2' will cause the output of the regulator to fluctuate in the same manner as the voltage trim circuit we discussed previously. The peak currents in the input circuit (which consists of the rectifier and filter capacitor) can be tens of amperes during charge cycles. These high-current spikes can cause substantial voltage drops on long-lead lengths or thin-wire connections. They can also degrade performance to the point that proper input voltage to the regulator cannot be maintained except during low-current operation.

The output current loop is also susceptible to circuit layout. In a three-terminal regulator, the fixed-output voltage $\mathrm{V}_{\text {octireg }}$ is referenced between "out" and "common" of the chip. Because the load current flows through R2', R3', and R4', as well as the load itself, these combined voltage losses may reduce Vour to an intolerable level. Notice that the ground for this circuit is at point C while the present R load is between points $A$ and $B$. If another load, more memory for example, is connected to this supply between points A and C , it would have a different $\mathrm{V}_{\text {out }}$. Adjusting the trim setting of such a seesaw supply can be dangerous; it's possible to have one load completely within tolerance and another over or under voltage. One last point to consider is that R4' serves to negate the purpose of the regulator because it continually reduces $\mathrm{V}_{\text {our }}$ as the load current increases.


Figure 1.18 A typical layout of the power supply components and associated problems.
a) A typical layout.
b) Errors contributed by the layout in figure 1.18a.

Figure 1.19 is the block diagram of a proper layout. All high-current paths should use heavy wire to minimize resistance and resultant voltage drops. You'll notice now that the input and output circuit current paths are separated effectively. Note that the wires from the rectifier go directly to the capacitor and that two wires from the capacitor send power to the rest of the circuit. If you follow this convention and use two separate pairs of leads, you can eliminate input-circuit induced errors.

Finally, we need to discuss the concept of the single-point ground. One point in the power supply must be designated as ground; the grounds of all other supplies and loads are connected to it. In practical terms, the best way to implement this ground connection is to use a metal strip or several lengths of heavy wire soldered together. The strip is a ground bus with such a low resistance that a voltage measured between point A and any place along the bus will be virtually undetectable. Another +5 V bus should be connected to the output of the supply so that voltage distribution throughout the circuit is consistent. Use thick wire in power supplies. Even if zero-resistance wire isn't easily obtainable, always remember-there is no such thing as wire that is too thick!


Figure 1.19 A block dlagram of a proper layout for the power supply components.

## THERMAL CONSIDERATIONS

You've just built the power supply l've outlined, flipped on the power, and everything works. After a few minutes, something happens and the computer suddenly stops running. Naturally, you start looking around and touching things. Eventually, your fingers will end up on the regulator chip. Immediately you scream, jump back, and in the process knock over the computer and your celebration martini. If you are lucky, your fingers will be the only thing burned!

When not properly cooled, the regulators will protect themselves from destruction by reducing their output or completely shutting off. In this case, the system could cease to function. A more catastrophic problem arises from ICs that use all three voltages for normal operation. Loss of one or more of these voltages could permanently damage the device. This will never happen if power dissipation is limited and the proper cooling methods are employed.
The first step is to check the power dissipation of our design with the ratings of the particular devices. In practical terms, power, expressed in watts, is volts times amperes:

$$
\mathrm{P}_{\mathrm{D}}=\mathrm{E} \times \mathrm{I}
$$

In our 5 V regulator we have $\mathrm{V}_{\mathrm{C}}=10 \mathrm{~V}$ and $\mathrm{V}_{\text {PEAK }}=12.5 \mathrm{~V}$ at 5 A .

$$
\begin{aligned}
\mathrm{P}_{D(\text { NOM })} & =\left(\mathrm{V}_{c}-\mathrm{V}_{\mathrm{OUT}}\right) \times 5 \mathrm{~A} \\
& =(10-5) \times 5 \\
& =25 \mathrm{~W} \\
P_{D(P E A K)} & =\left(\mathrm{V}_{P E A K}-\mathrm{V}_{\mathrm{OUT}}\right) \times 5 \mathrm{~A} \\
& =(12.5-5) \times 5 \\
& =37.5 \mathrm{~W} \\
P_{D(A V E R A G E)} & =\frac{37.5+25}{2}=31.25 \mathrm{~W}
\end{aligned}
$$

This means that under full load conditions, about 30 W of heat will be produced by the 78 H 05 . The device is forturately rated for 50 W at $25^{\circ} \mathrm{C}$ and is still capable of handling 30 W up to $75^{\circ} \mathrm{C}$.
Although the internal power dissipation is limited, the junction temperature must be kept below the maximum specified temperature $\left(125^{\circ} \mathrm{C}\right)$ in order for the device to function at all. To calzulate the heat sink required, there are specific equations to solve.

The required thermal data and calculations follow:

$$
\begin{array}{rr}
\text { Typical } \theta_{J C}=2.0 & \text { Maximum } \theta_{J C}=2.5 \\
\text { Typical } \theta_{J A}=32 & \text { Maximum } \theta_{J A}=38 \\
P_{D(M A X)}=\frac{\mathrm{T}_{J(M A X)}-\mathrm{T}_{A}}{\theta_{J C}+\theta_{C A}} \quad \text { for } \theta_{C A}=\theta_{C S}+\theta_{S A}
\end{array}
$$

Solving for $T_{J}$,

$$
\mathrm{T}_{J}=\mathrm{T}_{A}+\mathrm{P}_{D}\left(\theta_{J C}+\theta_{C A}\right)
$$

or without a heat sink,

$$
\begin{aligned}
\mathrm{P}_{D(M A X)} & =\frac{\mathrm{T}_{J(M A X)}-\mathrm{T}_{A}}{\theta_{J A}} \\
\mathrm{~T}_{s} & =\mathrm{T}_{A}+\mathrm{P}_{D} \theta_{J A} \\
\text { where } \mathrm{T}_{J} & =\text { junction temperature } \\
\mathrm{T}_{A} & =\text { ambient temperature } \\
\mathrm{P}_{D} & =\text { power dissipation } \\
\theta_{J C} & =\text { junction to case thermal resistance } \\
\theta_{J A} & =\text { junction to ambient thermal resistance } \\
\theta_{C A} & =\text { case to ambient thermal resistance } \\
\theta_{C S} & =\text { case to heat sink thermal resistance } \\
\theta_{S A} & =\text { heat sink to ambient thermal resistance } \\
\theta_{J A} & =\frac{\mathrm{T}_{J}-\mathrm{T}_{A}}{\mathrm{P}_{D}}=\frac{125^{\circ} \mathrm{C}-25^{\circ} \mathrm{C}}{31.25 \mathrm{~W}}=3.2^{\circ} \mathrm{C} / \mathrm{W}
\end{aligned}
$$

Because $\theta_{J A}$ as calculated is less than $\theta_{J A}$ from the specification sheet, a heat sink is defiritely required, and a TO-3 type heat sink of $3.2^{\circ} \mathrm{C} / \mathrm{W}$ is the minimum desired.

Before you size a heat sink for the 78 HO 0 , realize that there are two more regulators and two bridge rectifiers that will need heat sinking. Each 12 V regulator will average about 5 W dissipation. The diode bridge associated with the +5 V supply (remember the 2 V drop) dissipates about 10 W while the other is good for 2 W . Therefore, any heat sinks in the power supply must handle more than 50 W .

WHAT IS THE PRACTICAL METHOD FOR CHOOSING HEAT SINKS?
Choosing a heat sink can be easy or hard depending upon your outlook on rule of
thumb measures. We already know that we need a 50 W heat sink. It's easy to assume that buying one "rated for 50 W " from a local electronics supply will solve the problem. What this rating usually means, however, is that if 50 W is applied through a transistor to this sink, and the ambient temperature is $25^{\circ} \mathrm{C}$, the surface temperature of the sink will climb to $100^{\circ} \mathrm{C}$. Fried eggs anyone?

We must not forget that manufacturers' specs always refer to limiting maximum junction temperature, not to keeping the case cool enough to touch. Personally, I hate red-hot power supplies. To get a heat sink that would take our 50 W and stay about $60-70^{\circ} \mathrm{C}$ would probably mean getting one rated for 200-300 WI Remember that heat sinks are expensive-and big.

The simplest solution is best. I prefer forced air cooling. Put the 50 W on an economical heat sink of, say, a 100 W rating and put your money into a good fan. You can still run through all the calculations and determine how many square inches you need, but the effect of blowing a little air over a heat sink multiplies its capabilities enormously.

## OVERVOLTAGE PROTECTION

The final area to be addressed in the power supply is overvoltage protection. As designed by manufacturers, regulators protect themselves by reducing output voltage or complete shutoff. The chances of computer component damage from low voltage is miniscule by comparison to overvoltage. It is unlikely to happen, but if the 78 H 05 were to accidentally short out, as much as 12.5 V would be applied to the +5 V bus. You could then kiss the computer good-bye!

| +5 volt OVP |  |  |
| :--- | :--- | :--- |
| $\mathrm{D}_{1}$ | 5.6 V | 1,4734 |
| $\mathrm{SCR}_{1}$ | 50 V 25 A | $2 \times 682$ |
| Fuse | 6 amp | fast-blow |


|  | 12 volt OVP |  |  |
| :--- | :--- | :--- | :---: |
| $\mathrm{D}_{1}$ | 13 V | $1 \times 4743$ |  |
| $\mathrm{SCR}_{1}$ | 50 V 8 A | $2 \mathrm{~N}_{4} 441$ |  |
| Fuse | $1.5 a m p$ | fast-blow |  |

CHOOSING HEAT SINKS
The semiconductor components of this 12 volt OVP are reversed in polarity for the $\mathbf{- 1 2}$ volt OVP.


Figure 1.20 A simple overvoltage protection circuit.

The circuit of figure 1.20 is a simple OVP (over-voltage protector). It can be used as shown on the 5 V and 12 V supplies. The appropriate components are listed in the tables of figure 1.20. You'll notice that the fuses are rated higher than the output we've previously discussed. The fuse is for the OVP and not to protect the regulators. Unfortunately, the nature of fast-blow fuses is not to pass 5 A , if it is a 5 A fuse, but to open at 5 A . The fuse must have a higher rating in order to allow circuit operation at 5 A .


Figure 1.21 A schematic diagram of a more complex overvoltage protection circuit. The crowbar section of the OVP can be located next to the fuse while the OVP sensor $Z_{1}$ is located at the regulator output. This is a preferred placement of the parts if the sensor and clamp can be adequately separated. Low-current sensor $Z_{1}$ fires $S C R_{1}$ in an overvoltage condition. $S C R_{1}$ in turn fires high-curfent $S C R_{2}$. The combination of SCRs allows considerable leeway in the choice of $S C R_{2}$ since the question of gate current becomes less relevant.

Because the short-circuit current of the 78 H 05 is 7 A , the 25 A silicon-controlled rectifier (SCR) will certainly make short work of the fuse if it triggers. Figures 1.21 and 1.22 are slightly more complex OVP circuits and can also be used.


Figure 1.22 Schematic diagrams of adjustable-voltage overvoltage protection circuits.
a) An adiustable-voltage OVP circuit with an internal current amplifier to drive the SCR gate.
b) An alternate circuit for a simple adjustable-voltage OVP circuit.

What does an OVP (often called an "overvoltage crowbar") do It monitors a particular bus voltage and shuts it down if it goes above a predetermined level. OVP circuits can be designed to trigger 1 mV above our $5 \%$ tolerance band. Such circuits are not only complicated, but they may also create additional problems through accidental triggerings. The failure modes that are most likely to occur concern a regulator short or accidentally tying two buses together, for example the +5 V and +12 V . In either case, the result is a rapid voltage rise on the output lines. As voltage rises above the zener value, current flows into the SCR gate. At a certain point, usually below where any components would have been damaged, the SCR fires and shorts the output line to ground. The excessive current blows the fuse, eliminating the problem regulator or regulators (both fuses would blow if the +5 V and +12 V were connected). All this occurs very fast. The test circuit of figure 1.23 demonstrates what happens when the +5 V OVP suddenly has +12 V applied. Test circuits are the only way you ever want to see the action of an OVP. If your power supply functions properly, it should never trigger. The SCR never allows the line to go to 12 V before clamping it to ground. Replacing the fuse with a 220 ohm resistor allows multiple applications of the push button without replacing fuses.


Figure 1.23 A test circuit to demonstrate the action of the overvoltage protector.

## CHAPTER 2 CENTRAL PROCESSOR BASICS

There are many different microprocessors on the market and while instruction nomenclature is somewhat different for each one, the basic logical computing processes are similar in all devices. The rule to remember the next time a discussion turns to the capabilities of two computers is that "a computer is a computer." I don't wish to imply that they are all the same, but similarities abound and I would not like to spend a lifetime analyzing instruction sets and interfacing details before choosing one.
I once had lunch with the designer of one of the largest selling personal computer systems on the market. Thousands of computers had been sold, generating immense profits for the manufacturer. Our conversation eventually centered on the costeffectiveness of his design. I had fanciful thoughts of a design team spending months reducing component count and analyzing instruction sets to determine minimum memory requirements. In actuality, my designer friend was given two months to come up with a manufacturable design. The investors' only question was the price and availability of the particular components he had chosen. Being an avid personal computer enthusiast, he simply built a computer around the microprocessor he already owned. The eventual advertising for his system touted the advanced architecture embodied in the central processor, but no machine-language programming facility was available to the user. It had only a high-level language BASIC interpreter and was, from an engineering point of view, simply a black-box computer. He could have used any microprocessor. So much for textbook engineering design.
Unfortunately, the hobbyist who is building a microcomputer from scratch, and who won't be making a black box, has to try to pick a device that is somewhere in the middle of the performance and capability spectrum. The general rule that all computers perform similar functions is true, but a printed-circuit board is a luxury. The hobbyist who has to do all the wiring by hand will surely be interested in efficient design. It's a fact that some of the more esoteric microprocessors require very expensive peripheral circuitry. Even devices that seem quite straightforward, with limited instruction sets, can require 50 or more ICs as interface elements. The ultimate configuration should be a trade-off between circuit complexity, ease of testing, and component price.

## MICROPROCESSOR ARCHITECTURE

The internal architecture of the microprocessor determines the support devices required to make a microcomputer system. Perhaps the best place to start is to briefly discuss the major architectural differences.

Definition: A microcomputer is a logical machine that manipulates binary numbers (data) and processes this information by following an organized sequence of program steps referred to as instructions.

All microcomputers, like all computers, have the following features:

1. Input - Facilities must exist to allow the entrance of data or instructions.
2. Memory - The program sequence must be stored before and after execution, and resources must be available to store the result of any computations.
3. Arithmetic logic unit - Performs arithmetic operations on input or stored data.
4. Control section - Makes decisions regarding program flow and process control based on internal states of the results of arithmetic computations.
5. Output - The results are delivered to the user or stored in an appropriate medium.

The microprocessor is the single integrated circuit around which a microcomputer is constructed. The microprocessor is a device; the microcomputer is a system. In their least complex form, microprocessors include only the functions of items three and four and must rely on external devices attached to buses to perform the other tasks. Figure 2.1 is the basic block diagram of an 8 -bit microcomputer and shows the interconnection of these buses and support elements. The computer in figure 2.1 uses six separate buses: memory address, memory data in and out, I/O address, and data input and output. The microprocessor contains a central processor that consists of the circuitry required to access the appropriate memory and $\mathrm{I} / \mathrm{O}$ locations and interpret the resulting instructions that are also executed in this unit. The central processor also contains the ALU (Arithmetic and Logic Unit), which is a combination network that performs arithmetic and logical operations on the data. Additionally, the central processor includes a control section that governs the operations of the computer, and the various data registers used for manipulation and storage of data and instructions.


Flgure 2.1 A basic block diagram of a microcomputer illustrating the data busing concept. Numbers in parer:--eses are the usual require quantity of physical wires to perform bus functions for an 8-bit micropreenssor.

Actually few microprocessors support six separate buses. The number of pins that would be required on the IC is out of the question. Instead, to reduce pinouts, component manufacturers often combine the data input and output buses and make them "bidirectional." During an output instruction, data flows from the microprocessor to the output device and vice versa during an input instruction. To further cut the number of pins required on the central processor, the memory address bus can also serve as the address bus for input and output devices. During input/output instructions, the address present on the address lines references a particular input/output device(s). The resulting reduced configuration is shown in figure 2.2.

The concept of two buses is easy to understand and, from a hardware point of view, easy to utilize. The buses are time and function multiplexed. That is, during memory operations, the bits on the address bus refer to a memory location, and data on the data bus represent the content of memory. The direction of the data flow (to or from the central processor) is controlled within the microprocessor. Activities with input/output devices are performed in a similar fashion. During those instructions, input or output data and device addresses occupy the buses.


Figure 2.2 A block diagram of a microcomputer utilizing multiplexed bi-directional busing techniques to reduce pinout.

The number of bus wires can be further reduced by combining both data and address on the same lines and time multiplexing the data transfer along them. Figure 2.3 illustrates this final configuration. This method requires additional circuit elements to demultiplex and store pertinent data. The additional external components necessary to use this architectural feature defeat its purpose and make its use inadvisable for the hobbyist. There are other microprocessors that are simpler to use.


Flgure 2.3 A block diagram of a microcomputer utilizing a single multiplexed bi-directional bus for both memory and input/output functions.

When building rather than buying a personal computer, the following criteria must be carefully considered:

1. Circuit complexity - Keep components to a reasonable minimum. The more components in a design, the more likelihood of wiring errors and faulty devices.
2. Cost - While cost is important, it should not be the primary consideration. Any microprocessor function could be simulated by using small scale integrated logic; however, indirect costs resulting from using 200 chips to replace 3 or 4 LSI (large scale integration) devices would negate the value of using cheaper parts initially. On the other hand, in the semiconductor industry, density means dollars. The more functions a device can provide, and the fewer components necessary to ac-
complish these tasks, the higher the price. The level of integration incorporated in a homebrew computer should fit somewhere in the middle. The ZAP computer outlined in this book is a prime example of this philosophy. It uses a combination of cost-effective LSI (large scale integration) and inexpensive SSI (small scale integration) to produce a computer that the hobbyist can truly build, test, and use.
3. Software compatibility and availability - Building the hardware of a microcomputer is only half the job. It must be programmed to perform useful work. Initially, the builder will by necessity hand code and assemble his own programs. Eventually, however, the need may arise for the computer to do a task requiring a very large program which cannot be easily hand assembled. The user must rely upon an assembler program in a larger machine. The assembler program would, of course, have to be compatible with the instruction set of the microcomputer.

A further consideration is that personal computer enthusiasts are forever exchanging software. It is possible to convert programs to run on any central processor, but the effort would be the same as writing the entire program from scratch. This defeats the purpose of exchanging software. The personal computer owner should choose a microprocessor that is somewhat compatible with the computers already on the market. My statement that all computers are alike is theoretically true, but a book on how to build an esoteric one-of-a-kind computer is of little practical value.

Each criterion could be analyzed and answered individually, but we must give some credit to the manufacturers of personal computers for doing some of the thinking for us already. The fact that so many personal computers are in use has established de facto standardization of central processor choice. To be compatible with existing software and to have sufficient documentation available, the builder should consider choosing among those central processors in commercial use. The four most used microprocessors are

1. Intel 8080 A
2. Motorola 6800
3. MOS Technology 6502
4. Zilog Z 80

As a result of each device's wide following, documentation and software are readily available. The availability of 8080 A compatible software is highest; cost is low, but its circuit complexity is also the greatest of the above. The 8080 A , while described as a "single-chip computer," relies on various external drivers and support devices. Its minimum functional configuration consists of three chips as shown in figure 2.4. Its central processor bus structure is similar to figure 2.3, but when combined with the 8224 and 8228 support chips, it emulates the more desirable bus architecture outlined in figure 2.2.


Figure 2.4 A minimum three-chip 8080A configuration illustrating the necessary support devices. The control bus contains the timing functions necessary to decode the contents of the data and address buses.

The best of both worlds is incorporated within the Z80. Not only does it execute the complete instruction set of the 8080 A , but it also has additional instructions that serve to make it a very powerful processor. The Z80 bus structure is illustrated in figure 2.5. The Z80 is slightly more expensive than the other processors listed. However, its reduced external circuitry results in an effective cost comparison. Further, the ease of interfacing the Z 80 makes it the natural choice when building a microcomputer from scratch.


Figure 2.5 A block diagram of the zilog 280 bus structure.

## CHAPTER 3 <br> THE Z80 MICROPROCESSOR

Many books have been written on the software and hardware attributes of the $\mathbf{Z 8 0}$. Although I am not attempting to duplicate the efforts of other authors, any book dedicated to the construction of a microcomputer would be incomplete without a section describing the processor in some detail. By completely understanding the internal logic and external control functions of the central processor, you will be able to understand better the way I've designed the rest of the system hardware. You have many options when constructing a computer from scratch. The deeper your degree of understanding, the greater your confidence in the outcome, and it is more likely that you will add enhancements to your own design.

The ZAP computer allows considerable latitude in the selection of peripheral interfacing. The choice depends primarily upon the design philosophy of the system, which starts with the central processor.

## CENTRAL PROCESSOR ARCHITECTURE

The Z80 is a register-oriented microprocessor. Eighteen 8-bit and four 16-bit registers within the central processor are accessible to the programmer and function as static programmable memory. These registers are divided into two sets, main and alternate, each of which contains six general purpose 8-bit registers that may be used either individually, or as three pairs of 16 -bit registers. Also included are two sets of accumulators and flag registers. Figure 3.1 illustrates the internal architecture of the $\mathbf{Z 8 0}$ central processor. Figure 3.2 shows that within the Z80 there are accumulators and flag registers, along with general and special purpose registers.


Figure 3.1 A block diagram of the internal architecture of the $Z 80$ central processor.

\(\left.$$
\begin{array}{|l|l|}\hline \begin{array}{l}\text { WNERRUUT } \\
\text { VECTOR } \\
\text { I }\end{array} & \begin{array}{l}\text { MEMORY } \\
\text { REFRESH } \\
\text { R }\end{array}
$$ <br>
\hline INDEX REGISTER IX <br>
\hline INOEX REGISTER IY <br>
\hline STACK POINTER SP <br>
\hline PROGRAM COUNTER PC <br>

\hline\end{array}\right\}\)| SPECIRL |
| :--- |
| PURPOSE |
| REGISTERS |

Figure 3.2 z80 central processor register configuration.

The following is a description of the function and structure of the major components of the central processor.

## I. Registers

A. Accumulators and Flag Registers The centra! processor contains two independent accumulator and flagregister pairs, one in the main register set and the other in the alternate register set. The accumulator receives the results of all 8 -bit arithmetic and logical operations, whereas the flag register indicates the occurrence of specific logical or arithmetic conditions in the processor such as parity, zero, sign, carry, and overflow. A single exchange instruction allows the programmer to select either accumulator or flag-register pair.
B. General Purpose Registers

There are two similar sets of general purpose registers. The main register set contains six 8 -bit registers called B, C, D, E, H, and L; the alternate register set also contains six 8 -bit registers referred to as $\mathrm{B}^{\prime}$, $\mathrm{C}^{\prime}, \mathrm{D}^{\prime}, \mathrm{E}^{\prime}, \mathrm{H}^{\prime}$, and $\mathrm{L}^{\prime}$. For 16 -bit operations, these registers can be grouped in 16 -bit pairs ( $B C, D E, H L$ or $\mathrm{BC}^{\prime}, \mathrm{DE}^{\prime}, \mathrm{HL}^{\prime}$ ). A single exchange instruction allows the programmer to alternately choose between the register-pair sets.
C. Special Purpose Registers

1. PC (program counter)

The program counter contains a 16 -bit address in memory from which the current instruction will be fetched. Following execution of the instruction, the PC counter is either incremented, if the program is to proceed to the next byte in memory, or the present PC contents are replaced with a new value, if a jump or call instruction is to be executed.
2. SP (stack pointer)

The $Z 80$ allows several levels of subroutine nesting through use of a "stack" and a "stack pointer": when certain instructions are executed, or when calls to subroutines are made, the PC counter and other pertinent data can be temporarily stored on a stack. A stack is a reserved area of several memory locations, the top of which is indicated by the contents of the stack pointer. That is to say, the stack pointer shows the address of the most recently made entry, because the memory locations are organized as a last-in, first-out file. By looking at particular entries in the stack,
the central processor returns to a main program regardless of the depth of nested subroutines. Theoretically, the stack could be 64 K bytes long; however, program space must not be overwritten by an expanding stack.
D. IX and IY Index Registers

These registers facilitate table data manipulation. They are two independent 16-bit registers that hold the base addresses used in indexed addressing modes, and point to locations in memory where pertinent data is to be stored or retrieved. Incorporated within the indexed instructions is a two's complement signed integer that specifies displacement from this base address.
E. Interrupt Page Address Register (I)

This is an 8 -bit register that can be loaded with a page address of an interrupt service routine. During a mode 2 interrupt program, control will vector to this page address.
F. Memory Refresh Register (R)

To enable dynamic memories for the $\mathbf{Z 8 0}$, a 7 -bit memory refresh register is automatically incremented after each instruction fetch.
II. Arithmetic and Logic Unit

Arithmetic manipulations and logical operations are handled eight bits at a time in the $\mathbf{Z 8 0}$ ALU (arithmetic and logic unit). The ALU communicates internally to the central processor registers and is not directly accessible by the programmer. The ALU performs the following operations:

LEFT or RIGHT SHIFT
INCREMENT DECREMENT
ADD SUBTRACT AND
OR
EXCLLSIVE OR
COMPARE
SET BIT
RESET BIT
TEST BIT
III. Instruction Register and Central Processor Control

The instruction register holds the contents of the memory location addressed by the PC (program counter) and is loaded during the fetch cycle of each instruction. The central processor control unit executes the functions defined by the instruction in the instruction register and generates all control signals necessary to transmit the results to the proper registers.
IV. Central Processor Hardware
A. Figure 3.3 details the pinout of the Z80. It comes in an industry standard 40 pin dual in-line package. The following is a listing and explanation of the pin functions:
$\mathrm{A}_{0}-\mathrm{A}_{15} \quad$ Three-state output, active high. $\mathrm{A}_{0}-\mathrm{A}_{15}$ constitute a
(Address 16 -bit address bus. These signals provide the address for
Bus) memory data exchanges (up to 64 K bytes) and for I/O device data exchanges. I/O addressing uses the eight lower address bits to allow the user to directly select up to 256 input or 256 output ports. $A_{0}$ is the least significant address bit. During refresh time, the lower seven bits contain a valid refresh address.
$D_{0}-D_{7} \quad$ Three-state input/output, active high. $D_{0}-D_{7}$ consti(Data Bus) tute an 8-bit bi-directional data bus which is used for data exchanges with memory and I/O devices.
$\overline{\text { M1 }} \quad$ Output, active low. $\overline{\text { M1 }}$ indicates that the current ma-
(Machine chine cycle is the operation-code fetch cycle of an in-

Cycle One) struction execution. Note that during execution of 2-byte opcodes, $\overline{\text { M1 }}$ is generated as each opcode byte is fetched. These 2 -byte opcodes always begin with CBH, DDH, EDH, or FDH. M1 also occurs with $\overline{\text { IORQ }}$ to indicate an interrupt acknowledge cycle.
$\overline{\text { MREQ }}$ Three-state output, active low. The memory request (Memory signal indicates that the address bus holds a valid adRequest) dress for a memory-read or memory-write operation.
$\overline{\text { IORQ }}$ Three-state output, active low. The $\overline{\text { IORQ }}$ signal indi(Input/
Output Request) cates that the lower half of the address bus holds a valid I/O address for an 1/O read or write operation. An $\overline{\text { IORQ }}$ signal is also generated with an $\overline{\mathrm{M1}}$ signal when an interrupt is being acknowledged to indicate that an interrupt response vector can be placed on the data bus. Interrupt acknowledge operations may occur during $\overline{\mathrm{M} 1}$ time while I/O operations are prohibited.
$\overline{\mathrm{RD}} \quad$ Three-state output, active low. $\overline{\mathrm{RD}}$ indicates that the (Memory Read) central processor wants to read from memory or an I/O device. The addressed I/O device or memory should use this signal to gate data onto the central processor data bus.
$\overline{W R} \quad$ Three-state output, active low. $\overline{W R}$ indicates that the
(Memory
Write) central processor data bus holds valid data to be stored in the addressed memory or I/O device.
$\overline{\text { RFSH }}$
(Refresh)
Output, active low. $\overline{\text { RFSH }}$ indicates that the lower seven bits of the address bus contain a refresh address for dynamic memories and the current $\overline{M R E Q}$ signal should be used to do a refresh read to all dynamic memories.
$\overline{\text { HALT }}$ Output, active low. $\overline{\text { HALT }}$ indicates that the central (Halt processor has executed a HALT instruction and is
ant, active low. The Interrupt request signal is generated by I/O devices. A request will be honored at the end of the current instruction if the internal software controlled interrupt enable flip-flop is enabled and if the $\overline{B U S R Q}$ signal is not active. When the central processor accepts the interrupt, an acknowledge signal (IORQ during M1 time) is sent out at the beginning of the next instruction cycle. The central processor can respond to an interrupt in the three different modes.
NMI Input, negative edge triggered. The normaskable inter-(Non- rupt request line has a higher priority than INT and is Maskable always recognized at the end of the current instruction,

Interrupt) regardless of the status of the interrupt-enable flip-flop. NMI forces the Z80 central processor to restart to location $0066_{16}$. The program counter is automatically saved in the external stack so that the user can return to the program that was interrupted. Note that continuous WAIT cycles can prevent the current instruction from ending, and that a BUSRQ will override an NMI.


Figure 3.3 Pin configuration for the $\mathbf{Z 8 0}$ microprocessor.

The actual timing of these signals will be discussed in the hardware sections.
V. Z80 Instruction Types

The Z80 can execute 158 separate instructions including all 78 of the 8080A. They can be grouped as follows:
A. LOAD AND EXCHANGE

Load instructions move data between registers or between registers and memory. The source and destination of this data is specified within the instruction. Exchange instructions swap the contents of two registers.
B. ARITHMETIC AND LOGICAL

These instructions operate on data in the accumulator, a register, or a designated memory location. Results are placed in the accumulator and flags are set accordingly. Arithmetic operations include 16-bit addition and subtraction between register pairs.
C. BLOCK TRANSFER AND SEARCH

The Z80 uses a single instruction to transfer any size block of memory to any other group of contiguous memory locations. The block search uses a single command to examine a block of memory for a particular 8 -bit character.
D. ROTATE AND SHIFT

Data can be rotated and shifted in the accumulator, a central processor register, or memory. These instructions also have binary-coded
decimal (BCD) handling facilities.
E. BIT MANIPULATION

Bit manipulation includes set, reset, and test functions. Individual bits may be modified or tested in the accumulator, a central processor, or memory. The results of the test operations are indicated in the flag register.
F. JUMP, CALL AND RETURN

A jump is a branch to a program location specified by the contents of the program counter. The program counter contents can come from three addressing modes: immediate, extended, or register indirect. A call is a special form of jump where the address following the call instruction is pushed onto the stack before the jump is made. A return is the reverse of the call. This category includes special restart instructions.
G. INPUT AND OUTPUT

These instructions transfer data between register and memory to external I/O devices. There are 256 input and 256 output ports available. Special instructions provide for moving blocks of 256 bytes to or from I/O ports and memory.
H. CPU CONTROL

These instructions include halting the CPU or causing a NOP (no operation) to be executed. The ability to enable or disable interrupt inputs is a further control capability.
VI. Instruction and Data Formats

Memory for the Z 80 is organized into 8 -bit quantities called bytes (see figure 3.4). Each program byte is stored in a unique memory position and is referenced by a 16 -bit binary address.

Total direct addressing capability is 65,536 bytes ( 64 K ) of memory, which may be any combination of ROM (read-only memory), EPROM (erasable-programmable read-only memory), or programmable memory. Data is stored in the formats of figure 3.5.


Figure 3.4 Organization of a data byte in the 280 .


Figure 3.5 Machine-language instruction formats for the $Z 80$.
VII. Z80 Status Flags

The flag register ( F and $\mathrm{F}^{\prime}$ ) supplies information to the user regarding the status of the central processor at any given time. There are four testable and two nontestable flag bits in each register. Figure 3.6 shows the position and identity of these flag bits.


Figure 3.6 Position and identity of status flag bits in the flag register.

Instructions set (flag bit $=1$ ) or reset (flag bit $=0$ ) flags in a manner relevant to the particular operation being executed.
VIII. The Z80 Instruction Set

The following symbols and abbreviations are used in the subsequent description of the Z 80 instructions:
Symbol Meaning

| accumulator | Register A |
| :--- | :--- |
| address A 16-bit address quantity <br> high-order address The most significant 8 bits of the 16-bit address <br> low-order address The least significant 8 bits of the 16-bit address <br> data An 8 -or 16 -bit quantity <br> high-order data The most significant 8 bits of the 16-bit data <br> low-order data The least significant 8 bits of the 16-bit data <br> port An 8-bit address of an I/O device <br> $\mathrm{r}, \mathrm{r}^{\prime}$ One of the registers A, B, C, D, E, H, or L <br> n A 1-byte expression in the range of 0 thru 255 <br> nn A 2-byte expression in the range of 0 thru 65,535 <br> d A 1-byte expression in the range of -128 to 127 <br> b An expression in the range of 0 thru 7 <br> e A 1-byte expression in a range of -126 to 129 <br> cc The state of the flags for conditional JR and JP instructions: |  |


| CC | Condition | Relevant Flag |
| :---: | :---: | :---: |
| i. 000 | NZ non zero | Z |
| L 001 | Z zero | Z |
| 0010 | NC non carry | C |
| \% 011 | C carry | C |
| H 100 | PO parity odd | P/V |
| - 101 | PE parity even | $P / V$ |
| 110 | P sign positive | S |
| A 111 | M sign negative | S |


| XXH | Denotes hexadecimal address value |
| :--- | :--- |
| qq | Any one of the register pairs $\mathrm{BC}, \mathrm{DE}, \mathrm{HL}$, or AF |
| ss | Any one of the register pairs $\mathrm{BC}, \mathrm{DE}, \mathrm{HL}$, or SP |

pp Any one of the register pairs $\mathrm{BC}, \mathrm{DE}, \mathrm{IX}$, or SP
rr Any one of the register pairs $\mathrm{BC}, \mathrm{DE}, \mathrm{IY}$, or SP
Any of $\mathrm{r}, \mathrm{n},(\mathrm{HL}),(\mathrm{IX}+\mathrm{d})$, or (IY +d )
dd
Any one of the register pairs BC, DE, HL, or SP
m
Any of $\mathrm{r},(\mathrm{HL})$, ( $\mathrm{IX}+\mathrm{d}$ ), or ( $\mathrm{I}+\mathrm{d}$ )
(HL)
Specifies the contents of memory at the location addressed by the contents of the register pair HL
$(\mathrm{nn}) \quad$ Specifies the contents of memory at the location addressed by the 2 -byte expression in mn
PC
Program counter
SP
Stack pointer
$t \quad$ An expression in the range of 0 thru 7.
C,N, P/V, H, Z,S Condition flags:

C Carry<br>N Add/Subtract<br>P/V Parity/Overflow<br>H Half-Carry<br>Z Zero<br>S Sign

| - | "is transferred to" |
| :--- | :--- |
|  | Logical AND |
| $\oplus$ | Exclusive OR |
| + | Inclusive OR |
| + | Addition |
| - | Subtraction |
| - | "is exchanged with" |

## EIGHT-BIT LOAD GROUP

LD r, $\mathbf{r}^{\prime}$
$r-r^{\prime}$
The contents of any register $r^{\prime}$ are loaded into any other register $r$.


Cycles: 1
States: 4
Flags: none

LD $\mathrm{r}, \mathrm{n}$
rn
The 8 -bit integer n is loaded into any register r .


Cycles: 2
States: 7
Flags: none

LD r, (HL)
r - (HL)
The 8 -bit contents of memory location (HL) are loaded into register r. .


Cycles: 2
States: 7
Flags: none

LD r, (IX +d )
$\mathrm{r}-$ (IX+d)
The operand (IX +d ) (the contents of the Index Register IX summed with a displacement integer d ) is loaded into register r .


Cycles: 5


States: 19
Flags: none


LD r, (IY + d)
$\mathrm{r}-(\mathrm{IY}+\mathrm{d})$
The operand (IY+d) (the contents of the Index Register IY summed with a displacement integer $d$ ) is loaded into register $r$.


Cycles: 5


States: 19
Flags: none


LD (HL), r
(HL) $\leftarrow \mathbf{r}$
The contents of register r are loaded into the memory location specified by the contents of the HL register pair.


Cycles: 2
States: 7
Flags: none

LD ( $\mathrm{I} X+\mathrm{d}$ ), $\mathbf{r}$
$(\mathrm{IX}+\mathrm{d})-\mathrm{r}$
The contents of register $r$ are loaded into the memory address specified by the contents of Index Register IX summed with d, which is a two's complement displacement integer.

$$
\begin{array}{|l|l|l|l|l|l|l|l|}
\hline 1 & 1 & 0 & 1 & 1 & 1 & 0 & 1 \\
\hline & & & & & & & \\
\hline
\end{array}
$$

Cycles: 5
States: 19
Flags: none

$\mathrm{LD}(\mathrm{IY}+\mathrm{d}), \mathrm{r}$
$(I Y+d)-r$
The contents of register $r$ are loaded into the memory address specified by the sum of the contents of the Index Register IY and d, a two's complement displacement integer.

Cycles: 5
States: 19
Flags: none


LD (HL), n
(HL) - n
Integer $n$ is loaded into the memory address specified by the contents of the HL register pair.


Cycles: 3


States: 10
Flags: none
LD (IX+d), n
(IX d ) -n
The $n$ operand is loaded into the memory address specified by the sum of the contents of the Index Register IX and the two's complement displacement operand d.


Cycles: 5
States: 19
Flags: none

$L D(I Y+d), n$
(IY+d) - n
Integer $n$ is loaded into the memory location specified by the contents of the Index Register IY summed with a displacement integer $d$.


Cycles: 5
States: 19
Flags: none


LD A, (BC)
A - (BC)
The contents of the memory location specified by the contents of the BC register pair are loaded into the Accumulator.

$$
\begin{array}{|l|l|llllll|l|}
\hline 0 & 0 & 0 & 0 & 1 & 0 & 1 & 0 \\
\hline
\end{array}
$$

Cycles: 2
States: 7
Flags: none

LD A, (DE)
A-(DE)
The contents of the memory location specified by the register pair DE are loaded into the Accumulator.

$$
\begin{array}{|lllllllll|}
\hline 0 & 0 & 0 & 1 & 1 & 0 & 1 & 0 \\
\hline
\end{array}
$$

Cycles: 2
States: 7
Flags: none
LD A, (nn)
A-(nn)
The contents of the memory location specified by the operands nn are loaded into the Accumulator. The first n operand is the low-order byte of a 2-byte memory address.


Cycles: 4
States: 13
Flags: none


LD (BC), A
$(B C)-A$
The contents of the Accumulator are loaded into the memory location specified by the contents of the register pair BC .

$$
\begin{array}{|l|l|l|l|l|l|l|}
\hline 0 & 0 & 0 & 0 & 0 & 0 & 1 \\
\hline & & 0 \\
\hline
\end{array}
$$

Cycles: 2
States: 7
Flags: none
LD (DE), A
(DE) - A
The contents of the Accumulator are loaded into the memory location specified by the DE register pair.

$$
\begin{array}{|l|lllllllll|}
\hline 0 & 0 & 0 & 1 & 0 & 0 & 1 & 0 \\
\hline
\end{array}
$$

Cycles: 2
States: 7
Flags: none

LD (nn), A
$(\mathrm{nn})-\mathrm{A}$
The contents of the Accumulator are loaded into the memory address specified by the operands nn . The first n operand is the low-order byte of operand nn .

$$
\begin{array}{|l|lllllllll|}
\hline 0 & 0 & 1 & 1 & 0 & 0 & 1 & 0 \\
\hline & & & & & & & & & \\
\hline
\end{array}
$$



Cycles: 4
States: 13
Flags: none


LD A, I
A-I
The contents of the Interrupt Vector Register I are loaded into the Accumulator.


Cycles: 2


States: 9
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: set if I < 0; reset otherwise
$Z$ : set if $\mathrm{I}=0$; reset otherwise
H,N: reset
P/V: contains contents of IFF2

LD A, R
$A \leftarrow R$
The contents of Memory Refresh Register R are loaded into the Accumulator.


Cycles: 2


States: 9
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: set if $R<0$; reset otherwise
$Z$ : set if $R=0$; reset otherwise
$\mathrm{H}, \mathrm{N}$ : reset
P/V: contains contents of IFF2

LD I, A
I - A
The contents of the Accumulator are loaded into the Interrupt Control Vector Register 1.


Cycles:


States: 9
Flags: none

## LD R, A

R-A
The contents of the Accumulator are loaded into the Memory Refresh Register R.


Cycles: 2
States: 9


Flags: none

## SIXTEEN-BIT LOAD INSTRUCTIONS

LD dd, nn
dd - nn
The 2-byte integer nn is loaded into the dd register pair, where dd defines the $\mathrm{BC}, \mathrm{DE}, \mathrm{HL}$, or SP register pairs, assembled as follows in the object code:

| $\frac{\text { Pair }}{}$ | $\frac{\text { dd }}{\text { BC }}$ |
| :---: | :---: |
| DE | 01 |
| HL | 10 |
| SP | 11 |



SP 11


Cycles: 3
States: 10
Flags: none


LD IX, nn
IX - nn
Integer nn is loaded into the Index Register IX.


Cycles: 4
States: 14
Flags: none


LD IY, nn
IY - nn
Integer nn is loaded into the Index Register IY.


Cycles: 4
States: 14
Flags: none


The contents of memory address nn are loaded into register L , and the contents of the next highest memory location ( $n \pi+1$ ) are loaded into register H .


Cycles: 5
States: 16
Flags: none

LD dd, (nn)
$\mathrm{dd}_{H}-(\mathrm{nn}+1), \mathrm{dd}_{L}-(\mathrm{nn})$
The contents of address nn are loaded into the low-order portion of register pair dd, and the contents of the next highest memory address ( $n n+1$ ) are loaded into the high portion of dd .


Cycles: 6
States: 20
Flags: none


LD IX, (nn)
$\mathrm{IX}_{H}-(\mathrm{nn}+1), \mathrm{IX}_{L}-(\mathrm{nn})$
The contents of the address nn are loaded into the low-order portion of Index Register IX, and the contents of the next highest memory address ( $\mathrm{nn}+1$ ) are loaded into the high-order portion of IX.


## Cycles: 6

States: 20
Flags: none


LD IY, (nn)
$\mathrm{I} Y_{H}-(\mathrm{nn}+1), \mathrm{I} Y_{L}-(\mathrm{nn})$
The contents of address nn are loaded into the low-order portion of Index Register IY, and the contents of the next highest memory address ( $n n+1$ ) are loaded into the high-order portion of IY.


Cycles: 6


States: 20
Flags: none


LD ( nn ), HL

$$
(n n+1)-H,(n n)-L
$$

The contents of register L are loaded into memory address nn , and the contents of register H are loaded into the next highest address location $\mathrm{nn}+1$.

$$
\begin{array}{|lllllllllll|}
\hline 0 & 0 & 1 & 0 & 0 & 0 & 1 & 0 \\
\hline
\end{array}
$$

Cycles: 5


States: 16
Flags: none


LD (nn), dd
$(\mathrm{nn}+1)-\mathrm{dd}_{H},(\mathrm{n} \mathrm{n})-\mathrm{dd}_{\mathrm{L}}$
The low-order byte of register pair dd is loaded into memory address nn; the upper byte is loaded into memory address $n n+1$.


Cycles: 6
States: 20
Flags: none


LD (nn), IX
$(\mathrm{nn}+1)-\mathrm{IX}_{H^{\prime}}(\mathrm{nn})-\mathrm{IX} \mathrm{X}_{\mathrm{L}}$
The low-order byte in Index Register IX is loaded into memory address nn; the upper-order byte is loaded into the next highest address nn +1 .


Cycles: 6
States: 20
Flags: none


LD (nn), IX
$(\mathrm{nn}+1)-\mathrm{IX}_{H}(\mathrm{nn})-\mathrm{IY}_{\mathrm{L}}$
The low-order byte in Index Register IY is loaded into memory address nn ; the upper-order byte is loaded into memory location $\mathrm{nn}+1$.


Cycles: 6
States: 20
Flags: none


LD SP, HL
$S P-H L$
The contents of the register pair HL are loaded into the SP (stack pointer).

Cycles: 1


States: 6
Flags: none

LD SP, IX
SP - IX
The 2-byte contents of Index Register IX are loaded into the SP (stack pointer).


Cycles: 2
States: 10
Flags: none


LD SP, IY
SP - IY
The 2-byte contents of Index Register IY are loaded into the SP (stack pointer).


Cycles: 2
States: 10
Flags: none


PUSH qq
$(\mathrm{SP}-2)-\mathrm{qq}_{L^{\prime}}(\mathrm{SP}-1)-\mathrm{qq}_{H}$
The contents of the register pair $q q$ are pushed into the external memory LIFO (last-in, first-out) Stack. The Stack Pointer (SP) register pair holds the 16-bit address of the current "top" of the Stack. This instruction first decrements the SP and loads the high order byte of register pair $q q$ into the memory address now specified by the SP; then decrements the SP again and loads the low order byte of qq into the memory location corresponding to this new address in the SP.

Cycles: 3
States: 11


Flags: none
$(\mathrm{SP}-2)-\mathrm{I} \mathrm{X}_{\mathrm{L}}(\mathrm{SP}-1)-\mathrm{IX} \mathrm{H}$
The contents of the Index Register IX are pushed into the Stack. This instruction first decrements the SP and loads the high-order byte of IX into the memory address now specified by the SP; it then decrements the SP again and loads the low-order byte into the memory location corresponding to this new address in the SP.


Cycles: 3
States: 15


Flags: none
PUSH IY
$(S P-2)-I Y_{L}(S P-1)-I Y_{H}$
The contents of the Index Register IY are pushed into the Stack. This instruction first decrements the SP and loads the high-order byte of IY into the memory address now specified by the SP; it then decrements the SP again and loads the low-order byte into the memory location corresponding to this new address in the SP.

Cycles: 4


States: 15
Flags: none
POP $q q$
$\mathrm{qq} \mathrm{q}_{H}-(\mathrm{SP}+1), \mathrm{qq}_{t}-(\mathrm{SP})$
The top 2 bytes of the Stack are popped into register pair qq. This instruction first loads into the low-order portion of qq the byte at the memory location corresponding to the contents of SP ; then SP is incremented and the contents of the corresponding adjacent memory location are loaded into the highorder portion of qq , and the SP is now incremented again.


Cycles: 3
States: 10
Flags: none

POP IX
$\mathrm{IX}_{H}-(\mathrm{SP}+1), \mathrm{IX} \mathrm{X}_{\mathrm{L}}-(\mathrm{SP})$
The top 2 bytes of the Stack are popped into Index Register IX. This instruction first loads into the low-order portion of IX the byte at the memory location corresponding to the contents of SP; the SP is incremented and the contents of the corresponding adjacent memory location are loaded into the high-order portion of IX. The SP is now incremented again,


Cycles: 4
States: 14
Flags: none

The top 2 bytes of the Stack are popped into Index Register IY. This instruction first loads into the low-order portion of IY the byte at the memory location corresponding to the contents of SP; then the SP is incremented and the contents of the corresponding adjacent memory location are loaded into the high-order portion of IY. The SP is now incremented again.


Cycles: 4


States: 14
Flags: none

## EXCHANGE, BLOCK TRANSFER AND SEARCH GROUP

## EX DE, HL

DE - HL
The 2-byte contents of register pairs DE and HL are exchanged.


Cycles: 1
States: 4
Flags: none

EXAF, AF'
$\mathrm{AF}-\mathrm{AF}^{\prime}$
The 2-byte contents of the register pairs AF and $\mathrm{AF}^{\prime}$ are exchanged.


Cycles: 1
States: 4
Flags: none

EXX
$(\mathrm{BC})-\left(\mathrm{BC}^{\prime}\right),(\mathrm{DE})-(\mathrm{DE}),(\mathrm{HL})-\left(\mathrm{HL}^{\prime}\right)$
Each 2-byte value in register pairs $B C, D E$, and $H L$ is exchanged with the 2-byte value in $\mathrm{BC}^{\prime}, \mathrm{DE}^{\prime}$, and $\mathrm{HL}^{\prime}$ respectively.


Cycles: 1
States: 4
Flags: none
$\mathrm{H}-(\mathrm{SP}+1), \mathrm{L}-(\mathrm{SP})$
The low-order byte contained in register pair HL is exchanged with the contents of the memory address specified by the contents of register pair SP, and the high-order byte of HL is exchanged with the next highest memory address $(\mathrm{SP}+1)$.


Cycles: 5
States: 19
Flags: none

EX (SP), IX
$\mathrm{IX}_{H}-(\mathrm{SP}+1), \mathrm{IX}_{\mathrm{L}}-(\mathrm{SP})$
The low-order byte in the Index Register IX is exchanged with the contents of the memory address specified by the contents of register pair SP, and the high-order byte of IX is exchanged with the next highest address ( $\mathrm{SP}+1$ ).


Cycles: 6
States: 23


Flags: none

EX (SP), IY
$\mathrm{IY} Y_{H}-(\mathrm{SP}+1), \mathrm{IY}{ }_{L} \rightarrow(\mathrm{SP})$
The low-order byte in Index Register IY is exchanged with the contents of the memory address specified by the contents of register pair SP, and the highorder byte of IY is exchanged with the next highest memory address.


Cycles: 6


States: 23
Flags: none

LDI
$(\mathrm{DE})-(\mathrm{HL}), \mathrm{DE}-\mathrm{DE}+1, \mathrm{HL}-\mathrm{HL}+1, \mathrm{BC}-\mathrm{BC}-1$
A byte of data is transferred from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both register pairs are incremented and the BC (byte counter) register pair is decremented.


Cycles: 4


States: 16
Flags: $\quad \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
$\mathrm{H}, \mathrm{N}$ : reset
$P / V$ : set if $B C-1 \neq 0$; reset otherwise
(DE) - (HL), $\mathrm{DE}-\mathrm{DE}+1, \mathrm{HL}-\mathrm{HL}+1, \mathrm{BC}-\mathrm{BC}-1$
This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the DE register pair. Then, both register pairs are incremented and the $B C$ (byte counter) register pair is decremented. If decrementing causes the $B C$ to go to 0 , the instruction is terminated. If $B C$ is not 0 , the program counter is decremented by 2 and the instruction is repeated. Note: if $B C$ is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes. Also, interrupts will be recognized after each data transfer.


For $B C \neq 0$ :
Cycles: 5
States: 21
For $B C=0$ :
Cycles: 4
States: 16
Flags: H,N,P/V: reset

$$
(\mathrm{DE})-(\mathrm{HL}), \mathrm{DE}-\mathrm{DE}-1, \mathrm{HL}-\mathrm{HL}-1, \mathrm{BC}-\mathrm{BC}-1
$$

This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both register pairs inclading the BC (byte counter) register pair are decremented.


Cycles: 4
States: 16
Flags: $\quad \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
$\mathrm{H}, \mathrm{N}$ : reset
$P / V$ : set if $B C-1 \neq 0$; reset otherwise

## LDDR

$(\mathrm{DE})-(\mathrm{HL}), \mathrm{DE}-\mathrm{DE}-1, \mathrm{HL}-\mathrm{HL}-1, \mathrm{BC}-\mathrm{BC}-1$
This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both registers, as well as the BC (byte counter), are decremented. If decrementing causes the $B C$ to go to 0 , the instruction is terminated. If $B C$ is not 0 , the program counter is decremented by 2 and the instruction is repeated. Note: if $B C$ is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes. Also, interrrupts will be recognized after each data transfer.


For $B C \neq 0$ :


Cycles: 5
States: 21
For $B C=0$ :
Cycles: 4
States: 16
Flags: H,N,P/V: reset
$\mathrm{A}-(\mathrm{HL}), \mathrm{HL}-\mathrm{HL}+1, \mathrm{BC}-\mathrm{BC}-1$
The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare, a condition bit is set. Then HL is incremented and the byte counter (register pair $B C$ ) is decremented.


Cycles: 4


Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if $A=(\mathrm{HL})$; reset otherwise
H: set if no borrow from bit 4; reset otherwise
N : set
$P / V$ : set if $B C-1 \neq 0$; reset otherwise

CPIR
$\mathrm{A}-(\mathrm{HL}), \mathrm{HL}-\mathrm{HL}+1, \mathrm{BC}-\mathrm{BC}-1$
The contents of the memory location addressed by the HL register are compared with the contents of the Accumulator. In case of a true compare, a condition bit is set. The HL is incremented and the BC is decremented. If decrementing causes the $B C$ to go to 0 or if $A=(H L)$, the instruction is terminated. If BC is not 0 and if $\mathrm{A} \neq(\mathrm{HL})$, the program counter is decremented by two, and the instruction is repeated. Note: if $B C$ is set to 0 before instruction execution, the instruction will loop through 64 K bytes, if no match is found. Also, interrupts will be recognized after each data comparison.


For $B C \neq 0$ and $A \neq(H L)$ :
Cycles: 5
States: 21
For $\mathrm{BC}=0$ or $\mathrm{A}=(\mathrm{HL})$ :
Cycles: 4

States: 16
Flags: $\quad S, Z, H, N, P / V$
$S$ : set if result is negative; reset otherwise
$Z$ : set if $A=(\mathrm{HL})$; reset otherwise
H: set if no borrow from bit 4 ; reset otherwise
N : set
$P / V$ : set if $B C-I \neq 0$; reset otherwise
$\mathrm{A}-(\mathrm{HL}), \mathrm{HL}-\mathrm{HL}-1, \mathrm{BC}-\mathrm{BC}-1$
The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare a condition bit is set. The HL and the BC are decremented.


Cycles: 4

| 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

States: 16
Flags: $\quad S, Z, H, N, P / V$
S : set if result is negative; reset otherwise
$Z$ : set if $\mathrm{A}=(\mathrm{HL})$; reset otherwise
H: set if no borrow from bit 4; reset otherwise
N : set
P/V: set if $B C-1 \neq 0$; reset otherwise
$\mathrm{A}-(\mathrm{HL}), \mathrm{HL}-\mathrm{HL}-1, \mathrm{BC}-\mathrm{BC}-1$
The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare a condition bit is set. The HL and $B C$ register pairs are decremented. If decrementing causes the $B C$ to go to 0 or if $A=(\mathrm{HL})$, the instruction is terminated. If $B C$ is not 0 and $A \neq(\mathrm{HL})$, the program counter is decremented by 2 and the instruction is repeated. Note: if $B C$ is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes if no match is found. Also, interrupts will be recognized after each data comparison.


For $B C \neq 0$ and $A \neq(\mathrm{HL})$ :
Cycles: 5
States: 21

For $B C=0$ or $A=(H L)$ :
Cycles: 4
States: 16
Flags: $\quad S, Z, H, N, P / V$
$S$ : set if result is negative; reset otherwise
$Z$ : set if $A=(\mathrm{HL})$; reset otherwise
H : set if no borrow from bit 4; reset otherwise
N : set
P/V: set if $B C-1 \neq 0$; reset otherwise

ADD A, r
$A-A+r$
The contents of register $r$ are added to the contents of the Accumulator, and the result is stored in the Accumulator.


Cycles: 1
States: 4
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
Z: set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
C: set if carry from bit 7; reset otherwise
$\mathrm{P} / \mathrm{V}$ : set if overflow; reset otherwise

ADD A, n
$A-A+n$
The integer $n$ is added to the contents of the Accumulator, and the results are stored in the Accumulator.


Cycles: 2
States: 7
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
C: set if carry from bit 7; reset otherwise
$\mathrm{P} / \mathrm{V}$ : set if overflow; reset otherwise

ADD A. (HL)
A - A+(HL)
The byte at the memory address specified by the contents of the HL register pair is added to the contents of the Accumulator, and the result is stored in the Accumulator.


Cycles: 2
States: 7
Flags: S, Z,H,N,C,P/V
S: set if result is negative; reset otherwise
Z: set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
C: set if carry from bit 7; reset otherwise
$\mathrm{P} / \mathrm{V}$ : set if overflow; reset otherwise

ADD A, (IX +d )
$\mathrm{A}-\mathrm{A}+(\mathrm{IX}+\mathrm{d})$
The contents of the Index Register IX are added to a displacement $d$ to point to an address in memory. The contents of this address are then added to the contents of the Accumulator, and the result is stored in the Accumulator.


Cycles: 5
States: 19
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
Z: set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
C: set if carry from bit 7; reset otherwise P/V: set if overflow; reset otherwise

ADD A, $(Y Y+d)$
$A-A+(I Y+d)$
The contents of the Index Register IY are added to a displacement d to point to an address in memory. The contents of this address are then added to the contents of the Accumulator, and the result is stored in the Accumulator.


Cycles: 5
States: 19
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if carry from bit 3; reset otherwise
N : set
C: set if carry from bit 7; reset otherwise
P/V: set if overflow; reset otherwise
$A-A+s+C Y$
The $s$ operand is any of $r, n,(H L)$, (IX +d ), or ( $\mathrm{I} Y+\mathrm{d}$ ) as defined for the analogous ADD instruction. These various possible opcode operand combinations are assembled in the object code as follows:

ADC A, $\mathbf{r}$
ADC A, n


ADC A, (HL)


ADC A. (IX+d)

$\operatorname{ADCA}(I Y+d)$


The s operand, along with the Carry Flag (" C " in the F register) is added to the contents of the Accumulator, and the result is stored in the Accumulator.

| Instruction | Cycles |  | States |
| :--- | :---: | :---: | :---: |
| ADC A, r |  | $\mathbf{1}$ |  |
| ADC A, n | 2 |  | 7 |
| ADC A, (HL) | $\mathbf{2}$ |  | 7 |
| ADC A, (IX+d) | 5 |  | 19 |
| ADC A, (IY+d) | 5 |  | 19 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if carry from bit 3; reset otherwise
N : reset
C: set if carry from bit 7; reset otherwise
P/V: set if overflow; reset otherwise
$A-A-s$
The s operand is subtracted from the contents of the Accumulator, and the result is stored in the Accumulator.


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| SUB r | 1 | 4 |
| SUB $n$ | 2 | 7 |
| SUB (HL) | 2 | 7 |
| SUB (IX+d) | 5 | 19 |
| SUB ( $\mathrm{I} \mathrm{Y}+\mathrm{d}$ ) | 5 | 19 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if no borrow from bit 4; reset otherwise
N : set
C: set if no borrow; reset otherwise
P/V: set if overflow; reset otherwise
$A-A-s-C Y$
The s operand, along with the Carry Flag (" C " in the F register) is subtracted from the contents of the Accumulator, and the result is stored in the Accumulator.

SBC A, r


SBC A, n


SBC A, (HL)


SBC A, (IX+d)


SBC A, (IY+d)


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| SBC A, r | 1 | 4 |
| SBC A, n | 2 | 7 |
| SBC A. (HL) | 2 | 7 |
| SBC A, (IX+d) | 5 | 19 |
| SBC A, (IY+d) | 5 | 19 |

Flags: S, Z,H,N,C,P/V
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if no borrow from bit 4; reset otherwise
N : set
C: set if no borrow; reset otherwise
P/V: set if overflow; reset otherwise
$\mathrm{A}-\mathrm{A} \wedge \mathrm{s}$
A logical AND operation, bit by bit, is performed between the byte specified by the $s$ operand and the byte contained in the Accumulator; the result is stored in the Accumulator.


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| AND r | 1 | 4 |
| AND $n$ | 2 | 7 |
| AND (HL) | 2 | 7 |
| AND (IX +d ) | 5 | 19 |
| AND (IX+d) | 5 | 19 |


| Flags: | S, Z,H,N,C,P/V |
| ---: | :--- |
|  | S: set if result is negative; reset otherwise |
| Z: set if result is 0 ; reset otherwise |  |
| H: set |  |
| N: reset |  |
| C: reset |  |
| P/V: set if parity even; reset otherwise |  |

A-As
A logical OR operation, bit by bit, is performed between the byte specified by the soperand and the byte contained in the Accumulator; the result is stored in the Accumulator.

OR r


OR n


OR(HL)

$\mathrm{OR}(\mathrm{IX}+\mathrm{d})$

$\mathrm{OR}(\mathrm{IY}+\mathrm{d})$


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| OR r | 1 | 4 |
| OR $n$ | 2 | 7 |
| OR (HL) | 2 | 7 |
| OR ( $\mathrm{IX}+\mathrm{d}$ ) | 5 | 19 |
| $\mathrm{OR}(\mathrm{IY}+\mathrm{d})$ | 5 | 19 |

Flags: S,Z,H,N,C,P/V
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set
N : reset
C: reset
P/V: set if parity even; reset otherwise
$A-A \oplus s$
A logical exclusive-OR operation, bit by bit, is performed between the byte specified by the s operand and the byte contained in the Accumulator; the result is stored in the Accumulator.

Instruction
XOR r
XOR n
XOR (HL)
XOR (IX + d)
XOR (IY + d)

| Cycles |  |  | States |
| :---: | :---: | :---: | :---: |
|  |  |  | 4 |
| 2 |  | 7 |  |
| 2 |  | 7 |  |
| 5 |  |  | 79 |
| 5 |  | 19 |  |

Flags: $\quad$ S, Z, H, N, C, P/V
S: set if result is negative; reset otherwise
$Z$ : set if result if 0 ; reset otherwise
H: set
N : reset
C: reset
P/V: set if parity even; reset otherwise

A-s
The contents of the s operand are compared with the contents of the Accumulator. If there is a true compare, a flag is set.


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| CPr | 1 | 4 |
| $\mathrm{CP} \mathrm{n}^{\text {n }}$ | 2 | 7 |
| CP (HL) | 2 | 7 |
| $\mathrm{CP}(\mathrm{IX}+\mathrm{d})$ | 5 | 19 |
| $\mathrm{CP}(\mathrm{IY}+\mathrm{d})$ | 5 | 19 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if no borrow from bit 4; reset otherwise
N : set
C: set if no borrow; reset otherwise
P/V: set if overflow; reset otherwise

INC r

$$
r \leftarrow r+1
$$

Register $r$ is incremented.


Cycles: 1
States: 4
Flags: $\quad$ S, Z, H,N,P/V
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
$\mathrm{P} / \mathrm{V}$ : set if r was 7FH before operation; reset otherwise

INC (HL)
(HL) $-(\mathrm{HL})+1$
The byte contained in the address specified by the contents of the HL register pair is incremented.


Cycles: 3
States: 11
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
P/V: set if (HL) was 7FH before operation; reset otherwise

INC (IX+d)
(IX+d) $\leftarrow(\mathrm{IX}+\mathrm{d})+1$
The contents of the Index Register IX are added to a two's complement displacement integer d to point to an address in memory. The contents of this address are then incremented.


Cycles: 6


States: 23
Flags: S, Z, H,N,P/V
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if carry from bit 3; reset otherwise
N : reset
P/V: set if (IX +d ) was 7FH before operation; reset otherwise

$$
(\mathrm{IY}+\mathrm{d})-(\mathrm{IY}+\mathrm{d})+1
$$

The contents of the Index Register IY are added to a two's complement
displacement integer $d$ to point to an address in memory. The contents of this address are then incremented.


Cycles: 6


States: 23

## Flags: $\quad$ S, Z, H, N,P/V

S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if carry from bit 3; reset otherwise
N : reset
P/V: set if (IY + d) was 7FH before operation; reset otherwise

DEC m
$\mathrm{m} \leftarrow \mathrm{m}-1$
The byte specified by the m operand is decremented.
DEC r


DEC (HL)


DEC (IX+d)


DEC (IY+d)


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| DEC r | 1 | 4 |
| DEC (HL) | 3 | 11 |
| DEC (IX+d) | 6 | 23 |
| DEC ( $\mathrm{I} Y+\mathrm{d}$ ) | 6 | 23 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if no borrow from bit 4; reset otherwise
N : set
$P / V$ : set if m was 80 H before operation; reset otherwise

## general purpose arithmetic and cpu control groups

CPL

## $\mathrm{A}-\overline{\mathrm{A}}$

Contents of the Accumulator are inverted (1's complement).

$$
\begin{array}{|l|l|l|l|l|l|l|}
\hline 0 & 0 & 1 & 0 & 1 & 1 & 1 \\
\hline
\end{array}
$$

Cycles: 1
States: 4
Flags: H,N
H: set
N : set

NEG
$A \rightarrow 0-A$
The contents of the Accumulator are negated (two's complement). This is the same as subtracting the contents of the Accumulator from 0.


Cycles: 2

| 0 | 1 | 0 | 0 | 0 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

States: $\mathbf{8}$
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: set if no borrow from bit 4; reset otherwise
N : set
C : set if Accumulator was not 00 H before operation; reset otherwise
P/V: set if Accumulator was 80 H before operation; reset otherwise
$\mathrm{CY}-\overline{\mathrm{CY}}$
The C flag in the F register is inverted.


Cycles: 1
States: 4
Flags: H,N,C
H: previous carry will be copied
N : reset
C: set if CY was 0 before operation; reset otherwise

SCF
CY - 1
The C flag in the F register is set.


Cycles: 1
States: 4
Flags: H,N,C
$\mathrm{H}:$ reset
$\mathrm{N}:$ reset
$\mathrm{C}:$ set

NOP
The central processor performs no operation during this machine cycle.

$$
\begin{array}{|l|l|l|l|l|l|l|}
\hline 0 & 0 & 0 & 0 & 0 & 0 & 0 \\
\hline
\end{array}
$$

Cycles: 1
States: 4
Flags: none

DAA
This instruction conditionally adjusts the Accumulator for BCD addition and subtraction operations. For addition (ADD, ADC, INC) or subtraction (SUB, SBC, DEC, NEG), the following table indicates the operation performed:

| OPERATION | $\begin{aligned} & \text { C } \\ & \text { BEFORE } \\ & \text { DAA } \end{aligned}$ | HEX value IN UPPER DIGIT (bit 7-4) | $\begin{aligned} & \mathrm{H} \\ & \text { BEFORE } \end{aligned}$ DAA | HEX value IN LOWER DIGIT (bit 3-0) |  | C AFTER DAA |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { ADD } \\ & \text { ADC } \\ & \text { INC } \end{aligned}$ | $\begin{aligned} & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 0 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | $\begin{aligned} & 0-9 \\ & 0-8 \\ & 0-9 \\ & A-F \\ & 9-F \\ & A-F \\ & 0-2 \\ & 0-2 \\ & 0-3 \end{aligned}$ | $\begin{aligned} & 0 \\ & 0 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \\ & 0 \\ & 0 \\ & 1 \end{aligned}$ | $\begin{aligned} & 0-9 \\ & A-F \\ & 0-3 \\ & 0-9 \\ & A-F \\ & 0-3 \\ & 0-9 \\ & A-F \\ & 0-3 \end{aligned}$ | 00 <br> 06 <br> 06 <br> 60 <br> 66 <br> 66 <br> 60 <br> 66 <br> 66 | 000111111 |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
| SUB <br> SBC <br> DEC <br> NEG | 0 | $\begin{aligned} & 0-9 \\ & 0-8 \\ & 7-F \\ & 6-F \end{aligned}$ | $\begin{aligned} & 0 \\ & 1 \\ & 0 \\ & 1 \end{aligned}$ | $\begin{aligned} & 0-9 \\ & 6-F \\ & 0-9 \\ & 6-F \end{aligned}$ | $\begin{aligned} & 00 \\ & \text { FA } \\ & \text { A0 } \\ & 9 \mathrm{~A} \end{aligned}$ | 0011 |
|  | 0 |  |  |  |  |  |
|  | 1 |  |  |  |  |  |
|  | 1 |  |  |  |  |  |

Cycles: 1
States: 4
Flags: S, Z,H,C,P/V
S: set if most significant bit of Accumulator is 1 after operation; reset otherwise
Z: set if Accumulator is 0 after operation; reset otherwise
H : see instruction
C: see instruction
P/V: set if Accumulator is even parity after operation; reset otherwise

The HALT instruction suspends the central processor operation until a subsequent interrupt or reset is received. While in the halt state, the processor will execute NOPs to maintain memory refresh logic.

| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 1
States: $\mathbf{4}$
Flags: none

DI
IFF - 0
DI disables the maskable interrupt by resetting the interrupt enable flip-flops (IFF1 and IFF2). Note: this instruction disables the maskable interrupt during its execution.


Cycles: 1
States: 4
Flags: none

EI
IFF - 1
EI enables the maskable interrupt by setting the interrupt enable flip-flops (IFF1 and IFF2). Note: this instruction disables the maskable interrupt during its execution.


Cycles: 1
States: 4
Flags: none

## IM 0

The IM 0 instruction sets interrupt mode 0 . In this mode the interrupting device can insert any instruction on the data bus and allow the central processor to execute it.


Cycles: 2
States: 8
Flags: none

IM 1
The IM 1 instruction sets interrupt mode 1 . In this mode the processor will respond to an interrupt by executing a restart of location 0038 H .

| 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 2
States: 8


Flags: none

## IM 2

The IM 2 instruction sets interrupt mode 2. This mode allows an indirect call to any location in memory. With this mode, the central processor forms a 16 -bit memory address. The upper 8 bits are the contents of the Interrupt Vector Register I and the lower 8 bits are supplied by the interrupting device.


Cycles: 2

$$
\begin{array}{|l|l|l|l|l|l|l|l|}
\hline 0 & 1 & 0 & 1 & 1 & 1 & 1 & 0 \\
\hline
\end{array}
$$

States: 8
Flags: none

## SDXTEEN-BIT ARITHMETIC GROUP

ADD HL, ss
$\mathrm{HL} \leftarrow \mathrm{HL}+\mathrm{ss}$
The contents of register pair ss are added to the contents of register pair HL and the result is stored in HL.

| 0 | 0 | $s$ | $s$ | 1 | 0 | 0 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 3
States: 11
Flags: H,N,C
H : set if carry out of bit 11 ; reset otherwise
$N$ : reset
C: set if carry from bit 15 ; reset otherwise

ADC HL, ss
$\mathrm{HL}-\mathrm{HL}+\mathrm{ss}+\mathrm{CY}$
The contents of register pair ss are added with the Carry Flag to the contents of the register pair HL, and the result is stored in HL.


Cycles: 4


States: 15
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if carry out of bit 11; reset otherwise
N : reset
C: set if carry from bit 15; reset otherwise
$\mathrm{P} / \mathrm{V}$ : set if overflow; reset otherwise
$\mathrm{HL}-\mathrm{HL}-\mathrm{ss}-\mathrm{CY}$
The contents of the register pair ss and the Carry Flag are subtracted from the contents of register pair HL, and the result is stored in HL.

Cycles: 4


Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : set if no borrow from bit 12; reset otherwise
N : set
C: set if no borrow; reset otherwise
P/V: set if overflow; reset otherwise

ADD IX, pp
IX $-\mathrm{IX}+\mathrm{pp}$
The contents of register pair pp are added to the contents of the Index Register IX, and the results are stored in IX.

Cycles: 4


States: 15
Flags: H,N,C
H: set if carry out of bit 11; reset otherwise
N : reset
C: set if carry from bit 15; reset otherwise

ADD IY, rr
$\mathrm{Y}-\mathrm{I} \mathrm{Y}+\mathrm{rr}$
The contents of register pair rr are added to the contents of Index Register IY, and the result is stored in IY.


Cycles: 4


States: 15
Flags: H,N,C
H: set if carry out of bit 11; reset otherwise
N : reset
C: set if carry from bit 15; reset otherwise

INC ss
ss - $s s+1$
The contents of register pair ss are incremented.

| 0 | 0 | $s$ | $s$ | 0 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 1
States: 6
Flags: none

INC IX
IX - IX+1
The contents of the Index Register IX are incremented.

Cycles: 2


States: 10
Flags: none

INC IY
IY - IY +1
The contents of the Index Register IY are incremented.

$$
\begin{array}{|l|l|l|l|l|l|l|l|}
\hline 1 & 1 & 1 & 1 & 1 & 1 & 0 & 1 \\
\hline
\end{array}
$$

Cycles: 2


States: 10
Flags: none

DEC ss
ss - ss-1
The contents of register pair ss are decremented.


Cycles: 1
States: 6
Flags: none

DEC IX
IX - IX -1
The contents of the Index Register IX are decremented.


Cycles: 2
States: 10
Flags: none

DEC IY
IY - IY-1
The contents of the Index Register IY are decremented.


Cycles: 2
States: 10
Flags: none

## ROTATE AND SHIFT GROUP

RLCA


The contents of the Accumulator are rotated left. The content of bit 7 is copied into the Carry Flag, and also into bit 0.


Cycles: 1
States: 4
Flags: H,N,C
H: reset
N : reset
C: data from bit 7 of Accumulator

RLA


The contents of the Accumulator are rotated left. The content of bit 7 is copied into the Carry Flag, and the previous content of the Carry Flag is copied into bit 0 .


Cycles: 1
States: 4
Flags: H,N,C
H : reset
N : reset
C: data from bit 7 of Accumulator.

RRCA


The contents of the Accumulator are rotated right. The content of bit 0 is copied into bit 7 and also into the Carry Flag.


Cycles: 1
States: 4
Flags: H,N,C
H: reset
N : reset
C: data from bit 0 of Accumulator.


The contents of the Accumulator are rotated right. The content of bit 0 is copied into the Carry Flag, and the previous content of the Carry Flag is
copied into bit 7.

| 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Cycles: 1
States: 4
Flags: H,N, C
H: reset
N : reset
C: data from bit 0 of Accumulator.

RLC r


The 8 -bit contents of register $r$ are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.

Cycles: 2


Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : reset
N : reset
C: data from bit 7 of source register
P/V: set if parity even; reset otherwise

RLC (HL)

(HL)
The contents of the memory address specified by the contents of register pair HL are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0 .


Cycles: 4


States: 15
Flags: S,Z,H,N,C,P/V
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 7 of source register
P/V: set if parity even; reset otherwise

RLC (IX+d)


The contents of the memory address, specified by the sum of the contents of the Index Register IX and a two's complement displacement integer d, are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.


Cycles: 6


States: 23
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
Z: set if result is 0 ; reset otherwise
H : reset
N : reset
C: data from bit 7 of source register
P/V: set if parity even; reset otherwise
$\operatorname{RLC}(I Y+d)$


The contents of the memory address, specified by the sum of the contents of the Index Register IY and a two's complement displacement integer d , are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.


Cycles: 6
States: 23
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H : reset
N : reset
C: data from bit 7 of source register
P/V: set if parity even; reset otherwise

RL m


The contents of the m operand are rotated left. The content of bit 7 is copied into the Carry Flag and the previous content of the Carry Flag is copied into bit 0 .


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| RL r | 2 | 8 |
| RL (HL) | 4 | 15 |
| RL (IX+d) | 6 | 23 |
| RL (IY+d) | 6 | 23 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 7 of source register
P/V: set if parity even; reset otherwise


The contents of the operand $m$ are rotated right. The content of bit 0 is copied into the Carry Flag and also into bit 7.

RRC r


RRC (HL)


RRC ( $\mathrm{I} \mathrm{X}+\mathrm{d}$ )

$$
\begin{array}{|l|l|l|l|l|l|l|l|}
\hline 1 & 1 & 0 & 1 & 1 & 1 & 0 & 1 \\
\hline
\end{array}
$$


$\operatorname{RRC}(\mathrm{I} Y+\mathrm{d})$


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| RRC r | 2 | 8 |
| RRC (HL) | 4 | 15 |
| RRC (IX+d) | 6 | 23 |
| RRC (IY +d ) | 6 | 23 |

## Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$

S : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 0 of source register
P/V: set if parity even; reset otherwise

RR m


The contents of operand $m$ are rotated right. The content of bit 0 is copied into the Carry Flag, and the previous content of the Carry Flag is copied into bit 7.

RR r


RR (HL)

$R R(\mathrm{IX}+\mathrm{d})$


$$
\begin{array}{l|l|l|l|l|l|l|}
\hline 1 & 1 & 0 & 0 & 1 & 0 & 1 \\
\hline
\end{array}
$$


$R R(I Y+d)$


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| RR r | 2 | 8 |
| RR (HL) | 4 | 15 |
| RR (IX+d) | 6 | 23 |
| RR (IY+d) | 6 | 23 |

Flags: $\quad$ S, Z, H, N, C, P/V
$S$ : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 0 of source register
P/V: set if parity even; reset otherwise

SLA m $\underset{m}{C Y}-\frac{7 \leftarrow 0}{m} \rightarrow 0$
An arithmetic shift left is performed on the contents of operand m. Bit 0 is reset. The content of bit 7 is copied into the Carry Flag.

SLA r

| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



SLA (HL)

$$
1,1,0,0,1,0,1,11
$$

$$
\begin{array}{|l|l|l|l|l|l|l|}
\hline 0 & 0 & 1 & 0 & 0 & 1 & 1
\end{array} 0
$$

SLA (IX+d)



| Instruction | Cycles | States |
| :---: | :---: | :---: |
| SLA r | 2 | 8 |
| SLA (HL) | 4 | 15 |
| SLA (IX+d) | 6 | 23 |
| SLA (IY+d) | 6 | 23 |

Flags: S, Z, H,N,C,P/V
S : set if result is negative; reset otherwise
Z: set if result is 0 ; reset otherwise
H : reset
N : reset
C: data from bit 7
P/V: set if parity even; reset otherwise

SRA m


An arithmetic shift right is performed on the contents of operand $m$. The content of bit 0 is copied into the Carry Flag, and the previous content of bit 7 is unchanged.

SRA r

| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



SRA (HL)


SRA (IX+d)



| Instruction | Cycles | States |
| :---: | :---: | :---: |
| SRA r | 2 | 8 |
| SRA (HL) | 4 | 15 |
| SRA (IX+d) | 6 | 23 |
| $\mathrm{SRA}(\mathrm{IY}+\mathrm{d})$ | 6 | 23 |

Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{C}, \mathrm{P} / \mathrm{V}$
S : set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 0 of source register
$\mathrm{P} / \mathrm{V}$ : set if parity even; reset otherwise

SRL m
$0 \rightarrow \underset{\mathrm{~m}}{7 \rightarrow 0} \rightarrow \square$
The contents of operand $m$ are shifted right. The content of bit 0 is copied into the Carry Flag and bit 7 is reset.

SRL r


SRL (HL)


SRL (IX +d )

| 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |


| 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |



SRL ( $\mathrm{IY}+\mathrm{d}$ )


| Instruction | Cycles | States |
| :---: | :---: | :---: |
| SRL r | 2 | 8 |
| SRL (HL) | 4 | 15 |
| SRL (IX+d) | 6 | 23 |
| SRL (IY+d) | 6 | 23 |

Flags: S,Z,H,N,C,P/V
S: set if result is negative; reset otherwise
$Z$ : set if result is 0 ; reset otherwise
H: reset
N : reset
C: data from bit 0 of source register P/V: set if parity even; reset otherwise

RLD


The contents of the low-order 4 bits of memory location (HL) are copied into the high-order 4 bits of that same memory location. The previous contents of those high-order 4 bits are copied into the low-order 4 bits of the Accumulator, and the previous contents of the low-order 4 bits of the Accumulator are copied into the low-order 4 bits of the memory location (HL). The contents of the high-order 4 bits of the Accumulator are unaffected.


Cycles: 5


States: 18
Flags: $\quad$ S, Z, H, N, P/V
S: set if Accumulator is negative after operation; reset otherwise
$Z$ : set if Accumulator is 0 after operation; reset otherwise
H : reset
N : reset
P/V: set if parity of Accumulator is even after operation; reset otherwise

## RRD

The contents of the low-order 4 bits of memory location (HL) are copied into the low-order 4 bits of the Accumulator. The previous contents of the loworder 4 bits of the Accumulator are copied into the high-order 4 bits of location (HL), and the previous contents of the high-order 4 bits of (HL) are copied into the low-order 4 bits of (HL). The contents of the high-order 4 bits of the Accumulator are unaffected.


Cycles: 5


States: 18
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: set if Accumulator is negative after operation; reset otherwise
$Z$ : set if Accumulator is 0 after operation; reset otherwise
H : reset
N : reset
P/V: set if parity of Accumulator is even after operation; reset otherwise

## BIT SET, RESET AND TEST GROUP

BIT b, r
$Z-r_{b}$
After execution of this instruction, the $Z$ flag in the $F$ register will contain the complement of the indicated bit within the indicated register.


Cycles: 2


States: 8
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: unknown
$Z$ : set if specified bit is 0 ; reset otherwise
H : set
N : reset
P/V: unknown
BIT b, (HL)
$Z-\overline{(\mathrm{HL})_{b}}$
After the execution of this instruction, the $Z$ flag in the F register will contain the complement of the indicated bit within the contents of the HL register pair.


Cycles: 3


States: 12
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S : unknown
$Z$ : set if specified bit is 0 ; reset otherwise
H: set
N : reset
P/V: unknown

BIT b, (IX+d)
$Z-\overline{(X X+d})_{b}$
After the execution of this instruction, the $Z$ flag in the $F$ register will contain the complement of the indicated bit within the contents of the memory location pointed to by the sum of the contents of register pair IX and the two's complement displacement integer d .


Cycles: 5


States: 20
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: unknown
$Z$ : set if specified bit is 0 ; reset otherwise
H: set
N : reset
P/V: unknown
BIT $b,(I Y+d)$
$\mathrm{Z}-\overline{(\mathrm{IY}+\mathrm{d})_{b}}$
After the execution of this instruction, the $Z$ flag in the $F$ register will contain the complement of the indicated bit within the contents of the memory location pointed to by the sum of the contents of register pair IY and the two's complement displacement integer d .


Cycles: 5
States: 20


Flags: S,Z,H,N,P/V
S: unknown
$Z$ : set if specified bit is 0 ; reset otherwise
H: set
N : reset
P/V: unknown
SET b, r
$r_{b}-1$
Bit $b$ (any bit, 7 thru 0 ) in register $r$ is set.


Cycles: 2
States: 8
Fiags: none

$(\mathrm{HL})_{b}-1$
Bit $b$ in the memory location addressed by the contents of register pair HL is set.


Cycles: 4
States: 15
Flags: none

SET b, (IX+d)
$(\mathrm{IX}+\mathrm{d})_{b}-1$
Bit $b$ in the memory location addressed by the sum of the contents of the IX register pair and the two's complement displacement integer d is set.


Cycles: 6
States: 23
Flags: none

SET b, (IY + d)
$(\mathrm{IY}+\mathrm{d})_{6}-1$
Bit $b$ in the memory location addressed by the sum of the contents of the IY register pair and the two's complement displacement integer $d$ is set.


Cycles: 6


States: 23
Flags: none
$s_{b}-0$
Bit $b$ in operand $m$ is reset.

RES b, r


RES b, (HL)


RES b, (IX + d)


RES $\mathrm{b},(\mathrm{IY}+\mathrm{d})$

Instruction
RES b, r
RES b, (HL)
RES b, (IX+d)
RES b, (IY+d)

| Cycles |  | States |
| :---: | :---: | :---: |
|  |  |  |
| 4 |  | 8 |
| 4 |  | 15 |
| 6 |  | 23 |
| 6 |  | 23 |

Flags: none

JUMP GROUP
JP nn
PC - nn
Operand nn is loaded into register pair PC (program counter) and points to the address of the next program instruction to be executed.


Cycles: 3
States: 10
Flags: none

JP cc, nn
IF $\subset$ C TRUE, $P C$ - nn
If condition cc is true, the instruction loads operand nn into register pair PC, and the program continues with the instruction beginning at address nn . If condition cc is false, the program counter is incremented as usual, and the program continues with the next sequential instruction.


Cycles: 3
States: 10
Flags: none

JRe

$$
P C-P C+e
$$

This instruction provides for unconditional branching to other segments of a program. The value of the displacement e is added to the PC and the next instruction is fetched from the location designated by the new contents of the PC. This jump is measured from the address of the instruction opcode and has a range of -126 to +129 bytes.


Cycles: 3
States: 12
Flags: none

JR C, e
If $\mathrm{C}=0$, continue
If $C=1, P C-P C+e$
This instruction provides for conditional branching to other segments of a program depending on the results of a test on the Carry Flag. If the flag is set, the value of the displacement $e$ is added to the PC, and the next instruction is fetched from the location designated by the new contents of the PC. If the flag is reset the next instruction is taken from the location following this instruction.


If the condition is met:
Cycles: 3
States: 12
If the condition is not met:
Cycles: 2
States: 7
Flags: none

JR NC, e
If $\mathrm{C}=1$, continue
If $\mathrm{C}=0, \mathrm{PC}-\mathrm{PC}+\mathrm{e}$
This instruction provides for conditional branching to other segments of a program depending on the results of a test on the Carry Flag. If the flag is reset, the value of the displacement $e$ is added to the PC, and the next instruction is fetched from the location designed by the new contents of the PC. If the flag is set, the next instruction to be executed is taken from the location following this instruction.


If the condition is met:
Cycles: 3
States: 12
If the condition is not met:
Cycles: 2
States: 7
Flags: none

JR Z, e
If $Z=0$, continue
If $Z=1, P C-P C+e$
If the Zero Flag is set, the value of the displacement $e$ is added to the PC and the next instruction is fetched from the location designated by the new contents of the PC. If the Zero Flag is reset, the next instruction to be executed is taken from the location following this instruction.


If the condition is met:
Cycles: 3
States: 12
If the condition is not met:
Cycles: 2
States: 7
Flags: none

JR NZ, e
If $Z=1$, continue
If $Z=0, P C-P C+e$
If the Zero Flag is reset, the value of the displacement e is added to the PC, and the next instruction is fetched from the location designated by the new contents of the PC. If the Zero Flag is set, the next instruction to be executed is taken from the location following this instruction.


If the condition is met:
Cycles: 3
States: 12
If the condition is not met:
Cycles: 2
States: 7
Flags: none

JP (HL)
PC - HL
The PC is loaded with the contents of the HL register pair. The next instruction is fetched from the location designated by the new contents of the PC.


Cycles: 1
States: 4
Flags: none

JP (IX)
PC - IX
The PC is loaded with the contents of the IX Register Pair. The next instruction is fetched from the location designated by the new contents of the PC.


Cycles: 2
States: $\mathbf{8}$
Flags: none

JP (IY)
PC - IY
The PC is loaded with the contents of the IY Register Pair. The next instruction is fetched from the location designated by the new contents of the PC.


Cycles: 2
States: 8
Flags: none

## DJNZ, e

The $B$ register is decremented, and if a non 0 value remains, the value of the displacement $e$ is added to the PC. The next instruction is fetched from the location designated by the new contents of the PC. If the result of decrementing leaves $B$ with a 0 value, the next instruction to be executed is taken from the location following this instruction.


If $B \neq 0$ :
Cycles: 3
States: 13
If $B=0$ :
Cycles: 2
States: 8
Flags: none

## CALL AND RETURN GROUP

CALL nn
$(\mathrm{SP}-1)-\mathrm{PC}_{H},(\mathrm{SP}-2)-\mathrm{PC}_{\mathrm{L}}, \mathrm{PC}-\mathrm{nn}$
After pushing the current contents of the PC onto the top of the external memory stack, the operands nn are loaded into PC to point to the address in memory where the first opcode of a subroutine is to be fetched. Note: because this is a 3-byte instruction, the PC will have been incremented by three before the push is executed.


Cycles: 5
States: 17
Flags: none

CALL cc, nn
If cc TRUE: $(S P-1)-\mathrm{PC}_{H},(\mathrm{SP}-2)-\mathrm{PC}_{L}, \mathrm{PC}-\mathrm{nn}$
If condition cc is true, this instruction pushes the current contents of the PC onto the top of the external memory stack, then loads the operands $n n$ into PC to point to the address in memory where the first opcode of a subroutine is to be fetched.


If cc is true:


Cycles: 5
States: 17
If $c c$ is false:
Cycles: 3
States: 10
Flags: none

RET
$\mathrm{PC}_{L}-(\mathrm{SP}), \mathrm{PC}_{H}-(\mathrm{SP}+1)$
Control is returned to the original program flow by popping the previous contents of the PC off the top of the external memory stack, where they were pushed by the CALL instruction. On the following machine cycle, the central processor will fetch the next program opcode from the location in memory now pointed to by the PC.

$$
\begin{array}{|llllllllll|}
\hline 1 & 1 & 0 & 0 & 1 & 0 & 0 & 1 \\
\hline & & & & & & \\
\hline
\end{array}
$$

Cycles: 3
States: 10
Flags: none

RET cc
If cc TRUE: $\mathrm{PC}_{t}-(\mathrm{SP}), \mathrm{PC}_{H}-(\mathrm{SP}+1)$
If condition cc is true, control is returned to the original program flow by popping the previous contents of the PC off the top of the external memory stack where they were pushed by the CALL instruction. On the following machine cycle, the central processor will fetch the next program opcode from
the location in memory now pointed to by the PC. If condition cc if false, the PC is simply incremented as usual, and the program continues with the next sequential instruction.


If cc is true:
Cycles: 3
States: 11
If cc is false:
Cycles: 1
States: 5
Flags: none

## RETI

## Return from interrupt

This instruction is used at the end of an interrupt service routine to

1. Restore the contents of the PC.
2. Signal an I/O device that the interrupt routine has been completed.

The RETI instruction facilitates the nesting of interrupts allowing higher priority devices to suspend service of lower priority service routines. This instruction also resets the IFF1 and IFF2 flip-flops.


Cycles: 4
States: 14
Flags: none

Return from nonmaskable interrupt
Used at the end of a service routine for a nonmaskable interrupt, the instruction executes an unconditional return which functions identically to the RET instruction. Control is now returned to the original program flow; on the following machine cycle the central processor will fetch the next opcode from the location in memory now pointed to by the PC. Also, the state of IFF2 is copied back into IFF1 to the state it had prior to the acceptance of the NMI.


Cycles: 4
States: 14
Flags: none
page zero memory location given by operand $p$ is loaded into the PC. Program execution then begins with the opcode in the address now pointed to by PC. The restart instruction allows for a jump to one of 8 addresses as shown in the table below. The operand $p$ is assembled into the object code using the corresponding t state.


| p | $t$ |
| :---: | :---: |
| 00H | 000 |
| 08H | 001 |
| 10H | 010 |
| 18H | 011 |
| 20 H | 100 |
| 28H | 101 |
| 30 H | 110 |
| 38 H | 111 |

Cycles: 3
States: 11
Flags: none

## INPUT AND OUTPUT GROUP

IN A, (n)
$A-(n)$
The operand $n$ is placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. The contents of the Accumulator also appear on the top half of the address bus at this time. One byte from the selected port is then placed on the data bus and written into the Accumulator in the central processor.


Cycles: 3
States: 11
Flags: none

IN r, (C)
$r$ - (C)
The contents of register C are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. The contents of register B are placed on the top half of the address bus at this time. One byte from the selected port is then placed on the data bus and written into register $r$ in the central processor.


Cycles: 3
States: 12
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$

S: set if input data is negative; reset otherwise
$Z$ : set if input data is 0 ; reset otherwise
H : reset
N : reset
P/V: set if parity is even; reset otherwise
( HL ) - (C), B $-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}+1$
The contents of register $C$ are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. Register B may be used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is then placed on the data bus and written to the central processor. The contents of the HL register pair are then placed on the address bus, and the input byte is written into the corresponding location of memory. Finally, the byte counter is decremented, and register pair HL is decremented.

Cycles: 4
States: 16
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: unknown
$Z$ : set if $B-1=0$; reset otherwise
H : unknown
N : set
P/V: unknown

INIR
$(\mathrm{HL})-(\mathrm{C}), \mathrm{B}-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}+1$
The contents of register $C$ are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. Register B is used as a byte counter, and its contents are placed on the top half of the address bus. One byte is selected and is placed on the data bus and written into the central processor. The contents of the HL register pair are placed on the address, and the input byte is written into the corresponding memory location. The byte counter is then decremented and the HL register pair is incremented. If decrementing causes $B$ to go to 0 , the instruction is terminated. If B is not 0 , the PC is decremented by two and the instruction repeated. Interrupts will be recognized after each data transfer.

If $B \neq 0$ :


Cycles: 5
States: 21
If $B=0$ :
Cycles: 4
States: 16
Flags: $\quad$ S, Z, H,N, P/V

S: unknown
Z: set
H: unknown
N : set
P/V: unknown

IND
( HL ) $-(\mathrm{C}), \mathrm{B}-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}-1$
The contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is placed on the data bus and written to the central processor. The contents of the HL register pair are placed on the address bus, and the input byte is written into the corresponding memory location. Finally, the byte counter and register pair HL are decremented.


Cycles: 4


States: 16
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S: unknown
$Z$ : set if $B-1=0$; reset otherwise
H : unknown
N : set
P/V: unknown

INDR
$(\mathrm{HL})-(\mathrm{C}), \mathrm{B}-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}-1$
The contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B is used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is placed on the data bus and written to the central processor. The contents of the HL register pair are placed on the address bus and the input byte is written into the corresponding memory location. The HL register pair and the byte counter are then decremented. If decrementing causes $B$ to go to 0 , the instruction is terminated. If B is not 0 , the PC is decremented by 2 , and the instruction is repeated. Interrupts will be recognized after each data transfer.


If $B \neq 0$ :


Cycles: 5
States: 21
If $B=0$ :
Cycles: 4
States: 16
Flags: S,Z,H,N,P/V
S: unknown
Z: set
H: unknown
N : set
P/V: unknown

OUT (n), A
( n ) -A
The operand $n$ is placed on the bottom half of the address bus to select the I/O device. The contents of the Accumulator appear on the top half of the address bus. Then the byte contained in the Accumulator is placed on the data bus and written into the selected peripheral device.


Cycles: 3
States: 11
Flags: none

OUT (C), r
(C) $-r$

The contents of register C are placed on the bottom half of the address bus to select the I/O device. The contents of register B are placed on the top half of the address bus. The byte contained in register $r$ is placed on the data bus and written into the selected peripheral device.


Cycles: 3
States: 12
Flags: none

OUTI
(C) $-(\mathrm{HL}), \mathrm{B}-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}+1$

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. After the byte counter (B) is decremented, the contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is placed on the data bus and written into the selected peripheral device. Finally, the register pair HL is incremented.


Cycles: 4
States: 16
Flags: S, Z,H,N,P/V
S: unknown
$Z$ : set if $B-1=0$; reset otherwise
H : unknown
N : set
P/V: unknown

## (C) $-(\mathrm{HL}), \mathrm{B}-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}+1$

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. After the byte counter (B) is decremented, the contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus at this time. The byte to be output is placed on the data bus and written into the selected peripheral device. Then register pair HL is incremented. If the decremented $B$ register is not 0 , the $P C$ is decremented by two and the instruction is repeated. If $B$ is 0 , the instruction is terminated. Interrupts will be recognized after each data transfer.


If $B \neq 0$ :
Cycles: 5
States: 21
If $B=0$ :
Cycles: 4
States: 16
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S : unknown
Z: set
H: unknown
N : set
P/V: unknown

OUTD
(C) - (HL), B $-\mathrm{B}-1, \mathrm{HL}-\mathrm{HL}-1$

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. Then, after the byte counter (B) is decremented, the contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is placed on the data bus written into the selected peripheral device. Finally, the register pair HL is decremented.


Cycles: 4
States: 16
Flags: $\quad$ S, Z,H,N,P/V
S: unknown
$Z$ : set if $B-1=0$; reset otherwise
H : unknown
N : set
P/V: unknown
(C) - (HL), B - B-1, HL - HL-1

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in central processors. Then, after the byte counter (B) is decremented, the contents of register $C$ are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is then placed on the data bus and written into the selected peripheral device. Register pair HL is then decremented. If the decremented $B$ register is not 0 , the PC is decremented by 2 , and the instruction is repeated. If register B is 0 , then the instruction is terminated. Interrupts will be recognized after each data transfer.


If $B \neq 0$ :
Cycles: 5
States: 21
If $B=0$ :
Cycles: 4
States: 16
Flags: $\quad \mathrm{S}, \mathrm{Z}, \mathrm{H}, \mathrm{N}, \mathrm{P} / \mathrm{V}$
S : unknown
Z: set
H: unknown
N : set
P/V: unknown

# CHAPTER 4 BUILD YOUR OWN COMPUTER-Start With the Basics 

The computer to be built from the design described in this book is called ZAP, for Z80 Applications Processor. Building a computer from scratch is both educational and utilitarian (and it saves money). I explain each section of the construction process in detail. Ideally, each step should be tested before proceeding on to the next stage. While this is not possible in all cases, there is a beneficial side effect in taking this route. Often good designs fail to work because the level of construction is beyond the ability of the builder.
I've made the assumption that most hobbyists do not possess sophisticated test equipment, such as oscilloscopes or logic analyzers, and as a result, I've kept testing procedures as simple as possible. By dividing ZAP into logical milestones for checkout and test (and using proven components), problems can be identified at earlier stages and rectified more easily.
The initial implementation of ZAP will constitute a minimum operable configuration. It is important that this works before you attempt to add any of the optional peripherals. Every effort will be made to familiarize the reader with the components of each section and the philosophy of design. While it is necessary to assemble all the components of this minimum configuration completely in order to check proper central processor operation, comprehensive subassembly pretesting should (I hope) correct any wiring errors.

The basic ZAP is divided into four major subassemblies: Z80 busing and control, memory and I/O chip select decoding, memory, and input/output registers. These major divisions are further divided at the component level. Schematics include a complete explanation of their logical function, and test procedures are outlined after each construction presentation.

## The Processor

Figure 4.1 is a detailed block diagram of the basic ZAP computer.

## I. Z80 Busing and Control Logic

## A. Clock Generation

The ZAP computer runs on a 2.5 MHz TTL clock. Unlike the 8080A, the Z80 requires only a single-phase clock and can be driven from DC to 2.5 MHz (the Z80A runs to 4 MHz ). Figure 4.2 illustrates the basic timing cycle of the computer.

Each basic operation $\left(\mathrm{M}_{N}\right)$ of the computer is completed in three or six clock periods. Figure 4.2 shows a typical instruction cycle which consists of three machine cycles: fetch, memory read, and memory write. After the opcode of the instruction is fetched during M1, the subsequent cycles move the data between memory and the central processor.

Figures 4.3a and 4.3b illustrate two possible clock designs for the Z80. Both clock circuits have a 330 ohm pull-up to +5 V . This will satisfy both the AC and $D C$ clock signal requirements, but it is best to use a separate inverter gate
section to drive the pull-up whatever the oscillation technique.
The crystal controlled circuit of figure 4.3 a is preferred if consistent execution time is to be maintained. Thus, the circuit of figure 4.3 b , though otherwise acceptable, should be avoided if the computer is to be used as an event timer. It can serve a very useful purpose in the development stages, however, by allowing the user to slow the clock down (by increasing the values of $R$ and C) to a rate where it is possible to directly monitor the central processor operation. Should it ever be necessary to single-step the clock, the circuit in figure 4.4 should be used. Given the multiple clock cycles necessary to execute a single instruction, it would take a lot of button pushes to follow a program through execution.
A much easier diagnostic method would be to use an instruction singlestepping circuit. The circuit, shown in figure 4.5, is not part of the finished schematic of ZAP because it is necessary only if the builder has a problem and needs to follow the execution of a program instruction by instruction. This single-stepping function is accomplished by using the control signals generated by the $Z 80$ during program execution. The two particular signals of concern are M1 and WAIT. M1 is an output, and WAIT is an input. As shown in figure 4.6, M1 goes to a logic 0 level at the beginning of every instruction fetch cycle. M1 signifies that the computer has completed one instruction and is starting on the next. The objective is to stop the microprocessor before it executes this next instruction.
The WAIT input to the $Z 80$ does just that. A logic 0 level applied to this input will suspend the program execution of the computer and indefinitely hold it in the MI cycle. During $\mathrm{T}_{2}$, the central processor samples the $\overline{\mathrm{WAIT}}$ input line with the trailing edge of the clock. If, at this time, WAIT is at a logic 0 level, an additional wait state will be entered, and the line will be sampled again. The central processor will hang in this mode until WAIT is raised to a logic 1 . It should be noted that this is not a computer halt command.
The real purpose behind these signals is to allow the relatively slow memory and peripherals to be used with a very fast central processor. Extra wait states should be inserted only when necessary for the central processor to access these devices. The effect is to synchronize the timing between the central processor and its I/O devices. The circuit of figure 4.5 allows us to control the WAIT state and to execute only one instruction with each press of the button. The output at IC 1, pin 8 (the WAIT input) is normally low, causing an indefinite wait. When the button is pushed, a single debounced pulse clocks IC 2 , which is a D-type flip-flop. The duration of this pulse (the time you hold the button down) is irrelevant, because the flip-flop is edge triggered and is only concerned with the leading edge. Pressing the button sets IC 2 and raises the WAIT line. No longer told to wait, the central processor executes the instruction at full clock speed. As it is about to start the next instruction fetch cycle, M1 goes low as before, and triggers the one-shot. When it fires, IC 3 resets IC 2 and returns the central processor to a wait condition until the next time the button is pushed.
The single-step feature isn't of much use in a computer unless there is some way to monitor the contents of all the registers and to determine what the computer is trying to do at any one time. To accomplish this, ZAP must be completely operational and be running a breakpoint-monitor program which allows the user to single-step with a software routine. We'll discuss such programs later.
This fact is of small consolation to a person with a partially debugged computer or hardware error that keeps side-tracking large programs. While it would be nice to see all the register contents, it is virtually impossible to do so without having a central processor that can run a dump and display routine. This cannot be done using the hardware stepping circuit of figure 4.5. It is possible, however, to look at the contents of the address and data buses while the central processor is stopped. This should give a good indication as to
whether the computer is operating properly.
Many instruments can be used to read the TTL levels on the buses. A scope or high-impedance voltmeter can be used, but a visible display of the bus contents is a better idea. The circuits in figure 4.7 show simple methods to display the contents of the address and data buses. The circuits are included as aids and are not necessary for the operation of ZAP.

Basically, the circuit of figure 4.7 a is a simple LED driver that is duplicated 16 times for the address bus and 8 times for the data bus. Because the $\mathbf{Z 8 0}$ should drive only one TTL load from each output pin (bus driver inputs are already attached), any display drivers of this type must be attached on the output side of the bus drivers. This circuit will serve as a rudimentary front panel for any builders who feel a computer isn't complete without flashing lights.

Sometimes the need arises to monitor a single point in a circuit and watch for level changes. While the LED driver of figure 4.7a would detect a slowly changing level, it would miss short pulses such as $\overline{\mathrm{M1}}$. To monitor the occurrence of such events, especially if no oscilloscope is available for testing purposes, it is advisable to build the circuit in figure 4.7b. This simple logic probe is adequate for most applications, but care must be taken in its use. It cannot detect an open circuit and the pulse detector only triggers on the negative edge of any transition. Should that present any problems, add the optional circuit using the 7486; that will allow it to detect either edge.

The logic probe or similar logic level detector (scope, DVM, VOM, etc.) is necessary to statically test the subassemblies.


Figure 4.1 A block diagram of a minimum ZAP system.


Figure 4.2 An example of timing during a typical instruction cycle.

b)


Figure 4.3 Typical 2.5 MHz clock circuits for the $\mathbf{Z 8 0}$.
a) With crystal control.
b) With a variable-frequency oscillator.


Figure 4.4 A single-cycle clock-generator circuit.


Figure 4.5 An instruction single-stepping circuit.


Figure 4.6 Instruction operation-code fetch ( $\overline{M 1}$ ) timing.
a)



Light off 1 LIGHT ON
b)


Figure 4.7 Typical LED drivers and a simple logic probe to monitor logic level changes.
a) Visible logic level indicators that can be attached to the address and data buses to provide a display.
b) A simple logic probe.

## B. Reset Circuit

Often ignored, the reset function is one of the most necessary controls of a computer. Its importance is immediately recognized when running an incorrectly executing program. The reset command on the $Z 80$ stops execution and loads the program counter with 00 hexadecimal (the lowest memory address). This allows the programmer to restart the program. When combined with the instruction single-stepping circuit previously outlined, programs may be started, stopped, and started again at any time.

A reset input can be manual, automatic, or a combination of both. Figure 4.8 a is a standard push-to-reset circuit. Its output is normally high until the button is pushed, and then it goes low. The $Z 80$ will remain reset for as long as the button is held and will only begin to execute again when released. Manual reset is a necessity for initial program checkout, and this circuit is employed in the basic ZAP.

When computers are used in applications where no human attendant is present, such as a traffic light controller, the manual reset cannot be used; an automatic reset must be employed instead. Figure 4.8 b is the circuit of a totally automatic power-on reset. When power is first applied to the computer, the 10 mF capacitor will be completely discharged. The resultant logic 0 level on the input of the 7404 pin 1 will be maintained for approximately 50 ms , long after the +5 V supply has powered up the rest of the computer. The long charging rate of the capacitor will, in turn, generate a logic 0 (a reset condition) to the computer until the input level rises to approximately 2 V (a TTL logic 1). Once full power is applied, the time it takes the reset circuit to reach 2 V will constitute about a 35 ms power-on Reset pulse. Resetting the machine would require turning the power off.

Manual and automatic reset are combined in figure 4.9. This circuit allows the computer to start program execution immediately after power is turned on. The program can be stopped and restarted by pressing the reset button. Slightly different components and additional functions are included in this diagram. Schmitt-triggered inverters (7414s) increase the reliability of the design. When the power is turned off, the use of a diode to discharge the capacitor quickly assures that a pulse will be generated if power is suddenly reapplied. Because power line glitches are usually short in duration, the discharge rate of the capacitor has to be fast enough not to miss generating a reset pulse once power is restored.
While this reset circuit is not necessary for initial computer check-out, it should eventually be employed if ZAP is to be expanded to include any of the options outlined later. To synchronize the central processor and peripherals, they should be tied into the reset signal from this circuit.

a)

Figure 4.8 Reset circuits.
a) A manual reset circuit.
b) An automatic power-in reset circuit.


280


Figure 4.9 A circuit to combine manual and automatic reset functions.

## C. Address Bus and Control Output Buffering

The $\mathbf{Z} 80$ has the ability to directly address 65,536 (often called 64 K ) individual bytes of program memory and 256 individual input and output ports. Because the microprocessor is a binary device, it is only natural that this address be binary. There are 16 binary address lines labeled A0 thru A15. A0 is the LSB (least significant bit), and A15 is the MSB (most significant bit).
The logic levels on this bus are not arbitrary. The control section of the central processor sets the program counter to the next instruction to be executed, and on the fetch cycle, it places the program counter contents on the address bus. During I/O instructions, additional timing cycles place the I/O device address on the 8 least significant bits (A0 thru A7). Because this bus has to drive the inputs of many parallel devices, all of which draw some input power, the address bus must have an output current that will meet the load demand. The $\mathbf{Z 8 0}$ by itself can sink 1.8 mA maximum or one TTL load on each pin. This is no problem if the designer uses low power memories and peripheral interface chips. These are expensive devices, and their use would not necessarily serve to educate the builder in the same way as configurations of less complex circuits.
Using lower density ICs and TTL devices for decoding functions is less expensive but requires considerably more power from the bus. The following table lists the input loading of various devices:

## Device

Standard TTL (7404, 7442 , etc)
Low-power Schottky TTL ( $74 \mathrm{LSO4}$, etc)
2708 ( $1 \mathrm{~K} \times 8$ EPROM)
2114 ( $1 \mathrm{~K} \times 4$ programmable memory)
2716 ( $2 \mathrm{~K} \times 8$ EPROM)
$2102(1 \mathrm{~K} \times 1$ programmable memory)
$8212(8$-bit latch)
8 T 97 ( 6 -bit driver)

Worst case input current

$$
1.6 \mathrm{~mA}
$$

0.18 mA
$10 \mu \mathrm{~A}$
$10 \mu \mathrm{~A}$
$10 \mu \mathrm{~A}$
$10 \mu \mathrm{~A}$
0.25 mA
1.0 mA

It is easy to see that the real power eaters are TTL devices. Low-power Schottky TTL (LSTTL) devices can be substituted throughout the ZAP computer. They save power at slightly additional cost, but the circuit has sufficient power to support straight TTL. If LSTTL is substituted, it must be substituted throughout.
The loading caused by memory, especially with only 2 K bytes in the basic ZAP unit, is insignificant. With 1.8 mA drive current available from the Z 80 , we could use LSTTL for the I/O and memory address decoding but would have to limit the fanout (total input connections) on each address line to 9 LSTTL inputs. This is sufficient for the basic ZAP and would probably be an
acceptable procedure, but it is not recommended.
The first time a user attaches the logic probe (figure 4.7b) to an unbuffered address line, the computer may die. The load presented by the probe, as well as by the other circuitry, will exceed the drive capability of the bus. It's important that the monitoring devices not impede circuit operation.

Rather than try to optimize the design to a degree that forces the user to be aware of every $\mu \mathrm{A}$ (microampere) consumed by test probes and LED drivers, it's easier to add buffering that increases the bus output power to a point where loading is not an important factor. This is the philosophy behind ZAP busing, and as a side benefit, it will provide enough power to expand ZAP to 64 K should the user ever desire to do so. It also allows the user to add his own TTL circuitry without becoming overly concerned with bus loading.

To achieve high power output from the address bus, a buffering device (called a non-inverting bus driver) is used. The A0 thru A15 outputs of the Z80 make only one connection: to the drivers' input. All other devices that use the address are attached to the output of the drivers.

Figure 4.10 is the diagram and truth table of the 8 T 97 bus driver. (An equivalent bus driver is the 74367.) This three-state device is capable of sinking 48 mA and can accommodate any combination of TTL, LSTTL, and memory connections a user would want to make. The final address bus configuration is shown in figure 4.11.

The three-state function of the $8 T 97$ is controlled by the $\overline{B U S} \overline{A K}$ signal. This signal turns over control of the address bus to an external device during direct memory access operations. In a non-DMA situation, BUSAK is high and the 8 T 97 passes all outputs from the Z 80 . When a DMA request is acknowledged, BUSAK goes low, putting the 8 T97 in a high impedance output mode. This facility allows memory to be written into or read by an external device and is usually reserved for high-speed operations that are faster than the central processor can achieve.


Figure 4.10 The pinout and truth table of an $8797 / 74367$ bus driver.


Figure 4.11 The final buffered address bus configuration.

## D. Data and Control Bus

The fourth and last area of direct central processor connections is the data bus and the remaining lines of the control bus. The reason for buffering the data bus is similar to the argument for the address bus with one exceptionthe data bus is bi-directional.

A bi-directional bus means, of course, that data flows in both directions. When the Z80 is writing a byte of data into a memory location, the data flows from the central processor to memory. When the central processor is reading a memory byte, data flows from memory to the central processor. The bi-directional nature of the data bus requires that the bus drivers be either bi-directional internally, or attached in such a way that the same function is performed.
One way of making this bi-directional driver is to use two 8212 s. The 8212 (figure 4.12) was originally conceived and produced by Intel as an 8-bit latched input or output port. The 8212 can be latched continuously so that data flows through it, or it can be turned off to block the flow. It is well suited to this application because it has a three-state output.
Two 8212s (figure 4.13) are wired in opposite directions. IC 6 directs data from the central processor toward memory, while IC 7 channels data into the Z80. Control is exercised through a single line connected to the $\overline{\mathrm{RD}}$ control signal of the central processor. $\overline{\mathrm{RD}}$ is normally low except during write operations. This causes IC 6 to be off, in a three-state mode, and IC 7 on, which allows data from memory or I/O devices to reach the central processor. When $\overline{\mathrm{RD}}$ goes high during a write operation, the process is reversed; IC 6 turns on and IC 7 turns off. It is only necessary to use the $\overline{R D}$ line to control data direction. We're assuming, of course, that when the central processor isn't writing data, it must be reading it. While not exactly true, the concept
works well enough in practice, and the two $8212 s$ are connected schematically as in figure 4.14.

It is not absolutely necessary to use 8212 s to perform this function. Either 8T97s or 74367s work equally well but take 4 IC packages. If you don't mind the extra wiring and have a source for 8 T 97 s , they can be wired as illustrated in figure 4.15.
The final connections to the central processor to be discussed are the control bus signals, shown in figure 4.16. They coordinate peripherals and channel data and addresses into and out of the central processor at the proper times. Each was briefly explained on the Z80 pinout. Exact timing will be detailed when we discuss attachments of memory, I/O, and enhancements to ZAP. For the time being, unused control inputs are tied high (through resistors) to inhibit false triggering.
The output lines are buffered for the same reasons as was the address bus. Furthermore, because this is a development computer, with expansion in mind, both the inverted and noninverted control signals are brought out to the user.

8212
LOGIC DIAGRAM 4.17) called the $Z 80$ bus and control diagram.


Figure 4.12 The pinout and logic diagram of the 82128 -bit input/output port.


Figure 4.14 A schematic diagram of two 8212 8-bit latches configured as bi-directional data bus drivers.


Figure 4.15 A schematic diagram of a data bus driver configured with 8797s.


Figure 4.16 Control input connections and output buffering of the basic ZAP design.


## E. Testing

Insert all ICs except the $\mathbf{Z 8 0}$ and turn on the power. Each section is then individually tested as follows:
Clock - Testing the 2.5 MHz clock of figure 4.3a will require an oscilloscope or frequency counter to register the exact clock rate. Using the logic probe from figure 4.7 b to monitor this clock rate would light all three LEDs. This indicates that the clock functions, but it will not indicate the rate. A similar test can be performed on figure 4.3b.
Single Cycle - The logic probe (without the addition of the 7486 edge detector) is perfect for checking the single-cycle circuit of figure 4.4. With the probe on section C pin 8, the indication should be low. Pressing and holding the button down should change the indication to a high level and cause the "pulse" LED to flash once. Releasing the button should not flash the pulse indicator as it returns to its initial logic condition.
Single Step - With the switch in the single-step mode position (figure 4.5), take a clip lead and momentarily ground IC 3, pin 3. The output at IC 1, pin 8 should be low. Pressing the single-step button will cause this output to go high. It will stay high until IC 3 , pin 3 is momentarily grounded again. Check out the pushbutton debouncing circuit (which consists of IC 1 sections a and b) in the same manner as you did the single-cycle test. Finally, with the switch on the run mode, IC 1, pin 8 should aiways be high.

Power-on Reset - The circuits of figures 4.8 a and 4.8 b should have a normally high output. When power is first applied to figure 4.8 b , or the button pressed in figure 4.8a, the output should go low. Either situation will cause a logic low level to occur from the circuit of figure 4.9.
Address Bus Drivers - The Z80 should not be inserted! With IC 9, pin 5 grounded, all outputs of ICs 3, 4, and 5 on schematic figure 4.11 should appear high. In actuality, this will be the three-state output mode and the proper test equipment will register them as open circuits. Tying IC 9 , pin 5 to +5 V through a 2.2 K resistor will turn on all the bus drivers. Their outputs will all be iogic high levels. Successively grounding the A0 thru A15 lines at the Z 80 connector should result in a lowlevel indication on the respective buffered output line. When all 16 lines can do this successfully, the address bus checks out.

Bi-directional Data Bus - The data bus is tested in a similar manner except that the procedure is done twice-for data flow in either direction. Grounding K' 8 , pin 1 (figure 4.14) simulates a read condition. Data should flow from right to left. Applying ground and +5 V (through a 2.2 K resistor) alternately to the data input pins of IC 6 should produce similar levels on DOI thru DO8 of IC 6. Raising IC 8 , pin 1 to +5 V allows similar data transfer, but only from left to right this time.

Control Bus - Referring to the schematic of figure 4.16, testing is simply a case of applying a known logic level to the input side of the series inverters and noting the output levels one gate at a time. For example, if Z 80 pin 19 was a logic low, IC 9, pin 2 would be a logic high and conversely, IC 9, pin 4 would be low. Each inverter section which the signal passes through inverts the signal.

## II. Memory and I/O Decoding

Before we can utilize the memory or I/O devices we must learn how the $Z 80$ addressing works. Remember, the address FF hexadecimal could refer to memory, or an input or an output port. The computer must have the ability to differentiate among the three
possible meanings.
The control outputs of the Z80 contain the necessary routing information, and by properly gating them together, the correct signals are obtained. For basic I/O and memory operations, the four signals of particular interest are $\overline{M R E Q}, \overline{\text { IORQ }}, \overline{\mathrm{RD}}$, and $\overline{W R}$. Their definitions are as follows:
A. $\overline{M R E Q}$

Memory Request. Whenever a transaction occurs between the central processor and memory, the MREQ line goes to a logic 0 .
B. $\overline{\text { IORQ }}$

Input/Output Request. Whenever a transaction occurs between the central processor and either an input port or an output port, the IORQ line goes to a logic 0 .
C. $\overline{R D}$

Read Request. Whenever the central processor reads input data from either memory or an input port, the RD line goes to a logic 0 .
D. $\overline{\mathrm{WR}}$

Write Request. Whenever the central processor is writing data to either memory or to an output port, the $\overline{W R}$ line goes to a logic 0.

To differentiate between input and output ports during I/O instructions, $\overline{\mathrm{IORQ}}$, $\overline{\mathrm{RD}}$, and $\overline{\mathrm{WR}}$ are gated together as shown in figure 4.18. In a similar manner, $\overline{M R E Q}$, $\overline{\mathrm{RD}}$ and $\overline{\mathrm{WR}}$ are gated during memory transfers as shown in figure 4.19. Unlike the I/O decoding, but similar to the address bus driver discussed earlier, a memory-read condition does not have to be decoded. It is assumed that when the memory is not in a write mode, it is in the read state.

The resulting three decoded strobes define the operations of Input Port Read (IORD), Output Port Write (IOWR), and Memory Write (MEMWR). If only three functions were required in your particular computer configuration, then no other decoding would be necessary. Such a computer would have one input port, one output port, and one bank of memory. To alleviate this probiem, additional decoding of I/O and memory is necessary so that these control strobes can serve more than a single device. With the extra circuitry, the $Z 80$ can independently address 256 input and output ports and 64 K bytes of memory.

During an I/O request (either input or output), the 8 -bit binary address of the particular I/O port appears on lines AO thru A7 of the address bus. An explanation of address coding is shown in figure 4.20. Additional examples are illustrated in figure 4.21.

Using this information, if an instruction were to designate output port 7 as its destination, then the circuitry of figure 4.22 could be used. When a code of 007 octal ( 07 hexadecimal or 00000111 binary) appears on the address lines with an $\overline{\mathrm{OWWR}}$ strobe, the signals present on the data bus would be stored in an 8 -bit register as output data.


Figure 4. 18 input/output read and write decoding.


MREQ GOES TO A LOGIC O DURING MEMORY OPERATIONS

Figure 4.19 Memory read and write decoding.

GINARY WEIGHTING

TYPICAL PORT CODE hAROWARE DECODER
a)

b)


Figure 4.21 Address decoding logic.
a) For address $F F_{16}$.
b) For address $00_{16}$.


NOTE: OATA FLOW IS FROM THE CPU TO THE OUTPUT PORT
OURING IOWR OPERATIONS.

Figure 4.22 A possible method for decoding a single 8-bit output port address. The circuit is for a 007s device code.

## I/O Decoding

Of course, ZAP needs more than 1 port, even as a basic system. In fact, if it is expanded to include some of the optional peripherals, it will require 6 or 8 ports. Decoding these additional ports need not require 8 separate circuits like figures 4.20 or 4.21. By incorporating a 4 to 10 line demultiplexer into the design, 8 port strobes can be derived. The circuit of figure 4.23 can be used for either input or output port decoding (by selecting $\overline{\mathrm{RD}}$ or $\overline{\mathrm{WR}}$ ) and is addressed for 000 octal to 007 octal. It works by selecting either of the two unconnected outputs (IC 3, pin 9 or 10) when an undecodable address is presented on the address bus. A3 thru A7 still must be treated in the same manner as that presented in figure 4.20 , but A0 thru A 2 serve as the 7442 address inputs. These 3 bits will designate 1 of 8 possible lines when IC 1 's output goes low.
Duplicating this circuit to provide 8 separate input and output stobes (addressed 000 thru 007 ) would require a total of 7 chips. The number of chips can be reduced to 3 if we take a little poetic license with the design. So far, we have decoded all 8 bits of the I/O portion of the address bus, making our decoder select 1 of 256 or, as in the previous circuit, 8 of 256 . In either case, only the designated addresses are of any importance; all others are meaningless. For all practical purposes we could decode lines A0 thru A2 and ignore the rest. A circuit that does just that is shown in figure 4.24.
The difference between this circuit and those previously described, besides having fewer chips, is that this one requires an intelligent user to recognize the advantages and disadvantages of taking such liberties. As in figure 4.23, this circuit decodes ports 000 octal thru 007 octal. What the user should realize, however, is that it also decodes 010 thru 017 and 020 thru 027, etc. The 3 LSB (least significant bits) repeat every 8 ad-
dresses. This is not a problem as long as the user is aware of repetitive addressing and watches his programming. Should more than 8 stobes be required, the 7442 can be replaced with a 74154 ( 4 to 16 decoders). This will give 16 I/O port strobes that repeat every 16 addresses.


Figure 4.23 A formal input/output port address decoding method that decodes all 8 address lines.


Figure 4.24 A method for decoding input/output strobes with a reduced amount of circuitry.

## Memory Decoding

Decoding the memory address bus is accomplished in a similar manner. It is inadvisable to take the same tack and allow repetitive memory addressing because there is more likelihood of error. Even though 16 lines are involved, in actual application, memory decoding turns out to be less complicated. ZAP uses $1 \mathrm{~K} \times 8$-bit banks of programmable memory and 1 K -byte erasable read-only memory. Both of these devices require 10 address lines to define the 1 of 1024 locations in each bank. This leaves only 6 lines that have to be individually decoded to define any 1 K block of memory. Figure 4.25 illustrates how this can be accomplished. A 7442 ( 4 - to 10 -line decoder) is used to generate 8 separate chip-select lines. Because the address lines of the 7442 are tied to A10 thru A12, each strobe pulse will have a boundary of 1 K . It is not by chance that $1 \mathrm{~K} \times 8$ was chosen as the memory capacity of each bank.


Figure 4.25 Memory bank decoding for $8 K$ of memory.

While the basic configuration of ZAP provides decoding for 8 K of memory and 8 input and output ports, not all of these chip selects and port strobes are used. The extra lines are left for expansion. Figure 4.26 is a completed schematic of the $1 / \mathrm{O}$ and memory decoder for the builder to add to the circuit in figure 4.17.

## Testing

After you have added the components of figure 4.26 to figure 4.17 , you are ready to test the memory and I/O decoding. Insert ICs 10, 11, 12, 13, and 14, but don't insert IC 20 yet. ICs 1, 3, and 9 should remain inserted from the previous test. The Z80 should still be left out. The logic level at the $D$ address input of each of the $7442 s$ (ICs 12,13 , and 14) should be high. Pulling out ICs 8 and 9 (with power off) will cause this input to immediately change to a logic low level.

Next, ground pins 30,31 , and 32 and tie 23 high on the $Z 80$ socket. With the address bus buffers enabled, and a 000 address jumpered on A0 thru A2, a chip-select low should appear on the lowest strobe address. In this case, pin 1 of ICs 13 and 14 should be low and the other strobe lines high. Changing the 3 jumpers on A0 thru A2 will enable other device chip-select strobes. The memory bank decoder works the same way except that the jumpering should be applied to address lines A10 thru A12.
After testing, insert all chips except the $\mathbf{Z 8 0}$.


Figure 4.26 The memory and input/output decoding section of ZAP.
a) Memory bank chip-select strobes.
b) Input/output device chip-select strobes.

## III. Memory

Of course, a major consideration for any computer system is memory. Both program instructions and data must be stored and recalled at the appropriate time so the computer can perform its function. Even though the Z80 central processor has a quantity of 8 -bit storage registers, these can be only used for temporary manipulation of data and cannot store program instructions. Program instructions must be stored in external memory elements.
The external memory may be divided into two broad classes: ROM (read-only memory) and RWM (read/write memory). ROM is used to store specific, unchanging program steps or data. The contents of these memory locations are considered permanent and cannot be easily changed. Read/write memory, on the other hand, is used to store data that changes while the computer is operating. Examples would be the resuits of calculations or programs that change frequently. For either type of memory, the ultimate function is still the same: to provide, on demand, either an instruction for execution or a location where data may be stored.

## Read-Only Memory

ROM (read-only memory) is an important part of the computer system. ROM functions as a memory array whose contents, once set by special programming techniques, cannot be altered by the central processor. There are few exceptions to this rule.

By its nature, ROM is non-volatile. When power is turned off, the program contents are not lost. Reapplication of power allows immediate program execution.

Within this basic category of ROMs there are three subcategories - ROM, PROM, and EPROM - which are defined more by usage and application than their names might imply.

ROM - Read-Only Memory
This is storage which can be written into only once. The information is fixed and cannot be changed. A ROM is usually mask programmed by the manufacturer and is bought with a preset bit pattern. These types of ROMs are considered to be custom programmed.

## PROM - (User) Programmable Read-Only Memory

This storage can also be written into only once and the information is fixed. These devices are typically bipolar fusable link PROMs, which are programmed by the user rather than the manufacturer. ROMs and PROMs do not generally use the same semiconductor construction technology. Storage is much denser on a ROM than on a PROM, and cost-per-bit is generally lower on a ROM.

EPROM - Erasable-Programmable Read-Only Memory
This device combines the best parts of a ROM and a PROM. When received from a manufacturer, all storage locations are unprogrammed. Using a special interface, the EPROM can be programmed by the user as a PROM would be, with the result utilized as a ROM. If the EPROM content must be changed, it can be erased and reprogrammed. Depending upon the particular device, an EPROM can be either electronically alterable (often differentiated by the separate abbreviation EAROM) or ultraviolet erasable. The latter is sometimes called a UVEPROM, but is more often just called an EPROM. They are easily recognizable because they have a quartz window over the integrated circuit. This window is transparent to ultraviolet light and facilitates erasure.

While there can be considerable discussion as to the merits of each option, all ROMs perform the same ultimate function. For each independently addressable location, there is specific stored-bit pattern. Only the processor can determine whether this is data or an instruction. The method of storage is the same in either case. Figure 4.27 details the block diagram of a ROM.

A ROM is simply a logical block which, urider program control, provides a preset
pattern. Figure 4.28 is a 3-bit read-only memory. When switch SW1 is closed (the position it would take when the central processor wanted the stored information), the 3-bit code of " 101 " would appear at the outputs. The diode grounds the input signals to the 7404 inverters when SW1 is closed. Expanding to more than 3 bits is simply a matter of adding more diodes, resistors and buffer stages. Such a circuit is referred to as a diodematrix ROM and in this case would be a 1 -line by $n$-bit ROM.

A 3-bit memory is not much use. This concept can easily be expanded to 16 bytes by adding an address decoder as diagrammed in figure 4.29. A completed schematic with the diodes specifically arranged to perform a simple 9-byte program is illustrated in figure 4.30. This short test program will be used later during the checkout phase.

The diode-matrix ROM is presented for its educational value only. This is not a method that should be employed in the ZAP computer. Realizing that there are integrated circuits that would successfully fulfill the requirements in each of three categories, we must analyze our needs a little more closely.

The pertinent questions are: memory size, and the cost and ease of programming. The size of a ROM is determined by the user. When power is first applied, how much effort does the user want to expend to make the computer execute a specific program? ZAP has no front panel and no banks of address and data switches to toggle in instructions. This being the case, ZAP must have a program that executes immediately (when power is applied or the reset button is pushed), and that allows the central processor to communicate with its peripherals and set itself in a mode that is directly programmable through these devices. Once power is applied, a simple 50- to 100-byte program can be written, which facilitates keyboard to memory loading. But perhaps we need to enter a large program in memory? Are we to enter it all through the keyboard?

High-speed data entry can be accommodated through a serial interface. This can be added at the expense of another 100 or 200 bytes. Another consideration is the necessity for some operator address and data display to ease program development.

In conclusion, to incorporate all the functions necessary for a single-board development system, the ROM can easily require 500 to 1,000 bytes of storage. Many computer systems use a 64 - to 256 -byte ROM to store a bootstrap program. A bootstrap is a program that coordinates the minimum amount of necessary peripherals to load a larger program into the computer. In most personal computer systems, this bootstrap controls a cassette interface, and the program that is subsequently loaded is calied a monitor.

A monitor (explained in Chapter 6) is a very important piece of software that requires about 1 K of program storage. Our decision is whether to make the monitor totally resident in ROM (ready for immediate execution), or to reduce ROM to the barest minimum and load the monitor from either a keyboard or a cassette storage system.

This is an important consideration for someone building a computer from scratch. When given a choice, I feel, you should almost always opt for the solution that calls for the fewest components and you should include the ROM monitor in the hardware. It's like putting the cart before the horse to require that a cassette interface be used to load all the diagnostic software. It's quite possible that the monitor program, resident in a $1 \mathrm{~K} R O M$, would be required to troubleshoot and align the serial interface and cassette modem sections. A further consideration is that the ZAP computer can be brought on line sooner. With a ROM monitor, useful programs can be entered via the keyboard without having to build a serial interface.

I suggest that the preferred ROM memory size for ZAP be 1 K . As previously mentioned, ROM is mask-programmed by the manufacturer. However, let's not forget that for a home-built computer, you are the manufacturer. Fusable link PROMs are an expensive proposition when configured in a 1 K block. As a 64 -byte bootstrap loader they are ideal.

The suggested alternative for the ZAP read-only memory is to use an EPROM that is programmed by the user. A 1 K EPROM such as the 2708 (or the 2 K 2716 ) is costeffective for the home-built computer. The Intel 2708 ultraviolet erasable read-only memory is recommended for this application. (The 2716 is a 2 K EPROM with a single +5 V power supply.)


Figure 4.27 A block diagram of a read-only memory.


Figure 4.28 A simple 3-bit read-only memory ( $1 \times 3$ bits).


Figure 4.29 A block diagram of a 16 -byte read-only memory.


Figure 4.30 A diode-matrix read.onity memory with a test program.

## EPROMs

The EPROM is a read-mostly memory. It is used as a ROM for extended periods of time, erased occasionally and reprogrammed as necessary. Erasure is accomplished by exposing the chip substrate, covered by a transparent quartz window, to ultraviolet light. The EPROM memory element used by Intel in the 2708 is a stored-charge type called a FAMOS transistor (Floating-gate Avalanche injection Metal Oxide Semiconductor storage device). It is similar to a p-channel silicon gate field-effect transistor with the lower or "floating" gate totally surrounded by an insulator of silicon dioxide. The 1 or 0 storage value of the FAMOS cell is a function of the charge on the floating gate. A charged cell will have the opposite storage output of an uncharged cell. By applying a 25 V charging voltage to selectively addressed cells, particular bit patterns that constitute the program can be written into the EPROM. Surrounded by insulating material, the charge can last for years. When this silicon dioxide insulator is exposed to intense ultraviolet light it becomes somewhat conductive and bleeds off the charge on the floating gate. The result is erasure of all programmed information.

Appendices C1 and C2 detail the pin layout and electrical specifications of the 2708 and the 2716 respectively. Chapter 7 explores various methods to program and test the chip.

## Read/Write Memory

Read/write memory is just what its name implies. Such memory allows data to be written into it as well as be read from it. Read/write memory for microcomputers is generally configured from semiconductor programmable memory devices that retain data only while the power is on.

ROMs are technically random access devices; however, read/write memory, which is composed of semi-conductor devices and is primarily intended for use in microcomputers, has come to be called RAM (random access memory). From this point on, we shall refer to RAM as programmable memory.

There are two classes of programmable memories: static and dynamic. Static programmable memory stores each bit of information in a bi-stable storage cell such as a flip-flop. This information is retained as long as the power is supplied to the circuit. Dynamic programmable memories have a simpler internal structure, smaller size, dissipate less power, and are inherently faster. They store information as an electric charge on the gate to substrate of a MOS transistor. This charge lasts only a few milliseconds and must be refreshed. This necessity to refresh the stored information is one of the major distinctions between static and dynamic programmable memories.

Refreshing dynamic memories can be bothersome, however. The process requires that all storage cells be addressed at least once every few (usually 2) milliseconds. A counter circuit is usually incorporated to exercise the memory address lines when the computer is not accessing memory. In most systems, memory refresh requires additional external circuitry. The Z80 contains this circuitry within the central processor chip and greatly facilitates the use of dynamic memory. However, this facility is lost when the $Z 80$ is reset. Therefore, extra refresh circuitry is necessary.

The choice between dynamic and static programmable memory technology is predicated on cost and convenience. Even with the expense of external refresh circuitry, dynamic memory is less costly. In a prototype system such as ZAP, however, dynamic memory is more trouble than it is worth. Once built and operational, dynamic memory might well be the best answer to memory expansion. But at this point in the building process, the inclusion of dynamic memory would over-complicate the design. This book, which emphasizes getting a beginner on-line, deals exclusively with semiconductor static programmable memory applications.

## Static Programmable Memory

Figure 4.31 is a block diagram of a static programmable memory element typical of the type used in the ZAP computer. There are five basic components of a programmable memory: 1) address input lines, 2) data input, 3) data output, 4) chip select, and 5) a read/write- or write-enable strobe line. The address input lines are connected to the address bus of the computer. In the case of a N by M bit programmable memory, where N is the number of words and M is the length of each word, there must be enough address lines to address all N bytes. For example, in a 1 K programmable memory it would take 10 bits to address all 1024 bytes within this memory (eg: $2^{10}=1024$ ). Static programmable memory chips that contain fewer bytes of data, such as a 64 -byte programmable memory, would obviously require fewer address lines. For a 64 -byte memory, only 6 bits of address are necessary.

Because the function of a static programmable memory device is to allow storage and retrieval of data, provisions must be made for data input and data output from the device. The data input and data output lines (shown in figure 4.31) are designated as separate functions.

During the read function, the stored data within the addressed memory cell is available on the data output lines. During the write function, data that is placed upon the data input lines would be stored at the address designated by the code on the address input lines. It is not necessary that static programmable memory devices have independent data input and data output lines.

In most cases, these devices are configured with three-state outputs. Data input and data output can be attached together to a bi-directional data bus, or they can be the
same lines and time multiplexed. Figure 4.31 illustrates a three-state method of data busing. During a read function, the data input lines are disabled internally within the memory device. The contents of the memory cell addressed by the address input lines are available on data out and are fed directly to the bi-directional data bus. During a write function, the opposite is true. The data output lines are set in the three-state mode (which you may recall is effectively an open circuit), and draw no current from the bidirectional data bus. The contents of the bi-directional data bus are stored at the designated memory cell.

All of these multiplexing functions are dependent upon the read/write and chipselect lines. No operation can occur without the memory device being selected through the chip-select line. To select a particular bank, as outlined earlier, it is necessary to have decoding logic that enables these banks through the chip-select lines. Once a chip or bank of chips has been selected, the computer determines whether data should be read from or written into these memory locations. Under normal operation all static programmable memory is left in the read state, and only enabled during a write command by setting a level 0 on the write enable. This is called a write-enable strobe.

Figure 4.32 is a detailed timing diagram of the memory read and write cycles. The write/enable is a combination of memory request and write. A read/enable is a combination of memory request and read. Proper decoding of these signals and the chip select were discussed previously. In its basic form, ZAP has 8 chip-select lines, each addressing a 1 K bank of memory.

Figure 4.33 illustrates the memory map of the basic ZAP computer. As initially configured, ZAP contains 3 K bytes of memory. Location 0 thru 3 FF is a 1 K EPROM. Locations 400 thru BFF are static programmable memory locations. The 1 K EPROM is configured to reside in locations 0 thru 3FF so that ZAP can be easily started with a power-on reset. Programmable memory located at locations 400 and above is considered to be user programmable memory. At least 2 K is recommended for satisfactory operation. ZAP will work with 1 K , but 2 K is recommended for basic peripheral expansion.

Figure 4.33 also shows how memory is attached to the computer. All three banks of memory are attached in parallel between the address and data buses. Each bank has a separate decoded chip-select. When the EPROM is enabled and MCSO is at a logic level 0, EPROM data is impressed upon the data bus lines. The other two banks of memory are in the three-state mode and have no effect on the bus. When the computer accesses programmable memory, the chip for that particular bank of memory is set to a logic 0 , and only that bank of memory has access to the data bus.
While all banks of memory would have the same address applied to them, only the selected bank would be in the active mode. The logic flow is similar for the computer to write into a bank of memory. You will notice that there are write-enable lines leading to each of the 1 K static programmable memory banks, but not to the 1 K EPROM. A 1 K EPROM can only be written into with a special interface. Therefore, the write-enable strobe is only attached to the programmable memories.

If, for example, the computer were to write into location 400, the chip-select for bank 1 and the write enable for bank 1 would both have to be at a logic 0 to allow data on the data bus to be stored into location 400 . This type of programmable memory configuration is both multiplexed and three-state. In the read mode, data flows from the programmable memory chip; in the write mode it flows into it, and when not selected it's three-state.

Up to this point, we have discussed block diagrams of static programmable memory. To produce an operational computer, it's necessary to configure this memory with actual parts. Unfortunately, single chip 1 K by 8 -bit programmable memories were extremely expensive when ZAP was designed. Therefore, these 1 K blocks are designed from multiple components. Two relatively inexpensive and popular static programmable memory chips are the Intel 2102A (Appendix C3) and the Intel 2114 programmable memory (Appendix C4).
The 2102 A is a $1 \mathrm{~K} \times 1$ static programmable memory. Configuring a $1 \mathrm{~K} \times 8$ block of memory requires eight 2102s attached in parallel. By comparison, configuring a IK $\times 8$ block with 2114 s would require only two chips. This is because the 2114 has a higher internal density than the 2102 . Because the objective of any hand-wired comput-
er project is to get the device on line easily, 2114s are the recommended programmable memory devices for ZAP. While 2102s will work, the added wiring necessary to use these devices far outweighs the additional cost of the 2114s.
Figure 4.34 illustrates how two 2114 s are attached together to produce a $1 \mathrm{~K} \times 8$ programmable memory bank. They share a common chip-select line. The data input lines are divided so that 4 bits of data are stored on each chip. Because each has a 1024 -byte address capability, the 10 -bit address lines are commonly shared. To build the basic ZAP, two circuits of the type illustrated in figure 4.34 should be constructed. The total memory for the basic computer is 3 K . It can be expanded to 8 K without additional address decoding. It is not absolutely necessary to have 2 K of programmable memory if the user wishes only to check the operation of the system. At a minimum, the EPROM must be wired as 1 bank of memory.
The 1 K EPROM contains the monitor which allows ZAP to function. This monitor contains many smaller programs that are called subroutines. When the main program calls a subroutine, it places the return address on a software stack located in programmable memory. At the conclusion of the subroutine, the central processor pulls this address from the stack and returns to the main program. Usually the stack requires no more than 64 bytes. However, it is no less trouble to wire two 2114 s for a full $1 \mathrm{~K} \times 8$ bank of memory than to try to wire a 64 -byte memory.
An additional bank of 1 K , designated as bank 2, could be added at the user's discretion. This bank is necessary if you plan to write programs that will occupy more than 1 K of memory including the stack. As the computer is presently configured, 1 K may appear adequate; however, for the additional programs outlined in this book, 2 K is recommended. This is especially true when a buffer area is required to communicate with external peripherals. The schematic for the final memory configuration is shown in figure 4.35. It should be added to the circuitry of figures 4.17 and 4.26 .
Unlike the other sections of the computer, the memory cannot be checked except under program control. Theoretically, the address lines can be preset and data read or stored, but it's not worth the effort. Memory checks will occur after the input/output section is wired. Basically, it will be checked first with EPROM alone, then with the addition of the programmable memory. I mentioned previously that EPROM and programmable memory are related yet operate independently. While a program is often stored in PROM, it usually requires programmable memory for proper execution.
In a short program that loads the accumulator, writes to an output port, and jumps back to itself again, with no subroutine calls, programmable memory is not necessary. It can be completely located on EPROM. The exact procedure for this test will be outlined at the end of the I/O section.


Figure 4.31 A block diagram of a static programmable memory element of $N \times M$ bits.


Figure 4.32 A timing diagram of the memory read or write cycles for the 280. This diagram does not include WAIT states.


Figure 4.33 A block diagram of the memory map for the ZAP computer.


Figure 4.34 A $1 \mathrm{~K} \times 8$ programmable memory bank constructed by using two $21141 \mathrm{~K} \times 4$-bit programmable memory chips.


Figure 4.35 A schematic diagram of the final memory configuration for the basic ZAP computer.

## IV. Input/Output

Thus far we have discussed the central processor control and memory decoding. The input and output functions are equally important. For the computer to display useful information, it must be "interfaced" to peripherals. "Interface" is an overworked term that refers to a capability of communicating with external devices such as keyboards, video or LED displays, and memory storage systems. Communication can be either data input or output.

Input data can come from keyboards, audio cassette mass storage, or special data acquisition interfaces. Similarly, output data flows from the computer to peripherals (eg: video displays, numeric readouts, printers, and external control interfaces). The function and format of the data communication between the central processor and the peripherals might vary considerably, but the internal routing of the data is fundamentally the same.

The Z 80 microprocessor provides both an input and output instruction. An output from the processor is logically the same as writing to memory, and receiving an input from an external device is similar to a memory-read command. They are differentiated from memory operations by gating the read and write status lines with the I/O request control line. Logical concurrence of an I/O request and a read or write status output designates the direction of the communication with the peripheral device. Simultaneously with the control signals, the address code ( 1 of 256 ) of the subject device is placed on the address bus. A timing diagram of these signals is shown in figure 4.36. The decoding logic was detailed in section II of this chapter.
Wiring the I/O ports for ZAP is a two-stage process. When hand wiring a computer, the most important consideration is to see that the input/output function works by the least complicated method. A successful test of the ZAP I/O section also indirectly tests memory. This is so because input and output instructions cannot be exercised except by a program stored in memory.
Z 80 input and output is handled 8 bits at a time. It does not matter whether the external interface configuration is serial or parallel. Data transfer between the central processor and I/O is 8 bits parallel and basically occurs as follows.


Figure 4.36 A timing diagram of input or output cycles for the 280 .

## OUT(n), A

When this instruction is executed, the contents of the accumulator A are placed on the data bus and written into device $n$. The address of device $n$ is located on address lines A0 thru A7.

If the accumulator contains 40 hexadecimal when the instruction OUT $23, \mathrm{~A}$ is executed, 40 hexadecimal will be written into the peripheral device (also called "port number") decoded as 23 hexadecimal.

While there are other more complicated output instructions available in the $Z 80$ instruction set, they all pass data through the data bus to the external device. Because the data bus is used for transfer of information between the central processor and memory as well as $1 / O$, the computer must be allowed to continue executing its program. Data cannot remain on the data bus waiting for the peripheral (the central processor can be made to do this but such abstract configurations would be confusing at this time). The data is valid for only a few clock cycles and must be stored if needed for a longer period.

Figure 4.37 diagrams a typical 8 -bit storage register. It consists of 8 individual storage elements with a common "store enable" input. In its simplest form, the single storage cells can be D-type flip-flops such as shown in figure 4.38. Input data (ie: the data bus) is attached to the $D$ input lines and is only clocked onto the output lines ( Q and $\bar{Q}$ ) during an I/O write strobe. Using 7474s would require 4 chips for an 8 -bit word. A better method is to use the improved circuits of figure 4.39.

## Input Instruction

## IN A, (n)

When this instruction is executed, the data from the selected port ( n ) is placed on the data bus and loaded into the accumulator.

If the subject external device reads 10 hexadecimal when the instruction IN A, 20 is executed, the value 10 hexadecimal read from device number 20 hexadecimal would be loaded into the accumulator.

There are other more complicated input instructions but as was the case with output instructions, the route for all data is still the data bus. To keep the data bus from being dominated by a single device attached to it, all input devices (ie: the output from them) must be three-state. This can be accomplished either by using interface logic such as UARTs and peripheral interface adapters that are designed to be three-state, or by adding three-state input buffers such as illustrated in figure 4.40 (the block diagram of the typical 8 -bit, parallel-input port).

Whatever is on input lines $\mathrm{B}_{0}$ thru $\mathrm{B}_{\text {}}$ during an $\mathrm{I} / \mathrm{O}$ read instruction will be directed to the central processor. Using these direct read instructions there is no interaction between the central processor and the external hardware attached to the input port. Additional logic is required to coordinate the exact timing between the computer and an external peripheral. The solution is called "handshaking." Such a capability requires either more sophisticated input port hardware, connection to the central processor, interrupt logic, or additional I/O ports to coordinate the timing.

Checking out the basic ZAP hardware is best accomplished by using the least complicated hardware. A simple input port is illustrated in figure 4.41 and consists of 2 quad three-state buffers. Should there be any brave experimenters who wish to have full handshaking on I/O ports or need more than the 8 mA output drive capabilities of a LSTTL device, input and output ports can easily be configured using Intel 8212s. The specifications described in Appendix C5 demonstrate its versatility.

## Input/Output Checkout

Ultimately, ZAP could have a keyboard, RS232 serial CRT terminal, audio cassette interface, and analog, as well as digital I/O capabilities. Trying to attach all these pe-
ripherals together and checking everything simultaneously is a monumental undertaking. A more methodical approach is to construct the minimum hardware and software that proves operational and then build upon it. That is the route taken thus far.

With the exception of memory, we have attempted to eliminate any potential problems by static testing where possible. The simple I/O devices of figures 4.39 and 4.41 lend themselves easily to this situation. To test I/O fully requires one input port and one output port. It should be wired as shown in figure 4.42. Only port 0 need be connected at this time. The additional circuitry included in this diagram can be ignored. Only ICs 21 thru 23 are of concern presently. The other devices are enhancements to the basic ZAP and will be discussed later.

## Static Test

With power off, remove all ICs previously installed. Insert ICs 20, 21, 22, and 23. Turn on power. Temporarily ground $\overline{D S O W R}$ and $\overline{\mathrm{DS}} \overline{\mathrm{R}} \overline{\mathrm{D}}$. This maneuver, impossible under direct computer control, allows data bus access to both input port 0 and output port 0 at the same time. With the two ports connected in this manner applied input data should be available immediately at the output port. With the input lines of ICs 21 and 22 open and power applied, the outputs of IC 23 should be at a high level. Sequential grounding of input lines $B_{0}$ thru $B$, should be reflected on lines $B_{0}$ thru $B_{7}$ of IC 23. A final test is to disconnect the temporary ground on DSOWR while one of the input lines of IC 21 and 22 is grounded. The logic 0 output of IC 23 should remain low even when the input line is no longer grounded. The result is that the data is "latched." It will remain until updated by another write strobe.


Figure 4.37 A block diagram of a typical latched parallel output port configured with an 8 -bit storage register.


Figure 4.38 A block diagram of a latched parallel output port using D-type flip-flops as a storage register.


Figure 4.39 Schematic diagrams of 8-bit latched parallol output ports.
a) Using two 4 -bit LSTTL latches.
b) Using a traditional 8-bit TTL latch. Note that non-LSTTL devices can be substituted but care should be taken to observe the total bus loading.
c). Using a newer 8 -bit LSTTL latch.


Figure 4.40 A took diagram of a typical 8 -bit parallel input port.


8-8IT PARALLEL INPUT PORT

Figure 4.41 A schematic diagram of an 8-bit parallel input port for the ZAP computer.


Figure 4.42 A schematic diagram of a parallel input/output ports of the basic ZAP computer with additional enhancements required for use with the ZAP monitor software.

## V. Dynamic Checkout of the Basic Computer

All systems, with the exception of memory, should have successfully passed the static checkout procedures. The memory wiring should be checked for continuity. Because ZAP has no front panel or indicator (unless you wish to add one), the full system can only be tested by executing a program that dynamically exercises all the system hardware. This is easier than it sounds. For the computer to output a number to a specific port address, the central processor must be operational and have reset properly to execute the instruction. The memory read must work or the central processor wouldn't know what to do. The memory and I/O decoding must work for the data stored in memory to arrive at the right output port. And finally, for the data to be read at the port, the output port must function as well. In short, if you can execute a program, the computer works.
We can make the process simpler by using the fewest program steps possible and by initially eliminating the necessity for programmable memory. Remember, ZAP has both EPROM and programmable memory. With no monitor or front panel, programmable memory cannot be loadied directly to run a test program. The test program must be already loaded in ROM (in our case EPROM). By carefully selecting the instructions used in the test program, programmable memory can be left out entirely when we run the first test. Why complicate matters by having more hardware than is necessary?
Few instructions are required to test the operation of the processor, reset, memory and I/O. Usually the central processor either works or it doesn't. Central processor failure is rarely a case of one of the instructions executing improperly. If ZAP can read in data at port 0 and output the same value to output port 0 , we can assume it all works. For the data to reach output port 0, it must travel through the central processor (assuming you have removed the temporary grounds on the I/O strobe lines) under program control.
Such a test program is:

|  | OCTAL |
| :--- | :--- |
| IN A, 0 | 333000 |
| OUT 0, A | 323000 |
| JP NN | 303000000 |

This 7 -byte program will read input port 0 data into the accumulator and then write this same data to output port 0 . The jump instruction will cause the program to repeat this action continuously. The program requires no programmable memory to store either intermediate data or the stack pointer. Because only the accumulator is affected, the 7-byte program can be completely contained in ROM. In this case, ROM can be either a 2708 EPROM programmed manually as described in Chapter 7 or a simulated ROM as shown in figure 4.30. If you use a simulated ROM, it may be necessary to reduce the 2.5 MHz clock rate to compensate for the capacitance of the external circuitry. Figure 4.30 also includes an output to port 5 that tests a data display to be added later. Rather than rewrite the EPROM or rewire the pseudo-ROM, you may wish to add this instruction now.
The final test of the basic ZAP is to exercise a program that uses both programmable memory and EPROM. Again, the philosophy is that if it can store and retrieve 1 byte from programmable memory, then all 1 K of that bank should work. A slightly longer program is used this time. The following program is stored in EPROM and the programmable memory is used by the central processor to store the stack:

OCTAL HEXADECIMAL

LD SP,nn 061000006

| IN A, 0 | 333000 |
| :--- | :--- |
| CALL TEST | 315014000 |
| OUT 0, A | 323000 |
| JP nn | 303000000 |
| RET | 311 |

## DBo

CDIOD 00
D3 00
C3 0000 C9

## HEXADECIMAL

| DB 00 | read port 0 in |
| :--- | :--- |
| D3 00 | write to port 0 out |
| C3 0000 | jump to beginning |

310006 set stack pointer to
middle of bank 1 programmable memory read port 0 input call program test write data to port 0 out jump to beginning return to main program


When assembled, the 14-byte program would be loaded as follows (in hexadecimal):

| Location | Program |
| ---: | :--- |
| $00 / 00$ | 310006 |
| 03 | DB 00 |
| 05 | CD 0D 00 |
| 08 | D3 00 |
| $0 A$ | C3 0000 |
| 0D | C 9 |

The operation of this program is similar to the previous example. A byte is read from input port 0 and then read back out to output port 0 . In between these operations there is a call to a subroutine that is just a return instruction. When the call is executed, the location where the program is to resume operation after the call is put on the stack in programmable memory. At the conclusion of the call (the return instruction), the address is popped off the stack and placed in the program counter so that the program can resume where it left off. The only way for the input data from input port 0 to get to output port 0 is for this call to be executed properly. Of course, this requires that programmable memory work properly.
Many other programs that would further enhance the diagnostic checkout procedures can be written. In my experience, however, if it executes these two programs, you can count on everything running.
Once these milestones are reached, the experimenter has a truly operational computer. The next step is to expand this basic unit and make ZAP somewhat more versatile by adding address and data displays, a hexadecimal keyboard, a serial interface, along with an operating system that coordinates the activities of these peripherals. While the present system is a computer, these additions are necessary to move beyond an experimenter's breadboard project.


## CHAPTER 5

## THE BASIC PERIPHERALS

Once the basic ZAP computer has been constructed and tested, we are ready to add a few necessary peripherals that will greatly increase the system's utility. External peripherals facilitate the input and output capabilities of the computer. They include such items as printers, cathode-ray tubes (CRTs), tape drives, and disks. Peripherals of this magnitude, however, are usually used on larger systems. For our Z80-based ZAP, useful peripherals include a keyboard to ease data and program entry; a visual display to allow the computer to indicate a logical conclusion in readable form; a serial communications interface, which allows ZAP to "talk" to another computer; and an interface to an audio cassette mass storage device. These four ingredients are the difference between an experimental breadboard and a useful personal computer.

The keyboard can be either a small keypad for limited data entry or an alpha-numeric "typewriter"-style ASCII (American Standard Code for Information Interchange) keyboard for text editing and high-level language programming. The visual display could range from a hexadecimal LED readout to a full 24 -line by 80 -character CRT terminal. The serial port, in conjunction with the audio cassette interface, could be used to cold start the computer and load application programs.

As with the previous circuits in this book, I've tried to provide various alternative designs so that you, the builder, may construct a truly personal system. Each of the four peripheral devices will be explained in detail and numerous design examples will be provided; both limited function hexadecimal input and full ASCII keyboards will be addressed. In the case of the visual display, we will discuss a rudimentary LED octal and a hexadecimal readout for ZAP. For more sophisticated visual interaction, a CRT terminal is required. Because this unit is much more complicated than a keyboard or an LED display, an entire chapter has been dedicated to it. My basic premise is to start with the essentials, provide a thorough understanding of their applications, then move to more complex, more useful add-ons.

The expansion of the basic ZAP into an interactive microcomputer system requires the addition of a software program to synchronize and exercise the new peripherals. This software is called a monitor and is discussed in a later chapter. Peripherals merely provide the means for added data entry and display capability.

## I. KEYBOARDS

The only way the $\mathbf{Z 8 0}$ can communicate to an external device is through the input/ output bus structure previously described. (While more esoteric methods such as direct memory access exist, they will be ignored for the present.) When the processor wishes to signal the user that an event has occurred, it can do so by changing the output level on one bit of a parallel-output port. For example, the end of program execution can be designated by bit 7 on port 0 going from a logic 0 to a logic 1. Using this concept, 8 separate elements could be individually designated and controlled from the 8 bits of output provided on the single "basic ZAP" port.
Information input is just as simple. The numbers 0 thru 7 could correspond to 8 switches on the 8 input bits of port 0 . This is shown graphically in figure 5.1. When
bit-7 switch is pressed, grounding the input, the logic level transition can signify a numeric entry of 7 to the computer; many microprocessor applications require only these few bits of I/O. A traffic light controller, for example, with a single red, yellow, and green light would need only three bits of output.
The program to control the lights would have been written, assembled, and programmed into some type of non-volatile storage. However, ZAP must interact with a human operator in such a way that programs can be developed and tested. The major difference between the traffic light controller and ZAP would be the peripherals and not the microprocessor's capabilities.
In our example, we could put 8 switches on an input port. To enter information, we have only to write a short program that reads the data on port 0 into the accumulator and then stores or acts upon it. The chapter on monitor software will address these manipulations, but one problem must be solved first: synchronizing peripherals to the computer.
How does the computer know when the data on the switches is or is not valid? And, could we make a timer in software or hardware that reads the port every second, on the second? Can you, for example, see yourself trying to flip all the switches in time or to make the computer wait?


Figure 5.1 A parallel inputloutput interface with LED readout and switch input.

The most popular method of synchronizing a peripheral that has slow data input to a computer with fast program execution is to use "data ready" strobe pulses. (Interrupts may also be used but they involve complicated programming and will not be considered here.) The program is written to read and check the logic level of one bit only. By substituting a push button for one of the eight switches, say bit 7, we can simulate the strobe. To accomplish this, first set data on the other seven switches; then, with the program sitting in a loop checking bit 7, press the push button to generate a logic transition. The program, sensing that a "data ready" strobe is present, reads in the entire port and uses the other 7 bits of data.
Frequently, it is not practical to limit ourselves to just 7 symbolic interpretations when using 7 bits of input. A more logical approach is to code the input and let the 7 bits represent up to 128 individual symbols. The choice between a coded versus a straight parallel input is governed by the application. If the computer is part of a burglar alarm, with each input bit representing a door or window switch, then it is important to know individual and simultaneous bit transitions. In this application, it is necessary to have parallel signal input. On the other hand, alpha-numeric entry from a typewriter keyboard is by nature serial, one letter at a time. Therefore, nothing is gained by using 128 parallel input bits for a 128 -key keyboard. A 7 -bit code is more cost-effective.

The most widely used keyboard code is ASCII (American Standard Code for Information Interchange). Appendix B lists the code and the characters it represents. Any homebrew keyboard should reflect this coding to be compatible with commercially available software such as BASIC.
There are a number of methods that can be used to generate suitable key codes. Figures 5.2 and 5.3 reflect hardware and software approaches, respectively. The block diagram outlined in figure 5.2 is a hardware scanning system suitable for a 64 -key keyboard. A 6 -bit counter progressively enables each column while scanning all rows in each step. Should any key be pressed, a logic 0 will be routed through the 8 -input multiplexer to the scan control logic. This signal is used to generate a key-pressed strobe (also called data-ready strobe) to the computer. The row and column address lines from the counter are read and indicate the binary matrix address of the pressed key. Compatibility with the ASCII code is simply a matter of placing the proper key at the correct address within the matrix.
Another suitable encoding method is outlined in figure 5.3. This technique, which uses software logic to scan the matrix, should be used only when computer program execution speed is not critical. While reducing the circuitry to one chip, the trade-off in this approach requires both an input and output port. It functions in the same way as figure 5.2. The computer sets a 4 -bit column counter code on the decoder. Then it searches the parallel input port for the row with the logic level 0 signifying a pressed key. While this may seem to be an easy way to decode 128 keys, there are certain software considerations.


Figure 5.2 A matrix keyboard scanner for a 64 -key keyboard.


Figure 5.3 A software-driven 128 -key encoder circuit.

The key-pressed or data-ready strobe in any keyboard serves two purposes: it signifies that data is present and ready, and it is timed so the strobe is not generated until after a mechanical debounce time period has elapsed. The reason for the delay is obvious. Remember, these microprocessors can execute 200,000 instructions a second. A program written to look for a strobe and read the data would run a hundred times on a single keypress because of contact bounce. The mechanical making and breaking of the contact could appear like 100 data-ready strobes if we aren't careful. A true data-ready strobe is not generated until after a debounce time-out and then it should be fast-risetime ( $<200 \mathrm{~ns}$ ) pulse with a rate exceeding the cycle time of the computer. The duration of the pulse should be long enough to allow the scanning program to catch it even if it is off doing some other task, and short enough so that the central processor doesn't see the same strobe twice.

There are two techniques to combat the problem of strobe duration. One is to set a flip-flop with the rising edge of the strobe and tie the clear line of the flip-flop to an output bit. After reading in the data, the program can clear the "data-ready" condition by resetting the flip-flop. This is usually employed in cases where the response time to a keyboard or other device is variable. This method also guarantees that an event will be registered and not missed due to time delays. Of course, most keyboard encoders do not latch their output data. If a key is released, even if the strobe has been set in a flipflop, no data will be present when the computer reads the keyboard. There are ways to get around this but they all involve additional hardware.

Usually the experimenter's problem is reading a strobe twice rather than not waiting Iong enough to acknowledge it. Instead of using a hardware flip-flop, most programmers employ a software flag, the second technique in dealing with strobe duration. When a key-pressed strobe is sensed, the program sets a flag in a memory location, reads the data, then checks the strobe again. If the strobe is high, the flag is checked and the data is not read. Only when the strobe returns to a logic zero is the flag reset, enabling data input the next time.

It's not easy to construct keyboard encoders for 64- or 128-key ASCII keyboards. It's simpler to use a commercially available, scanning, read-only memory encoder such as the one documented in Appendix C6.

As far as ZAP is concerned, it is important to learn to walk before we run. Most people would consider ZAP to be a learning tool that could be eventually expanded into a full-blown inicrocomputer system. A full 128 -key ASCII keyboard could prove to be as expensive as the entire ZAP computer. To minimize expense and retain the experimen-
tal qualities of this endeavor, a limited keyboard, suitable for hexadecimal entry, is suggested as the first level of expansion. With a limited number of keys to encode, hardwired TTL circuitry offers a reasonable cost advantage over expensive encoder read-only memories.

Figure 5.4 is a hexadecimal keyboard interface designed specifically for the ZAP software monitor. A hexadecimal keyboard allows data and instruction entry as 2 digit hexadecimal numbers. In addition to the 16 numeric keys, there are 3 command keys designated "EXEC" (for execute), "NEXT," and "SHIFT." EXEC and NEXT will be explained in the monitor section. The SHIFT is similar to a regular keyboard and is used to double the number of key codes by allowing a SHIFT 1, SHIFT 2, etc. The particular significance of each code will be explained later.


Figure 5.4 A hexadecimal keyboard interface.

The keyboard required to support the ZAP software monitor has 19 keys. The encoder in figure 5.4 is a combination scanner and hard-wired parallel output. Encoding depends upon the particular key pressed. The hexadecimal keys 0 thru F are sensed through a multiplexed scanner, IC 2 and IC 3. As IC 2 counts, it sequentially places a logic 0 on each of the 16 output lines of IC 3. If any key is pressed, that low level is routed back to IC 4 and stops the clock. The counter is then locked on the address of the particular key being pressed. The same action that stops the clock also triggers a one-shot IC 5 which generates a key-pressed strobe. The output lines B0 thru B3 will contain the binary value of the pressed key while bit 7 is reserved for the strobe. The three function keys are directly tied to input bits 4, 5, and 6. Three sections of IC 1 serve to dampen contact bounce. The EXEC and NEXT are tied in so they will generate a key-pressed strobe when activated. Because the shift key is always used in conjuction with another key, it is not connected to the strobe circuit.

It is important to recognize that the coding of this 19-key circuit is not ASCII. An ASCII keyboard cannot be used directly with the software monitor outlined in this book, unless you use only those ASCII keys that correspond to the coding of figure 5.4, or rewrite the software monitor to accept ASCII rather than binary codes for each key.

## II. ADDING A VISUAL DISPLAY

Once a keyboard has been added to ZAP, we are ready for program development. The other key ingredient is a visual display that allows the programmer to examine instruction statements and data. The least costly configuration is an LED display, preferably hexadecimal because the software monitor is written that way. For the octal diehards, I've also included an octal display.

Hexadecimal displays may seem a trivial addition to an expensive computer system, but it is sometimes these little helpful add-ons that make program debugging easier. I don't intend that it should replace a CRT, but it's a necessary tool when debugging a program and a necessity for using the ZAP monitor. It will never replace a stepper or a break-point-monitor program, but it's great to display keyboard or I/O data quickly with a single output instruction.

There are many ways to display hexadecimal on a 7 -segment LED. Figure 5.5 is an


| INPUT CODE | 82S23 PROGRAM | 7-SEGMENT DISPLAY |
| :---: | :---: | :---: |
| D C B A | D7D6D5D4D3D2D1D0 |  |
| 0000 | $\begin{array}{llllllll}0 & 1 & 1 & 0 & 1 & 1\end{array}$ | 0 |
| 0001 | 0100000001 | 1 |
| 0010 | $\begin{array}{llllllll}0 & 1 & 1 & 0 & 1 & 1 & 1 & 0\end{array}$ | 2 |
| 0011 | $\begin{array}{lllllllll}0 & 1 & 1 & 0 & 1 & 0 & 1 & 1\end{array}$ | 3 |
| 0100 | 0100110001 | 4 |
| 0101 | 00011110011 | 5 |
| 0110 |  | 6 |
| 0111 | $0 \begin{array}{llllllll}0 & 1 & 1 & 0 & 0 & 0 & 0 & 1\end{array}$ | 7 |
| 1000 |  | 8 |
| 1001 | $\begin{array}{lllllllll}0 & 1 & 1 & 1 & 1 & 0 & 0 & 1\end{array}$ | 9 |
| 1010 |  | A |
| 1011 | $\begin{array}{lllllllll}0 & 0 & 0 & 1 & 1 & 1 & 1 & 1\end{array}$ | b |
| 1100 | $\begin{array}{lllllllll}0 & 0 & 1 & 1 & 0 & 1 & 1 & 0\end{array}$ | C |
| 1101 |  | d |
| 1110 | $\begin{array}{lllllllll}0 & 0 & 1 & 1 & 1 & 1 & 1 & 0\end{array}$ | E |
| 1111 | 001111100 | F |

Figure 5.5 A possible method for a hexadecimal latch/decoder/driver using a standard 7 -segment LED.
a) This entire circuit would be needed to replace one HP7340. $\overline{C S}$ on the $82 S 23$ can perform the blanking function.
b) The program for the $82 \$ 23$ (IC 2).
example of the usual brute force method using a PROM as a hexadecimal decoder. (A method of programming the 82 S 23 was described in the article in the November 1975 issue of BYTE magazine entitled "A Versatile Read-Only Memory Programmer," if you choose to use this circuit.)

However, this approach uses an excessive number of components and most people would not want to program a PROM. One alternative is to allow the computer to perform the decoding and drive the 7 -segment display through the transistors directly from a latched 8 -bit output port. Another way puts additional logic around a standard 7 -segment decoder driver for the extra requirements. The former case necessitates a computer program while the latter can involve as many components as figure 5.5.
Fortunately, there is a product on the market that can solve the problem. It is the HP7340 hexadecimal LED display (from Hewlett Packard; equivalent displays are available from other manufacturers). These hexadecimal digits depart from the standard 7 -segment format by using dots instead of bars and being capable of displaying a capital " B " and " D " in hexadecimal. This is accomplished by controlling the corner dots, which gives the appearance of "rounding." This ability discriminates a " B " from an " 8 " or a " $D$ " from a " 0 ." There are 16 distinctly different characters.

An additional feature of the HP7340 is that each display circuit contains a 4-bit latch and decoder/driver. This allows the display to be attached directly to the data bus. The result is a single 8 -pin hexadecimal display that successfully accomplishes the function of all the circuitry of figure 5.5. The specifications of the individual pins are given in figure 5.6.


Figures 5.7 and 5.8 demonstrate how the HP7340 can be configured to function as a 2 -digit hexadecimal output port or a 3-digit octal port. An 8 -bit latch is not required because it already contains one. The HP7340s can be attached to the data bus as simply as any other parallel output port and are strobed from the chip-select decoder outlined earlier in the section on I/O decoding.

To utilize the software monitor properly, 6 hexadecimal displays (separated into 3 single byte displays) are necessary. Three bytes are required to display a particular H and L address and the data contents of that location. The 6 hexadecimal displays should have the following decoded strobes:

| Output Port \# | Logic Line | Display Parameter | IC\# |
| :---: | :---: | :--- | :---: |
| $\mathbf{5}$ | $\overline{\text { DS5WR }}$ | MSD address field | 30,31 |
| 6 | $\overline{\text { DS6WR }}$ | LSD address field | 28,29 |
| 7 | DS7WR | data field | 26,27 |

> MSD - Most Significant Digit
> LSD - Least Significant Digit

A more complete description of each display function is described within the monitor section, and a completed schematic showing how the 6 displays are attached to the data bus is illustrated in figure 5.9.


Figure 5.7 An HP7340 hexadecimal latch/decoder/driver display.


Figure 5.8 An HP7340 octal latch/decoder/driver display. The HP5082-7300 can be substituted for the HP5082-7340 in octal display applications. The HP7300 displays numerics only.


## III. SERIAL INTERFACE

A serial communication capability is not absolutely necessary to make ZAP work, although the software monitor supplied in this book supports a serial interface.
First a word about concept before we pursue the design details. Why would ZAP need to communicate? When we discuss the serial cassette interface, you will understand that there are more advantages to it than appear presently. If future expansion is in mind or commercially made peripherals such as a CRT or printer are ever added, their interface will most likely be serial.
This last sentence is significant. Realize that I said nothing about communicating with another computer. While talking to another computer over telephone lines requires a serial link, in general, standard peripherals such as CRTs and printers also "talk" serially. Therefore, by designing a serial port to accommodate a printer, we also gain the ability to talk with another computer.
Communication is simply the transfer of information from one device to another. In the case of a CRT display unit, the computer sends character information for screen display while the keyboard relays the user's input to the computer. Each end of the fullduplex communication line must have a transmitter and a receiver. In both cases, the information being transferred is ASCII data probably consisting of a 7-bit code and, in some cases, an additional parity bit for error checking. This 7-bit data (ignoring the parity bit) will appear on the lines of a parallel port. These 7 lines plus a ground reference and a strobe (remember we have to tell the receiver when the data is valid) can be brought out to the CRT input. Keeping that as a dedicated line from the computer to the CRT, we now want a similar line between the keyboard output and an 8 -bit parallel port on the computer. This requires an additional 9 lines. To further complicate matters, let's separate the terminal and the computer by 300 to 400 feet, as might happen in some commercial computer systems. The result is that 400 feet of 18 lead ( $\mathbf{1 7}$ if you combine ground references) cable will cost more than the terminal. Also realize that the TTL parallel output should not be used to drive lines longer than 20 feet without special buffers/drivers; otherwise data errors could occur.

The solution to this costly wiring problem is to use serial rather than parallel communication. The parallel data is converted to serial and sent one bit at a time down a single twisted pair wire. If buffers/drivers are needed for long distances, less are required with the serial approach. Specially encoded "start" and "stop" bits included in the serial transmission notify the receiver that valid data is being sent. For the above example, only two pairs of wire are needed to perform "full-duplex" interaction (see figure 5.10). In "half-duplex" mode this can be reduced to a single twisted pair, but synchronization of the shared communication line is more complicated. All serial transmission references I shall make will be limited to full-duplex operation.


Figure 5.10 A block diagram of a fullduplex RS-232C communication link.

Now that we agree that the communication should be serial, how do we accomplish the parallel to serial conversion? The answer is a device called a UART (Universal Asynchronous Receiver/Transmitter). Appendix C7 gives the specification information for the SMC COM2017 UART which is equivalent in function to the AY-5-1013A (General Instruments). To minimize power supply requirements, a single +5 V AY-3-1015 or TR1602 (Western Digital) can be substituted as I have done. The only change from the specification sheet is that pin \#2 is no longer tied to -12 V .

A UART's internal structure consists of a separate parallel-to-serial transmitter and serial-to-parallel receiver joined by common programming pins. This means that the two sections of the UART can be used independently, provided they adhere to the same bit format that is hard-wire or software selectable on the chip.

The transmission from the computer to the CRT is done asynchronously and in one direction only. The computer likewise receives data directly from the keyboard through a dedicated line. As far as the computer is concerned, after reconversion to parallel in the UART, this input device is communicating parallel data.

Actual data transmission follows the asynchronous serial format illustrated in figure 5.11. Using the keyboard as an example, when no data is being transmitted, the data line is sitting at a mark (or " 1 " level) waiting for a key-pressed strobe. A key-pressed strobe is a 1 to 5 ms positive pulse (it can be as short as 200 ns ) indicating that a keyboard key has been pressed, and that an ASCII code of that key is available for transmission. This key-pressed strobe, which is attached to the data strobe of the UART, causes the ASCII data to be loaded into a parallel storage buffer and starts the UART transmission cycle. The serial output will then make a transition from a 1 to a 0. This mark-to-0 start bit is 1 clock period long and indicates the beginning of a serially transmitted word. Following the start bit, up to 8 bits of data follow, each data bit taking 1 clock period. At the conclusion of the data bits, parity and stop bits are output by the UART to signify the end of transmission. If another key is pressed, the process repeats itself.


Figure 5.11 A single data byte as it is transmitted in asynchronous serial format.

On the receiving end, the UART is continuously monitoring the serial input line for the start bit. Upon its occurrence, the 8 bits of data are slipped into a register and the parity checked. At the completion of the serial entry, an output signifying data available is set by the UART and can be used as an input strobe to the computer. The UART will not process additional serial inputs unless the data available flag is acknowledged, and the data available reset line is strobed. Actual transmission can include or exclude parity, have 1 or 2 stop-bits, and data can be in 5 -to 8 -bit words. These options are pin selectable.

The following is a pin function description for the AY-5-1013, COM2017, or AY-3-1015.

## Pin \# NAME

1 Vcc Power Supply
$2 . V_{c c}$ Power Supply
3 Ground
4 Received Data Enable

## SYMBOL FUNCTION

$V_{c c} \quad+5 \mathrm{~V}$ Supply
$V_{\text {oG }} \quad-12 \mathrm{~V}$ Supply (not connected on AY-3-1015)
GND Ground
$\overline{\mathrm{RDE}} \quad \mathrm{A}$ logic " 0 " on the receiver enable line places the received data onto the output


| Data Strobe |  | DS strobe on this line will <br> enter the data bits into the |
| :--- | :--- | :--- |
| data bits holding register. |  |  |
| Initial data transmission is |  |  |
| initiated by the rising edge |  |  |
| of DS. Data must be stable |  |  |
| during entire strobe. |  |  |
| This line goes to a logic " 1 " |  |  |
| each time a full character is |  |  |
| transmitted. It remains at |  |  |
| this level until the start of |  |  |
| transmission of the next |  |  |
| character. |  |  |

register may be loaded with another character. Threestate.

A strobe on this line will enter the data bits into the dat bits holding register. initiated by the rising edge of $\overline{\mathrm{DS}}$. Data must be stable during entire strobe.
This line goes to a logic " 1 " each time a full character is transmitted. It remains at start of character.

This line will serially, bit by bit, provide the entire transmitted character. It will remain at logic " 1 " when no data is being transmitted.
There are up to eight data bit input lines available.

A logic " 1 " on this lead will enter the control bits (EPS, NB1, NB2, TSB, NP) into the control bits holding register. This line can be strobed or hard-wired to a logic " 1 " level.
A logic " 1 " on this lead will eliminate the parity bit from the transmitted and received character (no PE indication). The stop bit(s) will immediately follow the last data bit. If not used, this lead must be tied to a logic "0."
This lead will select the number of stop bits, one or two, to be appended immediately after the parity bit. A logic " 0 " will insert 2 stop bits. A logic " 1 " inserts 1 stop bit.
These two leads will be internally decoded to select either $5,6,7$ or 8 data bits/ character.

The logic level on this pin selects the type of parity that will be appended immediately after the data bits. It also determines the parity that will be checked by the receiver. A logic " 0 " will insert odd parity, and a logic " 1 " will insert even parity.
This line should have as an input a clock whose frequency is 16 times ( $16 \times$ ) the desired transmitter data rate.

The final serial interface configuration is shown in figure 5.12. Because a UART is a three-state device, it can be attached directly to the data bus. Data is written into or read from it 8 bits parallel as any other I/O port manipulation. To the computer, the UART appears as one output and two input registers: status, transmitted data, and received data. As with all data bus manipulations, data transfers are synchronized through decoded strobes. The ZAP software monitor uses three port addresses to coordinate the hardware and software. To be compatible, they should be wired as follows:

| Port \# | Logic Line | Signal |
| :--- | :---: | :--- |
| 02 INPUT | $\overline{\text { DS2RD }}$ | READ DATA |
| 03 INPUT | $\overline{\text { DS3RD }}$ | READ STATUS |
| 02 OUTPUT | $\overline{D S} 2 W R$ | WRITE DATA |

The primary focus of this chapter is the hardware section of the serial interface. When connected directly to the data bus in this manner, there is no way to operate the UART except under program control. Explanation of the protocol and the significance of each UART register can be found in the section on the ZAP monitor.
There are two remaining hardware considerations: data rate and transmission signal level. Data rate can be loosely termed as bits per second and refers to the transmission speed along the twisted pair. Keep in mind that at lower data rates, only 8 of 11 bits of each transmitted word are data; 1 start bit and 2 stop bits are used. While any transmission frequency can be set on a UART, by adjusting the clock rate there are eight frequently used standard asynchronous transmission rates:
110 bps
150 bps
300 bps
600 bps
1200 bps
2400 bps
4800 bps
9600 bps

Using a special data rate generator chip and switch selector network shown in figure 5.12, ZAP can accommodate any of these specific frequencies. In normal operation, most teletypes run at 110 bps , printers such as the DECwriter II at 300 bps , acoustic telephone modems at 300 bps , and video terminals from 1200 to 19,200 bps. As you can see, in theory, we can communicate with them.
Transmission rate is only part of inter-communication prerequisites. A computer could be all TTL level logic while a peripheral used 15 V CMOS. They would be completely incompatible. Therefore, it is necessary to have one additional standard that governs the signal level of the transmissions. The most widely accepted and generally


Figure 5.12 The final serial interface configuration.
used standard is EIA RS-232C.
Although TTL levels could be used for communication, they are not suitable for carrying signals more than 10 or 20 feet. The problem stems from the fact that only 2 V separates a logic 1 or 0 rather than speed or drive capabilities. With only 2 V immunity to noise, communication would be susceptible to interference from motors and switches.

An industrial committee agreed to a standard interface to solve this problem as well as to suggest standards for the industry. Modem equipment uses EIA RS-232C. This specification applies not only to the specific voltages assigned to logic 0 and 1, but also to the type of plug, pin assignments, source and load impedances, as well as to a variety of other related functions.
The signal levels of RS-232C are bipolar and use a negative voltage between -3 and -15 V to represent a logic 1 and a positive 3 to 15 V to represent a logic 0 . The region between -3 V and +3 V helps our noise immunity and is a dead region. Even though + and -15 V would provide optimum transmission, +3 V and -7 V are also acceptable. However, try to maintain equal bipolar levels over long distances.

The basic ZAP computer requires $+12,+5$, and $-12 \mathrm{~V}(-5 \mathrm{~V}$ is necessary for the EPROM memory and is derived from the -12 V supply) supplies for operation. We can use the positive and negative supplies to generate RS-232C voltage levels in a number of ways. Figure 5.13 illustrates some RS-232C drivers, and figure 5.14 shows a couple of receiver circuits. One from each selection would have to be attached to the serial I/O pins of the UART for it to have complete RS-232C compatibility.

a)

b)

Figure 5.13 TTL to RS. 232 C drivers.
a) Using two transistors as a level shifter.
b) Using an opto-isolator as a level shifter.
c) Using a standard $R S-232 \mathrm{C}$ line driver.

c)


PINOUT OF MCI4B9 RS-232C TO TTL RECEIVER
b)


## IV. CASSETTE STORAGE INTERFACE

The last but by no means least of the enhancements we should add to ZAP is a cassette interface. With the keyboard and display, an operator will be able to write some elaborate programs but, unless they are transferred into read-only memory storage, they will be lost when power is turned off. Of course, the computer's power can be left on constantly. But what if you want to develop a second program that must occupy the same memory address space? The preferable solution is to have some medium that temporarily stores large memory blocks.
In large computer systems, this capability is achieved through hard-disk and 9-track magnetic tape systems. These high-speed, high-volume media are beyond the personal computing budget, but their value in large systems is obvious. A low price, lower performance alternative is an audio cassette storage system.

In general, a cassette storage interface consists of three major subsystems: a serial transmitter/receiver; a hardware assembly that converts serial TTL data so it's audio cassette compatible, and an application program that keeps track of what's going out to tape and can load it back into the correct place. The basic configuration is illustrated in block diagram form in figure 5.15 .


Figure 5.15 A block diagram of an audio cassette storage system.

The serial transmitter/receiver section is nothing more than the UART serial interface which we have already added. With MC1488 and 89 converters on its serial lines, it communicates via a RS-232C. However, if you attach a cassette interface to these lines, it can double as a storage device. An additional benefit is that serial data generated by the UART will offer some compatibility between personal computing systems; standard data rates and standard serial communication protocol will promote this.

The output of the UART is TTL. Even with the RS-232C drivers, the logic output is still a DC level. Because audio recorders cannot record DC, the UART output must be converted in some way. The solution is FSK (frequency shift keying). The ITL output from the UART is converted into audio tones. One frequency represents a ldgic 0 , and a second represents a logic 1.

Figure 5.16 shows a circuit that will produce frequency shift keyed tones. A 4800 Hz reference frequency is derived from the MC14411 data rate generator previously installed. IC 2A and 2B function as a programmable divider chain. With a TTL logic 1 on the input IC 2 divides the 4800 Hz by 2 , giving a 2400 Hz output. When the input level is changed to logic 0 , it divides by 4, producing a 1200 Hz output. The FSK frequencies are generated at a serial output rate of 300 bps and connected directly to the recorder through the microphone or auxiliary input. (These frequencies and data rate are often referred to as the Kansas City Standard.)


Figure 5.16 A 300 bps serial output driver to an audio recorder.

Getting the recorded tones off the audio tape requires the circuit shown in figure 5.17. In general, it consists of a pair of band-pass filters and a voltage comparator. The recorder is set to an output level of approximately 1 V peak to peak. This level is not critical because it is amplified and limited as it passes through IC 1. IC 2 and IC 3 are band-pass filters with center frequencies of 2400 Hz and 1200 Hz , respectively. The output of IC 1 is fed into both of them, but should be passed by only one. IC 4 compares the outputs of the two filters and generates a TTL logic 1 when a 2400 Hz tone is received and a logic 0 with a 1200 Hz tone. Tuning the interface will be explained later.

The choice of the FSK frequencies and data rate are not left to chance. They are a function of receiver response speed and recorder bandwidth. Most cassette recorders have a frequency response of around 8 kHz . Less expensive units can be as low as 5 or 6 kHz . It is unwise to try to record tones at this upper limit. The center of the frequency range offers more reliability, so the logic " 1 " FSK tone should be set less than 3 kHz ( 2400 Hz in our case). In addition, it takes time for the receiver to recognize a particular frequency. The circuit of figure 5.17 takes 2 or 3 cycles to respond. This means that at the low frequency of 1200 Hz , each logic 0 bit will need 3 cycles at 1200 Hz to be recognized.

Figure 5.17 A 300 bps serial input receiver from an audio cassette.

If we consider a worst case condition of sending all zeros, the transmission rate would have to be slower than 400 bps to be accurately received. The closest standard data rate to this value is 300 bps . Raising the 1200 Hz tone to increase the transmission speed only complicates the filter design the closer it is to 2400 Hz . This interface has been tested at 600 bps but it requires precise alignment to achieve faster speeds. The low frequencies and moderate data rate are chosen specifically to increase the probability of successful construction rather than to compete with high speed data storage systems.
The final point to consider is the software that runs the hardware. The ZAP monitor, as it now stands, does not directly support a cassette interface even though it does handle all the serial housekeeping. Until you write the cassette driver into an EPROM, you will have to type in a short "bootstrap" program. To read the cassette, the logic of the program would follow the flow diagram in figure 5.18.
First, a pointer is set in the H and L registers to designate where the cassette data will be stored in programmable memory and an address where it will end. Next, taking advantage of the serial communication routine in the ZAP monitor, we simply call "SERIAL IN" which returns with a byte of data from the UART. This byte is stored in memory, and the HL register pair is decremented and compared to a predetermined stop address. If not equal, it repeats the process of getting another byte of data.
Storing memory is equally straightforward and is diagrammed in figure 5.19. Again, a pointer is set to the beginning and the memory area to be written to tape. Next, the "SERIAL OUT" routine is called from the ZAP monitor, which sends the byte of data to the cassette. Finally, the pointer is decremented and compared to the end address to see if more data is to be written.
These are relatively easy routines to write and short enough that they may be squeezed into the few empty bytes within the ZAP monitor EPROM. Whatever the case, you will soon realize the versatility and capability that such a simple interface adds to a computer system. The 2 K of programmable memory on the basic ZAP will become resident program space while the cassette will be a potential megabyte file storage system for it.


Figure 5.18 A flowchart of software to read a cassette.


Figure 5.19 A flowchart of software to write a cassette.

## TUNING THE CASSETTE INTERFACE

To test the cassette interface, it is necessary first to construct the circuit from figure 5.16. Use a frequency counter to determine that the input to IC 1, pin 5 is 4800 Hz . With no UART installed, the frequency at pin 1 of IC $2 b$ should be 2400 Hz . Grounding IC 2 b , pin 1 should change this output to 1200 Hz . In both cases, voltages of 1 and 0.1 V should be present on the cassette auxiliary and microphone inputs respectively.

The receiver uses the frequencies generated by the output section previously described to set the calibration. With the output section set to 2400 Hz , attach a jumper from the output interface to the input of the receiver circuit (figure 5.17). Using an oscilloscope, check that the waveform at IC 1, pin 6 is a square wave of 2400 Hz . Next, with the scope attached to IC 2 , pin 6 , adjust R1 until the voltage at that point is maximum. Moving the scope probe to IC $3, \operatorname{pin} 6$, and changing the input frequency to 1200 Hz , repeat the procedure by adjusting R2 until the voltage peaks.

R3 sets the point at which the comparator switches between logic levels when the input frequencies change. The proper way to set this is to use a function generator on the input and set R3 to switch at exactly 1800 Hz . The result should be clean logic level switching at IC 4, pin 6, as the frequency is cycled between 1200 Hz and 2400 Hz . Generally speaking, the comparator setting is not especially critical.

## CHAPTER 6 THE ZAP MONITOR SOFTWARE

The function of an operating system is to provide the programmer with a set of tools to help him in developing, debugging and executing a program. In general, the operating system assists the programmer by managing the resources of the computer, and by eliminating his involvement with repetitive machine-code manipulations. Operating systems span a broad spectrum of complexity. Small systems, for example, provide only a rudimentary means for a programmer to enter and read 8-bit data from memory; large systems, on the other hand, can dynamically manage the allocation of all memory and peripherals.

Large systems allocate computer resources to more than one user in a multiprogramming, multitasking, or a time sharing environment. A system of this magnitude far exceeds the capabilities of the computer described in this book. This being the case, what would be a suitable operating system for the ZAP computer? As previously stated, the objective of an operating system is to manage the resources of the computer. The ZAP computer described in the previous chapters, and enhanced with the minimum peripherals, contains the following resources:

- Z80 microprocessor
- 1024 bytes of EPROM memory
- 1024 bytes of programmable memory (2048 optional)
- Nineteen-key keyboard
- Two-character data display
- Four-character address display
- UART for serial I/O

The operating system must provide access to these resources and give the user a way to manage them during execution of programs. The operating system designed for ZAP will include the following facilities and functions:

1. Cold start
2. Warm start
3. Memory display and replace
4. Register display and replace
5. Execute (begin program execution at a designated point)
6. Serial input and output

Each will be explained in detail concerning its functions and program implementation.

## I. OPERATING SYSTEM FUNCTIONS

## Cold Start Operation

The operating system must be available immediately after power is applied to
the computer. In the past, some systems provided this capability by storing, in read-only memory, a small "bootstrap" routine. This bootstrap routine was then used to load the operating system into memory from another device, such as a paper-tape reader or a cassette recorder. New technology eliminates this tedious step. The operating system for your computer resides permanently on the EPROM (erasable-programmable read-only memory) chip and is ready to be executed as soon as power is applied and the "RESET" button is pressed. The depression and release of the "RESET" button sets the Z80 PC (program counter) to zero.

With the next machine cycle, the processor begins execution of the instruction located at $00_{16}$ (location 00 hexadecimal) in memory. The operating system of the Z80 microprocessor provides the instructions to begin execution. This particular series of program instructions constitutes a "cold start" procedure and establishes the required start up conditions for the operating system. The operating system then initializes the SP (stack pointer) to an area in programmable memory for maintaining the "push-down/pop-up" stack. This stack is required for execution of any of the "RESTART" and "CALL" instructions provided by the 280 instruction set. If it were not initialized before the execution of a "CALL" or "RESTART" instruction, the effects of the instruction would be unpredictable. In this operating system, the stack pointer is set to programmable memory location $07 C 4_{16}$.

## Warm Start Operation

After initializing the SP address, the operating system enters a command recognition module. Before discussing this feature of the operating system, some of the other restart features should be explained. The $Z 80$ gives the user eight address-vectored "RESTART" instructions (see Chapter 3 for a description of the instructions). For example, the execution of a RST $08_{16}$ will store the current PC on the "STACK" and program execution will begin at location $08_{16}$.

The following "RESTART" instructions are available within the operating system:

| RST | $10_{16}$ |
| :--- | :--- |
| RST | $18_{16}$ |
| RST | $20_{16}$ |
| RST | $28_{16}$ |
| RST | $30_{16}$ |
| RST | $38_{16}$ |

The execution of any of these instructions causes the operating system to jump to a location in programmable memory. At that location the user executes a jump instruction to vector the computer to a new location.

RST $00_{16}$ and RST $08_{16}$ have been reserved for use by the operating system for special functions and will not result in a jump to a location in programmable memory. These two RST instructions can be utilized in the debugging of programs. RST $00_{16}$ will perform the same function as pressing the "RESET" button; or it will reinitialize the stack pointer and enter the command recognition module through execution of the "cold start" routine.

The execution of a RST $08_{16}$ by the $Z 80$ will result in the "warm start" module being entered. This module saves the existing data in all the registers in the "register save area" located in programmable memory (see the listing of the ZAP operating system in Appendix D). The module will also extract from the stack the user's restart address and save this in the register save area. The operating system then enters the command recognition mode to wait for the next command. The use of this feature allows the programmer to save register, pointer, flag, and program counter data, prior to using any additional debugging features in the operating system. A detailed description of the "warm start" module is provided in section II. 2 of this chapter.

## Program Development and Debugging Services

The cold start and warm start procedures exit to the command input sequence. With these command procedures, the programmer is able to examine and replace data in memory or registers, and to begin execution at a user-specified location. Upon entry to the command input module, the operating system displays "FFFF" on the address section, and "FF" on the data section of the six character hexadecimal LED display. The user then implements one of the three command functions by holding down the "SHIFT" key and pressing the " 0 ," " 1 ," or " 2 " keys. A "SHIFT 0 " (the SHIFT key and 0 key are pressed simultaneously) tells the operating system to enter the memory display and replace function; "SHIFT 1" enters the register display and replace function, and a "SHIFT 2 " enters the go execute module.

## Memory Display and Replace

The memory display and replace function allows the user to examine the contents of both read-only memory and programmable memory. During operation the address and the contents of that location are shown on the respective displays.

The memory display and replace function is entered by executing a "SHIFT 0" when the system is in the command recognition mode (address display $=$ FFFF and data display $=\mathrm{FF}$ ). At this time, the operating system is waiting for the user to enter an address of one to four hexadecimal digits from the keyboard. As entered, these shift into the display area sequentially. If more than four digits are entered, only the last 4 -digit value (shown in the address display) will be used as the address. Inputting of address data is terminated by pressing the "NEXT" key. This causes the contents of the indicated address to be displayed on the two digit hexadecimal data display. If the user wishes to display subsequent memory locations, he need only continue pressing the "NEXT" key. This will step the memory display program to the next higher memory location and display the new address and memory contents. If the user wishes to change the contents of a displayed memory location, he may enter new data by typing a two-digit value for that location before hitting the next key. This new value is loaded into the indicated address when the "NEXT" key is pressed. Pressing the "NEXT" key continues the sequential display of address and data.

Termination of this function is accomplished by pressing the "RESET" or "EXEC" buttons. Control is returned to the command recognition portion of the operating system.

## Display Memory Example

| Key | Address Display | Data Display |
| :---: | :---: | :---: |
|  | FFFF | FF |
| "SHIFT 0" | 0000 | FF |
| 1 | 0001 | FF |
| A | 001 A | FF |
| F | 01 AF | FF |
| "NEXT" | 01 AF | 01 |
| "NEXT" | 01 BO | 1 C |
| "RESET" | FFFF | FF |

## Memory Replace Example

| Key | Address Display | Data Display |
| :---: | :---: | :---: |
|  | FFFF | FF |
| "SHIFT 0" | 0000 | FF |
| 4 | 0004 | FF |
| 0 | 0040 | FF |
| 0 | 0400 | FF |


| "NEXT" | 0400 | 01 |
| :---: | :---: | :---: |
| $\mathbf{2}$ | 0400 | 02 |
| $\mathbf{1}$ | 0400 | 21 |
| "NEXT" | 0401 | 05 |
| 6 | 0401 | 06 |
| A | 0401 | 6 A |
| "EXEC" |  |  |
| esults will be: | Address | Data |
|  | 0400 | 21 |
|  | 0401 | 6 A |

## Register Display and Replace

The register display and replace function allows the user to examine and change the contents of the saved $Z 80$ registers. This is accomplished by executing a RST 1 (warm start) during the execution of the program. During execution of this function, the contents of the registers are shown on the address display. Eight-bit registers will be displayed on the lower two digits of the address display. (The upper two digits will be zeros during the display of 8 -bit registers.) A code that indicates which register is being displayed is shown on the data display. Table 6.1 describes the codes that have been assigned to the register display and replace function, as well as the key that initiates a particular register display sequence.

| Code <br> (shown on data display) | Z80 Register <br> (shown on address display) | Initiating Key |
| :---: | :---: | :---: |
| 02 | IX | 2 |
| 03 | IY | 3 |
| 04 | SI' | 4 |
| 05 | PC | 5 |
| 06 | I | 6 |
| 07 | R | 7 |
| 08 | L | 8 |
| 09 | H | 9 |
| 0A | A | A |
| OB | B | B |
| OC | C | C |
| OD | D | D |
| OE | E | E |
| OF | F | F |
| 40 | L' | "SHIFT 0" |
| 41 | $\mathrm{H}^{\prime}$ | "SHIFT 1" |
| 42 | $\mathrm{A}^{\prime}$ | "SHIFT 2" |
| 43 | $B^{\prime}$ | "SHIFT 3" |
| 44 | $\mathrm{C}^{\prime}$ | "SHIFT 4" |
| 45 | $\mathrm{D}^{\prime}$ | "SHIFT 5" |
| 46 | $\mathrm{E}^{\prime}$ | "SHIFT 6" |
| 47 | $\mathrm{F}^{\prime}$ | "SHIFT 7" |

Table 6.1 Display code/Z80 register//nitiating key correspondence.

The register display and replace function is entered by pressing a "SHIFT 1" when the system is in the command recognition mode (address display $=$ FFFF and data display $=\mathrm{FF}$ ). At this time the operating system is waiting for the programmer to enter the one-digit register code (see table 6.1). If more than one digit is entered, only the last code indicated on the data display will be used as the reg-
ister identifier. When the central processor detects that the "NEXT" key has been depressed, the contents of the indicated register are displayed on the address display.

If the user wishes to display subsequent registers he need only press the "NEXT" key. This causes the next register to come up with the register code and its contents. To change the contents of a displayed register the value is entered and loaded when the "NEXT" key is pressed. For 16-bit registers, the last four hexadecimal digits will be accepted if more than four characters have been entered. For 8 -bit registers the last two hexadecimal digits will be accepted. When replacing register data, the "NEXT" key also causes the register code to be indexed to the next register (see table 6.1) and its contents to be displayed.

The user may terminate this function by pressing the "EXEC" key. Control is returned to the command recognition portion of the operating system.

## Display Register Example

| Key | Data Display <br> (register code) | Address Display <br> (register contents) |
| :---: | :---: | :---: |
| "SHIFT 1" | FF | FFFF |
| A | 00 | FFFF |
| "NEXT" | 0 A | FFFF |
| "NEXT" | 0 A | 005 C |
| 'RESET" | OB | 0063 |
|  | FF | FFFF |

Register Replace Example

| Key | Data Display <br> (register code) | Address Display <br> (register contents) |
| :---: | :---: | :---: |
| "SHIFT 1" | FF | FFFF |
| 5 | 00 | FFFF |
| "NEXT" | 05 | FFFF |
| 4 | 05 | 043 A |
| 2 | 05 | 0004 |
| C | 05 | 0042 |
| "NEXT" | 05 | 042 C |
| "NEXT" | 06 | 00 FF |
| "EXEC" | 07 | 0003 |

## Go Execute ("EXEC")

The "go execute" ("EXEC") function allows the user to change the contents of the PC (program counter) register in order to direct execution of instructions at the user-selected address.

The "go execute" function is entered by pressing a "SHIFT 2" when the system is in the command recognition mode. Now the user must enter an address of one to four hexadecimal digits. If more than four digits are entered, only the value shown in the address display is used as the address to begin program execution. Execution begins when the "NEXT" or "EXEC" keys are pressed. This causes the Z80 registers to be stored in the register save area (see the operating system listing in Appendix D) and execution begins at the user-specified address.

| Key | Address Display | Data Display |
| :---: | :---: | :---: |
|  | FFFF | FF |
| "SHIFT 2" | 0000 | FF |
| 1 | 0001 | FF |
| A | 001 A | FF |
| F | IACF | FF |
| 'NEXT" |  |  |
| or |  |  |
| 'EXEC" |  |  |

## Serial I/O Services

The ZAP computer includes a serial input/output capability that is implemented with a UART. This interface allows serial communication between the computer and peripheral devices such as a printer or a CRT. To aid the user in utilizing this capability, the operating system has a UART diagnostic module, a serial input module, and a serial output module. The input and output modules are set up as subroutines that can be called during program execution and that are not necessarily keyboard and display limited.

## UART Diagnostic Module

The UART diagnostic module provides a means for checking the performance of the UART. To utilize this feature the user must first attach the serial output and input lines together so that data output from the UART may be read by the same device. The serial diagnostic subroutine is initiated by using the "go execute" function. Execution starts at 032D ${ }_{16}$.

Once started, the diagnostic module (UATST) begins by sending data to the UART and waiting for data to become available. The status of the UART is checked to verify that no fault conditions are present. In the event that a fault is detected, the status of the UART is displayed on the two low-order digits of the address display. (See table 6.2 for error codes.) If there are no errors, the data is read and displayed on the two-digit-data display. A comparison is made between the input and output data. If the 2 bytes are equal, the output character is incremented and another byte is sent to the UART to continue the sequence. This procedure continues until the "RESET" button is pressed, or until an error is detected. In the event that the input character does not equal the output character, a $0 \mathrm{~F}_{16}$ is displayed in the two lower digits of the address display and the diagnostic is halted. Figure 6.1 details the logic flow of this software routine.
Displayed Code
$12_{16}$ or $13_{16}$
$0 A_{16}$ or $0 B_{16}$
$06_{16}$ or $07_{16}$
00
$0 F_{16}$

## Error

Parity Error
Framing Error
Overrun Error
Transmitter Buffer Not Empty
Input Character $\neq$ Output Character


Figure 6.1 A flowchart of the UART diagnostic module (UATST).

## Serial Input Module

The serial input module has been included so the user can read serial data from external devices. To utilize this capability, the user must set aside a programmable memory buffer where the input data is to be stored, and designate the number of input characters expected. The input buffer address is stored at address $07 \mathrm{Fg}_{16}$ in memory (see Appendix D), and the number of characters is stored at address $07 \mathrm{FD}_{16}$. The communication reception begins when the TTYINP module is called.

## Serial Input Initiation Example

| TTYINP | EQU $035 F_{16}$ | Address of input module |  |
| :--- | :--- | :--- | :--- |
| BUFFER | EQU 07F9. | Input buffer address |  |
| NCHAR | EQU 80 | Number of characters to be received |  |
| TTYIBU | EQU 07F9 | 07F | Operating system address constant |
| TTYIC | EQU 07FD | Operating system address constant |  |
|  | LD HL, BUFER | Set buffer for operating system |  |
|  | LD (TTYIBU), HL |  |  |


| LD A, NCHAR | Set character count for operating system |
| :--- | :--- |
| LD (TTYIC), A |  |
| CALL TTYINP | Call UART serial input routine |

The data read by the serial input module will be stored in the user-specified buffer until the input sequence is terminated. When this occurs, control is returned to the user's program at the next instruction. Termination of the input process may be due to any of the following conditions:

- A status error is detected
- The number of characters read equals preset count
- The receipt of a carriage return as an input character (ASCII OD 10 )

In the event that a status error is detected, the A register will be equal to $80_{16}$ when control is returned to the user. If termination results from filling the character buffer correctly, the $A$ register will be equal to $00_{16}$. However, if termination is the result of a carriage return, the $A$ register will be equal to the number of characters remaining to be input. Figure 6.2 details the logic flow of the ITYINP software module.


Figure 6.2 A serial input module (TTYINP) flowchart.

## Serial Output Module

The serial output module is provided to assist the user in communicating serial output data to external devices. To use this module, the operator designates an output data buffer address and the the number of characters (bytes) to be transmitted. The output buffer address must be stored at $07 \mathrm{FB}_{16}$ in memory (see Appendix D ) and the number of characters to be sent is stored at address $07 \mathrm{FE}_{16}$. Data transmission starts when TTYOUT is called.

## Serial Output Initiation Example

| TTYOUT | EQU | $039 \mathrm{E}_{16}$ | Address of output module |
| :--- | :--- | :--- | :--- |
| BUFFER | EQU | $07 \mathrm{FB}_{16}$ | Output buffer address |
| NCHAR | EQU | 35 | Number of characters to be transmitted |
| TTYOBF | EQU | $07 \mathrm{FB}_{16}$ | Operating system address constant |
| TTYOC | EQU O7FE |  |  |
|  | LD HL, BUFFER | Operating system address constant |  |
|  | LD | Set buffer address for operating system |  |
|  | LD AOBF), HL |  |  |
|  | CALL TTYOUR | Set character count for operating system |  |
|  | Call UART serial output routine |  |  |

Control will be returned to the user when

- The output buffer is empty
- The transmit buffer does not become available, indicating an error

In the event that a normal termination occurs, the A register will be equal to $00_{16}$ when control is returned to the user. However, if a premature termination and return are required, the A register will be equal to $01_{16}$. Figure 6.3 details the logic flow of the serial output software module.


Figure 6.3 A serial output module (TTYOUT) flowchart.

## II. Operating System Module Description

## II. 1 Warm Start Module

The warm start module (WARM1) is responsible for saving all Z80 registers in the register save area allocated in the reserved portion of programmable memory (see Appendix D). Upon entry, the user's A, H, and L registers are saved to provide working registers for the remainder of the module operation. Next, the user's PC is removed from the stack and is saved in the memory locations reserved for it.

The AF register pair is pushed onto the stack and popped off into the HL register pair. This procedure enables the flag register to be saved in the register save area. The remainder of the user's working and alternate registers are examined and transferred to the register save area. Upon completion of this task, the module exits to the command recognition module. (See Appendix D for additional details.) Figure 6.4 details the logic flow of the warm start module.


Figure 6.4 A flowchart of the warm start module (WARM).

## II. 2 Command Recognition Module

The command recognition module (WARM2) is entered after the completion of a cold or warm start sequence. When initiated, the module clears the keyboard input buffer and the keyboard flags. This removes ambiguity for future operations. The module will set the data display to FF and the address display to FFFF. When completed, the module enters the KEYIN subroutine to get an input character from the keyboard. Any input character is checked to see if it corresponds to one of the three allowable functions. If so, control is transferred to the proper function; otherwise, the input is ignored and the module waits for the next input from the keyboard. (See Appendix D for additional details.) Figure 6.5 illustrates the logic flow of the command recognition module.


Figure 6.5 A flowchart of the command recognition module (WARM2).

## II. 3 Restart Module

The restart module (RESTRT) takes the values stored in the programmable memory register save area. It then restores the user's 8 - and 16 -bit registers before returning control to the location specified in the PC save area. This procedure restores the alternate registers, and then the working registers. In either instance, the flag registers are restored by pushing the data onto the stack and then popping if off to the F register. In order to exit to the user's restart address, the saved PC is pushed onto the stack and a "RET" (return instruction) is executed. (See Appendix $D$ for additional details.) Figure 6.6 details the logic flow of the restart module.


Figure 6.6 A flowchart of the restart module (RESTRT).

## II. 4 Keyboard Input Module

The keyboard input module (KEYIN) provides the primary interface between the computer and the user. Upon entry, it begins to read data from the keyboard input port. It stays in a loop, checking the MSB (most significant bit) of the data. The MSB is the key-pressed strobe. When it goes to a logic one level, the seven LSBs (least significant bits) of the keyboard input port are retained as the desired input character. The module then returns to the user's program with the keyboard character in the accumulator. (See Appendix D for additional details.) Figure 6.7 details the logic flow of the keyboard input module.


Figure 6.7 A flowchart of the keyboard input module (KEYIN).

## II. 5 One Character Input Module

The function of this module (ONECAR) is to input one or more characters from the keyboard. This module also indicates the last character and whether it was accompanied by a "NEXT" or "EXEC" key.

Upon entry, the input buffer and keyboard flags are cleared. (The data display may or may not be cleared depending on the requirements of the calling module.) The module waits for an input character to be passed to it. When it receives a character, it checks to see if it is a "NEXT", "EXEC", or valid data. In the event that the input is a "NEXT" or "EXEC", the appropriate keyboard flag is set along with the no data flag and control returned to the user (see figure 6.8).

If an invalid data character is received, the module is reinitiated. Upon receipt of valid data, the data is stored in a 1-byte input buffer, and the module waits for the next input character. This character is processed in a manner similar to the one just described with the following exception: in the event that the input character is a "NEXT" or "EXEC", only the appropriate flag is set before returning control to the user. (See Appendix D for additional details.) Figure 6.9 shows the logic flow of the one character input module.


Figure 6.8 The configuration of the keyboard flags.


## II. 6 Two Character Input Module

The function of this module (TWOCAR) is to input one or more characters from the keyboard and transfer to the user the last two characters when a "NEXT" or "EXEC" key is pressed. The module also notifies the user of the type of termination that took place.

Upon entry, the input buffer and keyboard flags are cleared. (The data display may or may not be cleared depending on the requirements of the calling module.) This module calls the keyboard input module to obtain its input data. The first character is checked to determine if it is a "NEXT" or "EXEC"; the appropriate keyboard flag is set along with the no data flag, and control is returned to the user (see figure 6.8). If an invalid character is received, the module is reinitiated.

The receipt of valid data will cause the module to format the data as a two-digit value in the keyboard input buffer. It then returns to the user with the appropriate flags set. (See Appendix D for additional details.) Figure 6.10 details the logic flow of the two character input module.


Figure 6.10 A flowchart of the two character input module (TWOCAR).

## II. 7 Four Character Input Module

The function of this module (FORCAR) is to input one or more characters from the keyboard and to transfer to the user the last four characters when a "NEXT"
or "EXEC" key is pressed. In the event that less than four characters are input, the higher order digits will be set to zero. The module also notifies the user via the keyboard flags (see figure 6.8).
The operation of this module is very similar to the two character input module. The main difference lies in the manner in which the new data (input from the keyboard) is merged into previous input data from the keyboard. (See Appendix D for additional details.) Figure 6.11 shows the logic flow of the four character input module.


## II. 8 Memory Display and Replace Module

The memory display and replace function is one of the three major modules of the operating system. Upon entry (see command recognition module), this module (MEMORY) makes a call to FORCAR (four character input module) to get the base memory address at which to begin displaying the memory contents. When it returns from FORCAR, the keyboard flags are examined to determine if the "EXEC" flag is set (=1). In the event that the "EXEC" flag is set, control is transferred to the restart module (RESTRT). If the "EXEC" flag is not set $(=0)$, the address location and memory contents are output to the appropriate displays. The TWOCAR (two character input module) is called to obtain new data from the displayed memory location.


Figure 6.12 A flowchart of the memory display and replace module (MEMORY).

When control is returned from TWOCAR, the module checks the "no data" flag in the keyboard flag word. If this flag is set $(=1)$, the "EXEC" flag is examined. If that is set, control is transferred to the command recognition module (WARM2). If, on the other hand, the "EXEC" flag is reset ( $=0$ ), the user's memory address is incremented, displayed on the address display, and its contents are displayed on the data display.
If, on return from TWOCAR, the "no data" flag is reset ( $=0$ ), the new data is extracted from the keyboard input buffer and stored in the displayed memory location. At this time, the module determines if TWOCAR was exited via an "EXEC" or "NEXT" directive. In the event that the "EXEC" flag is set ( $=1$ ), control is transferred to the command recognition module (WARM2). If, however, the flag is reset $(=0)$, the user's memory address is incremented, displayed on the address display, and its contents are displayed on the data display. Then the two character input module is called to get the next directive for the memory display and replace module. (See Appendix D for additional details.) Figure 6.12 shows the logic flow of the memory display and replace module.

## II. 9 Register Display and Replace Module

The register display and replace module (REGIST) is one of the three major modules of the operating system. This module calls the ONECAR (one character input module) to get the initial register display code from the user (see table 6.1). Upon return from ONECAR, the "EXEC' flag is checked. If this flag is set (=1), control is transferred to the command recognition module (WARM2). If the "EXEC" flag is reset ( $=0$ ), the base register display index is calculated from the user's register display code.

At this time, the register index is checked to see if the register request is an 8 - or 16 -bit register. If the user requests a 16 -bit register, the appropriate register code is displayed in the data display, and the requested register data is obtained from the register save area and displayed in the address display. The module then makes a call to the FORCAR (four character input module) to get new data for the register. Upon return, the "no data" flag is checked. If this flag is set and the "EXEC" flag is set, control is transferred to the RESTRT (restart module). If the "no data" and "NEXT" flags are set, the register display index is incremented and displayed in the data display. The new register data is obtained from the register save area and displayed on the address display.

If an 8 -bit register has been requested, the register code (see table 6.1) is displayed in the data display, and the appropriate data is obtained from the register save area and displayed on the address display. At this time, the module calls TWOCAR to get new data from the displayed register. When the two character input module returns control, the module determines the mode of execution by examining the keyboard flags. If the "no data" and "EXEC" flags are set, control is transferred to the command recognition module (WARM12). If the "no data" and "NEXT" flags are set, the register index is incremented and the register contents channeled to the appropriate display.

If the "no data" flag is reset, the new register data is obtained from the keyboard input buffer and stored in the appropriate register save location. At this time the "EXEC" flag is checked and, if set, control is transferred to the command recognition module (WARM2). If the "EXEC" flag is reset, the register data is displayed and the user directive processed. (See Appendix D for additional details.) Figure 6.13 details the logic flow of the register display and replace module.


Figure 6.13 A flowchart of the register display and replace module (REG/ST).

## II. 10 Go Execute Module

The go execute module (GOREQ) is the last of the three major functions of the operating system. Upon entry (see command recognition module), this module calls FORCAR to get the address where execution is to begin. Upon return from FORCAR, the "no data" flag is examined to determine the mode of execution. If this flag is set $(=1)$, control is immediately transferred to RESTRT. This restores the $Z 80$ registers and resumes execution at the PC address currently contained from the keyboard input buffer and stored in the PC save location in the register save area. Control is then transferred to the command recognition module (WARM2) which will restore the registers with the saved data, and begin execution of the user's program at the specified address. (See Appendix D for additional details.) Figure 6.14 details the logic flow of the go execute module.


Figure 6.14 A flowchart of the go execuit module (GOREQ).

## CHAPTER 7 PROGRAMMING AN EPROM

The ZAP computer has been designed to be inexpensive, reliable, and easy to construct. To keep costs and complexity to a minimum, some computer features that could be helpful to a beginner have been eliminated. The most visible of the missing features are a front panel and display. While this in no way detracts from the operation of the computer, its inclusion would make initial checkout and program development easier.
To properly test ZAP, a program must be in memory. This program does not have to be very long-only a few instructions are necessary to determine whether the computer runs at all. The problem arises when the user wishes to run a program of 50 or 100 bytes in length. We end up with a "catch- 22 " situation. To effectively enter machine code into ZAP's programmable memory, a program that coordinates this activity must be running in EPROM. Such a program is called a monitor and is outlined in Chapter 6. The catch is that writing the monitor software into an EPROM automatically requires the monitor to be running the programmer. Fortunately, if one has an alternate way of writing the $1 \mathrm{~K} Z A P$ monitor into EPROM, this is no longer a problem.
Rather than leaving the experimenter to his own devices, this section includes information on programming EPROMs. To solve the startup situation, I've outlined a design for a couple of manual ERROM programmers. Loading programs on a manual programmer is tedious. They are primarily intended for much shorter routines such as checking basic system operations. However, one manual unit can be modified to load the full 1 K monitor software. When ZAP is fully operational, you can use it in conjunction with an automatic programmer. This will help in writing a number of EPROMs. In the event that you do not wish to write your own EPROM, consult Appendix A for the availability of preprogrammed EPROMs.

## A Quick Review of EPROMs

It is often desirable to have the non-volatility of ROMs but the read/write capabilities of semiconductor programmable memories. An effective compromise is the EPROM. This is a read-mostly memory. It is used as a ROM for extended periods of time, occasionally erased and reprogrammed as necessary. Erasure is accomplished by exposing the chip substrate, covered by a transparent quartz window, to ultraviolet light. We'll cover erasure at the end of this chapter.

The EPROM memory element used by Intel and most other manufacturers is a stored charge type called a FAMOS transistor (Floating-gate Avalanche injection Metal Oxide Semiconductor) storage device. By selectively applying a 25 V charging voltage to addressed cells, particular bit patterns that constitute the program can be written into the EPROM. This charge, because it is surrounded by insulating material, can last for years. Exposure to intense ultraviolet light drains the charge and results in the erasure of all programmed information.

There are many EPROMs on the market-2708s, 2716s, and 2732s are the major ones. For the most part, computerists have moved away from the very difficult-toprogram 1702 s and have opted for the more easily programmed 2708 s and 2716s. An added benefit is their greater storage density. The newer EPROMs on the market are considerably more expensive than the 2708 . All things considered, the 2708 is the best
buy for the money. At slightly greater expense, you could use the 2758 for a single supply operation. For these reasons, the EPROM programmer outlined in this chapter is the 2708 .

Figure 7.1 is the circuit for a manual 2708 programmer. IC 5 and two sections of IC 3 provide the +25 V program pulse to the EPROM. IC 5 is set for a duration of 1 ms and is triggered by a logic 0 to 1 transition at its input. The EPROM both sources and sinks current through programming pin 18. A combination of devices rather than a simple open-collector driver is necessary. In the write mode, when $\overline{\mathrm{CS}} / \mathrm{WE}$ pin 20 is at +12 V and between programming pulses, pin 18 has to be pulled down by an active device because it sources a small amount of current. The programming pulse itself is about 30 mA and cannot easily be accommodated without emitter-follower configured Q1. This pulse should be between 25 and 27 V at pin 18 . Three 9 V batteries will suffice. (An alternative is to use a commercial encapsulated $24 \mathrm{~V}, 50 \mathrm{~mA}$ puwer supply. The encapsulated supply can be resistor trimmed to produce the desired 25 to 27 V .)
To write a byte into the EPROM, a 10 -bit address designating which of the 1024 bytes will receive the data is preset on switches SW 1 thru SW 10. To start at location 0 , all switches will be in the closed position. Next, the 8 bits that are to be stored are set on switches SW 12 thru SW 19. This data byte should be reflected on the output display LED 1 thru LED 8. Finally, to get the programmer in the write mode, switch SW 11 is set open. Actual insertion of the data occurs when the write pulse pushbution PB 1 is pressed. This fires a 1 ms pulse of 25 V into the 2708 program pin. According to manufacturer's specifications, no single programming pulse should be longer than 1 ms . For maximum data retention, 100 of these programming pulses are recommended (totalling 100 ms per byte).
Unfortunately, 100 ms cannot be applied to a single address all at once. Manufacturers specity that it should be done sequentially and should consist of 1001 -ms applications. In short, it means that for a 25 -byte program, each address should be written with one pulse and then the loop repeated up to 100 times. I have never tried to lengthen the pulse and pregram a 2708 faster than called for. Experience has shown, however, that some EPROMs are completely written with as few as 2 or 3 loops. Obviously, for full retention each address should be rewritten on an automatic programmer.

Reading back the stored contents of a 2708 is easy on the same manual programmer. First, all data input switches SW 12 thru SW 19 are opened to the " 1 " state and then "read :write" switch SW 11 is set in the closed or "read" mode. No other pulsing or clocking is necessary. The output display will show the contents of the byte pointed to by the address input switches SW 1 thru SW 10. It will remain constant until set to another address. Reading out the contents is simply a matter of incrementing this 10 -bit address through the range of program addresses.
A slightly more complex manual programmer is demonstrated in figure 7.2. Three presettable counters are inserted between the address input switches and the EPROM. Instead of changing the switch positions for each address, they are now used only to preset the counters to some beginning address. If we want to program an EPROM starting at hexadecimal 3AA, the switches would be set to that address and the "address preset" switch pressed. The 10 LEDs, LED A0 thru LED A9, would read 3AA as the address. The data to be programmed is set on SW 12 thru SW 19. Pressing the "write data" push button PBI (the renamed "address increment") stores the data from the switches. Successive memory locations are programmed by setting SW 12 thru SW 19 and pressing PB1. Resetting the address counter to zero is accomplished by pressing the clear button.
It is easy to see how this manual programmer, while not greatly improving programming time, facilitates reading memory. Put all the data input switches to the logic 1 level, set the interface to the read mode, and preset and load a start address. Readout is accomplished simply by repeated operation of the address increment button.

## An Automatic Programmer

You will need an operational ZAP computer to build an automatic programmer. The


Figure 7.1 A schematic diagram of a manual 2708 programmer.


Figure 7.2 A srnf natic diagram of a self-incrementing manual 2708 programmer. Light-emitting diodes (LEDS) are to he connected to all 10 address input lines of the 2708. For clarity, only one LED (connected to address line A9) is shown in the diagram. The other LEDS are to be wired in the same way.
complexity of design can be reduced considerably by taking advantage of decoded, but to this point unused, I/O strobes provided in the basic ZAP. The circuit shown in figure 7.3 takes three less chips than the manual programmer in figure 7.2. Its operations, while similar in operation, are quite different in detail.

Four I/O strobes (input and output port 1, and input and output port 4) synchronize the hardware and software. Figure 7.4 shows the logic flow for writing an EPROM. With the EPROM connected directly to the data bus, only the strobes, rather than fulllatched registers, are necessary for this interface.
To write data, the sequence should be as follows: first, an OUT 04 pulses the address counter clear lines, setting them to 0 . Next, the EPROM is set to the program mode, and the first byte is written into the EPROM with an OUT 01 instruction.
Figure 7.5 shows how the 2708 program mode is selected. The significance of this circuit is that its output is wired as a 2 -bit digital-to-analog converter to control the chipselect line of the 2708 .
Wher an OUT 04 is executed, the $\overrightarrow{\mathrm{CS}}$ pin will see 0 volts enabling the read mode. When an OUT 01 is executed, this voltage will be 12 V for program mode. When no strobe is present, $\overline{\mathrm{CS}}$ will be at +5 V and the 2708 will be three-state.
An OUT 01 fires the 25 V program pulse for 1 ms while the pertinent data is on the data bus. After that, an INP 01 is executed, which increments the address counter to the next address position. We are not actually doing any input function, but instead we are using the decoded strobe of the N P 01 instruction to mean "increment address register."
The hardware automatically keeps track of the address, but the software must implement its own counters to keep track of the 0 to 1023 positions as well as the number of times the complete 1024 bytes have been programmed. Remember, the manufacturer suggests 1001 -ms loops.
Reading the EPRON automatically is also very simple. A flow diagram of the logic is shown in figure 7.6. The address counter is cleared again by doing an OUT 04. Data is read by executing an I..P 04. This data can be stored and analyzed. Finally, the address counter is incremented again with an INP 01, and the process is repeated to read the next byte.
While discussion has centered on the Intel 2708 EPROM as the most cost-effective choice, there are many cther EPROMs on the market. Two devices of particular importance (should their price and availability improve by the time you read this) are the Intel 2758 and 2716 . These are 1 K and 2 K single supply ( +5 V ) EPROMs, respectively. The significance for the experimenter is that these parts can be programmed with a single, $50 \mathrm{~ms}, 25 \mathrm{~V}$ program pulse to each address rather than successive $1-\mathrm{ms}$ loops. The three programmer circuits presented are set up for $2708 s$ but can be easily reconfigured for these other devices. Changing the one-shot timing pulse from 1 ms to 50 ms and rewiring a few pins will allow complete programming with just a single run through the addresses (they don't have to be successively programmed, either).

## Erasing An EPROM

EPROMs bought directly from a manufacturer come completely erased. If you plan on writing an EPROM program once, and you either don't want to modify it or you don't make mistakes, forget about erasing. The majority of computerists will want to reprogram EPROMs. It then becomes necessary to know how to erase them. We all know that EPROMs are ultraviolet erasable. However, duration, distance from the light source, and intensity determine the quality of the erasure.
People concerned about maintaining a manufacturer's specifications during the programming sequence should also be advised of the proper erasing methods. Unlike the test read-after-write-loop method for programming, EPROMs are usually removed from the circuit during erasing. Therefore, it is advisable to perform the procedure correctly, or it will have to be repeated.
The typical 2708 EPROM can be erased by exposure to high intensity shortwave ultraviolet light, with a wave length of $2537 \AA$. The recommended integrated dose (UV intensity $\times$ exposure time) is 12.5 watt-seconds per square centimeter $\left(\mathrm{Ws} / \mathrm{cm}^{2}\right)$. The time required to produce this exposure is a function of the ultraviolet light intensity.

Cost and safety, equally emphasized, should be the guiding factors when selecting an ultraviolet eraser. A commercial unit not only specifies its intensity (that allows computation of exposure time), but also includes important interlocks. It is conceivable that some homebrew erasers might have improper shielding that could allow the ultraviolet light to escape or be accidentally turned on while being viewed. Such possibilities can lead to permanent eye damage.

One of the more cost-effective erasers on the market is the UVS-11E by Ultra-Violet Products, Inc, San Gabriel CA, 91776. This unit is made especially for the home computer market and includes some important safety features. The lamp will not operate unless properly seated, and if lifted from its holding tray, it will automatically shut off. At the standard exposure distance of 1 inch, the UVS-11E produces an intensity of $5,000 \mu \mathrm{~W}$ per square centimeter ( $\mu \mathrm{W} / \mathrm{cm}^{2}$ ). Exposure time for the 2708 is easily calculated.

Exposure time ( $\mathrm{T}_{\bar{E}}$ )

$$
\mathrm{T}_{E}=\mathrm{J} \div \mathrm{I}
$$

Where
$J=$ required erasure density of device
$\mathrm{I}=$ incident power density of eraser
For a 2708 which requires $12.5 \mathrm{Ws} / \mathrm{cm}^{2}$
$\mathrm{I}=5000 \mu \mathrm{~W} / \mathrm{cm}^{2}$
$\mathrm{J}=12.5 \mathrm{Ws} / \mathrm{cm}^{2}$

$$
\mathrm{T}_{\varepsilon}=\frac{12.5}{5000 \times 10^{-6}}=2500 \text { seconds }
$$

or $T_{E}=41.6$ minutes for complete erasure


Figure 7.3 A schematic diagram of an automatic 2708 programmer.




Figure 7.5 Programmable control of an EPROM $\overline{C S}$ line in an automatic EPROM programmer.


Figure 7.6 A flowchart cit antomatic EPROM programmer read cycie.

# CHAPTER 8 CONNECTING ZAP TO THE REAL WORLD 

It's now obvious that the ZAP computer can be configured in a number of ways. Depending on your needs, you can go far beyond the basic system I have outlined. If you want a personal computer that is the equivalent of large commercial microcomputer systems, then you must add considerably more memory and peripherals. Accommodations must be made for a more powerful operating system and most probably a high-level language such as BASIC or Pascal. If you intend to use the ZAP computer as a word processing system, then a video display and printer will be required. This, in turn, necessitates adding more parallel and serial ports. Whatever the eventual configuration, the design considerations that went into constructing the ZAP computer do not change.
The ZAP computer is intended as a trainer. This book is structured in such a way that you should be able to lay out a system configuration and build it. I have not discussed what it takes to design a word processing system, or to add floppy disk storage, because it is beyond the scope of this introductory text. The support material necessary to adequately cover such an undertaking would be enough for another book. This does not mean, however, that everything is finished once the ZAP computer is constructed and you learn how to write and execute a short program. Quite the contrary; a more significant application of ZAP is to connect it to something considered part of the "real world" and have it perform some constructive task. ZAP's "power to weight" ratio makes it a natural for intelligent control applications. The real key to using ZAP effectively is learning how to connect it to the real world.
Within the framework of the direct examples I have outlined, the ZAP computer created from this book should be a single-board computer suitable for use in a variety of applications. Because it includes a serial port, two parallel ports. PROM monitor, and programmable memory, ZAP is in many respects equivalent to commercial digital controllers costing hundreds of dollars more.

Small single-board computers are most often used in data acquisition and intelligent control applications. Their function is usually to digest certain input parameters and compute a result. For example, in a 100 HP electric motor control, the inputs would be voltage, current and RPM, and the control output would be a load factor correction voltage.
In all probability, a few of these "intelligent controllers" were used by the press that printed this book. A likely place is the electronic control unit that monitors print density and automatically adjusts ink flow. The computer "reads" the print and decides whether to increase or decrease the ink flow to the paper. This decision must take into account various input parameters such as humidity, temperature, paper velocity, and specific gravity of the ink. The control algorithm written in machine code and stored in ROM shifts through all the input data and generates its conclusion in the form of a proportional output to an ink-flow valve.
In most cases, computerized functions do not stop with simple control. In any process where repeatability and quality control are important, significant process parameters are constantly monitored for deviation from preset limits and an alarm is set if the limits are exceeded. To aid in long-term analysis, the data acquisition function often includes recording raw-process data from the input sensors at specific intervals and gen-

## THE REAL WORLD

I don't want to confuse you by discussing too many commercial applications of sin-gle-board controllers. I doubt there are many web presses hidden in closets to which you want to add computer control. There are, however, many equally challenging and less esoteric applications for computer controls around the home. For example, a few that come to mind include energy management, security, and environmental monitoring. I refer to such systems as real world systems, as opposed to the TTL digital world of computers.
Because real world is anything outside of the computer, it is generally an analog environment. The metamorphosis of ZAP into an intelligent controller is dependent primarily upon effective analog interfacing. For this reason, the rest of this chapter is dedicated to the design and construction of an economical analog I/O interface.

But first let's review the basics of D/A (digital-to-analog) conversion and then discuss a method to use a D/A to perform A/D (analog-to-digital) conversion. In data acquisition systems, there is often a need to acquire high resolution multiple channels, and $A C$ as well as $D C$ inputs. This being the case, I will also discuss a circuit which, in effect, allows ZAP to function as an 8 -channel digital voltmeter. Finally, because the temporal relationship of so many events is significant, ZAP will be configured with a real-time clock that defines the time at which control operations occur.

## DIGITAL-TO-ANALOG CONVERTERS

The D/A (digital-to-analog) converter can be thought of as a digitally controlled programmable potentiometer that produces an analog output. This output value ( $\mathrm{V}_{\text {our }}$ ) is the product of a digital signal (D) and an analog reference $\left(\mathrm{V}_{\text {REF }}\right)$ and is expressed by the following equation:

$$
V_{\text {VIT }}=D V_{R E F}
$$

To a large extent, no D A or A D converter is very useful without specifying the type of code used to represent digital magnitude. Converters work with either unipolar or bipolar digital codes. Unipolar includes straight binary and binary coded decimal (BCD). Offset binary, one's or two's complement and Gray code, is usually reserved for bipolar operation. However, we will limit our discussion to straight and offset binary.
It is important to remember that the binary quantity presented by the computer is a representation of a fractional value to be multiplied by a reference voltage. In binary fractions, the MSB (most significant bit) has a value of $1 / 2$ or $2^{-1}$, the next MSB is $1 / 4$ or $2^{-2}$, and LSB (least significant bit) is $1 / 2^{n}$ or $2^{-n}$ (where $n$ is the number of binary places to the right of the binary point). Adding up all the bits produces a value that approaches 1. (The more bits, the closer that value is to 1.) The algebraic difference between the binary value that approaches 1, and 1, is the quantization error of the digital system (to be discussed later).

Offset binary is similar to straight binary except that the binary number 0 is set to represent the maximum negative analog quantity; the MSB is a 0 for negative analog values, and a 1 for positive analog values.
The conversion of digital values to proportional analog values is accomplished by either of two basic conversion techniques: the weighted-resistor $\mathrm{D} / \mathrm{A}$ converter and the R-2R D/A converter. The weighted-resistor D/A converter is by far the simplest and most straightforward. This parallel decoder requires only one resistor per bit and works as follows: switches are driven directly from the signals that represent the digital number $D$; currents with magnitudes of $1 / 2,1 / 4,1 / 8, \ldots 1 /\left(2^{n}\right)$ are generated by resistors with magnitudes of $R, 2 R, 4 R, \ldots 2^{n} R$, that are connected by means of switches between a reference voltage, $-V_{\text {REF }}$, and the summing point of an operational amplifier. The various currents are summed and converted to a voltage by an operational amplifier (see figure 8.1).
While this may appear to be a simple answer to an otherwise complex problem, this method has some potentially hazardous ramifications. The accuracy of this converter
is a function of the combined accuracies of the resistors, switches (all switches have some resistance), and the output amplifier. In conversion systems of greater than 10 -bits resolution, the magnitudes of the resistors become exceptionally large and the resultant current flow is reduced to such a low value as to be lost in circuit thermal noise.

A reasonable alternative to the weighted-resistor $\mathrm{D} / \mathrm{A}$ converter is the $\mathrm{R}-2 \mathrm{R}$ converter. This is often referred to as a resistor-ladder $\mathrm{D} / \mathrm{A}$ converter and is the most widely used type even though it uses more components. This circuit (see figure 8.2) also contains a reference voltage, a set of binary switches, and an output amplifier. The basis of this converter is a ladder network constructed with two resistor values, $R$ and 2R.

One resistor (2R) is in series with the bit switch, while the other (R) is in the summing line, so that the combination forms a "pi" network. This suggests that the impedances of the three branches of any node are equal, and that a current I, flowing into a node through one branch flows out as $1 / 2$ through the other two branches. In other words, a current produced by closing a bit switch is cut by half as it passes through each node on the way to the end of the ladder. Simply stated, the position of a switch, with respect to the point where the current is measured, determines the binary significance of the particular switch closure.


Figure 8.1 A 4-bit weighted-resistor digital-to-analog converter. A 4-bit word is _ses to control four single-pole single-throw switches. Each of these switches is in series with $\bar{\prime}$ - sitor. The resistor values are related as powers of 2 , as shown. The other sides of the switches $a \because \succeq こ-$ nected together at the summing point of an operational amplifier. Currents with magnitudes ir: $:=$ ' $s=$ proportional to the resistors are generated when the switches are closed. They are summed by: $-=\sim$ amp and converted to a corresponding voitage.


Figure 8.2 A 4-bit R-2R resistor-tadder digital-to-analog converter. This type of D/A converter makes use of a resistor-ladder network constructed with resistors of value $R$ and $2 R$. The topology of this network is such that the current flowing into any branch of a 3 -branch node will divide itself equally through the two remaining branches. Because of this, the current will divide itself in half as it passes through each node on its way to the end of the ladder. The four switches are again related as powers of 2. The position of each switch with respect to its distance from the end of the ladder determines its binary significance.

This type of converter is easy to manufacture because only two resistor values are needed; in fact, one value, R , will suffice if three components are used for each bit. Keeping matched resistor values with the same temperature coefficients contributes to a very stable design. Certain trade-offs are required between ladder resistance values and current flow to balance accuracy and noise.

One form of the R-2R ladder circuit is the multiplying D/A converter and is available with either a fixed or an externally variable reference. Multiplying D/A converters that utilize external variable analog references produces outputs that are directly proportional to the product of the digital input multiplied by this variable reference. These devices have either current or voltage output. The current output devices are much faster because they do not have output amplifiers that limit the bandwidth; therefore, they tend to cost less than voltage types.

An economical 8-bit multiplying D/A is the Motorola MC1408-8 (see figure 8.3). As previously mentioned, this monolithic converter contains an R-2R ladder network and current switching logic. Each binary bit controls a switch that regulates the current flowing through the ladder. If an 8 -bit digital input of 11000000 ( 192 decimal) is applied to the control lines of the illustrated converter, the output current would be equal to $(192 / 256)(2 \mathrm{~mA})$ or 1.50 mA . Note that when binary 11111111 ( 255 decimal) is applied, there is always a remainder current that is equal to the LSB. This current is shunted to ground, and the maximum output current is $255 / 256$ of the reference amplifier current, or 1.992 mA for a 2.0 mA reference current. The relative accuracy for the MC1408-8 version is $\pm 1 / 2$ the LSB, or $0.19 \%$ of full scale (see figure 8.4). This is more than adequate for most home computer analog control applications.

The final circuit (figure 8.5) is an 8-bit MC1408-8 multiplying D: A converter. As previously outlined, "multiplying" means that it uses an external variable reference voltage. In this case, a 6.8 V zener-diode regulated voltage is passed through a resistor that sets the current flowing into pin 14 to approximately 2 mA .


Figure 8.3 A typical 8-bit current-output monolithic multiplying D/A converter. This Motorola integrated circuit contains an R-2R network like the one in figure 8.2, plus additional current-switching logic.

 tion.


Figure 8.5 A final 8-bit MC1408-8 multiplying digital-to-analog converter with span and offset adjustments.

An additional resistor, R1 (also in this current leg), allows the current to be varied by a small percentage and provides the ability to adjust the full-scale range of the D/A converter. The output is a current that is equivalent to the product of this reference current and the binary data on the control lines. The current is converted to a voltage through IC 9 and can be zero offset through the use of the offset adjustment pot, R2.

Using this circuit with the ZAP computer is simply a matter of connecting the input lines of IC 1 to a convenient parallel output port on ZAP. Any 8-bit value sent to that port will be converted to a voltage proportioned to that output.

The digital code presented to the D/A converter must be in offset binary. A binary value of 00 hexadecimal produces an output of -5 V while FF hexadecimal is equivalent to +5 V . In offset binary, if the MSB is a 0 , the output is negative, and if the MSB is a 1 , the output is positive. Because the converter has a range of 10 V , and is an 8 -bit device, the resolution of the converter is $1 / 256$ of 10 V , or approximately 40 mV . This means that the smallest output increments will be in 40 mV steps. To change this to finer increments requires a shorter range, such as +2.56 V to -2.56 V . By adjusting the span and zero pots, any reasonable range may be chosen, but the resolution will always be equal to the LSB or $1 / 256$ of the range, and accuracy is estimated to be $\pm 1 / 2$ the LSB.

Calibration is fairly straightforward. Apply the power, and with a short program that outputs a value from the accumulator, send a binary 10000000 to the port address corresponding to the D/A interface board. Using a meter to monitor the output of the LM301A, adjust the zero pot R2 until the output is 0 V . With the same program, load in binary 11111111 to the port address and adjust the span pot R1 for a meter reading of +5.12 V . A binary setting of 00000000 should produce -5.12 V . If you are unsuccessful at this point, turn the power off and remove the MC1408-8 and the LM301A; then reapply power and verify that the binary output is correct on the parallel output port. Nine times out of ten, problems like this can be attributed to choosing an incorrect output code.

If the test is successful, you are now ready to generate analog outputs under program control. A simple test is to designate a section of memory and sequentially output the values to the $\mathrm{D} / \mathrm{A}$. If the table is 256 bytes long with the values ranging from 0 to FF hexadecimal in 01 increments, the result will be a sawtooth-waveform output. If the samples are sent to the output rapidly enough, and it is connected to a speaker, the waveform will be audible. The exact frequency will be a function of the update timing loop.

The following is a short program that exercises the $D / A$ in such a manner:

| START | EQU | 0400 | Memory table start HL address |
| :--- | :--- | :--- | :--- |
| END | EQU | 05 | Memory table end H address |
| OPORT | EQU | 07 | D/A output port number |
| SAMP | EQU | AO | Sample rate time constant |
|  |  |  |  |
|  | LD | HL, START | Load table start address |
| AGAIN | LD | A,(HL) | Table value to accumulator |
|  | OUT | OPORT, A | Output byte to D/A |
|  | CALL | DELY | Sample time delay |
|  | INC | HL |  |
|  | LD | A,H |  |
|  | CP | END | Test to see if at end of table |
|  | JP | NZ, AGAIN If not, output the next sample |  |
|  | HALT |  |  |
|  |  |  |  |
| DELY | LD | B,SAMP | Sample rate timing loop |
| DCR | DEC | B |  |
|  | IP | NZ,DCR |  |
|  | RET |  |  |

The table can be set to any length. Values in the table can be calculated to produce any shape waveform.

## ANALOG-TO-DIGITAL CONVERTERS

It's always a good idea to discuss D/A converters first. They are rather straightforward and there are not an overwhelming number of conversion methods. By introducing them first, you will become aware of the process of binary conversion and appreciate the concepts of resolution and accuracy. Practically speaking, however, if you were going to set up the ZAP computer to serve in a data acquisition mode-say, reading and recording temperatures-you would need an A/D (analog-to-digital) converter before a D/A (digital-to-analog).

An A/D does what its name implies. It converts analog voltages into a digital representation compatible with the computer input. As in the case of an 8 -bit D/A, an A/D is subject to the same conversion rules. If you are trying to read a 10 V signal with an 8 -bit converter, the resolution will be $1 / 256$ of 10 V (or 40 mV ) and the accuracy will be $\pm 1 / 2$ the LSB.

For greater resolution more bits are necessary. The number of bits does not set the range of a converter; it only determines how finely the value is represented. An 8 -bit converter (either A/D or D/A) can be set up just as easily to cover a range of 0 to 1 V or 0 to 1000 V . Often the same circuitry is used, but a final amplification stage or resistor-divider network is changed. Understand, of course, that with a range of 1000 V and an 8-bit converter, the resolution is 4 V . Such a unit would be useless on 0 to 10 V signals. The problem can be reconciled in a number of ways, but the easiest solution is to use a converter with more bits. A 16-bit converter that has 65,536 ( $2^{16}$ ) steps instead of $256\left(2^{8}\right)$ would cover the same 1000 V range in 15 mV increments.

For the ZAP computer, the question becomes more one of reasonable price performance than nth degree accuracy.

Analog-to-digital conversion is considerably more expensive than D/A-the price is directly related to resolution and accuracy. There are many ways that A/D conversion can be accomplished. The range varies from very slow, inexpensive techniques to ultrafast, expensive ones. An A D converter can cost as little as $\$ 5$ or as much as $\$ 10.000$. An A/D converter that scans thermistor probes and provides data to control the temperature in a large supermarket may cost $\$ 4.75$, but it cannot encode video information from an optical scanner.

The objective of this book, of course, is to help you to build your own computer; little is served by presenting designs that are beyond a reasonable budget and average construction abilities. For these reasons, I have sifted through a multitude of techniques to select four designs that can easily be built and attached through the ZAP computer's parallel interface. One of them should meet your basic data acquisition requirements.

1. Basic analog to pulse width converter
2. Low cost and low speed 8-bit binary-ramp counter converter
3. High speed 8 -bit successive approximation converter
4. Eight-channel $31 / 2$-digit 0-200 V AC/DC interface

## PULSE WIDTH AND BINARY COUNTER CONVERTERS

## Analog to Pulse Width Converter

This converter is one of the most popular open-loop encoders because of its simplicity. A basic block diagram is shown in figure 8.6. This device uses a fixed oscillator in combination with a circuit that generates a pulse width that is a linear function of the analog input voltage.
To obtain this variable linear pulse width, designers frequently use a ramp generator and a Schmitt-trigger circuit. A gating pulse is started at the beginning of the ramp and a counting circuit starts incrementing at a fixed frequency. When the linear ramp reaches the same value as the input voltage, the counting is terminated. The value left in the register at that point is representative of the analog input.
Figure 8.7 is a schematic of a unipolar analog to puise width converter that operates on this principle. IC 1 is configured as a gate controlled linear ramp generator and IC 2 is the input comparator. The process starts when the 7.5 KHz clock signal fires IC 3 (a 74121 one-shot), and starts its 35 ms period, which is the gate time. At the beginning of this gate period, a pulse that clears the two 7493s and the ramp generator is generated.


| IC \# | TYPE | $+5 V$ | GND | +12V | $-12 V$ |
| :---: | :--- | :--- | :---: | :---: | :---: |
| 1 | LM301A |  |  | 7 | 4 |
| 2 | LM301A | 7 |  |  | 4 |
| 3 | 74121 | 14 | 7 |  |  |
| 4 | 7408 | 14 | 7 |  |  |
| 5 | NE555 | 8 | 1 |  |  |
| 6 | 7485 | 14 | 7 |  |  |
| 7 | 7400 | 14 | 7 |  |  |
| 8 | 7493 | 5 | 10 |  |  |
| 9 | 7493 | 5 | 10 |  |  |
| 10 | 7495 | 14 | 7 |  |  |
| 11 | 7495 | 14 | 7 |  |  |

NOTES: $1 . S E T$ RAMO TO GOFROM OV TO FULL SCALE OLRING SA:APLE GATE TIME.

2 SET FREQ TO PRODUCE WHATEVER COUNT IS DE SIRED TO REPRESENT INPUT VOLTAGE e. 256 COLNTS OURING SAMPLE PERIOD FOR 2.56 VOLTS

Figure 8.7 A schematic diagram of a unipolar analog to puise width converter.

This, in turn, enables the clock signal to the counter. The slew rate of the ramp generator is set to be approximately 10 V per 35 ms . IC 2 continuously compares the input and ramp voltages. When they are equal, the clock signal to the counter is stopped and the ramp generator is reset. At the conclusion of the 35 ms gate time, whatever value is in the counter is transferred to an 8 -bit storage register. The value stored in this register is an 8 -bit number proportional to the input voltage. The entire process starts again on the next clock pulse.

By properly selecting the gate times and the clock rate, you can change the span and resolution of the circuit. With a gate time of 35 ms and a clock rate of approximately $7500 \mathrm{~Hz}, 256$ clock pulses should be counted during the gate time. The ramp timing adjustment pot should be set so that the counter reaches maximum count when 2.56 V is applied to the input of IC 2. A 10:1 divider attached to this input will allow the same 8 -bit count to represent 25.6 V .

This circuit is simple, but its accuracy depends on the stability of the individual sections of the circuit. To use it, connect the register output to a parallel input port. Simply read the port when you want the latest value. The circuit automatically updates 28 times a second, hence no reading is older than 35 ms .

## Binary-Ramp Counter Converter

The above A/D technique is most often used in slow sampling rate, high-accuracy measurements. Achieving these results, however, hinges on the use of precision components and proper construction. The next most productive approach to consider is the binary-ramp counter method. In my opinion, this is the best type if you plan to construct an A/D for ZAP. It uses fewer components and, in practice, is much faster and easier to build than linear-ramp circuits.

Figure 8.8 illustrates the basic biock diagram for the binary-ramp counter converter. The linear-ramp gene:ator of the previous technique has been replaced by a D/A converter. In this case, the D. A is used to reconvert the digital output of the binary counter back to analog for comparison against the analog input. If they are equal, then whatever code is presently set on the D/A input is also our A/D output.


Figure 8.8 A block diagram of a basic binary-ramp counter $A / D$ converter.

The simplest way to operate the system is to start the counter initially at 0 and to allow it to count until the D/A equals or exceeds the analog input. The only critical consideration in designing this circuit is that the clock rate cannot be faster than the response of the comparator and $\mathrm{D} / \mathrm{A}$. If it takes $100 \mu \mathrm{~s}$ for these components to do their job, then the maximum clock rate should be 10 KHz . For an 8 -bit converter (counting from 0 to 256 each sample period), the maximum sample rate is $10,000 / 256$ or some 39 samples a second. In practice, however, $5 \mu$ is a more reasonable settling time, resulting in about 750 samples per second. For still higher speeds, we use a different kind of $\mathrm{A} / \mathrm{D}$ (more on this later).

Figure 8.9 shows a schematic of a binary-ramp counter converter that uses a MC1408-8 multiplying D/A converter chip. The counter output is connected to the MC1408-8 to provide a direct analog feedback comparison of the value set on the counter. Initially, ICs 4 and 5 are cleared, and the D/A output should equal the minimum input voltage. For a 0 to 5.12 V converter, this would be 0 V . For a -2.56 to +2.56 V unit, it would be -2.56 V . If the output of IC 1 is less than $\mathrm{V}_{\text {IN }}$, the clock pulses are allowed to reach the counter. As each pulse increments the counter, the cutput of the D/A keeps rising until eventually it equals or just exceeds $V_{N}$ on the comparator. When this happens, additional clock pulses are inhibited. At the end of the sample period, the count value of ICs 4 and 5 is stored in a separate register. For ZAP to read this data, it just requires connecting this register to an input port and reading it directly.


| IC\# | TYPG | $+5 V$ | GNO | +12 V | -12 V |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | LM301A | 7 |  |  | 4 |
| 2 | LM301A |  |  | 7 | 4 |
| 3 | MC1408-B | 13 | 7 |  | 3 |
| 4 | 7493 | 5 | 10 |  |  |
| 5 | 7493 | 5 | 10 |  |  |
| 6 | 7486 | 14 | 7 |  |  |
| 7 | 7400 | 14 | 7 |  |  |
| 8 | NE555 | 8 | 1 |  |  |
| 9 | 7495 | 14 | 7 |  |  |
| 10 | 7495 | 14 | 7 |  |  |

Figure 8.9 A schematic diagram of an 8-bit binary-ramp counter A/D converter.

## Using the Computer to Replace the Counter

Figure 8.9 is a stand-alone circuit. It does not require the computer for operation. The A/D updates itself at a preselected sample rate and loads this value into an 8 -bit Iatch. As far as the computer is concerned, there is a steady state reading from the converter. Every function required to perform the $A / D$ conversion is constructed from hardware components.

There are certain advantages to this approach. The A/D can be independently assembled and tested without a computer. For example, a voltage can be applied to the input and the 8 -bit value can be displayed on 8 LEDs. The ability to test each subsystem independently is the way I've tried to present all the hardware in this book. If, on the other hand, you feel you've mastered the art of programming and would rather not build elaborate interfaces, much of the hardware of figure 8.9 can be replaced with software subroutines.

Consider for a moment the major elements of this design. This 8 -bit A/D has four sections: D/A, analog comparator, 8 -bit counter, and timing logic. The resistor ladder and analog comparator are necessary components, but the last two sections are prime candidates for synthesis through the computer. The combined function of these devices is to increment an 8 -bit count and check the output of the comparator.

The ZAP computer has parallel input and output ports. By incrementing a central processor register and outputting the value after each increment, the 8 lines from the port will have all the appearances of a standard 8 -bit counter made with 7493 s and so on. By using one bit of an input port to read the status of the comparator, we can also replace the rest of the timing logic.

The resulting interface has fewer components and is shown in figure 8.10. The D/A remains essentially the same except that rather than being driven from two 4 -bit counters, it is connected to an 8 -bit paraliel ou:put port. The analog output of the D A will be whatever value is sent to the output port. Instead of hardwired logic to detect when the $\dot{D} / \mathrm{A}$ and input voltage are equal, we attach the comparator output to bito of an available input port.


Figure 8.10 A software-driven 8-bit analog-to-digital converter.

The conversion process is not unlike the hardware version. First, we clear a register (B, for example) and then output the register value to the port attached to the D/A. This will set the D/A to its minimum output. Next, we read the input port that has the comparator attached to it and check bit 0 (a logic 1 indicates that the input and D/A voltages are equal). If the comparator is low (the voltages are not equal), the register is then incremented and the process is repeated. Eventually, the register will be incremented to the point where the D/A output and the unknown input voltage are equal. The comparator will then switch. At this point the program is halted and the value of the $B$ register is the digital equivalent of the input voltage. The program to accomplish this follows:

|  | MVI | B | Clear B register |
| :--- | :--- | :--- | :--- |
|  | OUT | O,B | Output B register |
| AGAIN | INC | B | Increment B register |
|  | OUT | $0, B$ | Output B register |
|  | IN | O4 | Read comparator port |
|  | ANA | O1 | Isolate bit 0 |
|  | INZ | AGAIN | Continue if voltages not equal |
|  | HLT |  | A/D value is in B register |

The above program should be repeated each time a new reading is needed and the sample rate can be adjusted within broad limits. Remember, however, that we still have to wait for the D/A circuitry to settle and it should not be incremented any faster than $5 \mu \mathrm{~s}$. Lsing the 2.5 MHz Z80 should not present a problem. Using a 4 MHz crystal the central processor might necessitate a few NOPs in the loop.
There are rary variations on this circuit. As described, it takes up to 255 iterations of the program sofind an answer. On a computer with a $2 \mu \mathrm{~s}$ average instruction time, the program covid take $3 \mu$ s to finish, limiting us to about 300 samples a second. Add the other tasks that the computer must perform and you might be limited to 100 samples a second. Executing counting routines takes time; it will not, however, be a problem if you are ree:e.y menitoring a temperature probe that has a 30 -second time constant.
If you should want to track and record fast changing signals, such as an acoustic waveform, then a much taster conversion algorithm is required. One method that sreeds up the process is called successive approximation (more later).
The capabilities of this circuit can be expanded in other ways. An additional CMOS muitipiexor can be connected to 3 bits of another output port to turn this simple circuit into an 8 -channel A/D. Also, because this circuit includes a D/A, its output is available as well.

## Successive Approximation Converters

More than likely one of the three converters presented thus far will suffice for noncritical data acquisition. Slowly changing signals can be handled accurately and efficiently. However, there are occasions when the signal in question is not slow or it carries a particular transient that must be captured. For example, detecting a $100 \mu \mathrm{~s}$ event requires a converter with a capability of 20,000 samples per second. In such cases we need a much faster conversion method.
Figure 8.11 is the schematic of a general purpose high-speed, 8 -bit converter. It is capable of sample rates in excess of 200,000 samples per second. To attain these speeds, a technique called successive approximation is used. Like the binary-ramp counter converter, this $A / D$ also incorporates a $D / A$ in a feedback loop but replaces the counters with a special SAR (Successive Approximation Register). The circular logic of successive approximation is best explained in the block diagram of figure 8.12.

Initially the output of the SAR and mutually connected D/A are at a zero level. After a start conversion pulse, the SAR enables the bits of the D/A one at a time starting with the MSB. As each bit is enabled, the comparator gives an output signifying that the input signal is greater or less in amplitude than the output of the D/A. If the D/A output is greater than the input signal, $a$ " 0 " is set on that particular bit. If it is less than the input signal, it will set that bit to " 1 ". The register successively moves to the next least


| $16 \%$ | TYPE | +5V | G*3 | $+2 \mathrm{VV}$ | -124 | -6V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | MC1408-8 | 13 | 1 |  | 3 |  |
| 2 | MC14559 | 16 | 8 |  |  |  |
| 3 | 74100 | 24 | 7 |  |  |  |
| 4 | LM301A |  |  | 7 |  | 4 |
| 5 | LM710 |  |  | 8 |  | 4 |
| 6 | 7400 | 14 | 7 |  |  |  |
| 7 | 7404 | 14 | 7 |  |  |  |
| 8 | MC1408-8 | 13 | 1 |  | 3 |  |
| 9 | L. 4301 A |  |  | 9 | 0 |  |

NOTES: 1.ALL RESISTORS ARE $1 / 4 W 5 \%$ UNLESS OTHERWISE INDICATED.
2. ALL CAPACITORS ARE 100 V CERAMIG UNLESS OTHERWISE INDICATED.
3. WITH COMPONENTS SHOHN, CLOCK FREQUENCY is 800 kHz . THIS IS 100,000 CONVERSIONS PER SECOND IN FREE RUN MODE.
4. The following circuit can be adoed to EACH OUTPUT PIN OF IC3 FF A VISUAL INDICATOR IS DESIRED.



Figure 8.11 A schematic diagram of an 8-bit successive approximation A/D converter.


Figure 8.12 A bleck diagram of a typical 8-bit successive approximation A/D conversion system.
significant bit (retaining the setting on the previously tested bits) and performs the same test. After all the bits of the D/A have been tried, the conversion cycle is complete. As opposed to the 236 clock pulses of the binary counter method, the entire conversion period takes onily 8 clock cycles. Another conversion would commence on the next clock cycle when it s in the free-run mode. To retain the 8-bit value between conversions, an 8 -bit storage register IC 3 has been added. To use this $A / D$, simply connect the output of this laich to an 8 -bit input port.

The components of the $D$ A circuit are changed slightly from previous implementations to increase the speed, and a faster comparator is used. With a clock rate of 800.000 Hz , the circuit will do 100.000 corversions a second. Because they are automaticaliy loaded into the 8 -bit-holding register IC 3 , the update is transparent to the computer and can be read at any speed. The sample rate is a function of the clock rate. If it is unnecessary to have such a high sample rate, it may be reduced by increasing the value of C1. High speed A/D converters are susceptible to layout and component selection. While 200,000 samples per second is attainable, 20,000 samples per second might be more practical.

## A Unique Application for a Fast A/D

When we first considered adding an A/D to ZAP, our thoughts centered on monitoring some process or turning ZAP into an intelligent controller. In most cases, this requires one of the simpler A/D converters I've outlined. However, with the addition of a high speed A/D peripheral, a few more experiments come to mind.
Most often when we think of high speed analog, we want to capture video or other high bandwidth phenomena that have a voltage level within the range of the A/D. Of course, the audio frequencies, while much lower than video, may also require a high performance A/D for proper representation.

The bandwidth of the human voice is about 4000 Hz . These analog signals, when spoken into a microphone and fed to an A/D, can be digitized just like any other waveform. And, if our voice samples are taken quickly enough and stored, the accumulated data can be used to reconstruct the same voice. This reconstructed voice is called digitized speech.

In essence, digitized speech is simply the result of a standard data acquisition technique. When speaking into a microphone and amplifier, your voice results in a fluctu-
ating waveform, whose frequency rate varies. If this signal is applied to the input of a high speed A/D, and the conversions stored in memory, the computer couldn't care whether the source was speech or a nuclear reaction. The analog fluctuations would be digitized at discrete sampling intervals and stored. If the stored samples are output to a D/A at the same rate they were taken, speech will be reproduced. The fidelity of this reconversion is a function of the sampling rate.

Most of the intelligence or information content of human speech occurs in the frequency region below 1500 Hz . Obviously, sampling this waveform at 25 samples per second would be useless. It must be sampled very rapidly to retain anything of significance.
There is a specific law known as the "Nyquist criterion" that is used to determine the optimal sampling rate. In theory, this law states that at the very minimum, the sample rate must be twice the frequency of the input waveform. Thus, if the human voice extends to 4 Hz , then the minimum rate should be 8000 samples per second. This also presumes an ideal filter on the output, the existence of which is about as ephemeral as perpetual motion. In actuality, the sampling rate should be 3 or 4 times the highest input frequency. To digitize voice accurately requires a sampling rate of 12 Hz to 16 Hz . If, on the other hand, we shoot for just the lower frequencies, we can get by with 3 Hz or 4 Hz .

The possibility of using this speech technique has to be considered in light of the availability of large amounts of memory. At a 4 Hz sample rate, one second of speech takes 4000 bytes of memory. If you have added more than the 2 K of memory in the original configuration of ZAP, then perhaps you'll want to experiment with digitized speech. Even with just 2 K you should hear something.

A fairly simple program is needed to coordinate the digitization process and store the data:

| START | EQU | 400 | Memory table start HL address |
| :--- | :--- | :--- | :--- |
| END | EQU | C00 | Memory table end H address |
| TRIG | EQU | A8 | Input start conversion level |
| IPORT | EQU | 04 | A/D input port |
| SAMP | EQU | 38 | Sample-rate time constant |
|  |  |  |  |
| INP | IN | IPORT | Read A/D input value |
|  | CP | TRIG | Compare input to trigger level |
|  | JP | NZ, INP | Loop again if below trigger level |
|  | LD | HL, START | Load table start address |
| AGAIN | IN | IPORT | Take a sample |
|  | LD | (HL), A | Store sample in memory |
|  | CALL | DELY | Delay between samples |
|  | INC | HL |  |
|  | LD | A,H |  |
|  | CP | END | Test to see if at end of table |
|  | JP | NZ,AGAIN | If not, take another sample |
|  | HALT |  |  |
| DELY | LD | B,SAMP | Start delay timer |
| DCR | DEC | B |  |
|  | IP | NZ,DCR |  |
|  | RET |  |  |

When the program is executed, it will scan the A/D input port and compare the reading to A8 hexadecimal (about $65 \%$ of full scale). When speech is present, the audio level will presumably exceed this trigger level. When this happens, the program sets the address of the storage table and starts dumping data samples into it at a rate of about 4000 per second. The rate is determined by the value of "SAMP." The higher the number, the lower the sampling frequency. When the table is filled, the program stops and the memory will contain a digitized representation of whatever was spoken during the sample time. For 2 K of memory, only $1 / 2$ second of speech will be captured.

To hear this stored data, use the program outlined in the section on $\mathrm{D} / \mathrm{A}$ converters.

Set the limits to be the area of the memory table, then choose a time constant that results in putting out the samples at the same rate that they were taken. (It is also possible to create a digital reverberation system using this hardware, but for decent fidelity 12 - or 14-bit converters are required.)
Because digitized speech is a specialized application, the D/A circuit is modified slightly to include a low-pass filter. This will improve the sound quality. The modified circuit is shown in figure 8.13.


Figure 8.13 an 8-bit D/A converter wh a low pass filter.

Using ZAP for High Resolution Data Acquisition
L'p to this point our discussion has concerned experimenting with ZAP. Some aspects of these designs are usetul in noneducational applications, but for the most part they are intended more as teaching aids than as replacements for expensive monitoring equipment. However, it is possible to add more specialized interfacing to ZAP which allows it to be used in such a manner.
The 8 -bit A/D converters presented thus far have limited resolution and are singlechannel devices. They are adequate for measuring temperature in a solar heating system, but it is doubtful that they have the resolution to monitor the temperature gradient along a length of heating duct. The sensors used to measure such parameters would need to have a higher resolution than ambient air temperature sensors. For a range of -20 to $108^{\circ} \mathrm{C}$, an 8 -bit A/D could provide $0.5^{\circ}$ resolution. In a solar heating application, considering the variations in air movement, cloud cover, and general weather patterns, this is as much resolution as you would need. Within the system, however, there are areas that will require closer measurement.

A solar system is a typical example. After installation the next step is usually to investigate how to increase its efficiency. Nine times out of ten this requires cutting heat losses in the pipes and ducts. One way to determine such loss is to place temperature sensors along the heat distribution path and look for cold spots. The measured differences between sensors may be very small, a few tenths of a degree or so, but the overall losses could be significant. Measuring temperatures to tenths or hundredths of a degree and maintaining the same dynamic range requires more than 8 -bit resolution. Something between 10 and 12 bits is needed.

The situation is further complicated by the large number of points that may need monitoring within a system. It's rare to find only one temperature indicator in the system. At the very least there would be six: inside air, outside air, storage tank top, storage tank bottom, collector, and distribution air temperature.

Very few commercial data acquisition systems use a single channel. Usually they come with either eight or 16 multiplexed channels. The input of one A/D converter is switched (usually on a demand basis) between the channels and the results are compiled and averaged by the computer. This information can be logged on recording tape, transmitted serially to another system, or used to run a real-time display. What one does with the data is a function of the application program.

There are various ways to configure ZAP for high-resolution data acquisition. One is to simply to replace the 8 -bit A/D with a 12 -bit binary converter. When the conversion is finished, 12 bits of parallel data are available. Depending upon the converter chosen, many outboard analog components might still be required, but the process is straightforward. Unfortunately, these converters are not what you would call inexpensive. Although they are becoming cheaper every day, at this writing they are still considerably more expensive than 8 -bit converters of similar speed.

Most 12-bit binary converters are expensive because they are designed to give the appearance of parallel converters. Toggle the convert enable line and zip, there's 12 bits of answer. When the computer wants this data, it scans, manipulates, and stores it in a table for use by other programs. Making the hardware section of an A/D interface less expensive involves doing less in parallel. Taking the alternative serial approach generally requires more time and additional data manipulation. We can opt for the fowest expense and let our computer do most of the work. We have already demonstrated how to eliminate counters and timing logic by doing these functions in software.

## An 8-Channel 31/2-Digit AC DC Interface for ZAP

The solution to the high resolution versus expense question comes in the form of a $3^{1 / 2}$-digit multiplexed A D converter chip. The MC14433 CMOS integrated circuit is intended primarily for use in cig:tal voltmeters (DTMs) but enjoys a variety of other applications because of its versatility. It is a single-channel 11-bit converter, but it is called $31 / 2$ digits. The output is $B C D$ binary-coded decimal) and it specifically covers a range of -1999 to +1909 counts. Basic chip specifications are as follows:

MC14433 $3^{1}$ - -Digit A/D Converter
Accuracy: $\pm 0.05 \%$ of reading $\pm 1$ count
Two voltage ranges: 1.999 V and 199.9 mV 25 conversions per second $1000 \mathrm{M} \Omega$ input impedance Auto zero
Auto polarity
Over, under, and auto ranging signals available

The MC14433 is a modified dual-ramp integrating A/D converter and is outlined in figure 8.14. The conversion sequence is divided into two integration periods: unknown and reference. During the $\mathrm{V}_{i v}$ (unknown input) integration sequence, the unknown voltage is applied to an integrator with a defined integration time constant for a predetermined time limit. The voltage output of the integrator then becomes a function of the unknown input input. The more positive the input, the higher the integrator output.

During the second cycle of the integration sequence, a reference signal of 2.000 V is connected to $\mathrm{V}_{I N}$. This causes the integrator to move toward zero while the digital circuitry of the chip keeps track of the time it takes to reach zero. The time difference between the two integration sequences is then a function of their voltage difference. If 2.000 V were the applied $\mathrm{V}_{I N}$ then $t_{2}$ would equal $t_{1}$. The unknown voltage is equivalent to the ratio of the periods times the voltage reference ( $\mathrm{V}_{\text {REF }}$ ). This is also known as a ratiometric converter. The full scale of the converter is determined by $\mathrm{V}_{\text {REF }}$. Changing $\mathrm{V}_{\text {ref }}$ to 0.200 V will make the 1999 count output represent 199.9 mV instead of 1.999 V full scale.


$$
-45^{\top} \text { is: }
$$

$$
\frac{4}{-=5 F}=\frac{t_{2}}{t_{1}}
$$



Figure 8.14 A simplified representation of a dual-ramp $A / D$ converter.

The output of the DVM chip is a combination of serial and parallel data. There are 4 digit-select and 4 BCD data lines:

## BCD Output Lines

| Pin 23 | Q3 (MSB) |
| :--- | :--- |
| Pin 22 | Q2 |
| Pin 21 | Q1 |
| Pin 20 | Q 0 |

## Digit-Select Outputs

| Pin 19 | DS1 (MSD) |
| :--- | :--- |
| Pin 18 | DS2 |
| Pin 17 | DS1 |
| Pin 16 | DS0 |

With respect to what the computer sees through 74LS04 output buffers, the digit select output is low when the respective digit is selected. The most significant digit ( $1 / 2$ DS1) goes low immediately after an EOC (end-of-conversion) pulse and is followed by the remaining digits in a sequence from MSD to LSD. The multiplex clock rate is the system clock divided by 80 ; two clock periods are inserted between digit outputs.

During DS1, the polarity and certain status bits are available. The polarity is on Q2 and the $1 / 2$ digit value is at Q 3 . If Q 2 is a " 1 ", then the input voltage is negative, and if Q3 is a " 0 ", then the $1 / 2$ digit is a 0 .

Figure 8.15 details the schematic of the 8 -channel interface board. As shown, it has the following capabilities:

## ZAP 3 $1 / 2$-Digit DVM Interface

- 8 programmable-input channels
- AC or DC input capability
- Programmable gain of 1,10 , or 100
- Ranges of $0-200 \mathrm{mV}, 0-2 \mathrm{~V}, 0-20 \mathrm{~V}$, or $0-200 \mathrm{~V}$
- Input overvoltage protection

IC 1 is the MC14433 DVM chip. It is set for approximately 25 conversions a second and all outputs are buffered. IC 2 is a precision voltage reference chip that supplies the $\mathrm{V}_{\text {REF }}$ signal. It is nominally 2.5 V and is trimmed to 2.000 V and 0.200 V with two potentiometers. While a zener diode might provide the same voltage, the temperature drift associated with such components makes them inadvisable in this application.

IC 5 is configured as a set reset flip-flop. When the conversion is finished, an EOC signal sets IC 5 , indicating to the computer that data is available. When the computer finishes reading the data, it resets this flip-flop and awaits the next conversion.

ICs 1, 2, 3, and 4 constitute a single-channel $3: 2$-digit converter. It has a range of either 0.200 V or 2.000 V determined by $\mathrm{V}_{\text {RFF }}$. To achieve multichannel operation and $A C$ capability, it is necessary to place an input multiplexer and $A C$ to $D C$ converter in front of IC 1.


1. ALL AESISTCOS $20 E 5 \% 1 / 4$ W UNLESS OTHERWISE NOTED
2. ALL CAFAC:TORS ARE 100 V CERAMIC UNLESS OTHERWISE NOTED

| $I C \#$ | TYPE | $+5 V$ | $-5 V$ | GND |
| :---: | :---: | :---: | :---: | :---: |
| 2 | MC14433 | 24 | 12 | 13 |
| 2 | MC1403 | 1 |  | 3 |
| 3,4 | $74 L S 04$ | 14 |  | 7 |
| 5 | 7474 | 14 |  | 7 |
| 6.7 | CD4053 | 16 | 7 | 8 |
| 8 | CD4051 | 16 | 7 | 8 |
| 9 | 7445 | 16 |  | 8 |
| 10 | $L M 324$ | 4 | 11 |  |



$$
\begin{array}{c|c}
\text { CTRL } & \text { OUTPUT } \\
\hline 0 & \text { AX } \\
1 & \text { AY }
\end{array}
$$



FUNETIONAL OESCFIPTION OF A SINGLE (I OF 3) SWITCHING SECTION OF A CO4053 CMOS SWITCH

PIN DIAGRAM OF SIGMA
RELAY TYPE IGITEIAZ-5S
34 PIN DIP FACKAGE $k \leq 7-10.5-5 \backslash 6!$

Figure 8.15 An 8 -channel $3 / 2$-digit $0-200 \mathrm{~V}$ AC/DC DVM interface (continued on next page).


Figure 8.16 shows the voltage reference and range selection setup of this interface. The MC14433 can cover either $0-199.9 \mathrm{mV}$ or $0-1.999 \mathrm{~V}$. The ranges depend upon the level of $\mathrm{V}_{\text {REF }}$. When B5 of port 1 is low, switches 5 and 6 are in the positions shown. This would apply 2.000 V to $\mathrm{V}_{\text {REF }}$ input and set the integration time constant with an $82 \mathrm{k} \Omega$ resistor. With $\mathrm{B} 5=0, \mathrm{~V}_{\text {REF }}$ is 0.200 V , and the integration resistor is $10 \mathrm{k} \Omega$.
Figure 8.17 illustrates the input subsystem in simplified terms. SW1 and SW2 represent the gain selection section. As shown, the gain is 1 and no divider network is enabled. When an input relay is closed (controlled through IC 9), the input voltage of that channel is sent directly to the input of IC 1 through a $1 \mathrm{M} \Omega$ resistor. If the interface is set for DC and a gain of 1, a 1.400 V input signal at channel 3 would be read directly as 1.400 V by the DVM chip. If, however, 150 V were suddenly applied, it would be shunted through $Z 1$ and $Z 2$, which protect IC 1 . The data read by the computer will indicate an out of range condition because the input would be shunted to 4 V .

Closing SW1 or SW2 forms a divider network that allows the computer to read these higher voltages. A $10: 1$ divider is formed by closing SW1. The result is a divider network consisting of the $1 \mathrm{M} \Omega$ resistor R 1 , and a $111 \mathrm{k} \Omega$ resistor R 2 to ground. An 8 V input signal would be read as 0.800 V at the input of IC 1. The programmer should keep in mind that a divider was used on that channel and multiply the answer by 10 when recording it.

Closing SW 2 forms a $100: 1$ divider. The mathematics is the same except that the resistor ( R 3 ) is now $11.11 \mathrm{k} \Omega$. An 8 V input would become 0.080 V and a 150 V input would become 1.500 V . Obviously, proper range selection is necessary to maximize resolution.
An additional feature of this interface is the ability to accommodate $A C$ inputs. This is accomplished by simply converting the $A C$ signal to $D C$ after the divider section output. IC 6 and IC 7 function as single-pole, double-throw switches to gate the converter in or out of the signal path. The actual AC-to-DC converter is shown in figure 8.18.
This device is known as an average RMS (Root Mean Square) converter. If you apply a 1.0 V peak AC signal to it, it will output 0.707 VDC . This is the technique used in most digital multimeters. This is also the way we commonly express AC voitages. For example, household 115 VAC is 115 V average RMS. The peak is about $1 \% 6 \mathrm{~V}$. The converter passes both $A C$ and $D C$ because there is no blocking capacitor on the input. If it is inadvertently switched into a DC signal, it will multiply the reading by 1.414.


Figure 8.16 Voltage reference and integration time-constant modification circuitry for the digital voltmeter.


Figure 8.17 D.:. Fut conditioning sections.


Figure 8.18 A schematic diagram of an $A C-t o-D C$ converter.

## Exercising the Interface with a Software Driver

The interface is attached to ZAP through I/O ports. It takes 10 input bits and 8 output bits for full operation. They are arbitrarily chosen as ports 1 and 4 for this description. The actual choice will depend on what addresses you wire when you are configuring ZAP. These ports are not used for anything in the original description and will require the proper port hardware to be added. Summarizing the I/O requirements for the DVM (digital voltmeter) interface:

## Command Output Byte (port 1 output)

| B7 | EOC enable or disable | Disable $=1 ;$ Enable $=0$ |
| :---: | :---: | :---: |
| B6 | AC or DC select | $\mathrm{AC}=0 ; \mathrm{DC}=1$ |
| B5 | 2.0 V or 0.2 V range | $2.0 \mathrm{~V}=0 ; 0.2 \mathrm{~V}=1$ |
| $\left.\begin{array}{l} \mathrm{B4} \\ \text { B3 } \end{array}\right\}$ | gain code | $\begin{aligned} & 0,0=X_{1} \\ & 0,1=X 10 \\ & 1,0=X 100 \end{aligned}$ |
| $\left.\begin{array}{l}\text { B2 } \\ \text { B1 } \\ \text { B }\end{array}\right\}$ | channel code | channels 0-7 binary |

## Status Input Byte (port 4 input)

B7
B6
B5
not used
B4
B3
B2
B1 out cf range
Bo end of conversion
Data Input Byte (port 1 input)
B7 1st digit
B6 2nd digit
B5 3rd digit
B4 4th digit
B3
$\left.\begin{array}{l}\mathrm{B2} \\ \mathrm{B1} \\ \mathrm{BO}\end{array}\right\} \quad \mathrm{BCD}$ value
when $B 7=0$ then: $B 6$
B5 not used
B4
B3 $\quad 1 / 2$ digit value
B2 polarity
B1 not used
BO autoranging status bit

This interface uses a software driver to reduce hardware complexity. The program is not unlike a communications driver. To obtain data from the interface effectively, the computer must be synchronized with the DVM chip and must perform a specific sequence of operations to demultiplex the input data stream.
The actual program that interfaces to and stores the values from the DVM chip is written as a subroutine. All the information necessary for proper execution of the driver is provided in the DE register pair at the time of the call. Its contents will tell the interface which channel to set, whether it should be AC or DC , and which $\mathrm{V}_{\text {REF }}$ and gain to use. One channel is converted every time the driver routine is called.

The information set in the DE register pair at the time of the call is the command out-
put byte (port 1 output), and each bit has the designations previously listed. The only difference is that bit 7 (the enable/disable bit to the A/D converter) is sent as a logic 0 when doing a call. The driver will set it to an enable condition after it has pulled in the proper relay and allowed a 1.3 ms bounce delay.

Demultiplexing the output of the DVM chip is fairly straightforward. Following the call, the outputs to the interface close the proper switches, and the central processor hangs in a loop waiting for an end-of-conversion signal. When this happens, the program knows that the next 4 digits of data are what it wants. The DVM chip sets each of the digit select lines successively, and the program records the values of the 4 BCD data lines each time. It strips the status and polarity bits from the MSD $1 / 2$-digit byte and reformats and stores the voltage input value in 4 bytes of memory. The 3 whole digits are stored in BCD notation and occupy 3 of the bytes. The $1 / 2$ digit, polarity, and out of range indication are located in the fourth byte. Polarity is indicated by setting the MSB. A positive reading is a logic 1 and a negative input is a logic 0 . The $1 / 2$-digit value can only be a 0 or 1 and occupies the LSB of the quantity. Out of range is handled with a little program manipulation. If the driver detects that the incoming reading is not within range, it sets the equivalent of +2 in the $1 / 2$-digit byte. Obviously, this is an itlegal condition for a DWI only capable of counting to 1999 . The programmer using this stored data should check the limits of the data before acting upon it.

When the driver completes its operation, it has acquired a $3^{12} 2$-digit reading and stored it as 4 bytes in a special table in memory. The 8 channels of data constitute a 32-byte table. The location of a particular channel's data is found by a simple expression:

The 4-byite data starts at memory location $\mathrm{L}+4(\mathrm{~N}-1)$
where $L=$ starting address of memory table
$\mathrm{N}=$ channel number ( 1 to 8 )
Figure 8.19 is the assembly listing of the program that exercises this DVM interface. When assembled, it cccupies less than a page of memory.

Note: One caution showe be kept in mind when measuring AC signals with this interface. The ground on the DM i interface is the same as the computer's and a potential short circuit exists unless eithe: the computer power supply or the measured voltage is isclated.

| 0100 0110 | * |  |  |
| :---: | :---: | :---: | :---: |
| 0120* |  |  |  |
| 0125 | * FEU. | 1.9 |  |
| 0130* |  |  |  |
| 0140 | [1F' | EQU | 1 |
| 0150 | SIF | ECTU | 4 |
| 0160 | CLF. | EQU | 1 |
| 0170 | EビuC | ECSL | 200 |
| 0180 | EEOC | ECTJ | 000 |
| 0190* |  |  |  |
| 0200 * |  |  |  |
| 0210 | * CONV | FRTEU | CHANNEL |
| 0220 * |  |  |  |
| 0230 | CHANSO | IW | 000000 |
| 0240 |  | IW | 000000 |
| 0250 | CHAN1 | LIW | 000000 |
| 0260 |  | Liw | 000000 |
| 0270 | CHAN | ITW | 000000 |
| 0280 |  | Liw | 000000 |
| 0290 | CHANS | IW | 000000 |
| 0300 |  | IM | 000000 |
| 0310 | CHANA | IW | 000000 |
| 0320 |  | IIW | 000000 |
| 0330 | CHANS | IIW | 000000 |
| 0340 |  | IW | 000000 |

Figure 8.19 A listing of the assembly-language program that exercises the digital voltmeter.



Figure 8.19 : : ritinued

## Potential Applications

I feel that data acquisition is a natural application for ZAP. The interface outlined above can be used in a solar heating system to monitor and record pertinent data. Using the facilities of the ZAP monitor and the DVM interface routine, an 8-channel data logger is practical. In general, all that would be required is a supervisory program that calls the DVM 8 times to obtain the 8 sensor inputs. It then sets the limits of the memory table to a serial output subroutine and stores the readings on a cassette. This could be done continuously or at regular intervals. The ultimate system would include a real-time clock so that these readings, as well as the times at which they were taken, could be recorded.

## Real-Time Clock

If ZAP is going to be used for critical data acquisition or control functions, consideration should be given to real-time synchronization with process events. A simple definition of a real-time system is one that responds to the need for action in a period of
time proportional to the urgency of the need. It boils down to the fact that the computer must be capable of performing a specific action at a specific time. For this to happen, the computer must be able to "tell time."

We can accomplish this by using either software or hardware applications. The simplest technique is to use a clock circuit (figure 8.20) to provide a time tick to the central processor's nonmaskable interrupt line. It can be every 60th, 10th, or 1 second, as suggested in the schematic. When the computer acknowledges the interrupt, it first saves all the registers from the program it was executing, and then services the real-time interrupt. Frequently, the first action is to increment an internal counter that keeps track of elapsed time. Usually it's a value equivalent to the total number of clock ticks, whether in seconds or milliseconds. Once this regular interval has been established, it is easy for the computer to perform real-time functions.

Clock resolutions down to milliseconds sound great and make interval timing extremely accurate. However, I doubt most ZAP builders would want to use such an interface in light of the complex software involved. I much prefer an interface that is easier to implement and more likely to be used.

Essentially, the kind of real-time system most appealing to ZAP owners has a resolution of perhaps 1 minute rather than 1 ms . Also, it's best if it can be read directly in hours and minutes rather than as a total clock count. A direct benefit is reduced overhead. The computer does not have to acknowledge the clock update or scan status flags as often. At first glance, it may not seem like much of a saving, but some routines can use up to 10 percent of the processor time handling a millisecond clock interrupt.


Figure 8.20 A simple time-base generator for an interrupt-driven real-time clock.

## An Old Clock Chip to the Rescue

The easiest way to provide an hourly and minute-by-minute input is to interface the computer to an MOS/LSI clock chip similar to that found on most digital clocks or watches. There are two approaches to the design of a clock interface: one method is to let the clock circuit operate independently from the computer, attached in such a way that the computer can monitor the output lines and extract a time value on the fly. The software necessary for this approach would be very much like the DVM interface described previously. The other method, which I prefer because it involves less software, is to give the computer complete control over the information flow of the clock in a synchronous manner.

Figure 8.21 shows such a clock interface. This circuit, manually preset to keep it simple, is computer directed. The basic 4 -chip circuit consists of an MM5312 4-digit BCD/ 7 -segment output digital clock chip, an MM5369 time-base generator, and two MOS-to-TTL buffers to send data to the processor.

Time is set on the chip by grounding the slow and fast set lines, pins 14 and 15 . To know what is being set you must read the interface at the same time, and display the time on the 4-digit hexadecimal address display, already part of the expanded ZAP. Time is read from the interface as 4 binary-coded decimal numbers. The 8 input lines to the computer are attached to an 8 -bit parallel input port, and are divided between 4 digit-enable lines, and $4 B C D$ digit-value lines. Data appear as a digit enable and an associated BCD number. The tens of minutes data is read on BO thru B3 when B5 is high (B4, B6, and B7 are low). Similarly, B0 thru B3 will hold the tens of hours quantity when $\mathrm{B7}$ is high. The interface logic will stay on a particular digit until it is instructed to proceed to the next digit. Sequencing is under program control and uses one output bit of a convenient parallel port.


Figure 8.21 A schematic diagram of a real-time clock interface.
a) Using a MOS digital clock chip.
b) With battery backup.

Figure 8.22 shows how the multiplexer line is controlled in this application. One bit of an output port is used to pulse multiplexer input pin 22 . (All that is required is a 1 ms pulse. As an alternative, a one-shot could be triggered from a decoded strobe line of an unwired port.) At any time, 1 of the 4 digit-enable lines will be low and a digit's value will be on the $B C D$ output lines. Just determine which digit it is and store the value. Next we pulse the multiplexer input to enable the next digit and save it as well. Conceivably, it takes only 4 iterations of this procedure to obtain a complete 4 -digit reading. If you prefer a more orderly approach, you can follow the program flow outlined in figure 8.23. The only difference is that it waits until the chip cycies to the beginning before storing the readings.


Figure 8.22 The multiplex timing sequence for the display in the circuit of figure 8.21.

MINUTES (TENS)


Figure 8.23 A flowchart of a program for the circuit in figure 8.21.


RETURN OR
REPEAT

## CHAPTER 9

## BUILD A CRT TERMINAL

## LOW COST VERSATILE CRT TERMINAL

This chapter describes the design of a low-cost features-oriented cathode-ray tube (CRT) terminal. Two MOS/LSI devices from Standard Microsystems Corporation reduce the number of parts required for a CRT terminal yet enhance its capabilities.
The two devices, the CRT 5027 video timer and controller and the CRT 8002 video display attributes controller, provide virtually all of the circuitry for the display portion of the CRT terminal. (See Appendices C8 and C9 for specifications.)
The terminal is designed to stand alone and communicate via an RS-232C interface with any computer system. If, in the expanded ZAP, the c-character hexadecimal display proves inadequate, then the experimenter has only to corstruct this unit and attach it to the serial port already assembled.

## Device Description

The CRT ミini contairs the iogic required to generate all of the timing signals (vertical and herizontal synchronization, page refresh memory address, etc.) requireú by a CRT terminal. The entire display format including interlace/non-interlace, characters per row, rows per frame, scans per row, horizontal synchronization pulse wicth, and timing are user programmable for all standard and most nonstandard formats.

Although the CRT 5027 is basically structured for use with its own microprocessor, this design describes a "dumb terminal" using a low-cost PROM and standard TTL logic to replace the microprocessor control. While increasing the number of the parts, this design results in a low-cost, high quality alphanumeric/graphics terminal.
The CRT 8002 provides a $7 \times 11$ dot matrix, 128 character generator ROM, and a high-speed video shift register cursor. It includes logic to generate such functions as underline, blinking, reverse video, blanking, and strike-through. Additional wide and thin graphics modes allow the creation of line drawings, forms and unique graphic symbols.

## Terminal Description

As with most electronic designs, a CRT terminal involves a large number of performance and cost trade-offs. A screen format of 16 rows of 64 characters per row was selected to minimize memory requirements ( 1 K bytes) and keep the video frequency within the limits of lower cost video monitors. An 80 -character line would have not only increased the video frequency beyond the bandwidth of many low-cost monitors, but also would have increased the memory requirements. Similarly, more rows per page would have increased the memory requirement unless the characters per line were reduced.

In many microprocessor applications, the page memory is shared with the processor via a data bus. In this application, the page memory is used strictly by the CRT with data input synchronously, character-by-character, into the cursor position.

Full graphics or attributes may be selected on a character-by-character basis using
control words on the input data bus. A block diagram of the terminal is shown in figure 9.1.


Figure 9.1 A block diagram cia $-\therefore$.cost cathode-ray tube terminat.

## Character Format

The CRT 8002 requires a minimum $8 \times 12$ character block to form its basic $7 \times 11$ character and to provide line and character spacing. However, in order to allow framing a character fully for a reverse video presentation, the horizontal character block must be increased to 9 or 10 dots. For the same reason, allocating 13 lines per character allows top and bottom framing as well.

With the standard TV sweep rates of 60 Hz (vertical) and $15,750 \mathrm{~Hz}$ (horizontal), there are $15,750 \div 60=262.5$ lines per frame. As non-interlaced operation requires an even number of lines, a horizontal frequency of $15,720 \mathrm{~Hz}$ is used. The 16 rows $\times 13$ scan lines per row result in 208 lines of displayed data. The remaining 54 lines will be automatically blanked by the CRT 5027 and will provide upper and lower margins.

To allow for left and right margins as well as for retrace time, a total 80 character times are allocated per line. A good rule of thumb is that the total number of character
times is $25 \%$ greater than the actual number of displayed characters.
The video clock frequency is calculated as follows: 10 (dots per character) $\times 80$ (character times per line) $\times 15,720 \mathrm{~Hz}$ (horizontal sweep frequency) $=12.576 \mathrm{MHz}$. See the worksheet in table 9.1.

| 1. HCHARACTERMATRIX (No. of Dots): | 7 |
| :---: | :---: |
| 2. VCHARACTER MATRIX (No. Of Horiz. Scan Lines): | $1 /$ |
| 3. HCHARACTER BLOCK (Step $1+$ Desired Horiz. Spacing = No.in Dots) : | 10 |
| 4. $V$ CHARACTER BLOCK (Step $2+$ Desired Verlical Spacing $=$ No. in Horiz. Scan Lires): | 13 |
| 5. VERTICAL FRAME (REFRESH) RATE (Freq. in Hz): | 60 |
| 6. DESIRED NO. OF DATA ROWS: | 16 |
| 7. TOTAL NO. OF ACTIVE "VIDEO DISPLAY" SCAN LINES (Step $4 \times$ Step $6=$ No. in.Horiz Scan Lines): | 208 |
| 8. VERT, SYNC DELAY (No. in Horiz. Scan Lines): | 26 |
| 9. VERT. SYNC (No. in Horiz. Scan Lines; $T=190.8 \mathrm{H}^{*}$ ) | 3 |
| 10. VERT, SCAN DELAY (No. in Horiz. Scan Lines; $T=2$ (.59 ms*)* | 25 |
| 11. TOTAL VERTICAL FRAME \{Add steps 7 thru $10=$ No. in Horiz. Scan Lines): | 262 |
| 12. HORIZONTAL SCAN LINE RATE (Step $5 \times$ Step $11=$ Freq. in KHz ): | 5720 |
| 13. DESIRED NO. OF CHARACTEAS PER HORIZ. ROW: | 64 |
|  | 6 |
|  | 7 |
|  | 3 |
|  <br>  | 80 |
|  | 1.2576 |
|  | 12576 |

Table 9.1 A CRT 5027 worksheet for a 64 characters per row, 16 row, no " ": *ed screen format.

## Programming the VTAC

The CRT 5027 VTAC (Video Timer and Controller) is user programmable for all timing and format requirements. The programming data is stored in 9 on-chip registers. Although a microprocessor can easily provide the programming data, a low-cost PROM is used in this application. The 9 registers are programmed as follows (see table 9.2):

Register 0: This register contains the number of character times for one horizontal period, and is normally 1.25 times the number of characters per line, in this case $64 \times$ $1.25=80$. As the internal counters are initialized at zero, the actual number in the register is $80-1=79$.


Register 0
Register 1: This has 3 fields:

1) bit 7 - one for interlace, zero for non-interlace. In this example, noninterlaced operation is selected.
2) bits 3 thru 6 program the number of character times for the width of the horizontal synchronization pulse. This parameter is monitor dependent and is typically
$5 \mu \mathrm{~s}$ ．Because there are 80 character times for a $63.6 \mu \mathrm{~s}$ horizontal scan time （ $1 \div 15,720$ ），each character time is $0.801 \mu \mathrm{~s} ; 7$ character times will be used to generate a $5.56 \mu$ s pulse．
3）bits 0 thru 2 set the horizontal＂front porch．＂This essentially positions the data horizontally．The monitor＇s specification will determine initial programming al－ though some experimentation may be required to center the display exactly．Six character times were selected for the front porch．

| 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Register 1

| REG．\＃ | $\begin{gathered} \text { ADDRESS } \\ \text { A3 AO } \end{gathered}$ | FUNCTION | BIT ASSIGNMENT |  |  |  |  |  |  |  | HEX． | DEC． |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0000 | HORIZ．LINE COUNT 80 |  | 1 | 0 | 0 |  | 1 |  |  | $4 F$ | 79 |
| 1 | 0001 | $\begin{aligned} & \text { INTEQLACE-0 } \\ & \text { HS } \\ & \text { HSO-7 } \end{aligned}$ |  | 0 |  | 1 |  |  |  |  | $3 E$ | 62. |
| 2 | 0010 |  |  |  |  |  |  |  |  |  | 63 | 99 |
| 3 | 0011 | SKEW CHARACTEFS $\qquad$ <br> DATA ROWS $\qquad$ 16 |  |  |  |  |  |  |  |  | $\varepsilon=$ | 143 |
| 4 | 0100 | $\begin{aligned} & \text { SCANS/FRAME } 262 \\ & x=13 \end{aligned}$ |  | 0 |  |  |  |  |  |  | 03 | 3 |
| 5 | 0101 | $\begin{aligned} & \text { VERTICAL DATA START } \\ & =3+\text { VERTICAL SCAN DELAY: } \\ & \text { SCAN DELAY } 25 \\ & =\text { TA START } 28 \end{aligned}$ | 0 | 0 | 0 | 1 |  |  |  |  | $1 C$ | 28 |
| 6 | 0110 |  |  | $\times$ | 0 | 0 |  |  | 1 |  | OF | 15 |



Register 2：This has two fieids：
1：Lits 3 thru 6 （bit 7 is not used set the number of scans per character．In this case， we have defined the character as $10 \times 13$ ，so the binary equivalent of $13-1=$ 12 is used（all CRT 5027 counters start at zero，not one，so programming of counters is always one less than the number）．
2）bits 0 thru 2 contain a 3 －bit code for the number of characters per line．From the data sheet the code for 64 is 011.

| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Register 2
Register 3：This has two fields：
1）bits 6 and 7 delay the blanking cursor and synchronization timing to allow for character generator and programmable memory propagation delays．Generally， one character time will allow for these delays．
2）bits 0 thru 5 define the number of data rows，once again starting with binary zero for one line．16－1＝ 15 will be programmed．


Register 3
Register 4：Register 4 sets the number of raster lines per frame．For the noninterlaced mode this is derived by the formula $(\mathrm{N}-256) \div 2=3$ ．

| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## Register 4

Register 5: This contains the number of raster lines between the start of the vertical synchronization pulse and the start of data (vertical synchronization + back porch). This time must be long enough to allow for the full retrace time of the monitor and to allow vertical positioning of the display. We will use 28 here. The front porch will be calculated by the CRT 5027 as $262-(13 \times 16)-28=26$.


Register 5
Register 6: Register 6, the scrolling register, is programmed with the number of the last data row to be displayed. Since we want to initialize the CRT 5027 , this will be programmed the same as Register 3 (bits 6 and 7 are not used).


Register 6
Register 7 and Register 8: These registers contain the cursor character number and row number respectively. Since the cursor is to be initially positioned at the top left corner, both registers will be initialized with all zeros. Subsecuent cursor position changes will be entered as described under "circuit operation."


## Circuit Description

Reier: and the chatacter cock $D C C$, which is the dot clock $\div 10$ (each character is $i 0$ dots wide. The vicieo dot cock determines the actual video data rate. The characier clock determines the speed each character is addressed. IC 6A buffers the dot cloci input of the CRT 8202 . A pull-up resistor is used on the output to guarantee the losic one requirement of the VDC input.
The LOAD command loads the register information required for pregramming the CRT 5027 from the PROMIC 7 to the CRT 5027. The "self-load" capasitity of the CRT 5027 is used to automatically scan the PROM addresses. LOAD is automatically generated on power-on by IC 1D.
Because of the bus structure of the CRT 5027, cursor position information is loaded on the same bus as the register data. Three-state data selectors IC I4 and IC 15 select cursor $X$ position data from counter IC 8 and IC 7 or curser $Y$ position data from IC 1D. IC 12 and IC 13 select the address mode for the CRT 5027 . Three modes are used: "nonprocessor self-load" for register loading, load cursor X position, and load cursor $Y$ position.
IC 16 thru IC 21 decode attribute mode and cursor controls from the ASCII data bus. If graphics or special attributes are not desired, IC 16, 17, and 21 are not required. Similarly, if cursor controls are directly available, decoding them is not necessary.
IC 19 and IC 20 are $256 \times 4$ PROMs. Their exact programming can be suited to the user needs. The programming used in this terminal is shown in table 9.3. When a key designated as an attribute or mode key is depressed, the appropriate control word is latched in IC 21; all subsequent data entries will have that word loaded in the upper 4 bits of programmable memory. This allows the attribute or mode to be changed on a character-by-character basis. IC 18, a 2 to 4 decoder, is enabled when a cursor control backspace, carriage return/line feed, or $t$ is decoded and provides the appropriate cursor movement.
TTL or low power TTL can be used throughout. Shottky TTL is recommended for IC 6 due to the fast rise time requirements of the clock input.


Figure 9.2 A schematic diagram of a low-cost versatile CRT terminal using the CRT 5027 and CRT 8002 chips (continued on next page).


Figure 9.2 continued

## Operation

After power－on，Control $Q$ should be depressed to latch the system in the＂normal＂ mode．Depressing the space key and the erase key simultaneously will then blank the screen．All further character entries will be displayed normally．If other attributes or graphics are desired，the appropriate control code is entered．This character will not be displayed or cause cursor movement，but will latch the new command．Modes may be changed for every character desired．Cursor movement may be decoded from the ASCII input by the control key as indicated in table 9．3．

## PROM Programming

| Keyboard Entry | Function | Address | PROM 1 Output | PROM 2 Output |
| :---: | :---: | :---: | :---: | :---: |
|  |  | 76543210 | $\mathrm{D}_{1} \mathrm{D}_{2} \mathrm{D}_{3} \mathrm{D}_{4}$ | $\mathrm{D}_{1} \mathrm{D}_{2} \mathrm{D}_{3} \mathrm{D}_{4}$ |
| Return | Carriage Return | 00011011 | 0011 | 1000 |
| LF | Line Feed | 00010101 | 1011 | 1000 |
| Control H | Cursor Left | 00010001 | 0111 | 1000 |
| RS | Cuisor Lp | 00111101 | 1111 | 1000 |
| US | Cursor Right | 00111111 | 1111 | 1010 |
| Control Q | Normal Attribute | 00100011 | 1111 | 1011 |
| Control W | Blink | 00101111 | 1011 | 1011 |
| Control E | Underline | 00001011 | 0111 | 1011 |
| Control R | Reverse Video | 00100101 | 0011 | 1011 |
| Control T | External Mode | 00101001 | 1101 | 1011 |
| Control Y | Wide Graphics | 00110011 | 1100 | 1011 |
| Control U | Thin Graphics | 00101011 | 1110 | 1011 |
| Balance of PROM |  |  | 0011 | 1110 |

Table 9．3 PROいいごこごきー－ning for the circuit of figure 9．2．

## The Rest of the System

Egure 9.3 illustrates the baiance of the circuitry recuited to impement a full $\mathrm{FS}-\mathrm{E} 2 \mathrm{C}$ compatible serial I O ：erminal．Litization of MOS．LSI reduces the package ccu：t to a bare minimum．
$A<22376$ keyboard encoder．IC 1 ，encodes and de－bounces the keyboard switches anj provides an ASCII data wori to the COM 2017 LART isee Appendices C 6 and C7．The LART，in turn，provides the setial receive transmit interface．The data rate is program－able by means of the switch controlied input code to a COM1 8040 data rate generate：see Appendix C10）．

## TERMINAL VARIATIONS

The terminal described can easily be modified for a wide variety of other screen for－ mats．The following changes are required for an 80 －characters per row， 24 －row format：

1．Horizontal sweep rate－to allow for the increased number of displayed lines （312），the horizontal sweep rate is increased to $20,220 \mathrm{~Hz}$ ．
2．The video oscillator frequency is calculated as 9 （dots per character）$\times 100$（char－ acter times per row）$\times 20,220=18.198 \mathrm{MHz}$ ．Notice that 9 dots per character was selected instead of 10 ，as 10 would have resulted in a clock frequency of 20.2 MHz ，which is beyond the CRT 8002A＇s top frequency．IC 4，therefore， must be set for divide by 9 rather than 10 ．
3．An additional 1 K bytes of page memory is required．Figure 9.4 shows the revised address connections．
4．Register programming for the CRT 5027 follows the worksheet shown in tables 9.4 and 9．5．




| ここ | ADDRESS |  | E- - ¢ - ? |  |  |  |  |  |  |  | $\cdots$ | CEC. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| : | 0000 |  |  |  |  |  |  |  |  |  | 63 | 99 |
| - | C001 | $\begin{aligned} & \text { H. } \\ & \text { HS } \\ & \text { HS } \end{aligned}$ |  |  |  |  |  | : |  |  | 53 | 83 |
| 2 | $\because \cdot 0$ |  |  |  |  |  | ${ }^{0}$ |  |  |  | 65 | 101 |
| 3 | $\because ¢ 1$ | $\begin{aligned} & \text { SKEW CHAO: } \\ & \text { DATA ROWS } \end{aligned}$ |  | 0 | 10 | 1 | 0 |  |  |  | 97 | 151 |
| 4 | $\cdots$ | $\begin{aligned} & \text { SCANS/FRAME } 335 \\ & x=-40 \end{aligned}$ |  | 10 | 1 | 0 | It | 10 | 0 | 0 | 28 | 40 |
| 5 | 0105 | VERTICAL DATA STAOT $=3+$ VERTICAL SCAN DELAY: SCAN DELAY DATA START $\qquad$ $\qquad$ |  | 0 | 10 | 1 | 0 | 1 | 0 |  | 15. | 21 |
| 6 | 0110 | LAST DISPLAYED DATA ROW (= DATA ROWS) |  | X | 10 |  | 10 | 1 | 1 | 1 | 17 | 23 |

Table 9.5 A CRT 5027 register-programming worksheet for a $24 \times 80$ screen format.

## Appendix A

## Construction Techniques

## CONSTRUCTION TIPS

As a result of building a project every month for my "Ciarcia's Circuit Cellar" column in BYTE magazine and of constructing every circuit in this book, I feel I can speak as an authority on the subject of prototype construction. A prototype is a nice term that describes the one-of-a-kind kluge that you build from a schematic. This is opposed to the kit or semi-assembled project that includes a printed circuit board which only requires plugging in components.

Prototyping a circuit is not easy. There are many dos and don'ts, but successful prototyping is primarily a function of experience. And experience comes only by building something.

The text is purposely laid out with this philosophy in mind. I suggest that you start with the power supply. Not only is the rest of the computer useless without it, but it has built-in protective circuitry that is very forgiving if you make mistakes. Also, by constructing the power supply first, there is less likelihood of destroying the rest of the computer as you are testing the power supply.
In general, the cardinal rule of prototyping is: be neat. The ZAP comp:es has high frequencies. Wiring should be the shortest distance between two cernec::ons. The lunger the wire, the more of an antenna it becomes. In extreme cases. tre computer can actually cease to function because of induced electrical noise. Wi: the relatively slower digital signals carried by the wiring attached to exteraiainput and output ports, the situation is less critical. Short pulses and high-speed data, suici. as the signals on the central processor control and address lines, are more critical. In these cases, it is always a good idea to use additional protective circuitry such as buiters.

To a certain degree, the ZAP computer can be laid out as you see fit. Figure A. 1 suggests one approach: it can be wirewrapped or hand solceered. Almost any board large enough to accommodate all the chips should suffice. A good choice is a standard S-100 prototyping card available at most computer stores. There is no particular bus other than the standard Z80 signals designated for ZAP because it is primarily intended as a single-board system. The 100 -pin connector provides a convenient $1 / O$ and power connector. Care should be taken if you decide to split the computer schematic and assemble the computer on more than one board. The separation should be between logical subsystems; for maximum success, all signals should be buffered in and out of the board, e.g., all the memory could be put on a separate card. As outlined in the text, the address and data lines necessary to this function are already properly buffered.

The question of wirewrapping versus soldering is the builder's prerogative. Personally, I prefer point-to-point hardwiring because it's easier to modify when troubleshooting. Wirewrapping might be easier where the ZAP circuit has already been tested and refined.
Long power-supply daisy chains should be avoided. Rather than running a single +5 V and ground wire, it is better to use a double-sided prototyping board so that the top and bottom sides of the board can be set to ground and +5 V respectively. With this approach, each chip can be plugged in (using IC sockets) and the power leads soldered directly to the copper planes. Wirewrapping or not, it is a good idea to solder the power leads to reduce the potential of intermittent connections. Using the ground


Figure A. 1 A typical layout of the basic ZAP computer.
plane for wiring is one of the best ways to reduce noise in computers. If you don't have a ground plane, then solder heavy wire around the perimeter of the circuit board and run short jumpers to it.
Decoupling capacitors are another must for computer prototyping. Digital-integrated circuits, while being virtually burn-out proof in most applications, are unfortunately susceptible to noise carried along the power lines. Often, it will cause them to
go into oscillation. By placing a $0.01 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$ capacitor between +5 V and ground about every third IC, the problem is eliminated. Another good idea is to place an electrolytic capacitor at the entrance of any DC power connection to the board. Generally, capacitors are tantalum and three pieces would be required for ZAP's three supplies.
Finally, if you like the concept of ZAP but would rather spend more time applying the finished product than testing your construction techniques, you can look into purchasing various kits and assemblies, including EPROMs programmed for the ZAP monitor. For the latest price list, write or call: The MicroMint Inc, 917 Midway, Woodmere NY, 11598. Telephone: (516) 374-6793.

## Appendix B

## ASCII Codes

| Dec | Octal | Hex | Parity Space or | Character | Control Keybd. Equiv. | Alternate Code Names |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | 000 | 00 | Even | NUL | (1) | NULL, CTRL SHIFT P, TAPE LEADER |
| 001 | 001 | 01 | Odd | SOH | A | START OF HEADER, SOM |
| 002 | 002 | 02 | Odd | STX | B | START OF TEXT, EOA |
| 003 | 003 | 03 | Even | ETX | C | END OF TEXT. EOM |
| 004 | 004 | 04 | Odd | EOT | D | END OF TRANSMISSION. END |
| 005 | 005 | 05 | Even | ENQ | E | ENQUIRY, WRU. WHO ARE YOU |
| 006 | 006 | 06 | Even | ACK | F | ACKNOLILEDGE, RU, ARE YOU |
| 007 | 007 | 07 | Odd | BEL | G | BELL |
| 008 | 010 | 08 | Odd | BS | H | BACKSPACE, FEO |
| 009 | 011 | 09 | Even | HT | 1 | -OFZZONTAL TAB, TAB |
| 010 | 012 | OA | Even | LF | $J$ | LINE FEED, NEW LINE, NL |
| 011 | 013 | OB | Odd | VT | K | VERTICAL TAB, VTAB |
| 012 | 014 | 0 C | Even | FF | L | FORM FEED, FORM, PAGE |
| 013 | 015 | 00 | Odd | CR | M | CARRIAGE RETURN, EOL |
| 014 | 016 | OE | Odd | SO | N | SHIFT OUT, RED SHIFT |
| 015 | 017 | OF | Even | SI | 0 | SHIFT IN, BLACK SHIFT |
| 016 | 020 | 10 | Odd | DLE | P | DATA LINK ESCAPE, DCO |
| 017 | 021 | 11 | Even | DC1 | Q | XON, READER ON |
| 018 | 022 | 12 | Even | DC2 | $R$ | TAPE, PUNCH ON |
| 019 | 023 | 13 | Odd | DC3 | S | XOFF, READER OFF |
| 020 | 024 | 14 | Even | DC4 | T | TAPE, PUNCH OFF |
| 021 | 025 | 15 | Odd | NAK | U | NEGATIVE ACKNOVILEDGE, ERR |
| 022 | 026 | 16 | Odd | SYN | V | SYNCHRONOUS IDIE, SYNC |
| 023 | 027 | 17 | Even | ETB | W | END OF TEXT BUFFER, LEM |
| 024 | 030 | 18 | Even | CAN | X | CANCEL, CANCL |
| 025 | 031 | 19 | Odd | EM | Y | END OF MEDIUM |
| 026 | 032 | 1A | Odd | SUB | Z | SUBSTITUTE |
| 027 | 033 | 1B | Even | ESC | [ | ESCAPE, PREFIX |
| 028 | 034 | 1 C | Odd | FS | 1 | FILE SEPARATOR |
| 029 | 035 | 1D | Even | GS | ] | GROUP SEPARATOR |
| 030 | 036 | 1 E | Even | RS | $\wedge$ | RECORD SEPARATOR |
| 031 | 037 | 1 F | Odd | US | - | UNIT SEPARATOR |
| 032 | 040 | 20 | Odd | SP |  | SPACE, BLANK |
| 033 | 041 | 21 | Even | $!$ |  |  |
| 034 | 042 | 22 | Even | " |  |  |
| 035 | 043 | 23 | Odd | \# |  |  |
| 036 | 044 | 24 | Even | \$ |  |  |
| 037 | 045 | 25 | Odd | \% |  |  |
| 038 | 046 | 26 | Odd | \& |  |  |
| 039 | 047 | 27 | Even | , |  | APOSTROPHE |
| 040 | 050 | 28 | Even | , |  |  |
| 041 | 051 | 29 | Odd | $)$ |  |  |
| 042 | 052 | 2 A | Odd | * |  | . |
| 043 | 053 | 2B | Even | + |  |  |
| 044 | 054 | 2 C | Odd | , |  | COMMA |
| 045 | 055 | 2 D | Even | - |  | MINUS |
| 046 | 056 | 2 E | Even |  |  |  |
| 047 | 057 | 2F | Odd | 1 |  |  |


| Dec | Octal | Hex | Parity Space or | Character | Control Keybd. Equiv. | Alternate Code Names |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 048 | 060 | 30 | Even | 0 |  | NuMbER ZERO |
| 049 | 061 | 31 | Odd | 1 |  | NUMBER ONE |
| 050 | 062 | 32 | Odd | 2 |  |  |
| 051 | 063 | 33 | Even | 3 |  |  |
| 052 | 064 | 34 | Odd | 4 |  |  |
| 053 | 065 | 35 | Even | 5 |  |  |
| 054 | 066 | 36 | Even | 6 |  |  |
| 055 | 067 | 37 | Odd | 7 |  |  |
| 056 | 070 | 38 | Odd | 8 |  |  |
| 057 | 071 | 39 | Even | 9 |  |  |
| 058 | 072 | 3A | Even | : |  |  |
| 059 | 073 | 3B | Odd | ; |  |  |
| 060 | 074 | 3 C | Even | $<$ |  | LESS THAN |
| 061 | 075 | 3D | Odd | $=$ |  |  |
| 062 | 076 | 3E | Odd | $>$ |  | GREATER THAN |
| 063 | 077 | 3F | Even | ? |  |  |
| $0 ¢ 4$ | 100 | 40 | Odd | @ |  | SHIFT P |
| 065 | 101 | 41 | Even | A |  |  |
| 066 | 102 | 42 | Even | B |  |  |
| 067 | 103 | 43 | Odd | C |  |  |
| 068 | 104 | 44 | Even | D |  |  |
| 0 ¢9 | 105 | 45 | Odd | E |  |  |
| 070 | 106 | 46 | Odd | F |  |  |
| 071 | 107 | 47 | Even | G |  |  |
| 072 | 110 | 48 | Even | H |  |  |
| 073 | 111 | 49 | Odd | 1 |  | LETTER I |
| 074 | $1{ }^{1} 2$ | 4A | Odd | J |  |  |
| 075 | $1 \cdot 3$ | 4B | Even | K |  |  |
| 076 | 114 | 4 C | Odd | L |  |  |
| 077 | 115 | 40 | Even | M |  |  |
| 078 | 116 | CE | Even | N |  |  |
| 079 | 117 | 4 F | OdJ | 0 |  | LETTER O |
| 080 | 120 | 50 | E.eา | P |  |  |
| 081 | 121 | 51 | O-d | Q |  |  |
| 082 | 122 | 52 | Ocd | R |  |  |
| 083 | 123 | 53 | Even | S |  |  |
| 084 | 124 | 54 | Odd | $T$ |  |  |
| 085 | 125 | 55 | Even | U |  |  |
| 036 | 126 | 56 | Even | $V$ |  |  |
| C87 | 127 | 57 | Ond | W |  |  |
| ce8 | 130 | 58 | Odd | $X$ |  |  |
| 0¢Э | 131 | 59 | Even | $Y$ |  |  |
| C90 | 132 | 5A | Even | 2 |  |  |
| C 91 | 133 | 5 B | Ofd | I |  | SHIFT K |
| C92 | 134 | 5 C | Even | 1 |  | SHIFT L |
| C93 | 135 | 5D | Odd | ] |  | SHIFT M |
| 094 | 136 | 5 E | Odd | $\wedge$ |  | 1, SHIFT N |
| 095 | 137 | 5 F | Even | T |  | -, SHIFT O, UNDERSCORE |
| 096 | 140 | 60 | Even | 1 |  | ACCENT GRAVE |
| 097 | 141 | 61 | Odd | a |  |  |
| 098 | 142 | 62 | Odd | b |  |  |
| 099 | 143 | 63 | Even | c |  |  |
| 100 | 144 | 64 | Odd | d |  |  |
| 101 | 145 | 65 | Even | e |  |  |
| 102 | 146 | 66 | Even | $f$ |  |  |
| 103 | 147 | 67 | Odd | g |  |  |
| 104 | 150 | 68 | Odd | h |  |  |
| 105 | 151 | 69 | Even | i |  |  |
| 106 | 152 | 6 A | Even | j |  |  |
| 107 | 153 | 6B | Odd | k |  |  |
| 108 | 154 | 6 C | Even | I |  |  |
| 109 | 155 | 6 D | Odd | m |  |  |
| 110 | 156 | 6E | Odd | n |  |  |
| 111 | 157 | 6 F | Even | 0 |  |  |
| 112 | 160 | 70 | Odd | p |  |  |
| 113 | 161 | 71 | Even | q |  |  |


| Dec | Octal | Hex | Parity <br> Space <br> or | Character | Control <br> Keybd. <br> Equiv. | Alternate Code Names |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| 114 | 162 | 72 | Even | r |  |  |
| 115 | 163 | 73 | Odd | s |  |  |
| 116 | 164 | 74 | Even | t |  |  |
| 117 | 165 | 75 | Odd | u |  |  |
| 118 | 166 | 76 | Odd | v |  |  |
| 119 | 167 | 77 | Even | w |  |  |
| 120 | 170 | 78 | Even | x |  |  |
| 121 | 171 | 79 | Odd | y |  |  |
| 122 | 172 | $7 A$ | Odd | $z$ | VERTICAL SLASH |  |
| 123 | 173 | $7 B$ | Even |  | ALTMODE |  |
| 124 | 174 | $7 C$ | Odd |  | (ALTMODE) |  |
| 125 | 175 | $7 D$ | Even | $\}$ | DELETE, RUBOUT |  |
| 126 | 176 | $7 E$ | Even | OEL |  |  |

## Appendix C1

## intel ${ }^{\circ}$

## 2708 <br> $8 \mathrm{~K}(1 \mathrm{~K} \times 8)$ UV ERASABLE PROM

|  | Max. Power | Max. Access |
| :---: | :---: | :---: |
| 2708 | 800 mW | 450 ns |
| 2708 L | 425 mW | 450 ns |
| $2708-1$ | 800 mW | 350 ns |
| $2708-6$ | 800 mW | 550 ns |


| - Low Power Dissipation - 425 mW | -Data Inputs and Outputs TTL <br> Compatible during both Read and <br> Max. (2708L) |
| :--- | :--- |
| Program Modes  <br> - Fast Access Time -350 ns Max. (2708-1) | Three-State Outputs - OR-Tie <br> Capability |



 system bus structures.


 recuiring fast access: -es.
 package.


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| PROGRAMMING |  |
| :---: | :---: |
| Absolute Maximum Ratings* |  |
| Temperature Under Bias | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| $V_{\text {DO }}$ With Respect to $V_{\text {BB }}$ | +20 V to -0.3V |
| $V_{C C}$ and $V_{S S}$ With Respect to $V_{B B}$ | +15 V to-0.3V |
| All Input or Output Voltages With Respect to $\mathrm{V}_{B B}$ During Read $\qquad$ | +15 V to -0.3V |
| $\overline{\mathrm{CS}} / \mathrm{WE}$ Input Wish Respect to $V_{B E}$ |  |
| During Programming | +20 V to-0.3V |
| Program Input With Respect to $\mathrm{V}_{\mathrm{Ea}}$ | +35V 10-03V |
| Power Dissipation | 1.5 W |

*COMMENT
Stresses above those listed under "Absolute Maximum Fatungs" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the ooerational sections of this specification is not implied. Exposure to absolute maximum rating conctitions for extanded periods may affect device reliability.

## D.C. AND A.C.OPERATING CONDITIONS DURING READ

|  | 2708 | $2708 \cdot 1$ | $2708-6$ | 2708 L |
| :--- | :---: | :---: | :---: | :---: |
| Temperature Range | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\text {CC }}$ Power Supply | $5 \mathrm{~V} \pm 5 \%$ | $5 \mathrm{~V} \pm 5 \%$ | $5 \mathrm{~V} \pm 5 \%$ | $5 \mathrm{~V} \pm 10 \%$ |
| $\mathrm{~V}_{\text {OD }}$ Power Supply | $12 \mathrm{~V} \pm 5^{\circ} \%$ | $12 \mathrm{~V} \pm 5 \%$ | $12 \mathrm{~V} \pm 5 \%$ | $12 \mathrm{~V} \pm 10 \%$ |
| $\mathrm{~V}_{\text {EB }}$ Power Supply | $-5 \mathrm{~V} \pm 5^{5} .2$ | $-5 \mathrm{~V} \pm 5^{\circ} \%$ | $-5 \mathrm{~V} \pm 5 \%$ | $-5 \mathrm{~V} \pm 10 \%$ |

## READ OPERATION

## D.C. AND OPERATING CHARACTERISTICS





 - E- -: es' s_cply capacity only.


## 2708 FAMILY

2708L
RANGE OF SUPPLY CURRENTS VS. TEMPERATURE


2708, 2708-1, AND 2708-6 RANGE OF SUPPLY CURRENTS

VS. TEMPERATURE


ACCESS TIME VS. TEMPERATURE


## A.C. CHARACTERISTICS

| Symbol | Parameter | 2708. 2708t. Limis |  | 2708-1 Limits |  | 2708-6 Limits |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. | Min. | Max. | Min. | Max. |  |
| $\mathrm{i}_{\mathrm{acc}}$ | Address to Output Delay |  | 450 |  | 350 |  | 550 | ns |
| ${ }_{\text {t }}$ O | Chip Select to Output Delay |  | 120 |  | 120 |  | 160 | ns |
| $\mathrm{t}_{\mathrm{DF}}$ | Chip Deselect to Output Float | 0 | 120 | 0 | 120 | 0 | 160 | ns |
| ${ }_{\mathrm{O}}^{\mathrm{OH}}$ | Address to Output Hold | 0 |  | 0 |  | 0 |  | ns |

## CAPACITANCE ${ }^{[1]} \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}$

| Symbol | Parameter | Typ. | Max. | Unit. | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| C.v | Input Capacitance | 4 | 6 | pF | $V_{1:}=0 V$ |
| Cout | Output Capacitance | 8 | 2 |  | $\therefore 2-=\sim$ |

## A.C. TEST CONDITIONS:

Outpu: Load: 1 TTL gate and $C_{L}=100 \mathrm{pF}$ Irpu: $R$ se ard Fall Times: $\leqslant 20 \mathrm{~ms}$
Tim:ng Seasurement Reference Levels: 0.8 V and 2.8 V for F wes: 0.8 V and 2.4 V for outputs. Inpur Puse Leveis 0.05 V to 3.0 V


## A.c. WAVEFORMS ${ }^{[2]}$



NOTES
 C.



## ERASURE CHARACTERISTICS

The erasure characteristics of the 2708 family are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms ( $\mathcal{A}$ ). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the $3000-4000 \AA$ range. Data show that constant exposure to room level fluorescent lighting could erase the typical device in approximately 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the 2708 is to be exposed to these types of lighting conditions for extended periods of time, opaque labels are avaiiable from intel which should be placed over the 2708 window to prevent unintentional erasure.

The recommended erasure procedure (see Data Catalog PROM/ROM Programming Instructions Section) for the 2708 family is exposure to shortwave ultraviolet light which has a wavetength of 2537 Angstroms ( $\AA$ ). The integrated dose (i.e., UV intensity $X$ exposure time) for erasure should be a minimum of 15 W -sec $/ \mathrm{cm}^{2}$. The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with a $12000 \mu \mathrm{~W} / \mathrm{cm}^{2}$ power rating. The device should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure.

## Appendix C2

## intel

## 2716 <br> $16 \mathrm{~K}(2 \mathrm{~K} \times 8)$ UV ERASABLE PROM

## - Fast Access Time

- 350 ns Max. 2716.1
- 390 ns Max. 2716-2
- 450 ns Max. 2716
- 490 ns Max. 2716.5
- 650 ns Max. 2716.6
a Single +5 V Power Supply
- Low Power Dissipation
- 525 mW Max. Active Power
-132 mW Max. Standby Power
- Pin Compatible to Intel 2732 EPROM
- Simple Programming Requirements
- Single Location Programming
- Programs with One 50 ms Pulse
- Inputs and Outputs TTL Compatible during Read and Program


## - Completely Static

The Intel ${ }^{\text {e }} 2716$ is a 16,384 -bit ultraviolet erasabie ard elec: cain; O-Jgiar mable read-only memory (EPROMy Tha 2716 operates from a single 5 -volt power supply, has a statie standby mode, and features tast single address locatior 2 ming. It makes designing with EPROMs faster, easier and more economical.

 The 2716 is also the first EPROM with a static standby mode which reduces the power dissipation witho.: $\because \ldots \mathrm{i}$ : - -3 access time. The maximum active power dissipation is 525 mW while the maximum standby power dissipaior ; : . . 32 mW, a $75 \%$ savings.
The 2716 has the simplest and fastest method yet devised for programming EPROMs - single Du'se $\mathrm{T}^{-}$- e. E =-2gramming.
 time-e: ther indwidually, sequentially or at random, with the 2716 's single address location proy'zotime for ail 16.384 jits is only 100 seconds.


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## PROGRAMMING

The programming specifications are described in the Data Catalog PROM／ROM Programming／nstructions Section．
Absolute Maximum Ratings＊

Temperature Under Bias $\qquad$ $-10^{\circ} \mathrm{C}$ to $+80^{\circ} \mathrm{C}$
Storage Temperature ．．．．．．．．．．．．．．$-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
All Input or Output Voltages with
Respect to Ground ．．．．．．．．．．．．．．．． 6 V to -0.3 V
Vpp Supply Voltage with Respect
to Ground During Program ．．．．．．．．+26.5 V to -0.3 V

COMMENT：Siresses above those Fisted under＂Absolute Maxi－ mumn Ratings＂may cause permanent damage to the device．This is a stress rating only and functional operation of the device at these or any other conditions above those indieated in the operational sec． ions of this specafitation is not implied．Exposure to absolute maxumum rating conditions for extended periods may atfect device reliability．

DC and AC Operating Conditions During Read

|  | 2716 | 2716－1 | 2716－2 | 2716－5 | 2716－6 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Temperature Range | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ | $0^{\circ} \mathrm{C}-70^{\circ} \mathrm{C}$ |
| $V_{C C}$ Power Supply 1,2$]$ | $5 \vee \pm 5 \%$ | $5 \vee \pm 10 \%$ | $5 \vee \pm 5 \%$ | $5 \vee \pm 5 \%$ | $5 \vee \pm 5 \%$ |
| Vpa Power Supply ${ }^{\text {（2）}}$ | Vec | Vec | VCC | $V_{\text {cc }}$ | $V_{\sim c}$ |

## READ OPERATION

D．C．and Operating Characteristics

| Symbol | Parameter | Limits |  |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ．${ }^{\text {3 }}$ | Alax． |  |  |
| It 1 | Input Loas 乞．－ッぎ・ |  |  | 19 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=5.25 \mathrm{~V}$ |
| 1.0 | Output Leakasa C－＊＊＊： |  |  | is | $\mu \mathrm{A}$ | $V_{\text {Out }}=5.25 \mathrm{~V}$ |
| $\left.1: 2 \square^{\prime} 2\right]$ | $V_{\text {Pp }}$ Current |  |  | 5 | mA | $V_{\text {PP }}=5.25 \mathrm{~V}$ |
| 1ここ． 2 ！ | $V_{\text {cc }}$ Current（Standby） |  | 10 | 25 | $m \mathrm{~A}$ | $\overline{C E}=V_{I H}, \overline{O L E}=V_{I L}$ |
| 1082 | $V_{C C}$ Current（Active） |  | $\# 7$ | 100 | mA | $\overline{O E}=\overline{C E}=V_{\text {IL }}$ |
| V。 | Input Low Voltage | －0．1 |  | 0.8 | $V$ |  |
| i $\because$ | Input High Voltage | 22 |  | $V_{C c}+1$ | $\checkmark$ |  |
| － | Output Low Voltage |  |  | 0.45 | $V$ | $\mathrm{I}_{\mathrm{OL}}=2.1 \mathrm{~mA}$ |
| －$=$ | Output High Voltage | 2.4 |  |  | V | $\mathrm{IOH}=-400 \mu \mathrm{~A}$ |





Typical Characteristics


## A.C. Characteristics

| Symbol | Parameter | Limits ins) |  |  |  |  |  |  |  |  |  | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 2716 |  | 2716-1 |  | 2716-2 |  | 2716-5 |  | 2716-6 |  |  |
|  |  | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Mex. |  |
| $t_{\text {acc }}$ | Address 10 Output Delay |  | 450 |  | 350 |  | 390 |  | 450 |  | 450 | $\overline{C E}=\overline{O E}=V_{I L}$ |
| ${ }^{\text {tece }}$ | $\overline{\mathrm{CE}}$ ıo Output Delay |  | 450 |  | 350 |  | 390 |  | 490 |  | 650 | $\overline{O E}=V_{1 L}$ |
| ${ }^{\text {toE }}$ | Outpur Enable to Outpur Delay |  | 120 |  | 120 |  | 120 |  | 160 |  | 200 | $\overline{C E}=V_{1 L}$. |
| ${ }_{\text {t }} \mathrm{F}$ | Output Enasie H.gh to Output Float | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | $\overline{C E}=V_{i L}$ |
| ${ }^{1} \mathrm{OH}$ | Oistout hoid from Addresses, $\overline{\mathrm{CE}}$ or WFitinghever Occurred Furst | 0 |  | 0 |  | 0 |  | 0 |  | 0 |  | $\overline{C E}=\widetilde{O E}=V_{I L}$ |

Capacitance ${ }^{[4]} \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}$

| Symbol | Parameter | Typ. | Max. | Unit | Conditions |
| :--- | :--- | ---: | :---: | :---: | :--- |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance | 4 | 6 | pF | $V_{1}=0 \mathrm{~V}$ |
| Cout | Output Capacitance | 8 | 12 | pF | $V_{\mathrm{V}}=0 \mathrm{~V}$ |

## A.C. Test Conditions:

Output Load: 1 TTL gate and $\mathrm{C}_{\mathbf{L}}=100 \mathrm{pF}$ Input Rise and Fall Times: $\leqslant 20$ ns
Input Pulse Levels: $0.8 \mathrm{~V}: 02.2 \mathrm{~V}$

A. C. Waveforms ${ }^{[1]}$


NOTE. 1. VCC must be applied simultaneously or before Vpp and removed simultaneously or after Vpp.
2. Vpp may be connected directly to VCC except during programming. The supply current would then be the sum of ICC and Ipp1.
3. Typical values are for $T_{A}=25^{\circ} \mathrm{C}$ and nominal supply voltages.
4. This parameter is only sampled and is not $100 \%$ tested.
5. $Q E$ may be delayed up to t $A C C$ - tOE after the falling edge of CE without impact on taCC.
6. TDF is specified from OE or CE, whichever occurs first.

## ERASURE CHARACTERISTICS

The erasure characteristics of the 2716 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms（ $\mathcal{A}$ ）．It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the $3000-4000 \AA$ range．Data show that constant exposure to room level fluorescent lighting coutd erase the typical 2716 in approximately 3 years，while it would take approximatley 1 week to cause erasure when exposed to direct sunlight．If the 2716 is to be exposed to these types of lighting concit：ons for ex－ tended periods of ：－re，caeaje ：a气ts are a．j à＇e from Intel which shoud be $=$ sces oier ire 2716 andow to prevent unintentional erasuis．
 PROM／ROM Programming Instruction Sec：or； $0^{\circ}$ ：－ 2716 is exposure to shortwave ultraviolet light wh ch ras a wavelength of 2537 Angstroms（ $\mathbb{A}$ ）．The integrated cose （i．e．，UV intensity $X$ exposure time）for erasure should be a minimum of $15 \mathrm{~W}-\mathrm{sec} / \mathrm{cm}^{2}$ ．The erasure time with this dosage is approximately 15 to 20 minutes using an ultra－ violet lamp with a $12000 \mu \mathrm{~W} / \mathrm{cm}^{2}$ power rating．The 2716 should be ploced tithin 1 inch of the lamp tubes during erasure．Sorre azas rave a filter on their tubes which


## DEVICE OPERATION

The five modes of osers：：－ $0^{\text {：}}$ ：he 2716 are listed in Table 1．It should be noted：$:=\cdots=-5$ sor the five modes are at
 a Vpp．The $V_{\text {Pp }}$ power $555=$ ，－$: 5$ et 25 V durng the
 two modes．

| PINS | CEIPGMA 1981 | $\begin{gathered} \overline{0} \\ 122 . \end{gathered}$ | $\because$ | $\because \approx$ | $\begin{aligned} & \therefore=-5 \\ & \therefore=3 \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\cdots+\%$ | $V_{\text {IL }}$ | ， | $\checkmark$ | $\cdots$ | ：．${ }^{-}$ |
| ：$:$ | $V_{14}$ | Ot－ 0 － | $\cdots$ | $\stackrel{\square}{-}$ | －， |
| ＊：：－ | Pulsea $\mathrm{V}_{16}$ to $\mathrm{VIM}_{\text {IM }}$ | $\because 1$ | $\because$ | $\cdot$ | i ： |
| E：：－ | $V_{12}$ | $V_{11}$ | $\because$ | －！ | $\because \cdot$ |
| 1：：： | $V_{12}$ | $\mathrm{v}_{\mathrm{IH}}$ | $\because$ | $\cdot \underline{ }$ | $-; 1$ |

READ $\because Q D E$

les：




 tre cosy from $\overline{C E}$ ： 0 ortout（ $\mathrm{t} C \mathrm{CE}$ ）．Data is ava iso at
 ass．m－g that $\overline{C E}$ hes oeen tow and addresses have been stabie for at least tacc－tos．

## STANDEY MODE

The 2716 has a standby mode which reduces the active power gissipation by $75 \%$ ，from 525 mW to 132 mW ．The 2716 is placed in the standby mode by applying a TTL high signai to the $\overline{\mathrm{CE}}$ input．When in standby mode，the outputs are in a high impedence state，independent of the $\overline{O E}$ input．

## OUTPUT OR－TIEING

Because 2716＇s are usually used in larger memory arrays， Intel has provided a 2 line control function that accomo－ dates this use of multiple memory connections．The two line control function allows for：
a）the lowest possible memory power dissipation，and
b）complete assurance that output bus contention will not occur．
To most efficiently use these two control lines，it is recom－ mended that $\overline{\mathrm{CE}}$（pin 18）be decoded and used as the primary jevice selecting function，while $\overline{O E}$ ipin 20）be meco a common connection to all devices in the array and conrected to the READ tine from the systeti cortrol bus． $T$ This essures that all deselected memory devices ore in their low power stancby mode and that the outputa ns are only active when data is desired from a particular memory device．

## PROGRAMMING

Initially，and after each erasure，all bits of the $2716 \varepsilon^{\prime}$ an the＂1＂state Data is introduced by selective＇v＝rosom． ming＂ 0 ＇s＂into the desired bit locations．Aitheus＂o－ly ＂ 0 ＇s＂will be programmed，both＂ 1 ＇s＂and＂ 0 ＇$s$＂za＂be presented in the data word．The only way to charge a＂ 0 ＂ to a＂ 1 ＂is by ultraviolet light erasure．
The 2716 is in the programming mode when the Voo ejwar supply is at 25 V and $\overline{\mathrm{E}}$ is at $\mathrm{V}_{\mathrm{IH}}$ ．The data to oe ero． grammed is auplied 8 bits in parallel to the data ou：う」t pins．The levels required for the address and data inpu：s a：e TTL．
When the address and data are stable，a 50 msec，ac：$\because$ e high，TFL program pulse is applied to the $\overline{C E} / P G M$ incju． A program pulse must be applied at each address loca：ion to be programmed．You can program any location at any time－either individually，sequentially，or at rancom． The program pulse has a maximum width of 55 msec ．The 2716 must not be programmed with a $D C$ signal appied to the CE／PGM input．
Programming of multiple 2716 s in parallel thith the same dara can be easily accomplished due to the s．－atcisy of the programming requiremenss．L ke noدis of the paral－ leled 27165 may be connected together when they are pro－ grammed with the same data．A h．gh level TIL pulse appied to the $\overline{C E}, P G M$ input programs the paralleled 27 16s．

## PROGRAM INHIBIT

Progemming of multiple 2716 s in parallel with different data is also easily accomplished．Except for $\overline{C E} / P G M$ ．all like inputs linetuding $\overline{O E}$ ）of the parallel 2716 s may be common．A TTL level program pulse applied to a 2716＇s $\overline{\mathrm{CE}} / \mathrm{PGM}$ input with $\mathrm{V}_{\mathrm{PP}}$ at 25 V will program that 2716. A low level $\overrightarrow{C E} / P G M$ input inhibits the other 2716 from being programmed．

## PROGRAM VERIFY

A verify should be performed on the programmed bits to determine that they were correctly programmed．The verify mav be pertormed wth $V_{p p}$ at 25 V ．Except during pro－ gramming and program verify．$V_{\text {pp }}$ must be at 5 V ．

## Appendix C3

## intel

# 2102A，2102AL／8102A－4＊ $1 \mathrm{~K} \times 1$ BIT STATIC RAM 

| P／N | Standby Pwr． <br> $(\mathrm{mW})$ | Operating Pwr． <br> $(\mathrm{mW})$ | Access <br> $(\mathrm{ns})$ |
| :--- | :---: | :---: | :---: |
| $2102 A L-4$ | 35 | 174 | 450 |
| $2102 A L$ | 35 | 174 | 350 |
| $2102 A L-2$ | 42 | 342 | 250 |
| $2102 A-2$ | - | 342 | 250 |
| $2102 A$ | - | 289 | 350 |
| $2102 A-4$ | - | 289 | 450 |

## －Single +5 Volts Supply Voltage <br> －Directly TTL Compatible：All Inputs and Output <br> －Standby Power Mode（2102AL） <br> －Three－State Output：OR－Tie Capability

The Intelt 2102A is a hign sこeef ：仓24 word by one bit static random access memory element using N－crarnel MOS devices integrated on a monolitric a $\boldsymbol{E}_{j}$ l：uses fully DC stable（static）circuitry and therefore requires no clozas or refreshing to operate．The data is read $0 .:$ ron costructively and has the same polarity as the input data．

The 2102A is designed for memsn，قここ cations where high performance，low cost，large bit storage，arjs rele interfacing are important design objectives．A ： 2 w s：andby power version（2102AL）is also available．It 5 ans a！the same operating characteristics of the 2102A wintre aここed feature of 35 mW maximum power dissipation in stançy and 174 mW in operations．

It is directly TTL compatible in all respects inputs，output，and a single +5 volt supply．A separate ch．penable（ $\overline{C E}$ ）lead allows easy selection of an individual packa̧̧e wrien outputs are OR－tied．
The Intel 2102A is fabricated with $N$－char．nel silicon gate technology．This technology allows the design and production of high performance easy to use MOS circiis and provides a higher functional density on a monolithic chip than either conventional MOS technology or P－channel slicon gate technology．

＊All $8102 \mathrm{~A}-4$ specificallons ave identical to the 2102A－4 specifications．
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## Absolute Maximum Ratings＊

Ambient Temperature Under Bias $-10^{\circ} \mathrm{C}$ to $80^{\circ} \mathrm{C}$
Storage Temperature $\quad-65^{\circ} \mathrm{C}$ io $+150^{\circ} \mathrm{C}$
Voltage On Any Pin
With Respect To Ground

Power Dissipation
-0.5 V to +7 V
1 Watt
＊COMMENT：
Stresses above those listed under＂Absolute Maximum Rating＂ may cause permanent damage to the device．This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the opera－ tionat sections of this specification is not implied．Exposure to absolute maximum rating conditions for extended periods may affect device reliability．

## D．C．and Operating Characteristics

$T_{A}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, V_{C C}=5 \mathrm{~V} \pm 5 \%$ unless otherwise specified．

| Symbol | Parameter | $\begin{gathered} \text { 2102A, 2102A-4 } \\ 2102 \mathrm{AL}, 2102 \mathrm{AL}-4 \end{gathered}$ <br> Limits |  |  | $2102 \mathrm{~A}-2,2102 \mathrm{AL}-2$ <br> Limits |  |  |  | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 14 | Input Load Current |  | 1 | 10 |  | 1 | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{1 \mathrm{~N}}=0$ to 5.25 V |
| ILOH | Output Leakage Curreat |  | 1 | 5 |  | 1 | 5 | $\mu \mathrm{A}$ | $\begin{aligned} & \overline{\mathrm{CE}}=2.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{OH}} \end{aligned}$ |
| ILOL | Output Leakaje Cirrent |  | －1 | －10 |  | －1 | －10 | H | $\begin{aligned} & \overline{\mathrm{CE}}=2.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{OUT}}=0.4 \mathrm{~V} \end{aligned}$ |
| ICC | Power Supply Cur＊＊T |  | 33 | Note 2 |  | 45 | 65 | mA | $\begin{aligned} & \text { All Inputs }=5.25 \mathrm{~V} \text {, } \\ & \text { Data Out Open, } \\ & \mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C} \end{aligned}$ |
| $V_{1 L}$ | Input Low Voite： | －0．5 |  | 0.8 | －0．5 |  | 0.8 | $V$ |  |
| $V_{14}$ | Input High Voitas？ | 20 |  | $V_{C C}$ | 2.0 |  | $V_{C C}$ | $V$ |  |
| VOL | Output Low Voitas？ |  |  | 0.4 |  |  | 0.4 | $\checkmark$ | $1 \mathrm{OL}=2.1 \mathrm{~mA}$ |
| V | Output High Voltage | $\therefore:$ |  |  | 2.4 |  |  | $V$ | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |
|  <br> 2 The maximum ${ }^{\circ} \mathrm{CC}$ value is $55-\therefore \because \cdots 2 \cdot 2 \mathrm{~F}$ and 2102 A .4 ，and 33 mA for the 2102AL and 2102AL－4． |  |  |  |  |  |  |  |  |  |

Standby Characteristics 2102AL．2102AL－2，and 2102AL－4（Available only in the Plastic Package）


| Symbol | Parameter | 2102AL．2102AL． 4 Limits |  |  | Min． | $\begin{gathered} \text { 2102AL-2 } \\ \text { Limits } \\ \text { Typ. }{ }^{[1]} \end{gathered}$ | Max． | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{P D}$ | $\because$－－－－－－ | 1.5 |  |  | 1.5 |  |  | V |  |
| $\mathrm{V}_{\text {CES }}$ ： |  | 2.0 |  |  | 2.0 |  |  | $\checkmark$ |  |
|  |  | $V_{P D}$ |  |  | VPD |  |  | $V$ | $1.5 \mathrm{v} \leqslant \mathrm{VPO}_{0}<2.0 \mathrm{~V}$ |
| IPD1 | らっきここ，ごき＊＊ |  | 15 | 23 |  | 20 | 28 | mA | A：117puls $=V_{P O} 1=1.5 \mathrm{~V}$ |
| \＄PO2 |  |  | 20 | 30 |  | 25 | 38 | mA | All Inputs $=\mathrm{V}_{\mathrm{PO} 2}=2.0 \mathrm{~V}$ |
| ${ }^{\prime} \mathrm{CP}$ |  | 0 |  |  | 0 |  |  | ns |  |
| ${ }^{4}{ }^{[3]}$ |  | ${ }^{\text {R }} \mathrm{C}$ |  |  | $t_{\text {t }}$ |  |  | $n 5$ |  |

## STANDBY WAVEFORMS



NOTES：
1．Typical vatues are for $T_{A}=25^{\circ} \mathrm{C}$ ．
2．Consider the test conditions as shown： 11 the stand－ by voltage＇$V$ pD＇is between 5.25 V （VCC Max． 1 and 20 V ，then CE must be held at 2.0 V Min．（ $\mathrm{V}_{1 \mathrm{~W}} \mathrm{~V}^{2}$ ．If the standby voltage is less than 2.0 V but greater than 1.5 V （VPD Min．），then $C E$ and standby voltage must be at least the same value or．if they are dif． ferent，$\overline{C E}$ must be the more positive of the two．
3． $\mathrm{t}^{+}{ }^{+} \mathrm{t}_{\mathrm{RC}}$（ $\mathrm{F} E \mathrm{AD}$ CYCLE TIME）．
A. C. Characteristics $T_{A}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cC}}=5 \mathrm{~V} \pm 5 \%$ unless otherwise specified read cycle

| Symbol | Parameter | $\begin{gathered} \text { 2102A-2, 2102AL-2 } \\ \text { Limits (ns) } \end{gathered}$ |  | $\begin{gathered} \text { 2102A, 2102AL } \\ \text { Limits (ns) } \end{gathered}$ |  | $\begin{gathered} \text { 2102A-4, 2102AL-4 } \\ \text { Limits (ns) } \end{gathered}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. | Min. | Max. | Min. | Max. |
| $t_{\text {RC }}$ | Read Cycle | 250 |  | 350 |  | 450 |  |
| $t_{\text {A }}$ | Access Time |  | 250 |  | 350 |  | 450 |
| ${ }^{\text {coo }}$ | Chip Enable to Output Time |  | 130 |  | 180 |  | 230 |
| ${ }^{\text {toh }}$ | Previous Read Data Valid with Respect to Address | 40 |  | 40 |  | 40 |  |
| ${ }^{\text {t }}{ }_{(12}$ | Previous Read Data Valid with Respect to Chip Enable | 0 |  | 0 |  | 0 |  |

Write cycle

| twe | Write Cycle | 250 | 350 | 450 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {AW }}$ | Address to Write Setup Time | 20 | 20 | 20 |
| twp | Write Pulse Width | 190 | 250 | 300 |
| $t_{\text {NR }}$ | Write Recovery Time | 0 | 0 | 0 |
| tow | Data Setup Time | 30 | 250 | 300 |
| ${ }^{\text {to }}$ | Data Hold Time | 0 | 0 | 0 |
| ${ }^{\text {t }} \mathrm{CW}$ | Chip Enable to bif:e Se:-2 Time | - 3 | 250 | 300 |

## A.C. CONDITIONS OF TEST

| input $P_{\text {ij }}$ se Levels |  |  |
| :---: | :---: | :---: |
| Input Pise ard Fall Times: |  | 10nsec |
| Tır.n玉 *easurement | Inputs: | 15 Volts |
| Fieference Levels | Qutpur | - £ n - 2.0 Volts |
| Output Load: | 1 T |  |


| SYMBOL | TEST | LIMITS (DF) |  |
| :---: | :---: | :---: | :---: |
|  |  | TYP. | MAX. |
| $\mathrm{C}_{\text {IN }}$ | INPUT CAPAC:TA: OE <br> (ALLINPLTP P. S?. = OV | 3 | 5 |
| $C_{\text {OUT }}$ | OUTPUT CAPACIT~: : CE $V_{\text {OUT }}=0 \mathrm{~V}$ | 7 | 10 |

## Waveforms

## READ CYCLE



Write cycle


NOTES: 1. Typical values are for $T_{A}=25^{\circ} \mathrm{C}$ and nominal supply voltage.
2. This parameter is periodically sempled and is not $100 \%$ tested.

## Typical D. C. and A. C. Characteristics





OUTPUT SINK CURRENT VS. OUTPUT VOLTAGE



ACCESS TIME VS. load capacitance


## Appendix C4

## intel ${ }^{\circ}$

2114A
1024 X 4 BIT STATIC RAM

|  | $2114 \mathrm{AL}-1$ | $2114 \mathrm{AL}-2$ | $2114 \mathrm{AL}-3$ | $2114 \mathrm{AL}-4$ | $2114 \mathrm{~A}-4$ | $2114 \mathrm{~A}-5$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Max. Access Time (ns) | 100 | 120 | 150 | 200 | 200 | 250 |
| Max. Current (mA) | 40 | 40 | 40 | 40 | 70 | 70 |

## - HMOS Technology

- Low Power, High Speed
- Identical Cycle and Access Times
- Single +5 V Supply $\pm 10 \%$
- High Density 18 Pin Package
- Completely Static Memory - No Clock or Timing Strobe Required
- Directly TTL Compatible: All Inyuts and Outputs
- Common Data Input and Output Using Three-State Outputs
- 2114 Upgrade

The Intele 2114A is a 4096 -bit stat \& Panjon Access Memory organized as 1024 words by 4-bits using HMOS. a high performance MOS techriology. It wses $f$. y DC s:3ele static) circuitry throughout, in both the array and the decoding. therefore it requires no clocks of refreshing to overate Jata access is particularly simple since address setup times are not required. The data is read out nondestructively and nas the same polarity as the input data. Common input/output pins are provided.

The 2114A is designed for memory $a==23: 5^{-5}$ where the high performance and high reliability of HMOS. IOW cost, large bit $^{\text {h }}$ storage, and simple interfacing are irparant cesign odjectives. The 2114A is placed in an 18-pin package tor the highest possible density.
It is directly TTL compatible in all respects: inputs, outputs, and a single +5 V supply. A separate Chip Select ( $\overline{\mathrm{CS}}$ ) lead allows easy selection of an individual package when outputs are or-tied.


## ABSOLUTE MAXIMUM RATINGS*

| Temperature Under Bias ................... $-10^{\circ} \mathrm{C}$ to $80^{\circ} \mathrm{C}$ <br> Storage Temperature $\ldots \ldots \ldots \ldots \ldots . . . . . . . . . . . . . .5^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |  |
| :---: | :---: |
|  |  |
| Voltage on any Pin |  |
| With Respect to Ground ................ 3.5 V to +7 V |  |
| ower Dissipation |  |
| C. Output Cu | 5mA |

*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure is not implied. Exposure to absolute maximum rating conditions for exfended periods may affect device reliability.

## D.C. AND OPERATING CHARACTERISTICS

## $T_{A}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%$, unless otherwise noted.

| SYMBOL | PARAMETER | 2114AL-1/L-2/L-3/L-4 |  |  | 2114A-4/-5 |  |  | UNIT | CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. ${ }^{11}$ | Max. | Min. | Typ.11] | Max. |  |  |
| $\mathrm{I}_{\mathrm{LI}}$ | Input Load Current (All Input Pins) |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ | $V_{\text {IN }}=0$ to 5.5 V |
| HLOO | I/O Leakage Current |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ | $\begin{aligned} & \overline{\mathrm{CS}}=V_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{I} / \mathrm{O}}=\mathrm{GND} \text { to } \mathrm{VCC} \end{aligned}$ |
| Icc | Power Supply Current |  | 25 | 40 |  | 50 | 70 | mA | $\begin{aligned} & V_{C C}=\max , I_{V / O}=0 \mathrm{~mA}, \\ & T_{A}=0^{\circ} \mathrm{C} \end{aligned}$ |
| $V_{16}$ | Input Law Voltage | -3.0 |  | 0.8 | -3.0 |  | 0.8 | V |  |
| $V_{\text {iH }}$ | Input High Vol:age | 2.0 |  | 6.0 | 2.0 |  | 6.0 | $\checkmark$ |  |
| げ | Output Low Current | 2.1 | 9.0 |  | 2.1 | 9.0 |  | mA | $\mathrm{V}_{\mathrm{OL}}=0.4 \mathrm{~V}$ |
| 1 CH | Output High Current | -1.0 | -2.5 |  | -1.0 | -2.5 |  | mA | $\mathrm{V}_{\mathrm{OH}}=2.4 \mathrm{~V}$ |
| los ${ }^{\|2\|}$ | Output Snort Circuit Current |  |  | 40 |  |  | 40 | mA |  |

NOTE: 1. Typical values ate for $T_{A}=25^{\circ} \mathrm{C}$ and $\vee \mathrm{C}=5 . \mathrm{jV}$.
2. Duration not to exceed 30 seconds.

## CAPACITANCE

$T_{A}=25^{\circ} \mathrm{C} .1=1.0 \mathrm{MHz}$

| SYMBOL | TEST | MAX | UNIT | CONDITIONS |
| :--- | :--- | :---: | :---: | :--- |
| $C_{1 . O}$ | InQu: O U:Dut Capacitance | 5 | pF | $V_{1 / O}=\mathrm{OV}$ |
| $\mathrm{C}_{\mathrm{iN}}$ | Inpur Capacitance | 5 | pF | $\mathrm{V}_{1 \mathrm{~N}}=\mathrm{OV}$ |

NOTE: This perameter is periodically smpled and not 100\% tested.
A.C. CONDITIONS OF TEST
Input Pulse Levels . . . . . . . .................................................. 0.8 Volt to 2.0 Volt
Input Rise and Fall Times .................................................................. 10 nsec
Input and Output Timing Levels ......................................................... 1.5 Volts
Output Load $\ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots$................................. $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$
A.C. CHARACTERISTICS $T_{A}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \pm 10 \%$, unless otherwise noted.

## READ CYCLE ${ }^{11]}$

| SYMBOL | PARAMETER | 2114AL-1 | 2114AL-2 | 2114AL-3 | 2114A-4/L-4 | 2114A-5 | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |  |
| tac | Read Cycle Time | 100 | 120 | 150 | 200 | 250 | ns |
| ${ }^{1}$ | Access Time | 100 | 120 | 150 | 200 | 250 | ns |
| teo | Chip Selection to Output Valid | 70 | 70 | 70 | 70 | 85 | ns |
| $t_{\text {cx }}$ | Chip Selection 10 Output Active | 10 | 10 | 10 | 10 | 10 | ns |
| tord | Oulput 3-state from Deselection | 30 | 35 | 40 | 50 | 60 | กs |
| towa | Output Hold from Address Change | 15 | 15 | 15 | 15 | 15 | ns |

WRITE CYCLE ${ }^{[2]}$

| SYMBOL | PARAMETER | 2114AL-1 | 2114AL-2 | 2114AL-3 | 2114A-4/L-4 | 2114A-5 | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. Max. | Min. Max. | Min. Max. | Min. Max. | Min. Max. |  |
| twc | Write Cycle Time | 100 | 120 | 150 | 200 | 250 | -5 |
| tw | Write Time | 75 | 75 | 90 | 120 | 135 | $\cdots$ |
| twr | Write Release Time | 0 | 0 | 0 | 0 | 0 | -5 |
| totw | Output 3-state from Write | 30 | 35 | 40 | 50 | $6:$ | ns |
| fow | Data to Write Time Overlap | 70 | 70 | 90 | 120 | 135 | ns |
| $\mathrm{ItH}^{\text {chen }}$ | Data Hold from Write Time | 0 | 0 | 0 | 0 | 0 | ns |

## NOTES:

1. A Read occurs during the guerlap of a low $\overline{\mathrm{CS}}$ and a high $\overline{W E}$.


## WAVEFORMS

## READ CYCLE ${ }^{(3)}$



NOTES:
3. $\overline{W E}$ is hign for a Reed Cycle.
4. II the $\overline{\mathrm{CS}}$ low transition occurs simutianeousty with the $\overline{\mathrm{WE}}$ tow trangition. the output butfers remtin in a bigh impedance state.
5. WE must be high during all address Iranslions.

## WRITE CYCLE



## Appendix C5

## intel ${ }^{\circ}$

## 8212 <br> 8-BIT INPUT/OUTPUT PORT

Fully Parallel 8-Bit Data Register and Buffer<br>- Service Request Flip-Flop for Interrupt Generation<br>Low Input Load Current - .25mA Max.<br>Three State Outputs<br>© Outputs Sink 15 mA

3.65V Output High Voltage for Direct Interface to 8008, 8080A, or 8085A CPU

- Asynchronous Register Clear
- Replaces Buffers, Latches and Multiplexers in Microcomputer Systems
- Reduces System Package Count
 logic. Also included is a service request' $p$-lizp tor the generation and control of interrupts to the microprocessor.
The device is multimode in nature. It can be used to implement latches, gated buffers or multiplexers. Thus, all of the principal peripheral and input output functions of a microcomputer system can be implemented with this device


PIN NAMES

| Di. $\mathrm{Ol}_{1}$ | CaTam |
| :---: | :---: |
| -0, $0^{0} 0_{1}$ こaTa OUT |  |
| $\mathrm{OSO}_{2}$ | DEVICESELECT |
| MO | MOOE |
| STE | Staces |
| INT | ENfERRUPTICTTVE LOM- |
| त्ती | CLEAA IACTIVE LOW) |



## FUNCTIONAL DESCRIPTION

## Data Latch

The 8 flip－flops that make up the data latch are of a＂D＂ type design．The oulput（ $Q$ ）of the flip－flop will follow the data input（ D ）while the clock input（ C ）is high．Latching will occur when the clock（ C ）returns low．
The latched data is cleared by an asynchronous reset input（ $\overline{\mathrm{CLF}}$ ）．（Note：Clock（C）Overrides Reset（ $\overline{\mathrm{CLR}}$ ）．）

## Output Buffer

The outputs of the date latch $\mathcal{Q}$ ）are connected to 3－state． non－inverting output buffers．These buffers have a common control line（ $E N$ ：；this controf line either enables the butter to transmit the cata from the outputs of the data latch（Q）or disables the buffer，forcing the output into a high impedance state．： 3 －state）
The high－impedance sta！e attows the designer to connect the 8212 directly onto ine $\mathrm{m}:$ ：croprocessor bi－cirectional data bus．

## Control Logic

The 8212 has control inputs $\overline{D S 1}, ~ D 52, M D$ and STE． These inpuls are used to control device selection，data latching，output butter state and service request thip－flop．

## $\overline{\text { DSt }}, \mathbf{D S 2}$（Device Select）






## MD（Mode）

 a－d to determine the source of tre cockrpui $C$ ：e ：ne c却a latch．





 ミロここe－fut．

## STB（Strobe）

T～simer：s $\quad \$ f=$ as the clock（ $C$ ）to the data latch for the ineui rose＇$\because$＇ $2=0$ ．and to synchronously reset the

Note ：nat the SA $f: p-f!\rho$ is negatlue edge triggered．

## Service Request Flip－Flop

The（SR）flip－flop is used to generate and control interrupts in microcomputer systems．It is asynchron－ ously set by the CLR input（active low），When the（SR）flip－ flop is set it is in the non－interrupting state．
The output of the（SR）flip－flop（ $Q$ ）is connected to an inverting input of a＂NOR＂gate．The other input to the ＂NOR＂gate is non－inverting and is connected to the device selection logic（DS1－DS2）．The output of the ＂NOR＂gate（INT）is active low tinterrupting state）for connection to active low input priority generating circuits．


## Applicatlons of the $\mathbf{8 2 1 2}$－For Microcomputer Systems

| I Basic Schematic Symbol |  |
| :--- | :--- |
| II | Gated Buffer |
| III Bi－Directional Bus Oriver |  |
| IV | Interrupting Input Port |

II Gated Butfer
IV Interrupting Input Port

## 1．Basic Schematic Symbols

Two examples of ways to draw the 8212 on system schernatics－（1）the top belng the detailed view showing pin numbers，and（2）the bottom being the symbolic view

V Interrupt Instruction Fort
VI Output Port
VIf 8080A Status Latch
VII 8085A Address Latch
showing the system input or output as a system bus（bus containing 8 parallel lines）．The output to the data bus is symbolic in referencing 8 paraliel lines．


## II．Gated Buffer（3－State）

The simplest use of the 8212 is ：＇et of a gated buffer By tying the mode signal low aro ：re ciroe teu：r gh the data latch is acting as a stra $\mathrm{g}^{-::-\cdots}$ ． $\mathrm{g}^{h}$ gate Tre cu：put butfers are then enabled fro $\uparrow$ ：ne ce，ce se ect 0 ：logic OS1 and OS2．

When the device selection logit is fa se．：re v．f． state．

When the device selection logic stree ：re－＝nt data from the system is directly transferred to：re $\begin{gathered}\text {＿：}:=\text { ：Themput } \\ \text { The }\end{gathered}$ date load is 250 micro amps．Tre cute f：こもta can sink 15 milli amps．The minimum high oulpht 5 ご

GATED EUFFER


## III．Bi－Directlonal Bus Driver

A pair of 9212＇s wired（back－to－back！can te tsed as a symmetrical drive．bi－directional bus driver．Tre ce：ces are controlled by the data bus input conirot wh．ch is connected to $\overline{D S 1}$ on the tirst 8212 and to DS2 on the second．One device is active，and acting as a s：ra：ght through bulfer the other is in 3 －state mode．This is a very useful circuit in small system design．

## BI－DIRECTIONAL BUS DRIVEA



## IV．Interrupting Input Port

This use of an 8212 is that of a system inpul port that accepts a strobe from the system input source，which in turn clears the service request flip－flop and interrupts the processor．The processor then goes through a service routine，identifies the port，and causes the device selection logic to go true－enabling the system input data onto the data bus．

INTERRUPTING INPUT PORT


## V．Interrupt Instruction Port

The $8212 \mathrm{cz}=\mathrm{z}$ used to gate the interrupt instruction． normally $\mathrm{FES} \mathrm{S}^{-}=\mathrm{ET}$ instructions，onto the data bus．The device is $e^{-} \equiv 5 \div$＇rom the interrupt acknowledge signal from the meこここ・こessor and from a port selection signat． This signal s ${ }^{-2 \cdots}$ y tied to ground．IDS1 could be used to multiplex a. $\mathfrak{E}^{*} 二{ }^{\prime}$ ，ef interrupt instruction ports onto a common bus

## INTERRUPT INSTAUCTION PORT



## VI．Output Por（With Hand－Shaking）

 a s．s：e－c．：s．：－re output strobe could be a nard－
 that：－e s，stem iscu：e ut：ng to．It in turn，can interrupt the sys：em s．g＂，my ire receptron of data．The selection of the fort cires trom tre cevice selection logic．$\overline{\mathrm{DS1}} \cdot \mathrm{DS2}$ ，

## OUTPUT PORT（WITH HAND－SHAKING）



## VII．8080A Status Latch

Here the 8212 is used as the status latch for an 8080A microcomputer system．The input to the 8212 latch is directly from the 8080A data bus．Timing shows that when the SYNC signal is true．which is connected to the OS2 input and the phase 1 signal is true，which is a TTL level coming from the clock generator；then，the status data will be latched into the 8212.

Note：The mode signal is tied high so that the output on the latch is active and enabled all the time．
It is shown that the two areas of concern are the bi－ directional data bus of the microprocessor and the control bus．


## 8212

VIII．8085A Low－Order Address Latch
The 8085A microprocessor uses a－．：＝こees afdress／ data bus that contains the low c：－E•E： information during the first parl $\mathrm{c}^{+}$a $-\mathrm{a}^{--e c: e}$ The same bus contains data at a la：er：$:-\mathrm{p}-$－－e cyc！e．An address latch enable ।ALE；s＇G゙ai s ごこ．こ巨寸 by the 8085 A to be used by the 8212 to la：c゙：゙e ョこごったs so that it

 the 8212＇s output buffers turned on at a 1 ：～


## ABSOLUTE MAXIMUM RATINGS＊



## COMMENT

Stresses above those listed under＂Absolute Maximum Ratings＂may cause permanent damage io the device This is a stress ralang oniy and functional permanent damage io the device This is a stress ralang oniy and functional operation of the device al these or any other condilions above those Exposure to absolute maximum rating condilions lor extended periods may altect device reliabilly

D．C．CHARACTERISTICS $T_{A}=0^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C} . V_{C C}=+5 \mathrm{~V} \pm 5 \%$

| Symbol | Parameter | Limils |  |  | Unit | Test Condllions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Mex． |  |  |
| If | input Load Current，ACK，DS2，CR． Dli－Dl8 Inputs |  |  | －． 25 | mA | $V_{F}=.45 \mathrm{~V}$ |
| If | Input Load Current MD Input |  |  | －．75 | mA | $V_{F}=.45 \mathrm{~V}$ |
| If | Input Load Current DS Input |  |  | －1．0 | mA | $V_{F}=.45 \mathrm{~V}$ |
| If | Input Leakage Current．ACK，DS，CA $\mathrm{Dl}_{1}$－DI8 Inputs |  |  | 10 | $\mu \mathrm{A}$ | $V_{\text {R }} \leq V_{\text {c }}$ |
| If | Input Leakage Current MO Input |  |  | 30 | $\mu \mathrm{A}$ | $V_{\text {R }} \leq V_{\text {If }}$ |
| 1 A | Input Leakage Current DS．Input |  |  | 40 | $\mu \mathrm{A}$ | $V_{R} \leq V_{\text {c }}$ |
| V c | Input Forward Voltage C．amp |  |  | －1 | $V$ | $16=-50, \mathrm{~A}$ |
| Vル | Input＂Low＂Voltage |  |  | ． 85 | V |  |
| VIH | Input＂High＂Voltage | 20 |  |  | $V$ |  |
| VOL | Output＂Low＂Voltage |  |  | ． 45 | $V$ | $1 \mathrm{OL}=15 \mathrm{~mA}$ |
| VOH | Ojtput＂Hign＂Voltage | 355 | 4.0 |  | $v$ | $1 \mathrm{OH}=-1 \mathrm{~mA}$ |
| Isc | s－art Circuit Output Current | －15 |  | $-75$ | mA | $V_{0}=0 \mathrm{~V} . \mathrm{V}: 5=5 \mathrm{~V}$ |
| 1101 | こ－： E t Leakage Current Hign <br>  |  |  | 20 | $\mu \mathrm{A}$ | $V_{0}=45 \mathrm{~V} 525 \mathrm{~V}$ |
| Jcc |  |  | 90 | 130 | mA |  |

## TYPICAL CHARACTERISTICS

INPUT CURRENT VS．執PUT VOLTAGE


OUTPUT CURRENT VS． OUTPUT＂HIGH＂VOLTAGE


OUTPUT CURRENT VS．OUTPUT＂LOW＂VOLTAGE

data to output delay VS．LOAD CAPACITANCE



A．C．CHARACTERISTICS $T_{A}=0^{\circ} \mathrm{C}$ to $-70^{\circ} \mathrm{C}, \mathrm{VCC}=+5 \mathrm{~V} \pm 5 \%$

| Symbol | Parameter | Limits |  |  | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min． | Typ． | Max． |  |  |
| tpw | Pulse Width | 30 |  |  | ns |  |
| tPD | Data to Output Delay |  |  | 30 | ns | No：e 1 |
| twe | Write Enable to Ouicul Deà |  |  | 43 | ns | Nole 1 |
| HSET | Data Set Up Time | 15 |  |  | ns |  |
| $\mathrm{th}^{\text {H }}$ | Data Hold Time | 20 |  |  | ns． |  |
| $t_{\text {f }}$ | Resel to Output 5 eay |  |  | 40 | ns | Note 1 |
| ts | Set to Output Ce ey |  |  | 30 | ns | Note 1 |
| te | Output Enable 5 sas $\mathrm{y}^{+}-\frac{1}{*}$ |  |  | 45 | ns | Nole 1 |
| tc | Clear to Output Deay |  |  | 55 | ns | Note 1 |



| Symbot | Test | Limits |
| :---: | :---: | :---: |
|  |  | Typ．Mar． |
| $\mathrm{Cl}_{\text {IN }}$ | DS，MD input Capacitance | gzF－żF |
| CIN | DS ${ }_{2}$ ．CK，ACK，Dli－Dla Input Capacitance | ちご 9 のF |
| Cout | DO1－DO8 Output Capacitance | 80 F 1くっF |

＂This parameter is sampled and not $100 \%$ tested

## SWITCHING CHARACTERISTICS

## Conditions of Test

Input Pulse Amplitude $=2.5 \mathrm{~V}$
Input Rise and Fall Times 5 ns
Test Load
Between 1 V and 2 V Measurements made at 1.5 V with 15 mA and 30 pF Test Load

Note 1：

| Teat | $c_{6}{ }^{\text {－}}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ |
| :---: | :---: | :---: | :---: |
| tpo．twe，th，ts，to | 30pF | 300 n | 6000 |
| te．ENABLEI | 30pF | 10Kn | 1K0 |
| le．EnAbLEE 1 | 30pF | $300 \Omega$ | $600 \cap$ |
| TE，DISABLE\％ | 5pf | $300 n$ | 6000 |
| te．DISABLE！ | 5pF | $10 \mathrm{~K} \Omega$ | 1 kn |

$15 \mathrm{~mA} \& 30 \mathrm{pF}$

Includes probe and jig capacitance．

TIMING DIAGRAM


## Appendix C6

## STANDARD MICROSYSTEMS CORPORATION

## Keyboard Encoder Read Only Memory

## FEATURES

Outputs directly compatible with TTLIDTL or MOS logic arrays．$\square$ External control provided for output polarity selection．External control provided for selection of odd or even parity．Two key roll－over operation．N－key lockout．Programmable coding with a single mask change．Self－contained oscillator circuit．Externally controlled delay network provided to eliminate tne eftect of contact bounce．
ニ One integra：ed crrcuit required for complete keyboard assembly．
Z cu：fui termınals．
ᄃ．Entire circuit protected by a layer of glass passivation．

PIN CONFIGURATION


GENERAL DESCRIPTION

The SMC KR2376－XX is a 2376－bit Read Or＇y Nemory with all the logic necessary to encode 5 － single throw keyboard closures into a usace 9 －et code．Data and strobe outputs are direct ycミテかatible with TTL／DTL or MOS logic arrays withcut the use of
any special interface components
 P－channel technology and contains $29-2=$ ． enhancement mode transistors on a singeーごごこ， chip，available in a 40 pin dual－in－line paこィコご．

TYPICAL CONNECTION OF KR2376－XX


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Operating Temperature Range
Storage Temperature Range $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Logic Input Voltages，with respect to Vcc $\qquad$
$\dagger$ Stresses above those listed may cause permanent damage to the device．This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied．

ELECTRICAL CHARACTERISTICS
（ $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}, \mathrm{VCC}=+5 \mathrm{~V} \pm 0.5 \mathrm{~V}, \mathrm{VGG}=-12 \mathrm{~V} \pm 1.0 \mathrm{~V}$ ，unless otherwise noted）

| Characteristics | Min | Typ | Max | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CLOCK | 20 | 50 | 10.0 | KHz | see fig． 1 footnote（＂）for typical R－C values |
| DATA INPUT |  |  |  |  |  |
| Logic＂0＂Level |  |  | －0．8 |  |  |
| Logic＂1＂Level | Vcc－1．5 |  | 10 | Vf |  |
| INPUT CURRENT |  |  |  |  |  |
| －Control，Shift \＆YO |  |  |  |  |  |
| thru Y10 | 10 | 100 | 140 | $\mu \mathrm{A}$ | $\mathrm{VIN}_{1 \mathrm{~N}}=+5.0 \mathrm{~V}$ |
| ＊Control，Shift \＆YO thru Y 10 <br> Data Invert，Parity Invert | 5 | $\begin{array}{r} 30 \\ .01 \end{array}$ | 50 1 | $\mu \mathrm{A}$ | $\begin{aligned} & V_{\text {in }}=\text { Ground } \\ & V_{:}=-5.0 \mathrm{~V} \text { to }+5.0 \mathrm{~V} \end{aligned}$ |
| DATA OUTPUT \＆X OUTPUT |  |  |  |  |  |
| Logic＂0＂Level |  |  | －ご | $V$ | $12=1$－A（see fig． 7 ） |
| Logic＂1＂Level | Vcc－1．0 |  |  | － |  |
| FO＊TER CONSUMPTION |  | 140 | 2：う | $\cdots$ |  <br> ぼミジミが |
| $\varepsilon \therefore$－$-2 H$ CHARACTERISTICS |  |  |  |  |  |
| $\because$－tum Swith Closure see timing diagram－fig． 2 |  |  |  |  |  |
| ：：act Closure Resistance $\therefore$ 3en X 1 and Y 1 |  |  | 300 | c－m |  |
| $\bigcirc: \therefore \because$ Open Resistance | $1 \times 10^{7}$ |  |  | $\mathrm{C}-7$ |  |



## DESCRIPTION OF OPERATION

The KR2376－XX contains（see Fig．1）．a 2376－bit ROM． 8 －stage and 11 －stage ring counters．an 11－bit comparator，an oscillator circunt．an externally control：able delay network for eliminating the effect of contact bounce，and TTL／DTL／MOS compatible output drivers．
The ROM portion of the chip is a 264 by 9 －bit memory arranged into three 88 －word by 9 －bit groups．The appropriate levels on the Shift and Control inputs selects one of the three 88 －word groups；the 88 －individual word locations are addressed by the two ring counters．Thus，the ROM
address is formed by combining the Shift and Control Inputs with the two ring counters．

The external outputs of the 8 －stage ring counter and the external inputs to the 11－bit comparator are wired to the keyboard to form an $X-Y$ matrix with the 88 －keyboard switches as the crosspoints．In the standby condition，when no key is depressed，the two ring counters are clocked and sequentially address the ROM；the absence of a Strobe Output indicates that the Data Outputs are＇not valid＇at this time．

When a key is depressed. a single path is completed between one output of the 8 -stage ring counter (X0 thru $\times 7$ ) and one input of the 11-bit comparator (Y0-Y10). After a number of ctock cycles, a condition will occur where a level on the selected path to the comparator matches a level on the corresponding comparator input from the 11 -stage ring counter. When this occurs, the comparator generates a signal to the clock controland to the Strobe Output (via the delay network). The clock control stops the clocks to the ring counters and the Data Outputs
(B1-B9) stabilize with the selected 9-bit code, indicated by a 'valid' signal on the Strobe Output. The Data Outputs remain stable until the key is released.
As an added feature two inputs are provided for external polarity control of the Data Outputs. Parity Invert (pin 6) provides polarity control of the Parity Output (pin 7) while the Data and Strobe Invert Input (pin 20) provides for polarity control of Data Outputs B1 thru B8 (pins 8 thru 15) and the Strobe Output (pin 16).

## SPECIAL PATTERNS

S-ce the selected coding of each key is defined cong the manufacture of the chip, the coding can te cnanged to fit any particular application of the keyboard. Up to 264 codes of up to 8 bits (plus one parity bit) can be programmed into the KR2376-XX

ROM covering most popular codes such as ASC11, EBCD1C, Selectric. etc, as well as many specialized codes. The ASC11 code is available as a standard pattern. For special patterns, use Fig. 9 .

TIMING DIAGRAM




Fig. 2


OUTPUT DRIVER \& " $X$ " OUTPUT STAGE TO KEYBOARD


POWER SUPPLY CONNECTIONS FOR MOS OPERATION
"Y" INPUT STAGE FROM KEYBOARD


Fig. 3


Fig. 4


CODE ASSIGNMENT CHART
KR2376-ST
a Bit ASCII, odd parity


DATA (81-B8) INVERT
TRUTH TABLE


STROBE INVERT
TRUTH TABLE


MODE SELECTION
$\bar{S} \bar{C}=N$
$\mathrm{S} \overline{\mathrm{C}}=\mathrm{S}$
$\mathrm{S} \mathrm{C}=\mathrm{C}$
SC = INNALID ISPLRIOJSCATAI

Fig. 9


STANDARD MICROSYSTEMS CORPORATION =-


Circuit dragrams utilizrng SMC prodjcts are included as a means on ilustrating lypical semiconductor applicalinhs. consequently comple? inicrmation sultcient tof construchion purposes is not mecessarily given The iniormation has been care:ully chect xed and is believed to be enlirely reliable However, ho responsibility is assumed ior inaccuracies Furithermore. such intormalion does nol convey to the purchaser of the semiconductor cevices described any bcense under the palent righls of SMC or others SMC reserves the rignt to make changes
at any lime th order to improve design and supply the best product possibie.

## Appendix C7

## Universal Asynchronous Receiver/Transmitter UART

## FEATURES

Direct TTL Compatibility - no interfacing circuits requiredFull or Half Duplex Operation - can receive and transmit simultaneously at different baud ratesFully Double Buffered-eliminates need for precise external timingStart Bit Verification - decreases error rateFully Programmable - data word length, parity mode. number of stop bits; one, one and one-half, or twoHigh Speed Operation - 40K baud. 200ns strobesMaster Reset - Resets all status outputs| Pin Configuration |  |
| :---: | :---: |
| vec 1 | 40 |
| voo 2 | ${ }^{39} \mathrm{P}$ POE |
| Snd ${ }^{\text {a }}$ | 38 nobl |
| ROE 4 | ${ }^{37}$ P ND日2 |
| RO8 $\mathrm{C}_{5}$ | ${ }^{36}$ N NS |
| $\mathrm{ROC7}^{8}$ | ${ }^{36} \mathrm{~F}^{\mathrm{NPB}}$ |
| R06 ${ }^{\text {a }}$ | ${ }^{34} \mathrm{f} \mathrm{cs}$ |
| ROS ${ }^{\text {d }}$ | ${ }^{33}{ }^{\text {P }}$ |
| RD4 ${ }^{\text {R }}$ | ${ }^{32}$ TV\% |
|  |  |
| RC2 ${ }^{\text {R }}$ | ${ }^{39}{ }^{30}$ ¢ TOS |
| RPE ${ }^{\text {a }} 13$ | ${ }_{28}{ }^{\text {5 }}$ TD3 |
| Rfe 14 |  |
| $\mathrm{AOPO}^{\text {O }}$ is | ${ }^{26} 51$ |
| SWE C 18 | 25.150 |
| ACP $\mathrm{Cl}^{17}$ | 24.1 teoc |
| ADAE ${ }^{18}$ | 23.105 |
| ADA ${ }^{19}$ |  |
| ASt 20 | ${ }^{21} \mathrm{MA}$ |
| PACKAGE: $40-$ Pin D.IP |  |

$\square$ Tri-State Outputs - bus structure oriented
LLow Power-minimum power requirementsInput Protected - eliminates handling problemsCeramic or Plastic Dip Package - easy board insertion

## GENERAL DESCRIPTION

The Universal Asynchronous Receiver/Transmitter is an MOS/LSI monolothic circuit that performs all the receiving and transmitting functions associated with asynchronous data communications. This circuit is fabricated using SMC's P-channel low voltage oxidenitride technology. The duplex mode, baud rate, data word length, parity mode, and number of stop blts are independently programmable through the use of externai controls. There may be $5,6,7$ or 8 data bits, odd/even or no parity, and 1 , or 2 stop bits or 1.5 stop bits when utilizing a 5 -bit code from the COM 2017 or COM 2017/H. The UART can operate in either the full or half duplex mode. These programmable features provide the user with the ability to interface with all asynchronous peripherats.


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## DESCRIPTION OF OPERATION - TRANSMITTER

At start-up the power is turned on, a clock whose frequency is 16 times the desired baud rate is applied and master reset is pulsed. Under these conditions TBMT, TEOC, and TSO are all at a high level (the line is marking).
When TBMT and TEOC are high, the control bits may be set. After this has been done the data bits may be set. Normally, the control bits are strobed into the transmitter prior to the data bits. However, as long as minimum putse width specifications are not violated, TDS and CS may occur simultaneously. Once the date strobe (TDS) has been pulsed the TBMT signal goes low, indicating that the data bits buffer register is full and unavailable to recelve new data.
If the transmitter shift register is transmitting previously loaded data the TEMT signal remains low. If the transmitter shift register is empty, or when it is through transmitting the previous character, the data in the butfer register is loadedimmediately into the transmitter shift register and data transmission
commences. TSO goes low (the start bit), TEOC goes low, the TBMT goes high indicating that the data in the data bits buffer register has been loaded into the transmitter shift register and that the data bits buffer register is available to be loaded with new data.
If new data is loaded into the data bitsbuffer register at this time, TBMT goes low and remains in this state until the present transmission is completed. One full character time is available for loading the next character with no lossinspeed of transmission. This is an advantage of double buffering.
Data transmission proceeds in an orderly manner: start bit, data bits, parity bit (if selected), and the stop bit(s). When the last stop bit has been on the line for one bit time TEOC goes high. If TBMT is low, transmission begins immediately. If TBMT is high the transmitter is completely at rest and, if desired, new control bits may be loaded prior to the next data transmission.

## TRANSMITTER BLOCK DIAGRAM



## DESCRIPTION OF OPERATION - RECEIVER

At start-up the power is turned on, a clock whose frequency is 16 times the desired baud rate is applied and master reset is pulsed. The data available (RDA) signal is now low. There is one set of control bits for both the receiver and transmitter.
Data reception begins when the serial input line transitions from mark (high) to space (low). If the RSI line remains spacing for a $1 / 2$ bit time, agenuine start bit is verified. Should the line return to a marking condition prior to a $1 / 2$ bit time, the start bit verification process begins again. A mark to space transition must occur in order to initiate start bit verification. Once a start bit has been verified, data receptıon proceeds in an orderly manner: start bit verified and received, data bits received, parity bit received (if selected) and the stop bit(s) received.
If the transmitted parity bit does not agree with the received parity bit, the parity error tlip-flop of the status word buffer register is set high, indicating a parity error. However, if the no parity mode is se-
lected, the parity error flip-flop is unconditionally held low, inhibiting a parity error indication. If a stop bit is not received, due to animproperly framed character, the framing error flip-flop is set high. indicating a framing error.
Once a fult character has been received internal logic looks at the data available (RDA) signal. If, at this instant, the RDA signal is high the receiver assumes that the previously received character has not been read out and the over-run flip-flop is set high. The only way the receiver is aware that data has been read out is by having the data available reset low.
At this time the RDA output goes high indicating that all outputs are available to be examined. The receiver shift register is now available to begin receiving the next character. Due to the double buffered receiver, a full character time is available to remove the received character.

| $\frac{\overline{\text { and }}}{\text { ENAELE }}$ <br>  |  |  | BLOCK DIAGRAM |
| :---: | :---: | :---: | :---: |
| DESCRIPTION OF PIN FUNCTIONS |  |  |  |
| PIN NO． | SYMBOL | NAME | FUNCTION |
| 1 | Vcc | Powersazey | －5 voli Supply |
| 2 | Vod | Poxersuごy | －iていご！Sufzly |
| 3 | GND | Ground | Ground |
| 4 | $\overline{\text { ROE }}$ | Fecerved Data Enasie | A low－level input enables the outputs（RD8－RD1）of the receiver buffer register． |
| 5－12 | RD8－RD1 | $\begin{aligned} & \text { Fiselver Data } \\ & \text { Ou:puis } \end{aligned}$ | These are the 8 tri－state data outputs enabled by $\overline{\text { FこE }}$ Unused data output ines，as selected by NOB＇$a^{-}=$ゆDB2， have a low－level output，and received characters a－er ght justified，i．e．the LSB always appears on the F．J．cust． |
| 13 | RPE | Fぎener Parity Eiror |  the received character parity bit coes 「こ：未う＇ee win the selected parity． |
| 14 | RFE | Recener framing Error | This tri－state output（enabled by $\overline{S W E} \cdot: \Xi$ ：a nigh－level if the received character has no valid s：こえ口 |
| 15 | ROR | Receiver Over Run | This tri－state output（enabled by Sin：is at a high－level if the previously received character is not read（RDA output not reset）before the present character is transferred into the receiver buffer register． |
| 16 | SWE | Status Word Enable | A low－level input enables the outputs（RPE，RFE，ROR， RDA，and TBMT）of the status word buffer register． |
| 17 | RCP | Receiver Clock | This input is a clock whose frequency is 16 times（16X）the desired receiver baud rate． |
| 18 | $\overline{\text { RDAR }}$ | Receiver Data Available Reset | A low－level input resets the RDA output to a low－level． |
| 19 | RDA | Receiver Data Available | This tri－state output（enabted by $\overline{S W E}$ ）is at a high－level when an entire character has been received and transterred into the receiver buffer registor． |
| 20 | RSI | Receiver Serial Input | This input accepts the serial bit input stream．A high－level （mark）to low－level（space）transition is required to initiate data reception． |
| 21 | MR | Master Reset | This input should be pulsed to a high－level after power turn－on．This sets TSO，TEOC，and TBMT to a high－level and resets RDA，RPE，RFE and ROR to a low－level． |


| 22 | TBMT | Transmitter Butfer Empty | This tri-state output (enabled by $\overline{\mathrm{SWE}}$ ) is at a high-level when the transmitter buffer register may be loaded with new data. |
| :---: | :---: | :---: | :---: |
| 23 | $\overline{T D S}$ | Transmitter Data Strobe | A low-level input strobe enters the data bits into the transmitter buffer register. |
| 24 | TEOC | Transmitter End ot Character | This output appears as a high-level eachtime afull character is transmitted. It remains at this level until the start of transmission of the next character or for one-half of a TCP period in the case of continuous transmission. |
| 25 | TSO | Transmitter Serial Output | This output serialfy provides the entire transmitted character. TSO remains at a high-level when no data is being transmitted. |
| 26-33 | TD1-TD8 | Transmitter Data Inputs | There are 8 data input lines (strobed by $\overline{T D S}$ ) available. Unused data input lines, as selected by NDB1 and NDB2, may be in either logic state. The LSB should always be placed on TD1. |
| 34 | CS | Control Strobe | A high-level input enters the control bits (NDB'. NDB2. NSB, POE and NPB) into the control bits th: $\begin{aligned} \text { reg reg ster }\end{aligned}$ This line may be strobed or hard wired to a nıgn-etiel. |
| 35 | NPB | No Parity Bit | A high-tevel input eliminates the parity bit from ce ${ }^{-} \boldsymbol{g}$ transmitted; the stop bit(s) immediately follow tre Est data bit. In addition, the receiver requires the stop $\mathrm{b}: \leq: 2$ foilow immediately after the last data bit. Also, the RPE cu: \#ut is forced to a low-level. See pin 39, POE. |
| 36 | NSB | Number of Stop Eits | This input selects the number of stop bits. A low-level input selects 1 stop bit; a high-level input selects 2 stop bits. Selection of 2 stop bits when programming a 5 data bit word generates 1.5 stop bits from the COM 2017 or COM $2017 . \mathrm{H}$. |
| 37-38 | NDB2, NDB1 | Number of Data BitsiCharacter | These 2 inputs are internally decoded to select either 5. 6.7, or 8 data bitsicharacter as per the following truth table: |
| 39 | POE | Odd/Even Parity Select | The logic level on this input, in conjunction with the NPB input, determines the parity mode for both the receiver and transmitter, as per the following truth table: |
|  |  |  | NPS POE MODE <br> L L odd parity <br> $L$ $H$ even parity <br> H $X$ nop parity <br>   $X=$ don't care |
| 40 | TCP | Transmitter Clock | This input is a clock whose frequency is 16 times (16X) the desired transmitter baud rate. |

TRANSMITTER TIMING-8 BIT, PARITY, 2 STOP BITS


-The ROA hins was previously nol reset iROR a high-levelf.
-The ROA line was previously resel ( $\mathrm{COR}=\mathrm{I}$ Iow-leveli.
START BIT DETECT/VERIFY
RCP
RSI

 marking condition prior to a $1 / 2$ bill time. In fiari bil vorilicauon procest bagins again.

## MAXIMUM GUARANTEED RATINGS*

Operating Temperature Range $\ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots{ }^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

Lead Temperature (soldering, 10 sec .) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $+325^{\circ} \mathrm{C}$
Positive Voltage on any Pin, Vcc ............................................................................. +0.3 V
Negative Voltage on any Pin, Vcc . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -25 V
-Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other conditionabove thoseindicated in theoperational sections of this specification is not implied.

ELECTRICAL CHARACTERISTICS ( $T_{A}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{VCC}=+5 \mathrm{~V} \pm 5 \%, \mathrm{VDD}=-12 \mathrm{~V} \pm 5 \%$, unless otherwise noted)

| Parameter | Min. | Typ. | Max. | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D.C. CHARACTERISTICS INPUT VOLTAGE LEVELS |  |  |  |  |  |
| Low-level, VIL High-level, $\mathrm{V}_{\mathrm{H}}$ | $\begin{gathered} V=0 \\ V<0-1.5 \end{gathered}$ |  | $\begin{aligned} & 0.8 \\ & \mathrm{VCC} \end{aligned}$ | V |  |
| OUTPUT VOLTAGE LEVELS |  |  |  |  |  |
| Low-level, Vol High-level, Von | 2.4 | $\begin{aligned} & 0.2 \\ & 4.0 \end{aligned}$ | 0.4 | $V$ | $\begin{aligned} & 10 \mathrm{~L}=1.6 \mathrm{~mA} \\ & 1 \mathrm{OH}=100 \mu \mathrm{~A} \end{aligned}$ |
| INPUT CURRENT |  |  |  |  |  |
| Low-level, IIL |  |  | 1.6 | mA | see note 4 |
| OUTPUT CURRENT |  |  |  |  |  |
| Leakage, JLo |  |  | -1 | $\mu \mathrm{A}$ | $\overline{\text { SWE }}=\overline{\mathrm{RDE}}=\mathrm{V}_{\text {IH, }} 0 \leq \mathrm{V}_{\text {OUT }} \leq-5 \mathrm{~V}$ |
| Short circuit, los** |  |  | 10 | mA | Vout $=0 \mathrm{~V}$ |
| INPUT CAPACITANCE |  |  |  |  |  |
| All inputs, CiN |  | 5 | 10 | pf | $\mathrm{VIN}=\mathrm{Vcc}, \mathrm{f}=\mathbf{1 M H z}$ |
| output capacitance All outputs, Cout |  | 10 | 20 | pf | $\overline{\mathrm{SWE}}=\overline{\mathrm{RDE}}=\mathrm{V}_{1 \mathrm{H},} \uparrow=7 \mathrm{MHz}$ |
| POWER SUPPLY CURRENT |  |  |  |  |  |
| $\begin{aligned} & \mathrm{ICC} \\ & \text { lod } \end{aligned}$ |  |  | $\begin{aligned} & 28 \\ & 28 \end{aligned}$ | $\mathrm{mA}_{\mathrm{mA}}$ | All outputs $=$ VOH. $\mathrm{A}: 1 \mathrm{l}$ inputs $=\mathrm{VCC}$ |
| A.C. CHARACTERISTICS CLOCK FREQUENCY |  |  |  |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| (COM2502, COM2017) | DC |  | $400$ | $\mathrm{KHz}$ | RCP, TCP RCP TCP |
| PULSE WIDTH |  |  |  |  |  |
| Clock | 1 |  |  | $\mu \mathrm{s}$ | RCP, TCP |
| Master reset | 500 |  |  | ns |  |
| Control strobe | 200 |  |  | ns | CS |
| Transmitter data strobe | 200 |  |  | ns | TDS |
| Receiver data available reset | 200 |  |  | ns | RDAR |
| INPUT SET-UP TIME |  |  |  |  |  |
| Data bits | $\geq 0$ |  |  | ns | TD1-T08 |
| Control bits | $\geq 0$ |  |  | ns | NPB, NSB, NDB2, NDB1, POE |
| INPUT HOLD TIME |  |  |  |  |  |
| Data bits | $\geq 0$ |  |  | ns | TD1-TD8 |
| Control bits | $\geq 0$ |  |  | ns | NPB, NSB, NDB2, NDB1, POE |
| STROBE TO OUTPUT DELAY |  |  |  |  | Load $=20 \mathrm{pf}+1 \mathrm{TTL}$ input |
| Receive data enable |  |  | 350 | ns | RDE: TPdi, Tros |
| Status word enable |  |  | 350 | ns | SWE: TPDI, TPDO |
| OUTPUT DISABLE DELAY |  |  | 350 | ns | RDE, SWE |

**Not more than one output should be shorted at a time.
NOTES: 1. If the transmitter is inactive (TEOC and TBMT are at a high-level) the start bit will appear on the TSO line within one clock period (TCP) after the trailing edge of TDS.
2. The start bit (mark to space transition) will always be detected within one clock period of RCP. guaranteeing a maximum slart bit slippage of $1 / 16$ th of a bit time.
3. The tri-state output has 3 states: 1) lowimpedance to Vcc 2)lowimpedancetoGND 3) high impedance OFF $\cong$ 10 M ohms. The "OFF" state is controlled by the SWE and RDE inputs.
4. Under steady state conditions no current flows for TTL or MOS interfacing. (COM 2502 or COM 2502/H)



STANDARD MICROSYSTEMS
CORPORATON

Circ, $\dagger$ dizまams utiling SMC products are inctuded as a means of iflustrating typical semicontuctor applicatien. Fcrsezueniy complete intormation sulicient tor construction purposes is nol necessarily given The intcriatict res ceen carefully checked and is believed to be eniwely reliable. However. no responsibllivy is assariez :or !reatejacies Furlhermore. suth nits devices cesc wed any at any time in order to improve design and supply the best product possible

## Appendix C8

# CRT Video Timer and Controller VTAC ${ }^{\text {® }}$ 

FEATURES
$\square$ Fully Programmable Display Format
Characters per data row（1－200）
Data rows per trame（1－64）
Raster scans per data row（1－16）
［］Programmable Mor ：or Sync Format
Raster Scans．Frame（256－1023）
＂Front Poren
Sync Width
＂Back Porch＂
Interlace $\because=n+$ nterlace
Vertical $3=-3$
口 Lock Line！：＿：SRT 5057）
－Direct Dutニ－
Horizざっミ ミ：ーこ
Vertっきぎご
Corr＝ミ：こう，－こ（CRT 5027，CRT 5037）
Bla～＊～？
Cしくらご：こ～こ こもヤce
ᄃPrくごきーーデーシ

Ex：ぎミニニご，



［Gero：l－7
Sing e＿－
Multi－－e
PIN CONFIGURATION

$\square$ Split－Screen Applications
Horizontal
Vertical
－Interlace or Non－Interlace cperation
$\square$ TTL Compatibility
［－BUS Oriented
$\square$ Cursor Fes：こー＝をこ きters
$\square$ High Speed Operation
$\square$ COPLAMOS：N－Channel Silicon
Gate Technology

Balanced 日eき～こいうni nierlace（CRT 5037）
Compatible with CRT $8: 902$ VDAC $^{\text {TM }}$
$\square$ Compalible with CRT 7CO4

## GENERAL DESCRIPTION

The CRT Video Tımere゙こここんここ erChip（VTAC）is a user programmable 40－pin COPLAMOS＊nchanne：MOS／LS device containing the $\log \varepsilon^{\prime}-こ: \Sigma^{\prime}$ s requred to generate all the timing signals for the presentation and formatting of interlaced and non－interlacez，持 za：a on a standard or non－standard CRT monitor．

With the exception of the ここ：ç－－ter．which may be clocked at a video frequency above 25 MHz and theretore not recommended for MOS imp $\in^{-\rightarrow-s^{*}}$ on allfame formalting，such as horizontal，vertical，and composite sync，characters per data row，data rows per frame $2 \rightarrow \square$ easter scans per data row and per frame are totally user programmable．The data row counter has been designed to ！at ：a：e scroling．

Programming is effected ty tazing seven 8 bit control registers directly offan 8 bit bidirectional databus．Four register address lines and a chip select line orgice compiete microprocessor compatibity for program controlled set up．The device can be＂self loaded＂via an externa：FFOMtıed on the data bus as described in the OPERATION section．Formatting canalso be programmed by a single mask opt．on．

In addition to the seven control registers two additional registers are provided to store the cursor character and data row addresses for generation ol the cursor video signal．The contents of these two registers can also be read out onto the bus for update by the program．

Three verslons of the VTAC are available．The CRT 5027 provides non－interlaced operation with an even or odd number of scan lines per data row，or interiaced operation with aneven number of scan lines perdata row．The CRT 5037 may be programmed for an odd or even number of scan lines per data row in both interlaced and non－interlaced modes． Programming the CRT 5037 for an odd number of scan lines per data row eliminates character distortion caused by the uneven beam current normally associated with odd field／even field interlacing of alphanumeric displays．

The CRT 5057 provides the ability to lock a CRT＇s vertical reiresh rate，as controlled by the VTAC＇s＊vertical sync pulse，to the 50 Hz or 60 Hz line frequency thereby eliminating the so called＂swim＂phenomenon．This is particularly well suited for European system requirements．The line frequency waveform，processed to conform to the VTAC＇s ${ }^{( }$ specified logic levels，is applied to the line lock input．The VTAC＊will inhibit generation of vertical sync until a zero to one transition on this input is detected．The vertical sync pulse is then initiated within one scan line after this transition rises above the logic threshold of the VTAC． 6

To provide the pin required for the line lock input，the composite sync output is not provided in the CRT 5057.

```
－FOR FUTURE RELEASE
```

| Pin No. | Symbol | Name | Input/ Output | Function |
| :---: | :---: | :---: | :---: | :---: |
| 25-18 | D8¢-7 | Data Bus | 10 | Data bus. Input bus for control words from microprocessor or PROM. Bidirectional bus for cursor address. |
| 3 | cs | Chip Select | 1 | Signals chip that it is being addressed |
| 39,40,1,2 | A9.3 | Register Address | 1 | Register address bits for selecting one of seven control registers or either of the cursor address registers |
| 9 | $\overline{\text { DS }}$ | Oata Strobe | 1 | Strobes DBg. 7 into the appropriate register or outputs the cursor character address or cursor line address onto the data bus |
| 12 | DCC | DOT Counter Carry | 1 | Carry from off chip dot counter establishing basic character clock rate. Character clock. |
| 38-32 | Hø-6 | Character Counter Outputs | 0 | Character counter outputs. |
| 7,5,4 | R1-3 | Scan Counter Outputs | 0 | Three most significant bits of the Scan Counter: row select inputs to character generator. |
| 31 | H7/DR5 | H7/DR5 | 0 | Pin definition is user programmable. Output is MSB of Character Counter if horizontal line count (REG. $)$ is 2128 ; otherwise output is MSB of Data Row Counter. |
| 8 | R $\varnothing$ | Scan Counter LSB | 0 | Least significant bit of the scan counter. In the interlaced mode with an oven number of scans per data row, Ro will toggle at the field rate; for an odd number of scans per data row in the interlaced mode. RO whil toggle at the data row rate. |
| $26 \cdot 30$ | DR8. 4 | Data Row Counter Outputs | 0 | Data Row counter outputs. |
| 17 | BL | Eank | 0 | Defines non active portion of torizontal and vertical scans. |
| 15 | HSYN | Hoz zontal Sync | 0 | Initiates horizontal retrace. |
| 11 | VSYN | Ve:cal Sync | 0 | Initiates vertical retrace. |
| 10 | $\begin{aligned} & \text { CSYN/ } \\ & \text { LLI } \end{aligned}$ | Coms Line Lesく Input | O/l | Composite sync is provided on the CRT 5027 and CRT 5037. <br> This output is active in non-? !er'aced mode only. Provides a true RS-170 composite sync wave !erm. For the CRT 5057, this pin is the Line Lock Input. The lire 'equency waveform, processed to conform to the VTAC'ss specifed logic levels, is applied to this pin. |
| 16 | CRV | Cursor Video | $\bigcirc$ | Defines cursor locaton in Ca:a seid. |
| 14 | Voc | Power Supply | PS | -5 volt Power Supply |
| 13 | Voo | Power Supoly | PS | + 12 volt Power Supply |



## Operation

The design philosophy employed was to allow the device 10 interface effectively with either a microprocessor based or hardwife logic system．The device is programmed by the user in one of two ways；via the processor data bus as part of the system initialization routine，or during power up via a PROM tied on the data bus and addressed directly by the Row Select outputs of the chip．（See figure 4）．Seven 8 bit words are required to fully program the chip．Bit assignments for these words are shown in Table 1．The information contained in these seven words consists of the following：

Horizontal Formatting：
Characters／Dala Row

Horizontal Sync Delay
Horizontal Sync Width

Horizontal Line Count
Skew Bits

Vertical Formatting
interlaced／Non－interlaced

Scans／Frame 8 bits assigned，defined according to the following equations：Let $X=$ value of 8 assigned bits．
1）in interlaced mode－scans／frame $=2 x+513$ ．Therefore for 525 scans． program $X=6(00000140)$ ．Vertical sync will occur precisely every 262.5 scans． thereby producing two interlaced fields
Range $=513$ to 1023 scans／frame，odd counts only
2）in non－interlaced mode－scansiframe $=2 x+256$ ．Therefore for 262 scans． Pregram $X=3(00000011)$ ．
Rarge $=256$ to 766 scans／irame，even counts only．
in either mode，vertical sync width is fixed at three horizontal scans（ $\mathbf{x} 3 \boldsymbol{H}$ ）
 s，－o until the start of display data．At this raster scan the data rこ．こえunter is $\$ \approx$ to the data row address at the top of the page．
Data Rows F－z－e
Lasi Data Ron
Scans／Data Row $\quad \pm=:$ sassigned providing up to 16 scan lines per deta row

## Additional Features

## Device initialization：

Under microprocessor control－The device can be resel under syslem or program control by presenting a 1010 address on A3－才．The device will remain reset at the top of the even field page until a start command is executed by presenting a 1110 address on A －$\varnothing$ ．

Via＂Self Loading＂－In a non－processor environment，the self loading sequence is effected by presenting and holding the 1111 address on A3• $\mathbb{O}_{\text {，}}$ and is intiated by the receipt of the strobe pulse（DS）．The 1111 address should be maintained long enough to insure that all seven registers have been loaded（in most applicalions under one millisecond）．The timing sequence will begin one line scan after the 1111 address is removed．In processor based systems，self foading is initiated by presenting the $\varnothing 111$ address to the device．Self toading is terminated by presenting the start command to the device which also inituates the tirming chain．

Scrolling－In addition to the Register 6 storage of the last displayed data row a＂scroll＂command（address 1ø11） presented to the device will increment the first displayed data row count to facilitate up scrolling in certain applications．

## Control Registers Programming Chart

Horizontal Line Count： Characters／Data Row：

Horizontal Sync Delay Horizontal Sync Width：

Skew Bits

Scans／Frame

Vertical Data Start
Data Rows／Frame
Last Data Row：

Mode：
Scans／Data Row：

Total Characters／Line $=\mathrm{N}+1, \mathrm{~N}=0$ to 255 （ $\mathrm{DBO}=$ LSB） DB2 DB1 DB0

| 0 | 0 | $0=20$ |
| :--- | :--- | :--- |
| 0 | 0 | $1=32$ |
| 0 | 1 | $0=40$ |
| 0 | 1 | $1=64$ |
| 1 | 0 | 0 |
| 1 | 0 | $1=72$ |
| 1 | 1 | 0 |
| 1 | 1 | $1=96$ |
| 1 | $=132$ |  |

$=N$ ，from 1 to 7 character times（ $D B O=L S B$ ）（ $N=0$ Disallowed） $=N$ ，from 1 to 15 character times（DB3＝LSB）$(N=0$ Disallowed $)$ Sync／Blank Delay CursorDelay
DB7 DB8

| 0 | 0 |
| :--- | :--- |
| 1 | 0 |
| 0 | 1 |
| 1 | 1 |

Character Times）

## 0

0
1 2
2

8 bits assigned，defined according to the following equations： Let $\mathrm{X}=$ value of 8 assigned bits ．（ $\mathrm{DB} 0=\mathrm{LSB}$ ）
1）in interiaced mode－scans／frame $=2 X+513$ ．Therefore for 525 scans， program $X=6(00000110)$ ．Vertical sync will occur precisely every 262.5 scans，thereby producing two interlaced fields．
Range $=513$ to 1023 scans $/$ frame，odd counts only
2）in non－interlaced mode－scans／frame $=2 \mathrm{X}+256$ ．Therefore for 262 scans，program $X=3(00000011)$ ．
Range $=256$ to 766 scans $/$ frame，even counts only．
In either mode，vertical sync width is fixed at three horizontal scans（ $=3 \mathrm{H}$ ）．
$N=$ number of raster lines delay after leading edge of vertical sync of vertical start position．（DEO $=\mathrm{LSB}$ ）
Number of data rows $=N+1, N=0$ to 63 （DBO $=\mathrm{LSB}$ ）
$N=$ Address of last dsplayed data row，$N=0$ to 63 ，ie；for 24 data rows， program $N=23$ ．（ $\mathrm{DBO}=\mathrm{LSB}$ ）
Register， $1, \mathrm{DB7}=1$ establishes Interlace．
Interlace Mode
CRT 5227 ：Scans per Data Row $=\mathrm{N}+1$ where $\mathrm{N}=$ programmed number of Gミ：こns $N=0$ to 15 Scans per data row must be even counts only
Cごミこうて．CRT 5057：Scans per data Row $=\mathbf{N + 2 .} \mathbf{N}=0$ to 14，odd or even ccr－ts．

Non－Interlace Mode
CRT 5こ2．CRT 5＾37．CfT 5057：Scans per Data Row $=\mathbf{N + 1}$ ，odd or evencoun：$N=0: 015$


## Register Seiects/Command Codes

A3 A2 A1 Ag

| 0 | 0 | 0 | 0 |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 0 |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 0 |
| 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 0 |
| 0 | 1 | 1 | 1 |


| 1 | 0 | 0 | 0 |
| :--- | :--- | :--- | :--- |
| 1 | 0 | 0 | 1 |
| 1 | 0 | 1 | 0 |

1011

11000
$\begin{array}{llll}1 & 1 & 0 & 1 \\ 1 & 1 & 1 & 0\end{array}$

1111

Select/Command
Load Control Register $\emptyset$
Load Control Register 1
Load Control Register 2
Load Control Register 3
Load Control Register 4
Load Control Register 5
Load Control Register 6
Processor Initialed Self Load

Read Cursor Line Address Read Cursor Character Address Reset

Up Scroll

Description
I
See Table 1

Command from processor instructing VTAC to enter Self Load Mode (via external PROM)

Resets timing chain to top left of page. Reset is latched on chip by $\overline{D S}$ and counters are held until released by star command. Increments address of first displayed data row on page. ie; prior to receipt of scroll command-top line $=0$, bottom line $=23$. After receipt of Scroll Command-top line $=$ 1, bottom line $=0$.

Receipt of this command after a Reset or Processor Self Load command will release the timing chain approximately one scan line later. In applications requiring synchronous operation of more than one CRT 5027 the dot counter carry should be held low during the $\overline{D S}$ for this command.
Device will begin self load via PROM when $\overline{D S}$ goes low. The 1111 commend should be maintained on A3-7 ong enough to guarantee self lozc. IScan counter should cycle througn at least once). Self load is automatice y terminated and timing chain initiz: $\because=$ when the all " 1 's" condition is removes. independent of DS. For synchrorous operation of more than one VTAC!. tre Jot Counter Carry should be held low when the command is removed.
-NOTE: During Self-LCaz. t-E C-sor Character Address Register (REG 7) and the Cursor Pew Aderess
 Therefore, Cursor ces: $n$ ine PROM should be stored at these addresses.

TABLE 1




## MAXIMUM GUARANTEED RATINGS



ELECTRICAL CHARACTERISTICS $\left(T_{A}=0^{\circ} \mathrm{C}\right.$ to $70^{\circ} \mathrm{C} . \mathrm{VCC}=+5 \mathrm{~V} \div 5 \% . \mathrm{V} 00=-12 \mathrm{~V}=5 \%$, unless otherwise noted $\}$

| Parameter | Min. | Typ. | Max. | Unit | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D.C. CHARACTERISTICS input voltage levels |  |  |  |  |  |
| Low Level, V/k | $V C 0-1.5$ |  | 0.8 | V |  |
| High Level. Vİ $\mathrm{V}^{\text {a }}$ |  |  | Vce | V |  |
| OUTPUT VOLTAGE LEVELS |  |  |  |  |  |
| Low Level-Vor for Rig-3 |  |  | 0.4 | V | $10 \mathrm{c}=3.2 \mathrm{ma}$ |
| Low Level-Vot all others |  |  | 0.4 | V | $1 \mathrm{a}=1.6 \mathrm{ma}$ |
| High Level-Vom for F ¢ - $3, \mathrm{DBQ}$-7 | 2.4 |  |  |  | $1 \mathrm{OH}=80 \mu \mathrm{a}$ |
| High Level-Von all others | 2.4 |  |  |  | $10 \mathrm{n}=40 \mu \mathrm{a}$ |
| INPUT CURRENT |  |  |  |  |  |
| Low Level, It (Address, CS only) |  |  | 250 | $\mu \mathrm{A}$ | $V_{10}=0.4 V$ |
| Leakage, Ill (All Inputs except Address. CS |  |  | 10 | ${ }_{\mu} \mathrm{A}$ | $\mathrm{O} \leq \mathrm{V}_{1} \leq \mathrm{Vcc}$ |
| INPUT CAPACITANCE |  |  |  |  |  |
| Data Bus, Cin |  | 10 | 15 | pF |  |
| DS, Clock, Cin |  | 25 | 40 | pF |  |
| All other, Cin |  | 10 | 15 | pF |  |
| DATA BUS LEAKAGE in INPUT MODE los |  |  | 10 | $\mu \mathrm{A}$ | $0.4 \mathrm{~V} \leq \mathrm{V}_{\mathrm{s}} \leq 5.25 \mathrm{~V}$ |
| POWER SUPPLY CURRENT |  |  |  |  |  |
| icc |  | 80 | 100 | $m A$ |  |
| IOD |  | 40 | 70 | mA |  |
| DOT COUNTER CARAY |  |  |  |  |  |
|  |  |  |  |  |  |  |
| Irequency | 0.2 |  | 4.0 | MHz | F こ- ${ }^{\text {cos }}$ |
| PWH PW | 35 215 |  |  | ns | F $\overline{\text { F }}$ - 1 |
| PW/ tr.til | 215 | 10 | 50 | ns | F F-el |
| DATA STROBE |  |  |  |  |  |
| PW $\overrightarrow{D S}$ | 150 ns |  | 10, S |  | F.jure 2 |
| ADDRESS. CHIP SELECT |  |  |  |  |  |
| Set-up time | 125 |  |  | ns | Figure 2 |
| Hold time | 50 |  |  | ris | Figure 2 |
| OATA BUS-LOADING |  |  |  |  |  |
| Set-up lime | 125 |  |  | 「3 | Figure 2 |
| Hold time | 75 |  |  | res | Figure 2 |
| DATA BUS-READING |  |  |  |  |  |
| Tdetz |  |  | 125 | ns | Figure 2. $\mathrm{CL}=50 \mathrm{pF}$ |
| ToEl | 5 |  | 60 | ns | Figure 2. $\mathrm{CL}=50 \mathrm{pF}$ |
| OUTPUTS: HD.7.HS, VS, BL, CRV, CS.Tpel, |  |  | 125 | ns | Figure 1. CL=20pF |
| OUTPUTS: Rด/3.ORD-5 ToEl3 | * |  | 500 | ns | Figure 3, CL=20pF |

*Rg-3 and DRig-5 may change prior to the falling edge of H sync

## Restrictions

1. Only one pin is available for strobing data into the device via the data bus. The cursor $X$ and $Y$ coordinates are therefore loaded into the chp by presenting one set of addresses and outpuled by presenting a different set of addresses. Therefore the standard WRITE and READ controi signais from most microprocessors must be "NORed" externally to present a single strobe (DS) signal to the device.
2. In interlaced mode the total number of character slots assigned to the horizontal scan must be even to insure that vertical sync occurs precisely between horizontal sync pulses.
 tions. consequently complete intormation sulficient tor consiruction purposes is not necessarily given The information has been carefully checked and is believed 10 be entirely reliable however. no respomsibuy is assumed tor inaccuracies. Furthermore, such information does not convey io he purchaser oithe semakendacion devices described any license under the palent rights of bit product possibie.

# Appendix C9 

# STANDARD MICROSYSTEMS CORPORATION <br> CRT 8002 <br> $\mu$ PC FAMILY 

# CRT Video Display Attributes Controller Video Generator VDAC $^{\text {™ }}$ 

## FEATURES

On chip character generator (mask programmable) 128 Characters (alphanumeric and graphic) $7 \times 11$ Dot matrix blockIO On chip video shift register
Maximum shift register írequency

| CRT 8002A | 20.4 H |
| :--- | :--- |
| CRT 8002 B | 15 H |
| CRT 8002 C | 100 H |
| ACess time | 4 C |

CRT $8002 \mathrm{C} \quad 10: 4 \mathrm{~Hz}$
IOn chip horizontal anc ver:cal retrace video blanking
$\square$ No descender circuitry recuiredFour modes of operation intermix三敃)
Internal character gent?
Wide graphics
Thin graphics
Externalinputs (fonts con.crsen cs)

- On chip attribute logic-chàracier. field Reverse video
Character blank
Character blink
Underline
Strike-thru
$\square$ Four on chip cursor modes
Underline
Blinking underline
Reverse video
Blinking reverse videoProgrammable character blink rate
Programmable cursor blink rate

PIN CONFIGURATION

$\square$ Subscriptable
$\square$ Expandable character set External fonts
Alphanumeric and graphic
RAM, ROM, and PROM
$\square$ On chip address buffer
$\square$ On chip attribute buffer
$\square+5$ volt operation
$\square$ TTL compatible
[: MOS N-channel silicon-gate COPLAMOS ${ }^{*}$ process
[i CLASP* technology-ROM and options
$\square$ Compatible with CRT 5027 VTAC ${ }^{5}$

## General Description

The SMC CRT 8002 Video Display Attriblies C=mtroller (VDAC) is an N -channel COPLAMOS $E$ hos LSI cevice which utilizes CLASP* technology it cyntans a 7X11×128 character generator ROM. a w se grashics mode, a thin graphics mode, an external irput mode. character address/data latich, field and or character attribute logic, attribute latch, four cursor mooes. two programmable blink rates, and a high speed video shift register. The CRT $8002 \mathrm{VDAC}^{+4}$ is a companion chip to SMC's CRT 5027 VTAC. Together these two chips comprise the circuitry required for the display portion of a CRT video terminal.
The CRT 8002 video output may be connected directly to a CRT monitor video input. The CRT 5027 blanking output can be connected directly to the CRT 8002 retrace blank input to provide both horizontal and vertical retrace blanking of the video output.
Four cursor modes are available on the CRT 8002.
They are: underline, blinking underline, reverse video block, and blinking reverse video block. Any one of these can be mask programmed as the cursor function. There is a separate cursor blink rate which can be mask programmed to provide a 15 Hz to 1 Hz blink rate.

The CRT 8002 attributes include: reverse video, character blank, blink, under'ne, and strike-thru. The character blink rate is masi programmable from 7.5 Hz to 0.5 Hz and has a duty cycle of $75 / 25$. The underline and strike-thru are similar but independently controlled functions and can be mask programmed to any number of raster lines at any position in the character block. These attributes are available in all modes.
In the wide graphic mode the CRT 8002 produces a graphic entity the size of the character block. The graphic entity contains 8 parts, each of which is associated with one bit of a graphic byte, thereby providing for 256 unique graphic symbols. Thus, the CRT 8002 can produce either an alphanumeric symbol or a graphic entity depending on the mode selected. The mode can be changed on a per character basis.
The thin graphic mode enables the user to create single line drawings and forms.
The external mode enables the user to extend the onchip ROM character set and/or the on-chip graphics capabilities by inserting external symbols. These external symbols can come.from either RAM, ROM or PROM.

Positive Voltage on any Pin，with respect io ground ．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．+8.0 C
Negative Vollage on any Pin，wilh respect to ground
＊Stresses atove those listed may cause permanent damage to the device．This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied．
NOTE：When powering this device from laboratory or system power supplies，it is important that the Absolute Maximum Ratings not be exceeded or device failure can result．Some power supplies exhibit voltage spikes or＂glitches＂on their outputs when the AC power is switched on and off． In addition，voltage transients on the AC power line may appear on the DC oulput．If this possibility exists it is suggested that a clamp circuit be used．

ELECTRICAL CHARACTERISTICS $\left\{T_{A}=0^{\circ} \mathrm{C}\right.$ to $70^{\circ} \mathrm{C}, V C C=+5 \mathrm{~V} \pm 5 \%$ ，unless otherwise noted）

| Parameler | Min． | Typ． | Max． | Unit | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D．C．CHARACTERISTICS <br> INPUT VOLTAGE LEVELS <br> Low－level，$V_{1}$ <br> High－level， $\mathrm{V}_{1-1}$ |  |  |  |  |  |
|  |  |  |  |  |  |
|  | 2.0 |  | 0.8 | V | excluding VDC <br> excluding VDC |
| INPUT VOLTAGE LEVELS－CLOCK <br> Low－level，$V_{10}$ <br> High－level， $\mathrm{V}_{\mathrm{IH}}$ | 4.3 |  | 0.8 | V | See Fighre 6 |
| OUTPUT VOLTAGE LE：：ELS Low－level，Vos High－level， $\mathrm{VOH}_{\mathrm{OH}}$ | 2.4 |  | 0.4 | $V$ | $\begin{aligned} & =0.4-A \cdot 74 L S \times \times 1 \text { oad } \\ & =-20, A \end{aligned}$ |
| INPUT CURRENT Leakage．I（Except CLOC Leakage，lı（CLOCK On．y） |  |  | $\begin{aligned} & 10 \\ & 50 \end{aligned}$ | ${ }_{\mu A}^{\mu A}$ | $\begin{aligned} & 0 \leq V_{1 N} \leq V_{c e} \\ & 0 \leq V_{1 N} \leq V_{c c} \end{aligned}$ |
| IN：OUT CAPACITANCE $\begin{aligned} & \text { DESH } \\ & \text { C-OCK } \end{aligned}$ |  | 10 20 25 |  | pf pF pF | $\begin{aligned} & \text { © } 1 \mathrm{MHz} \\ & 1 \mathrm{MHz} \\ & \text { (1) } 1 \mathrm{MHz} \end{aligned}$ |
| FここEA SUPPLY CURRENT 1きニ |  | 100 |  | mA |  |
| A．C．CHARACTERISTICS Sにき Figure 6， 7 |  |  |  |  |  |


| SYMBOL |  |  |  | PRELIMINARY$x=-1 n$ |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | PARAMETER | CRT 8002A |  | CRT 8002B |  | CRT 8002C |  | UNITS |
|  |  | MIN． | MAX． | MIN． | MAX． | M1N． | MAX． |  |
| VDC | Video Dot Clock Frequency | 1.0 | 20 | 1.0 | 15 | 1.0 | 10 | MHz |
| $\mathrm{PW}_{\mathrm{H}}$ | VDC－High Time | 15.0 |  | 23 |  | 40 |  | ns |
| PW | VDC－Low Time | 15.0 |  | 23 |  | 40 |  | ns |
| $t_{\text {cy }}$ | LD／$\overline{\mathrm{SH}}$ cycle time | 400 |  | 533 |  | 800 |  | ns |
| $t_{\text {r }}, \mathrm{t}_{\text {f }}$ | Rise，fall time |  | 10 |  | 10 |  | 10 | ns |
| $\mathrm{t}_{\text {ser．ur }}$ | Input set－up time | $\geq 0$ |  | $\geqslant 0$ |  | $\geq 0$ |  | กs |
| $t_{\text {HoL }}$ | Input hold time | 15 |  | 15 |  | 15 |  | ns |
| $\mathrm{t}_{\text {PDI，}} \mathrm{t}_{\text {PDO }}$ | Output propagation delay | 15 | 50 | $\pm 5$ | 65 | 15 | 100 | ns |
| $t_{1}$ | LD／${ }_{\text {SH }}$ set－up time | 10 |  | 15 |  | 20 |  | ns |
| $\mathrm{t}_{2}$ | LD／SH hold time | 15 |  | 15 |  | 15 |  | ns |



| PIN NO． | SYMBOL |  | NAME | $\left\lvert\, \begin{aligned} & \text { INPUT/ } \\ & \text { OUTPUT } \end{aligned}\right.$ | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | VIDEO |  | ideo Output | 0 | The video output contalins the dol stream for the selected row of the alpha－ numeric，wide graphic，thin graphic，or external character after processing by the attribute logic，and the retrace blank and cursor inpuls． <br> In the atphanumeric mode，the characlers are ROM programmed into the 77 dots，（ 7 X 11 ）allocated for each of the 128 characters．See figure 5 ．The top row（ $R$ d）and rows R12 to R15 are normally all zeros as is column C7．Thus，the character is defined in the box bounded by R1 to R11 and C6 to C6．When a row of the ROM，via the attribute logic，is parallel loaded into the 8 －bit shilt－register， the first bit serially shitted out is C7（A zero：or a one in REVID）．It is foliowed by $\mathrm{C} 6, \mathrm{C}$ ，through Co ． <br> The timing of the Load／亏hift pulse will determine the number of additional （－－，zero to N）backfill zeros（or ones it in REVID）shtted oul．See figure 4. When the next Load／Shift pulse appears the next character＇s row of the ROM， via the attribute logic，is parallel loaded Into the shilt register and the cycle repeats． |
| 2 | LD／5H |  | oad／SThift | 1 | The 8 bil shift－register parailel－in load or serial－out shift medes are established by the Load／Shift input．When low，this input enables the st＇t register for serial shifting with each Video Dot Clock pulse．When high，tre shift register parallel（broadside）data Inputs are enabled and synchronous isea ng occurs on the next Video Dot Clock pulse．During parallel loacing，ser al data flow is inhibited．The Address／Dala inpuls（AD－A7）are latched on the regative ：rans＇tion of the Load／Shift input．See timing diagram，figure 7 ． |
| 3 | VDC |  | ideo Dot Clock | 1 | F－esjenty at which video is shitted． |
| 4－11 | AV．A7 |  | ddress／Data |  | ！n ire Alshanumeric Mode the 7 bits on inputs（AD－A6）are inter＂a y cesoced to atzress one of the 128 available characters（ $A 7 \approx X$ ）．In the Extermal $\because=s e$ ， Ai－A 18 used to insert an 8 bit word from a user delined external ROM，PROM or EA：．1 nto the on－chip Attribute logic．In the wide Graphic Modes A 0 －A7 is used to cefine one of 256 graph：c entities．In the thin Graphic Mode Ag－A2 is luser：zcetine the 3 line segments． |
| 12 | Ve： |  | ower Supply | PS | －5： 5 ：sjwer supply |
| 13，14，15，16 | R2．Fご＊＊ |  | 27 Address | 1 | $T$－ |
| 17 | GND |  | こurd | G1．3 | Gra－J |
| 18 | ATTEE |  | $\because$－ |  |  <br>  <br>  <br>  <br>  －＇is＇ate atiribute latching on a characier by character basis，tie ATTEE －ミڭミ：－－－clagram，figure 7. |
| 19 | STKRU |  | $\because ¢$ |  |  <br>  <br>  <br>  <br>  <br>  ct： <br>  Eo a scuble line on rows R5 and R6． |
| 23 | UNDLN |  | nderitine |  | $\therefore-\ni-{ }^{-}$s $n$ ？ul is high and RETBL $=0$ ，the paraliel inputs to the st＇t reg＇ster <br>  <br>  <br>  <br>  <br>  $0^{*}$＝ra＂jement of horizontal línes in the character block．The standard urger－ －e：：Ee a single line on R11． |
| 21 | F． 6.0 |  | everse Video |  | $\because^{-}=^{-}:^{-} s$ ？ $=\cdot \in ; y$ is the shift register parallel inpuls．When reverse video is high data EO－ ： |
| 22 | Ch：ABL |  | racter Blank |  | $\therefore \sim_{0}^{*-*: s ~ i n p u t ~ i s ~ h i g h, ~ t h e ~ p a r a l l e l ~ i n p u t s ~ t o ~ t h e ~ s h i f t ~ r e g i s t e r ~ a r e ~ a f t ~ s e t ~ l o w, ~}$ pros a ng a blank character line segment．Character blank will override blink． Tre coeration of Character Blank is modified by the Reverse Video Input． Sep ：an＇e 1 |
| 23 | V SYNC |  | SYNC | 1 | This mput is used as the clock input for the two on－chip mask programmabile blink rate dividers．The cursor blink rate（ $50 / 50$ duty cycle）will be twice the character blink rate（ $75 / 25$ duty cycle）．The divisors can be programmed from -4 to $\div 30$ for the cursor $(\div 8$ to $\div 60$ for the character）． |
| 24 | BLINK |  | ink | 1 | When this input is high and RETBL $=0$ and CHABL $=0$ ，the character will blink at the programmed character blink rate．Blinking is accomplished by blanking the character block with the internal Character Blink clock．The standard character brink rate is 1.875 Hz ． |
| $\begin{aligned} & 25 \\ & 26 \end{aligned}$ | MS1 MS§ | Mode Select 1 Mode Select 1 |  |  | These 2 inputs define the four modes of operation of the CRT 8002 as follows： Alohanumeric Mode－In this mode addresses A 0 －A 6 （ $\mathrm{A} 7=\mathrm{X}$ ）ase in－ ternally decoded to address 1 of the 128 available ROM characters．The addressed character along with the decoded row will define a 7 blt output from the ROM to be loaded into the shift register via the attribute logic． <br> Thin Graphics Mode－In this mode AD－A2（A3－A7＝X）will be loaded into the thin graphic logic along wilh the row addresses．This logic will deline the segments of a graphic entity as defined in figure 2．The top of the entlty will begin on row 0000 and will end on a mask programmable row． |
|  | MS1 | MS0 | M MODE |  |  |
|  | 1 1 0 0 | 1 0 1 0 | Alphanumeric Thin Graphics External Mode Wide Graphics |  |  |


| PIN NO. | SYMBOL | NAME | INPUT/ OUTPUT | FUNCTION |
| :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} 25 \\ 26 \\ \text { (conl.) } \end{gathered}$ |  |  |  | Exiernal Mode - In this mode the inputs Aa-A7 go directly from the character latch into the shift register via the attribute logic. Thus the user may detine external character fonts or graphic entitles in an external PROM. ROM or RAM. See figure 3. <br> Wide Graphics Mode - In this mode the inputs Ag-A7 will define a graphic enlity as described in figure 1. Each line of the graphic entity is determined by the wide graphic logic in conjunction with the row inputs R10 10 R3. In this mode each segment of the entity is defined by one of the bils of the 8 bit word. Therefore, the 8 bits can define any 1 of the 256 possible graphic entities. These entities can butt up against each other to form a contiguous pattern or can be interspaced with alphanumeric characters. Each of the entities occupies the space of 1 character block and thus requires 1 byte of memory. <br> These 4 modes can be intermixed on a per character basis. |
| 27 | CUPSOR | Cufsor | 1 | When this input is enabled 1 of the 4 pre-programmed cursor modes will be activated. The cursor mode is on-chip mask programmable. The standard cursor will be a blinking (at 3.75 Hz ) reverse video block. The 4 cursor modes are: Underline-in this mode an underline ( 1 to N raster lines) at the programmed underline position occurs. <br> Blinking Underline-In this mode the underline blinks al the cursor rate. Reverse Video Block-In thls mode the Character Block is set to reverse video. <br> Blinking Reverse Video Block-In this mode the Character Block is set to reverse video at the cursor blink rate. The Character Block will alternate belween normal video and reverse video. <br> The cursor functions are listed in tables. |
| 28 | AETEL | Retrace Blank | 4 | When this Input is latched nigh, the shift register parallel inputs are unconditionally cleared to all zeros and loaded into the shift register on the next Load/Shiff pulse. This blanks the video, indepencent of all attributes, during horizontal and vertical retrace time. |

TABLE 1

| CURSOR | RETBL | REVID | CHABL | UNDLN* |  | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $X$ 0 0 | $\begin{aligned} & 1 \\ & 0 \\ & 0 \end{aligned}$ | $X$ 0 0 | $\begin{aligned} & X \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & \hline X \\ & 0 \\ & 1 \end{aligned}$ | $\begin{gathered} \text { "0" } \\ \text { D } \\ \text { "1" } \\ \text { D } \end{gathered}$ | S.R. All (S.R.) All (S.R.) (S.R.) All others |
| 0 | 0 | 0 | 1 | $x$ | " 0 " | (S.R.) All |
| 0 | 0 | 1 | 0 | 0 | $\bigcirc$ | (S.R.) All |
| 0 | 0 | 1 | 0 | 1 | " | (S.R.) <br> (S.R.) $A^{\prime \prime}$ others |
| 0 | 0 | 1 | 1 | $x$ | "1" | (S.R.) Al |
| Underline* | 0 | 0 | 0 | X | "1" | (S.R.)' |
|  |  |  |  |  | D | (S.R. . All others |
| Underline* | 0 | 0 | 1 | X | "1", | (S.R.) ${ }^{\text {c }}$ |
| Underline* | 0 | 1 | 0 | X | '0' | (S.R.f, ${ }^{\text {(S }}$ |
|  | 0 |  |  |  | D | (S.R.) All others |
| Underline* | 0 | 1 | 1 | $x$ | $\begin{aligned} & \text { "0" } \\ & \text { " } 11 \text { " } \end{aligned}$ | (S.R.)* <br> (S.R.) All others |
| Blinking** Underline* | 0 | 0 | 0 | X | "1" | (S.R.)* Blinking |
| Blaking Underine | 0 | 0 |  |  | D | (S.R.) All others |
| Bllnking** Underline* | 0 | 0 | 1 | X | "11" | (S.R.)* Blinking |
|  |  |  |  |  | "0", | (S.R.) All others |
| Blinking* * Underline* | 0 | 1 | 0 | X | $" \frac{0}{D}$ | (S.R.)* Blinking (S.R.) All others |
| Blinking* ' Underline* | 0 | 1 | 1 | X | $\begin{aligned} & " 01 " \\ & " 101 " \end{aligned}$ | (S.R.) E Elinking (S.R.) All others |
| REVID Black REVID Block | 0 | 0 | 0 | 0 | "D | $\begin{aligned} & \text { (S.R.) All } \\ & \text { (S.R.) } \\ & \text { (S.R.) All others } \end{aligned}$ |
| REVID Block | 0 | 0 | 1 | $x$ | "1") | (S.R.) A! |
| REVID Block | 0 | 0 | 0 | 1 | $\text { " } \overline{\mathrm{D}} \text { " }$ | (S.R.)* <br> (S.R.) All others |
| REVID Block | 0 | 1 | 0 | 0 | D | (S.R.) All |
| REVID Block | 0 | 1 | 0 | 1 |  | (S.R.)* <br> (S.R.) Alt others |
| REVID Block | 0 | 1 | 1 | $X$ | "0" | (S:R.) All |
| Blink** REVID Block | 0 | 0 | 0 | 0 | $\left\{\begin{array}{l} \text { Alternate Normal Video/REVID } \\ \text { At Cursor Blink Rate } \end{array}\right.$ |  |
| Blink**REVID Block | 0 | 0 | 0 | 1 |  |  |
| Blink**REVID Block | 0 | 0 | 1 | X |  |  |
| Blink**REVID Block | 0 | 1 | 0 | 0 |  |  |
| Blink* REVID Block | 0 | 1 | 0 | $\frac{1}{x}$ |  |  |
| Blink* REVID Block | 0 | 1 | 1 | X |  |  |

[^0]FIGURE 5
ROM CHARACTER BLOCK FORMAT



FIGURE 1
WIDE GRAPHICS MODE
$\because$ OV CHIP ROM PROGRAMMARELE TO 2，3．OR \＆LINE MLHLTIFLES $\because G+N$ EE PROGRAMMED FROM FTO 7 BITS

|  |  |
| :---: | :---: |
|  | 浸： |
|  | 校ジジン |
|  |  |


$B F=$ back fill

FIGURE 2
THIN GRAPHICS MODE


FIGURE 3
EXTERNAL MODE
MS』＝1 MS1＝${ }^{6}$

|  | C7 | C6 | C5 | C4 | C3 | C2 | C1 | C0 | BF | BF |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| R ${ }^{\text {－}}$ R15 | A7 | A6 | A5 | A4 | $\mathrm{A}^{\circ}$ | A． 2 | A1 | A0 | A7 | A7 |  |

FIGURE 4 TYPICAL VIDEO OUTPUT


STANDARD MACROSYSTEMS CORPORATION

## Masiand

 intormation has been caretully checked and is believed to be entirgly relable However, no responsibitity is assumed for inaccuraties. Furthermore. such intormation does not convey to the purchaser of the semiconductor devices described any license under the patent rights ol SMC or others. SMC reserves the right to make changes at any time in order to improve design and supply the best product possible.

## Appendix C10

## STANDARD MICROSYSTEMS CORPORATION

## COM 8046 <br> COM 8046T

## Baud Rate Generator <br> Programmable Divider

FEATURESOn chip crystal oscillator or external frequency inputSingle +5 vower supplyChoice of 32 output frequencies32 asynchronous synchronous baud ratesDirect UART/USRT/ASTRO;USYNRT compatibilityRe-programmable ROMvia CLASP* technology allows generation of other frequenciesTTL, MOS compatible1XClock via fo: 16 outoutCrystal frequency output via ${ }^{2} x$ and $f x / 4$ outputsOutput disable via FENA

PIN CONFIGURATION


BLOCK DIAGRAM


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The Sfandard Microsystems COM 8046 is an en－ hanced version of the COM 5046 Baud Rate Generator．It is fabricated using SMC＇s patented COPLAMOS＊and CLASP\＆technologies and em－ ploys depletion mode loads，allowing operation from a single +5 v supply．
The standard COM 8046 is specifically dedicated to generating the full spectrum of 16 asynchronous／ synchronous data communication frequencies for $1 X$ ， 16X and $32 \times$ UART／USRT／ASTRO／USYNRT devices．

The COM 8046 features an internal crystal oscillator which may be used to provide the master reference frequency．Alternatively，an external reference may be supplied by applying complementary TTL level sig－ nals to pins 1 and 2．Parts suitable for use only with an external TTL reterence are marked COM $8046 T$ ．TTL outputs used to drive the COM 8046 or COM $8046 T$ should not be used to drive other TTL inputs，as noise immunity may be compromised due to excessive loading．
The reference frequency（ $f x$ ）is used to provide two high frequercy outputs：one at $f x$ and the other at $\mathrm{fx} / 4$ ．The $\mathrm{fx} / 4$ output will drive one standard 7400 load，while the ix output will drive two 74LS loads．
The output of the oscillator／buffer is applied to the divider for $\mathrm{ge}^{-\mathrm{g}} \mathrm{a}$ ation of the output frequency $f_{2}$ ．Th．e divider is capasie of dividing by any integer from 6
to $2^{\prime \prime}+7$ ，inclusive．If the divisor is even，the output will be square；otherwise the output wifl be high longer than it is low by one $f x$ clock period．The oulput of the divider is also divided internally by 16 and made available at the $\mathrm{f}_{0} / 16$ output pin．The $\mathrm{f}_{0} / 16$ cutput will drive one and the $f_{0}$ outpul will drive two standard 7400 TTL loads．Both the $f_{0}$ and $f_{0} / 16$ outputs can be disabled by supplying a low logic level to the FENA input pin．Note that the FENA input has an internal pull－up which will cause the pin to rise to approx－ imately $V_{c c}$ if left unconnected．

The divisor ROM contains 32 divisors，each 19 bits wide，and is fabricated using SMC＇s unique CLASPS technology．This process permits reduction of turn－ around－time for ROM patterns．
The five divisor select bits are held in an externally strobed data latch．The strobe input is ：e：．el sensitive： while the strobe is high，data is $f \equiv s s \in d$ directly through to the ROM．Initiation of a neさ．＂とこうこのが＂is effected within $3.5 \mu \mathrm{~s}$ of a change in $a^{-y} c^{*}$ the $f$ ve divisor select bits：strobe activity is $\because \because \cdot \cdots=-\cdots$ ． This leature may be disabled through a CLASP：ごうー gramming option causing new frequerこy $-: ~=: こ ゙: ~ 0$
 All five data inputs have pull－ups idぎさ こう ： 0 ：－at of the FENA input，while the stroje irf．：mas roo pull－up．

## Description of Pin Functions

| Pin No． | Symboi | Name | Function |
| :---: | :---: | :---: | :---: |
| 1 | XTALIEXT1 | Crystal or External Input 1 | This input is either one pin of the crystal package or one polarity of the external input． |
| 2 | XTAL／EXT2 | Crystal or External Input 2 | This input is either the other pin of the crystal package or the other polarity of the extemal input． |
| 3 | $V_{\text {ce }}$ | Power Supply | ＋5volt supply |
| 4 | $f_{x}$ | $f_{x}$ | Crystal／clock frequency reference output |
| 5 | GND | Ground | Ground |
| 6 | fol16 | $f_{6} / 16$ | 1Xclock output |
| 7 | FENA | Enable | A low level at this input causes the $f_{0}$ and $f_{0} / 16$ outputs to be held high．An open or a high level at the FENA input enables the $f_{0}$ and $f_{0} / 16$ outputs． |
| 8 | E | E | Most significant divisor select data bit．An open at this input is equivalent to a logic high． |
| 9 | NC | NC | No connection |
| 10 | $\mathrm{f}_{\mathrm{x}} / 4$ | $\mathrm{f}_{\mathrm{x}} / 4$ | 1／4 crystal／clock frequency reference output． |
| 11 | ST | Strobe | Divisor select data strobe．Data is sampled when this input is high， preserved when this input is low． |
| 12－45 | D，C，B，A | D，C，B，A | Divisor select data bits．$A=$ LSB．An open circuit at these inputs is equivalent to a logic high． |
| 16 | $\mathrm{f}_{0}$ | $\mathrm{f}_{0}$ | 16 X clock output |

MAXIMUM GUARANTEED RATINGS*


ELECTRICAL CHARACTERISTICS $\left(T_{2}=\theta^{\circ} \mathrm{C} 1070^{\circ} \mathrm{C}, \mathrm{VCc}=+5 \mathrm{~V}=5^{\circ} \%\right.$. Unless otherwise noted)

| Parameler | Min. | Typ. | Max. | Unit | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D.C. CHARACTERISTICS |  |  |  |  |  |
| INPUT VOLTAGE LEVELS |  |  |  |  |  |
| Low-level. $V_{11}$ |  |  | 0.8 | $V$ |  |
| High-revel, Vm | 2.0 |  |  | $V$ | excluding XTAL inputs |
| OUTPUT VOLTAGE LEVELS |  |  |  |  |  |
|  |  |  | 0.4 | V | $\mathrm{I}_{-}=3.2 \mathrm{~mA}$, for $\mathrm{f}_{0} \mathrm{f}_{\mathrm{R}}, f_{T}$ |
|  |  |  | 0.4 | $V$ | $\mathrm{I}_{\mathrm{o}}=0.8 \mathrm{~mA}$, for $\mathrm{f}_{x}$ |
| High-levei, Vom | 3.5 |  |  | V | $1 ;=-100 \mu \mathrm{~A}$; for $\mathrm{f}_{3}, \mathrm{l}_{\text {OH }}=-50 \mu \mathrm{~A}$ |
| INPUT CURRENT |  |  | -0.1 | $m \mathrm{~A}$ | $\mathrm{V}_{19}=$ GND, excluding XTAL inp:S |
| INPUT CAPACITANCE All inputs. C. |  | 5 | 10 | pF | $V \cdot=$ GND, excluding XTAL irputs |
| EXT INPUT LOAD |  | 8 | 10 |  | Series 7400 equivalent loads |
| POWER SUPPLY CURRENT Icc |  |  | 50 | mA |  |
| A.C. CHARACTERISTICS |  |  |  |  | $T_{1}=+25^{\circ} \mathrm{C}$ |
| CLOCK FREQUENCY, im | 0.01 |  | 7.0 | MHz | XTAL/EXT, $50 \%$ Duty Cy: $-=5^{\circ} \%$ COM 8046, COM 8126. Cこ $\because=\cdot 46$ |
|  | 0.01 |  | 5.1 | MHz | XTAL/EXT, $50 \% \mathrm{D}_{1} .5 \mathrm{C}_{2}= \pm=5 \%$ COM 8116, COM 8135 |
| STROBE PULSE WIDTH, $t_{\text {w }}$ INPUT SET-UP TIME | 150 |  | DC | ns |  |
| tes | 200 |  |  | ns |  |
| INPUT HOLD TIME to | 50 |  |  | ns |  |
| STROBE TO NEW FREQUENCY DELAY |  |  | 3.5 | $\mu \mathrm{S}$ | @ $f_{\mathrm{x}}=5.0 \mathrm{MHz}$ |




The ROM cro゚̧a~~~ $\$$ automalically generated

## Crystal Specifications

User must scec. ${ }^{f}$ y termination (orn wre oreer)
Preler: $\mathrm{HC}-18 / \mathrm{U}$ or $\mathrm{HC}-25$ : U
Frequency - 50688 MHz . AT Cut Temperature range 0 C to 70 C

Series resislance 50 n 7 Series Resonant
Overall tolerance - $01 \%$ or as required

Crystal manufacturers Pir: a Ls: Northern Engineering Laboratories 357 Belolt Street
Burlington. Wisconsin $\$ 3105$
(414) 763.3591

Butova Frequency Control Products
61-20 Woodside Avenue
Woodside. New York 11377
(212) 335-6000

CTS Knights Inc.
101 East Church Street
Sandwich. Illinois 60548
(815) 786-8411

Crystek Crystals Corporation 1000 Crystal Drive
Forl Myers. Florida 33901
(813) 936.2109

## COM 8046 COM 8046T

Table 2


| Divisor <br> Select <br> EDCBA |  |
| :---: | :---: |
| 00000 | ここ： |
| 0001 | ここう |
| 000.0 | －${ }^{\text {j }}$ |
| 00011 | $\because こ=3$ |
| $00 \cdot 0$ |  |
| 00101 | $2: \% 0$ |
| 00110 | ごこ： 2 |
| 00111 | ¢－： |
| 01000 | $12 .: 5$ |
| 01001 | $\mathfrak{l}$ |
| 01010 | 2：$=: 9$ |
| 01011 | そここ： 2 |
| 01100 | ¢こ： |
| 01101 | ここ： |
| 01110 | G0： 0 |
| 01111 | 1気ごつ |
| 10000 | 620 |
| 10001 | 750 |
| 19010 | 1：－－ |
| 10011 | 15： 30 |
| 10100 | $15 こ$－0 |
| 10101 | 3030 |
| 10110 | 600 |
| 10111 | 12こ200 |
| 11000 | $1 \varepsilon$ こう00 |
| 11001 | 2ここう00 |
| 11010 | 260300 |
| 11011 | 3600.00 |
| 11100 | 4800.00 |
| 11101 | 7200.00 |
| 17110 | 9600.00 |
| 11111 | 19200.00 |


| Clock Factor | Desıred Frequency （ KHz ） | Divisor |  |
| :---: | :---: | :---: | :---: |
| 32 x | 160000 | 3169 | 50.00 |
| 32 x | 240000 | 21：2 | 7500 |
| 32 X | 3.52000 |  | 11000 |
| 32 x | 4.30400 | 117 | 130.58 |
| 32 x | 4.80000 | 10こち | 15000 |
| 32 x | 6.40000 | 7 C 2 | 2000 |
| 32 x | 9.60000 | 523 | 3000 |
| 32 X | 19.20000 | 2゙き | 6.000 |
| 32 x | 38.40000 | 122 | 120000 |
| 22 x | 57.60000 | \＆ 9 | 1800.00 |
| 32 x | 7680000 | 6 6 | 240000 |
| 32 X | 115.20000 | 44 | 360000 |
| $32 x$ | 15360000 | 33 | 4800.00 |
| 32 x | 23040000 | 22 | 7200.00 |
| 32 x | 30720000 | 16 | 9900.00 |
| 32 x | 6144000 | 8 | 19800.00 |
| 16 x | 080000 | 6336 | 50.00 |
| 16 X | 1.26000 | 4224 | 75.00 |
| $16 \times$ | 1．760こ0 | 2880 | 110.00 |
| 16 X | $21 \equiv$ くら0 | 2355 | 13452 |
| 16 x | 2 －tio | 2112 | 150.00 |
| 16 x | 4 E ¢う0 | 1056 | 30000 |
| 16 X | 9600 | 528 | 60000 |
| 16 X | 1920 | 264 | 120000 |
| $16 \times$ | 28 8．000 | 176 | 180000 |
| $16 \times$ | 320500 | 158 | 200506 |
| 16 X | 38.4000 | 132 | 240000 |
| 16x | 57.60000 | 88 | 3600.00 |
| 16X | 7680000 | 66 | 480000 |
| 16 X | 11520000 | 44 | 720000 |
| 16 X | 15360000 | 33 | 960000 |
| 16X | 307.20000 | 16 | 19800.00 |


| Actual Frequency （K Hz ） | Deva： |
| :---: | :---: |
| 1600000 | OCここご＊ |
| 2.400000 |  |
| 3.520000 | $0 こ: \%$ |
| 4.306542 | 0： 0 |
| 4.800000 | ？ |
| 6400000 | 。 |
| 9600000 | \％ |
| 19.200000 |  |
| 38.400000 |  |
| 57600000 | ：： 2 こo |
| 7680000 | $こ こ .200$ |
| 115．200ちゃ | $6: 100 \%$ |
| 153 6cc： 3 | $=200 \%$ |
| 230 － | － $6000 \%$ |
| 315 をここう | $31250 \%$ |
| 630 ¢こ： 3 | $31250 \%$ |
| c $5 \cdots ?$ ） | $0.0000 \%$ |
| 1 $2: 3: 3$ | $0.0000 \%$ |
| －ここここう | 0．0000\％ |
| 2 － | $0.0166^{\circ}$ 。 |
| 200 | 0．0000\％ |
| く もここ．00 | 0．0000\％ |
| ぢちら00 | 0．0000\％ |
| － 2.20050 | 0．0000\％ |
| 22900000 | $00000{ }^{\circ}$ |
| 32081013 | 0．2532\％ |
| 38.400000 | $00000 \%$ |
| 57600000 | $00000^{\circ}$ 。 |
| 76800000 | $0.0000^{\circ}$ |
| 115200000 | $00000 \%$ |
| 153.600000 | $0.0000 \%$ |
| 316.800000 | 3．1250\％ |

## Appendix D

## ZAP Operating System







| $\begin{aligned} & 0183 \\ & 0183 \\ & 0183 \end{aligned}$ |  |  | $\begin{aligned} & 3230 \\ & 3240 \end{aligned}$ | ＊TG THE | USER | IN | AND KIMTAS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | ＊ |  |  |  |
|  |  |  | 3250 | ＊ |  |  |  |
| O1E3 | Cn AO | 0.1 | 3260 | FORCAR | C＇Al | Cldiat | ＊CLEAF Flags andi buFliek |
| 0186 | Cat 0 | 01 | 3270 |  | CALI． | KEYIN | ＊GET TNFUT CHAFACTEKR |
| 0189 | ENSII | 01 | 3280 |  | Cratul． | CARCK1 | ＊CHECK FOR NEXT OR EXEC |
| 01BC | I\％ 10 |  | 3290 | FQRCAL | SUB | 16 H | ＊WHAR゙ACTEF： $0-\mathrm{F}$ |
| OHEE | F2 2 B 3 | 01 | 3300 |  | 3F | F9FORCAR | ＊JUMF ILF NOT O－FF |
| O1Ci | C6 10 |  | 3310 |  | AUTI | 16 L |  |
| 01.53 | 32 FF4 | 07 | 3320 |  | LTI | （TEMF），A | ＊SAUE CHARACTER |
| 01.6 | 3 A F2 | 07 | 3330 |  | Li． | A\％（K゙MATA1．） | ＊ $\mathrm{A}=\mathrm{MSS}$ |
| 0109 | 21 F3 | （7） | 3340 |  | L． H | HL，KRATA． |  |
| O） CC | ELI 67 |  | 3350 |  | BE E |  | ＊anvust mata for new chamacter |
| OLCE | 07 |  | 3380 |  | FiLC．${ }^{\text {cha }}$ |  |  |
| 01 CFF | 07 |  | 3370 |  | FL．．EA |  |  |
| 0110 | 07 |  | 3380 |  | RL．CA |  |  |
|  | 07 |  | 3370 |  | Ri．．cA |  |  |
| 01．12 | EG FO |  | 3400 |  | ANE | 2400 | ＊MASK OFF OLG TMGT |
| 01 DA | 21 F゙¢ | 07 | 34.10 |  | $1 . \mathrm{H}$ |  |  |
| 0118 | 86 |  | 3420 |  | ADOI | A）（ HL | ＊AMG TN NEW MIGTT |
| 0.119 | 2 AF F | 07 | 3430 |  | L．．． I | Hmp（Ftmtas） | ＊SAVE NEW ILSLS |
| 0.1 LE | 2 F 2 | 07 | 3440 |  | 1. | （KGATAX），HfL | ＊SAVE NEU MSDS |
| O．4E | 32 F 3 | 07 | 3，${ }^{\text {cos }}$ |  | 1.10 | （kJataz），A | ＊SAVE NEW L．ELIS |
| OIE！ | 11306 |  | 3440 |  | 0uT | Aumbes | ＊DJGFLAY L．sds |
| OHE 3 | 3A F？ | 07 | 3470 |  | th | Ay（kimernl） |  |
| O1E6 | 130 |  | 3490 |  | OUT | ammed |  |
| 01 ES | Ca 03 | 01 | 3490 |  | CAflulu | FEEY | ＊GET NEXT CHARACTER |
| OfEs | CH ba | 0.1 | 3500 |  | Cofl． | CAECK2 | ＊CHECK FOF NEXT OF EXEC |
| 01 EE | C 3 EC | 01. | 300 |  | J ${ }^{\text {a }}$ | FORCAI | ＊JWM IF MOT NEXT OR EXEC |
| O1FF． |  |  | 3520 | ＊ |  |  |  |
| 01 F |  |  | 3530 | ＊ |  |  |  |
| 01F1 |  |  | 3 F 40 | ＊ |  |  |  |
| 0 OF |  |  | 3550 | ＊ |  |  |  |
| OLFI |  |  | 3560 |  | －$\because=$ |  | OS FROM THE REYBGARL FOLLOWED |
| OlFI |  |  | 3570 | 氷EY ${ }^{\text {cos }}$ | －A 介－ |  | THE SEOLENCE |
| Q1FI |  |  | 3580 | ＊的： | ¢ $\square^{\text {and }}$ | －braxtum |  |
| OIF． |  |  | 3590 | ＊TF Th | TA18 | T0 ME Ajum！ | AYEG |
| OIF1 |  |  | 3600 | ＊if | CAObFE |  | T．O．NEXT，EXEC |
| O1F． |  |  | 361.0 |  | WJIL |  | （TO THE COmman recognjo tow |
| 91F\％ |  |  | 3620 | ＊ |  |  |  |
| 01.15 |  |  | 3820 | ＊ |  |  |  |
| 0151 | 管 |  | W640 | MEMOFY | 1. | AYEFO |  |
| 01 F | \％－－ |  | $\because 50$ |  | Stiof |  |  |
| ） 1 F F | － |  | $\therefore 80$ |  | 1.1 |  |  |
| ）1F\％ | Ei |  | $\because \therefore$ |  | CALIL． | Clama |  |
| O．f | \％ |  | －－ |  | Call | FORCate | \％GET BASE Ambress |
| OJFF | 捡f： | $\therefore$ |  |  | $1 . \mathrm{H}$ | A（EFEmin） |  |
| 0202 | CE |  | 「． |  | ETr | 1．）A |  |
| 0204 | ¢2 39 | $\cdots$ |  |  | dF＇ | Nz．WAFEP？ | WHNF TF EXEC FLAB SET |
| 0207 | 3¢ F － | \％ | $\cdots$ |  | 1． 0 |  | ＊COE MEMOFO A MGEES |
| 020 A | 32 F 7 | 07 | $\therefore$ \％ |  | 1.11 |  |  |
| 0200 | 3A Fra | 67 | 30 |  | 1 | A（kUATm2） |  |
| 0210 | 32F6 | 07 | $37 \%$ |  | 11 |  |  |
| 0213 | 2 AFB | 07 | 3700 |  | 1.17 | HL M（GEABE 1 ， | ＊SFT MEM BASE ALHAEESS |
| 0216 | 7 F |  | 9769 | Hi－\％ | L | Ay（HL．） | WGET MEMORY Wata |
| 0217 | WS 07 |  | \％70 |  | OUT | W⿵冂卄ts | ＊Thspmay memory liata |
| 0219 | CH 77 | 0. | \％90 |  | cill |  | WEET ME CJ DATA |
| 0210 | 3\％ FF | 07 | 890 |  | 17 |  |  |
| 021F | ［F5 5 |  | 00 |  | ETY | 29 a |  |
| 02 l | C2 $4 \%$ | 02 | 9810 |  | 15． |  | ＊JUMF IF MO TATA |
| ○○я | 2 AFB | 07 | 3220 |  | 1. | HI．．（MEASE1） |  |
| 0 O．27 | OA FB | 07 | 3530 |  | 10 | A（ CHATAO ） | ＊GET NEW MATA |
| 922 | 77 |  | 3840 |  | I．． H | （ HL ．）y A |  |
| O22B | \％A FI． | 07 | 3850 |  | 1.0 | Aッ（バFl．ACS） |  |
| O22E | CE AF |  | 3660 |  | BTT | $1 \%$ 合 |  |
| 0230 | C2 89 | 00 | 3 3 70 |  | NF | NZ．WARM？ | ＊JUiM JF EXEC FIMAG SET |
| 0233 | 2 AFB | 07 | 3990 |  | 1 H | HL y（MGASEI） | （ ${ }^{\text {WTNC BASE MEM AKII }}$ |
| 0236 | 23 |  | 3890 |  | INC | $\mathrm{H}_{1}$ |  |
| 0237 | 22 FW | 07 | 3900 |  | $1 . \mathrm{H}$ | （MEASE1）Y HL |  |


| 023A | 7II |  |  | 3901 |  | 1. | A．L |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 023 B | 13 | 06 |  | 3902 |  | OUT | Alidise |  |
| 0230 | 70 |  |  | 3703 |  | Lom | A 9 H |  |
| O23E | 1）3 | 05 |  | 3904 |  | our | Anusis |  |
| 0240 | C3 | 16 | 02 | 391.0 |  | JF－ | MEETV． |  |
| 0243 | CB | 4 F |  | 3920 | MEVA | BIT | 1．$\% \mathrm{~A}$ |  |
| 0245 | C2 | 87 | 00 | 3930 |  | JF | NZ，WARM2 | ＊JUMP IF EXEC FLAG SET |
| 0243 | C3 | 33 | 02 | 3940 |  | WF | MEM12 |  |
| 0248 |  |  |  | 3950 | ＊ |  |  |  |
| 024B |  |  |  | 3960 | ＊ |  |  |  |
| 024B |  |  |  | 3970 | ＊ |  |  |  |
| 024 A |  |  |  | 3980 | ＊ |  |  |  |
| 0248 |  |  |  | 3990 | ＊REGTS | T TNFU | UTS A REGIST | TER FROM THE：KEYROARD FOLILOWED EY |
| 0248 |  |  |  | 4000 | ＊İATA | AS DEF | FTNEG BY THE | GERUENCE |
| 024 B |  |  |  | 4010 | ＊FEG | （TNIT | FEG）NEXT 0 （ | AATA）NEXT＋＋（DATA）EXEC |
| 0248 |  |  |  | 4020 | ＊ FEGGT | YER SA | EQUENCE TS I |  |
| O2AB |  |  |  | 4030 | ＊ML y AH． |  |  |  |
| 0248 |  |  |  | 4040 | ＊${ }^{\text {PF }}$ ORLL | Y dat | TA IS TO EE | WISFIAMYEI |
| 224B |  |  |  | 4050 | ＊EEG | （INIT | REG）NEXT，NE | XXT ．．FEXEC |
| O2，${ }^{\text {8 }}$ |  |  |  | 4060 | ＊EXEC | WILI | BETHKiv CONTR | NOL TO THE COMMAND FECDONITIGN |
| $024 B$ |  |  |  | 4070 |  |  |  |  |
| 024B |  |  |  | 4080 | ＊ |  |  |  |
| 024 B | CH | 3 A | 01 | 4090 | FEGEST | Côll | ONECAR | ＊GET INITJAL CHARACTEF |
| O2AE | 3 A | FI | 07 | 4100 |  | L． H | A，（Kllagh ） |  |
| 02\％ | CE | 57 |  | 4110 |  | Etr | 2，A |  |
| 0253 | C 2 | 89 | 00 | 4120 |  | N | NZ．WALCM | ＊JUMF JF NO LIATA FLAG SET |
| 0256 | 3 A | FS | 07 | $4 \pm 30$ |  | $1 . \mathrm{II}$ | Ag（バMATAX） | ＊GET BASE REGISTER |
| 0259 | 32 | F\％ | 07 | 4140 | REGGO | 1． 5 | （TEMF2），$A$ |  |
| 0250 | CB | 77 |  | 41.41 |  | EIT | 6．A | ＊CHECK FOR SHIFT |
| 225： | C2 | CC | 02 | 4142 |  | dF | NZ，REGTSA | ＊JUSF JFE SHIF゙T KEY SET |
| 026.1 | FE | 0.6 |  | 41.43 |  | CF | 6 |  |
| 0263 | F2 | 6 C | 02 | 41.44 |  | W | FyFEGII | ＊．JUMF IF EETHMT HIT FEGISTER |
| 0266 | 3II |  |  | 41.45 |  | TEEC | A |  |
| 0267 | $3 \pm$ |  |  | 4146 |  | Wecter | A |  |
| 0268 | 37 |  |  | 4147 |  | ADO | A | ＊$x=(\mathrm{E}-2) * 2$ |
| 0269 | C3 | 6E | 02 | 4148 |  | JF＇ | EEGT2 |  |
| 0260 | 3 C |  |  | 41.49 | EEGIL | JME | A |  |
| 026 L | 3 C |  |  | 4150 |  | Tie | A |  |
| 026E | 32 | $\mathrm{F9}$ | 07 | 4 x \％ | FEGl2 | $1 . .1$ | （REGJNX）\％A | ＊SAVE TVREX |
| 0271 | 3 A | FS | 07 | 4152 |  | $1 . \mathrm{H}$ | AY（TEMH2） |  |
| 0274 | FEE | 10 |  | 4.53 |  | C＊ | 10 H |  |
| 0276 | FA | 83 | 02 | 4154 |  | 少： | Motctersm |  |
| 0279 | CB | 77 |  | 4155 |  | ETT | S．A |  |
| 0278 | C2 | 83 | 02 | 4 4 47 |  | \％ | HZ． $1: 6 T 2 A$ | ＊JUMF 「：EjT 6 SET |
| 027E | 35 | 49 |  | 4159 |  | 1．${ }^{1}$ | n，${ }^{\text {a }}$ |  |
| 0280 | 32 | FE | 07 | 4159 |  | 1.7 | （there）， |  |
| 0298 | 33 | 07 |  | 4160 | Fegasa | QT | गिए？ | ＊Sigrlay FEGISTER SELECT |
| 0285 | 3 A | $F 6$ | 07 | 4210 |  | $1 . \mathrm{H}$ |  |  |
| 0298 | FE | 08 |  | 4220 |  | $\underline{\square}$ | F16i |  |
| 0¢）m | F－ | 016 | 02 | 4230 |  | ．${ }^{\circ}$ | Mrx\％s\％ | ＊，品产 XF I6 ETT REG |
| o2a． | 21 | 17\％ | 07 | 4240 |  | $1 . .1$ | Haymention | ＊GET BASE ADII |
| 0290 | AFF |  |  | 4250 |  | 1.0 | 己，合 |  |
| 0291 | 06 | 00 |  | 4260 |  | 10 | By， BER |  |
| 0293 | 09 |  |  | 4270 |  | AOH | HL． $\mathrm{ESC}^{\text {c }}$ |  |
| 0294 | 22 | F6 | 07 | 4280 |  | 4 | （MEASEI ）y HL |  |
| 0297 | 7E |  |  | 4290 |  | 10 | A．（ HE ） | ＊GET FEGGETER LATA |
| 0298 | ［\％ | 06 |  | 4300 |  | 0197 | Amtse |  |
| 629A | 78 |  |  | A310 |  | 10 | A，B |  |
| 0293 | dx | O6 |  | 4390 |  | QuT | Amos． |  |
| 9297 | CO | 77 | 91 | 4360 |  | Call | TWOCAF | WGET NEW MATA |
| 0 SaO | उ＇A | F1． | 07 | 4340 |  | E．in |  |  |
| O2A3 | CE | －7 |  | 4350 |  | QTT | 29 A |  |
| O2A | C2 | 197 | 02 | 4360 |  | JF＊ |  | ＊．JImp if no inata |
| O2ns | 2 A | F6 | 07 | 4390 |  | 1 ll | HL．，（MBASEL） |  |
| 02 AE | 3 3－1 | F 2 | 07 | 4400 |  | L． | Ay（K゙DATA1） | ＊Get new mata |
| O2AE | 77 |  |  | 4410 |  | Itil | （HL）${ }^{\text {A }}$ | ＊FIEFI．ACE CLID IIATA |
| 02AF | 3 3 | F1 | 07 | 44.1. |  | 1.1 | A．（KFLAGS） |  |
| 02 E 2 | CB | AF＊ |  | 4．412 |  | ETT | $1, \mathrm{~A}$ |  |


| 02E．4 |  |  | 00 | 4413 |  | JFP | NZ，WATM2 | ＊JUMP TF EXEC FIAG SET |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| O2R7 | 3 A |  | 07 | 4420 | FEGI3 | 1.1. | A\％（TEMFO2） | ＊JNCFEMEMT INLIEX |
| 02 BA | 3 C |  |  | 4421 |  | INC | A |  |
| O2BE | 32 |  | 07 | 4422 |  | 1 LI | （TEMPr2）\％ A |  |
| O2RE | 3 3 |  | 07 | 4423 |  | 1． F | A－（RESINX） | ＊INCEEMENT TNDEX |
| O2Ca | 3 C |  |  | 4430 |  | INC． | A |  |
| 02c2 | FE | 1A |  | 4440 |  | CF | 1 AlH |  |
| 0264 | FA | 6E | O2． | 4450 |  | JF\％ | MYRECTIC | ＊Uldif IF INMEX •LT，1A |
| 02 C 7 | 3E | 02 |  | 4460 | REGIA | LH | A．TWO | ＊SET INTTTAL INEEX |
| 0209 | C3 | 57 | 02 | 4470 |  | $\bigcirc$ | FEEGIO |  |
| 026C | 116 | 48 |  | 4430 | feglsa | sub | 484 |  |
| O2CE | FA | 4 B | 02 | 4490） |  | ， 1 \％ | M W EEGTST | ＊JUMF JF JMUALIG REGISTER |
| 0201 | c6 | 12 |  | 4500 |  | ATM | 12 H |  |
| 02113 | C3 | $6 E$ | 02 | 4510 |  | JF＇ | REGI2 |  |
| 02 H | 2.1 | 17 | 07 | 4520 | XYSF＇ | I．${ }^{\text {LI }}$ | H． H ，XLSAU |  |
| 02119 | $4 \mathrm{~F}^{\text {－}}$ |  |  | 4530 |  | 1 L | C，A |  |
| 02 DA | 06 | 00 |  | 4540 |  | 1.10 | あy ZERO |  |
| O2nc | 09 |  |  | 4500 |  | ACO | HL． BC | ＊HL－REG SAUE ALITEESS |
| 02 HH | 22 | F6 | 07 | 4560 |  | I． $\mathrm{I}_{1}$ | （MFASE1）PHL |  |
| O2EO | 7E |  |  | 4570 |  | 41 | A）（ $\mathrm{HIL}_{\text {I．}}$ ） | ＊DISFLAY REGTSTEF MATA |
| 02 E 1 | ［13 | 06 |  | 4580 |  | 001 | Ammise |  |
| O2E3 | 23 |  |  | 4570 |  | INC | HIL |  |
| O2EA | 7E |  |  | 4600 |  | t．l． | A，（HI．） |  |
| O2EES | 113 | 05 |  | 46.10 |  | OUT | Antis． 1. |  |
| 02E7 | 3 A | F\％ | 07 | 4620 |  | 1 LI | A，（FEGTNX） |  |
| O2FA | 30 |  |  | 4630 |  | INC | A |  |
| O2EB | 32 | FS | 07 | 4640 |  | 1.1 | （FEGIMX），A |  |
| O2EEE | C．I | E3 | 01 | 4650 |  | Calle | FORCAR | ＊GET NEW MATA |
| 02 FL | 3A | F1 | 07 | 4660 |  | f． 1 | Ay（KFLAGS） |  |
| O2F4 | CE | 57 |  | 4670 |  | ETT | 2，A |  |
| 02F66 | C 2 | 08 | 03 | 4680 |  | IF | Nz．E日615 | ＊Unale fr no liata |
| 0279 | 3 A | ：－ 5 | 07 | 4710 |  | 1. |  | ＊FiFlabe gla data |
| O2FC | 3A | F＝3 | 07 | 4720 |  | LIt |  |  |
| O2FF | 77 |  |  | 4730 |  | LII |  |  |
| 0300 | 3 A | F2 | 07 | 4740 |  | i． I |  |  |
| 0303 | 23 |  |  | 4750 |  | Jide | HI |  |
| 0,304 | 77 |  |  | 4760 |  | It 5 | （ HL ），A |  |
| 0305 | 3A | F1 | 07 | 4761 |  | LIS | A．（ FFFHOS ） |  |
| 0308 | CE | 4 F |  | 4762 | FEGJ5 | EIT | 1，A |  |
| 030 A | C2 | 87 | 50 | 4763 |  | 小F＇0 |  | ＊JUiff IF EXEC FLag get |
| 03011 | $\mathrm{C}_{3}$ | E7 | 02 | 4770 |  | 小l＊ | FiEG3 |  |
| 0310 |  |  |  | 4780 | ＊ |  |  |  |
| 0310 |  |  |  | 4790 | ＊ |  |  |  |
| 0310 |  |  |  | 8800 | ＊ |  |  |  |
| 0310 |  |  |  | 4910 | ＊ |  |  |  |
| 0310 |  |  |  | 439 | ＊ GO r E | SETS | THE JGERS RE | TTAFT ADDEESS IN THE |
| 0310 |  |  |  | $4=30$ | ＊FEGIS | TER | Save mbea midi | EXITS TG THE RESTART |
| 0310 |  |  |  | $4 \mathrm{~L}+0$ | 米的以itut |  |  |  |
| 0310 |  |  |  | 4ここ0 | ＊ |  |  |  |
| 0310 |  |  |  | $4=-5$ | ＊ |  |  |  |
| 0310 | CII | AC | 01 | A 970 | cutbo | CiAme | Clamm |  |
| 0313 | C．1 | E3 | 0.1 | $43 \% 1$ |  | CAl． | FORCAK | ＊WET FESTART AMDESS |
| 0316 | 3 A | FI | 07 | 4880 |  | 11 | Ay（KHLAGS） |  |
| 0319 | CB | 57 |  | 4990 |  | ETT | 29 A |  |
| 0318 | ［2 | 89 | 00 | 4700 |  | 少 | H2，WAFM2 | ＊TE NO MATA EXIT |
| O31E | 3A | F3 | 07 | 4910 |  | 10 | A．（ 6 DATA ） | ＊SAUE NEW AMMJESS |
| 0321 | 32 | 1 C | 07 | 4920 |  | 1.0 | （FGLSAU）${ }^{\text {a }}$ |  |
| 0324 | 3 A | F 2 | 07 | 4880 |  | 10 | Ay（KDATA1） |  |
| $03 \% 7$ | 32 | DE | 07 | 4940 |  | 1． H | （FCHSAU）．A |  |
| O32A | C3 | fa | 00 | 4950 |  | JF＇ | FESTRT |  |
| 072\％ |  |  |  | A 960 | ＊ |  |  |  |
| 0325 |  |  |  | 4970 | ＊ |  |  |  |
| $03 \%$ |  |  |  | 4980 | ＊ |  |  |  |
| 032 c |  |  |  | 4990 | ＊ | IS A | A UABT LOOF | HECK FOUTTNE |
| 032 L |  |  |  | 5000 | ＊IT UT | Itaz | Es a LOOF WR | H THE：OUTFUT |
| 032 L |  |  |  | 5010 | ＊FORT | FATC！ | HEO TO THE IN | NTU FOFT |
| 0320 |  |  |  | 5020 | ＊IF AiN | ERKO | OR IS DETECTE | 0 THE ERfok IS |
| 0320 |  |  |  | 5030 | ＊IJSF＇L | YED 0 | O THE ADMEES | 5 UTEFI．．．AY ANU |




| 00 |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{array}{r} 07 E 0 \\ 00 \end{array}$ | 6350 | RSAV | 4 L | 0 |  |
| $\begin{array}{r} \text { OTE } 1 \\ 00 \end{array}$ | 6360 | LSAV | HE | 0 |  |
| $\begin{array}{r} \text { O7E2 } \\ 00 \end{array}$ | 6370 | HSAU | 0 H | 0 |  |
| $\begin{array}{r} 07 E 3 \\ 00 \end{array}$ | 6380 | ASAV | Lis | 0 |  |
| $\begin{array}{r} 07 \mathrm{EA} \\ 00 \end{array}$ | 6390 | BSAU | 0 H | 0 |  |
| $\begin{array}{r} 07 E 5 \\ 00 \end{array}$ | 6400 | csav | 108 | 0 |  |
| $\begin{array}{r} 07 E S \\ 00 \end{array}$ | 6410 | ISAV | Lis | 0 |  |
| $\begin{array}{r} 07 E 7 \\ 00 \end{array}$ | 6420 | ESAV | UR | 0 |  |
| $\begin{array}{r} 07 E 8 \\ 00 \end{array}$ | 6430 | FSAV | 13 | 0 |  |
| $\begin{array}{r} 07 E 9 \\ 00 \end{array}$ | 6440 | ALSAV | 0 E | 0 |  |
| $\begin{array}{r} 07 E A \\ 00 \end{array}$ | 6450 | AHSAV | H18 | 0 |  |
| $\begin{array}{r} O 7 E \mathrm{E} \\ 00 \end{array}$ | 6460 | AASAV | LE | 0 |  |
| $\begin{array}{r} 07 E \mathrm{E} \\ 00 \end{array}$ | 6470 | ABSAV | 1 B | 0 |  |
| $\begin{array}{r} 07 \mathrm{EF} \\ 00 \end{array}$ | 6480 | acsmu | 0 H | 0 |  |
| $\begin{array}{r} O \text { OEE } \\ 00 \end{array}$ | 6490 | ALSAV | DE | 0 |  |
| $\begin{array}{r} 075 \% \\ 00 \end{array}$ | 6500 | AESAU | 48 | 0 |  |
| $\begin{array}{r} 0760 \\ 00 \end{array}$ | 6510 | Atrsal | $\underline{108}$ | 0 |  |
| 07F1 | 6520 | ＊ |  |  |  |
| 07F： | 6530 | ＊Lata | STOR | GE AREA |  |
| O7Fi | 6540 | ＊ |  |  |  |
| $\begin{array}{r} 07 F \mathrm{t} \\ 00 \end{array}$ | 6550 | KFI．AGS | M18 | 0 | ＊KEYBOAFLI FIMAGS |
| $\begin{array}{r} 0752 \\ 00 \end{array}$ | 6560 | K゙Latal | 118 | 0 |  |
| $\begin{array}{r} 07 F 3 \\ 00 \end{array}$ | 6570 | K゙ロataz | His | 0 |  |
| 07F4 00 | 6580 | TEMF＇ | His | 0 |  |
| $\begin{array}{r} 07 \mathrm{FG} \\ 00 \end{array}$ | 858.1 | TEMES | $\underline{1}+8$ | 0 |  |
| $\begin{array}{r} 07 F 6 \\ 00 \end{array}$ | 6590 | MBASE． | 118 | 0 | WEASE Mrabe ABERESS |
| $\begin{array}{r} 0757 \\ 00 \end{array}$ | 6600 | MEASE？ | WE | 0 |  |
| $\begin{array}{r} 07 F 8 \\ 00 \end{array}$ | 6610 | REGINX | UR： | 0 | ＊REGISTER INDEX |
| 0759 | 6620 | TTYEEF | us | 2 | ＊TTY TNFUT BUFFEF AMDRESS |
| 07FE | 6630 | TTYOes | I． 5 | 2 | ＊TTYOUTFUT EUFFER ACDINESS |
| $\begin{array}{r} 07 F \mathrm{E} \\ 00 \end{array}$ | 6640 | TTYIE | If | 0 | ＊TTY InFUT Chafacter count |
| $\begin{array}{r} 07 F E \\ 00 \end{array}$ | 6650 | tryoc | DE | 0 | ＊TTY GUTFIJT CHARACTER COLNT |
| $O D F F$ | 6660 | ＊ |  |  |  |
| 07FF | 6670 | END |  |  |  |

FILE $3000 \quad 7323$
REALiY

Appendix E-Z80 CPU Technical Specifications

Due to wide availability on the Internet, the Z80 CPU Technical Specifications were not scanned and included with the rest of this document.

Z80 CPU data sheets, technical documentation, and user manuals can be found on Gaby Chaudry's Z80 site at http://www.z80.info/ , or via a web search.

## GLOSSARY

Accumulator A temporary register where results of calculations may be stored by the central processor. One or more accumulators may be part of the arithmetic-logical unit.

Acoustical coupler A device that permits a terminal to be connected to the computer via a telephone line. It connects to the telephone handset.

Address An identifying number or label for locations in the memory.
Algorithm A step-by-step solution to a problem in a finite number of steps. A specific procedure for accomplishing a desired result.

ASCII American Standard Code for Information Interchange. Widely used 7-bit standard code. Also known as USASCII; IBM uses EBCDIC, which has 8 bits.

Assembler A program that converts symbolic instructions into machine macroinstructions.

Backplane A board equipped with plugs interconnected by buses into which the modules that make up a computer may be inserted. Also known as a motherboard.

BASIC Beginner's All-purpose Symbolic Instruction Code. Algebraic language developed at Dartmouth College. The language is easy to learn and use.

Binary A rumeeing system based on multiples of two using the digits 0 and 1 .
Bit Abbreviation of binary digit. A single element in a binary number-either a 0 or a 1. Bits are represented in a microcomputer by the status of electronic switches that can be either on or off. Four bits equal a nibble; eight bits equal a byte.

Byte A group of adjacent bits, usually eight bits, which is operated upon as a unit by the central processor.

CMOS Complementary Metal-Oxide Semiconductor. Technology that combines the component density of $p$-channel MOS (PMOS) and the speed of n-channel MOS (NMOS). Power consumption is very low.

Clock A device that generates regular pulses that synchronize events throughout a microcomputer.

Central processor The central processor controls the operation of a microcomputer. The central processor can fetch and store data and instructions from memory.

CRT Cathode-Ray Tube. An electronic vacuum tube that can be used for graphic display. Also refers to a terminal incorporating a CRT.

Compiler A program that translates high-level programming language into machine language. May produce numerous macro-instructions for each high-level instruction, unlike an assembler which translates item for item. When using a compiler, one cannot change a program without recompilation.

Development system A microcomputer system having all the related equipment necessary for hardware and software development.

Digital Pertaining to discrete integral numbers in a given base which may express all
the variables occurring in a problem. Represented electronically by 2 (binary) to 16 (hexadecimal) states at the present time. Contrasts with analog, which refers to a continuous range of voltage or current quantities.

Double density Method of doubling bit density on magnetic storage mediums.
Dynamic memory Storage of data on dynamic chips in which storage of a small charge indicates a bit. Because the charge leaks over time, dynamic memory must be periodically refreshed.

EBCDIC IBM's 8-bit code, similar to ASCII.
Editor A program that rearranges text. Permits the addition or deletion of symbols and changes of format.

EIA-RS-232C Interface standard for data transmitted sequentially that is not synchronous with the central processor.

EPROM Erasable-Progammable Read-Only Memory. A PROM that can be erased and reprogrammed. Some EPROMs have a quartz window over the chip; data can be erased by exposure to intense ultraviolet light; other EPROMs may be erased electrically.

File A set of related records treated as a unit.
Flag A bit attached to a word for identification or for the purpose of signaling some condition. Typical microprocessors include carry, zero, sign, overflow and half-carry status flags.

Floating-point package A set of software routines that allows some microcomputers to perform floating-point arithmetic without the addition of extra hardware.

FSK Frequency Shift Keyirg. Technique of transforming bits into two different frequencies representing 0 and 1 for transmission over telephone or radio lines. The interface device is called a modem.

Ground Electrical reference point of a circuit.
Hard-copy Printed output on paper.
Hardware The physical components, peripherals, or other equipment that make up a computer system. Contrast with software.

Hexadecimal A numbering system based on multiples of 16 using the character 0 thru 9 and A thru F. For example, OB hexadecimal equals 00001011 binary. One byte may be encoded in exactly 2 hexadecimal symbols.

High-level language A programming language that is relatively independent of assembler or machine language. The grammar often resembles English and requires a compiler or interpreter to convert to executable code. Examples: BASIC, FORTRAN, COBOL, ALGOL, PL/M, APL.

Instruction A step in a program that defines an operation together with the address(es) of any data needed for the operation.

Interface A common boundary between two systems or devices. The hardware or software necessary to interconnect two parts of a system.

Interrupt A break in the execution of a program usually caused by a signal from an
external device.
Kansas City standard Refers to a standard for cassette tape recordings of EIA-RS-232C data. Eight cycles of 2400 Hz equals 1, and 4 cycles of 1200 Hz equals 0 .

Least significant bit The binary digit occupying the right-most position in a number or word, ie: $2^{\circ}$ or 1.

LIFO Last-In, First-Out. Method of accessing the most recent entry, then the next most recent, and so on.

Light pen Photosensitive device that can be used to change the display on a CRT by generating a pulse at the point of contact.

Machine language Sets of binary integers that may be directly executed as instructions by the microcomputers without prior interpretation.

Mass storage Floppy disks, cassettes or tapes used to store large amounts of data. Less accessible, but larger than main storage.

Memory Storage device for binary information.
Microcomputer A small computer system capable of performing a basic repertoire of instructions. Includes a central processor, often contained on a single chip, memory, 1/O devices, and power supply.

Microprocessor A central processor on a chip. A complete processor on a single chip, manufactured using microminiature manufacturing techniques, known as LSI (large scale integration).

Modem MOdulator-DEModulator. Device that transforms binary data into frequencies suitable for transmission over telephone lines and back again.

Monitor A program that controls the operation of basic routines to optimize computer time.

Most significant bit The binary digit occupying the left-most position in a number or word, usually $2^{\prime}$ or 128 .

Octal A numbering system based on multiples of eight using digits 0 thru 7. Now largely superseded by the hexadecimal system.

Operating system Software that operates the hardware resources of a microcomputer. The operating system may do scheduling, debugging, I/O control, accounting, compilation, storage assignment, and data management.

Parity An extra bit that indicates whether a computer word has an odd or even number of 1 s . Used to detect errors.

Peripheral Any piece of equipment, usually an I/O device, attached to the central processor.

Programmable memory Storage in which access to new information is independent of the address previously examined.

Read-only memory (ROM) Storage that cannot be altered. The information is written at the time of manufacture.

Register A memory device directly accessible by the central processor used for the
temporary storage of a computer word during arithmetic, logical, or input/output operations.

S-100 A 100-pin bus used in the popular 8080/Z80 system.
Software Programs that translate high-level languages into machine language, such as compilers, operating systems, assemblers, generators, library routines, and editors.

Stack A technique of presenting programs sequentially. A stack is a LIFO structure controlled by PUSH and POP instructions.

Tiny BASIC The BASIC programming language reduced to a simple form that permits integer arithmetic and some string operations. Tiny BASIC usually oscupies 4 K or less bytes of memory.

Three-state Capable of existing in three logical states-0 (low), 1 (high), or undefined (high-impedance), ie: floating.

UART Universal Asynchronous Receiver Transmitter. A transmitter that converts serial to parallel and vice versa.

Word A set of bits that occupies one storage location and is treated as a unit. May have any number of bits, but usually 4,8 , or 16 .

Word processor A text editor that allows the user to modify text: formats, books, letters, and reports.

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# Build Your Own Z80 Computer: Design Guidelines and Application Notes 

"There is a major need for a book such as this. The information is not readily available elsewhere. Or anywhere. There are dozens (hundreds?) of microprocessor books, but nearly all deal with software and treat hardware as abstractions or block diagrams. Ciarcia's book is literally filled with very useful and practical "hands-on" hardware advice, tips and techniques....The book will do for the reader what no other microprocessor book or manufacturer's literature I know of does: It will enable a person to actually buy individual parts and assemble them into a working microcomputer-with peripherals and options! That's very important. Too bad we couldn't have had such a book years ago.'
-Forrest Mims, III
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-Joseph Nichols
Digital Analysis Corporation

[^1]
[^0]:    *At Selected Row Decode **At Cursor Blink Rate
    Note: If Character is Binking at Character Rate, Cursor will change it to Cursor Blink Rate.

[^1]:    About the Author
    Steve is a computer consultant, electrical engineer, author of BYTE magazine's most popular column, "Ciarcia's Circuit Cellar," and a "national technological treasure."

